

RZ/T2, RZ/N2 Group

OPC UA Server and PubSub Sample Software

Introduction

This document describes sample software for running OPC UA Server and PubSub on the RZ/T2, RZ/N2 in a real-time OS environment.

RZ/T2M and RZ/T2ME are designed to be compatible, so please use the model names in this document interchangeably.

Target Device

RZ/T Series: RZ/T2M (RZ/T2ME), RZ/T2H Group

RZ/N Series: RZ/N2L, RZ/N2H Group

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1. Overview

OPC UA, which enables interoperability of industrial applications, is becoming widely used not only in factory automation but also in various industries.

This document describes the configuration and usage of sample software for implementing OPC UA Server and PubSub using a real-time OS on the RZ processors RZ/T2 and RZ/N2 for industrial networks.

1.1 Abbreviations / Definitions

The terms used in this document are defined and used as shown below.

Table 1.1. Abbreviations/Definitions

Index	Abbreviations/Definitions	Description
1	BPS	Board Support Package
2	CA55	Cortex®-A55
3	CR52	Cortex®-R52
4	CRL	Certificate Revocation List
5	EVB	Evaluation Board
6	EWARM	Embedded Workbench® for ARM
7	FAT	File Allocation Table
8	FSP	Flexible Software Package
9	FSP SC	FSP Smart Configurator
10	LLDP	Link Layer Discovery Protocol
11	MIB	Management Information Base
12	MQTT	Message Queuing Telemetry Transport
13	NTP	Network Time Protocol
14	OPC UA	Open Platform Communications Unified Architecture
15	PubSub	Publisher Subscriber
16	RSK	Renesas Starter Kit
17	SNMP	Simple Network Management Protocol
18	SNTP	Simple Network Time Protocol
19	TFTP	Trivial File Transfer Protocol
20	TLV	Type Length Value
21	UADP	UA Datagram Protocol
22	XML	Extensible Markup Language

1.2 Reference

Table 1.2. Technical Inputs for RZ/T2M

Document Type	Description	Document Title	Document No.
User's Manual	Describes the technical details of the RSK+RZ/T2M hardware.	Renesas Starter Kit+ for RZ/T2M User's Manual	R20UT4939*****
User's Manual	Provides technical details of the RZ/T2M microprocessor.	RZ/T2M User's Manual Hardware	R01UH0916*****

Table 1.3. Technical Inputs for RZ/N2L

Document Type	Description	Document Title	Document No.
User's Manual	Describes the technical details of the RSK+RZ/N2L hardware.	Renesas Starter Kit+ for RZ/N2L User's Manual	R20UT4984*****
User's Manual	Provides technical details of the RZ/N2L microprocessor.	RZ/N2L User's Manual Hardware	R01UH0955*****

Table 1.4. Technical Inputs for RZ/T2H

Document Type	Description	Document Title	Document No.
User's Manual	Describes the technical details of the RZ/T2H Evaluation Board hardware.	RZ/T2H Evaluation Board Kit User's Manual	R20UT5405*****
User's Manual	Provides technical details of the RZ/T2H, RZ/N2H microprocessors.	RZ/T2H and RZ/N2H User's Manual Hardware	R01UH1039*****

Table 1.5. Technical Inputs for RZ/N2H

Document Type	Description	Document Title	Document No.
User's Manual	Describes the technical details of the RZ/N2H Evaluation Board hardware.	RZ/N2H Evaluation Board Kit User's Manual	R20UT5522*****
User's Manual	Provides technical details of the RZ/T2H, RZ/N2H microprocessors.	RZ/T2H and RZ/N2H User's Manual Hardware	R01UH1039*****

Table 1.6. Technical Inputs for RZ/T2, N2 (Common)

Document Type	Description	Document Title	Document No.
Application Note	RZ/T2, N2 FSP startup guide	RZ/T2, RZ/N2 Getting Started with Flexible Software Package	R01AN6434*****

2. Features

This package includes the firmware for the OPC UA stack on Renesas RZ/T2 and RZ/N2 series processors.

2.1 Function List

The features supported by this sample software are as follows.

2.1.1 OPC UA Server

The OPC UA Server specifications for this sample software are as shown in Table 2.1. This project has obtained OPC UA Server certification using software developed for RZ/T2M, RZ/T2H and RZ/N2L based on the Sample Software v3.0.0. This sample software offers the same functionality as those software packages.

Table 2.1. OPC UA Server Specifications

Items										
Supported Profiles and Facet										
Application Profile	Micro Embedded Device 2017 Server [UACore 1.04]									
Additional Facets	Method Server Facet									
Security Policies	None Basic256 Basic128Rsa15 Basic256Sha256 Aes128-Sha256-RsaOaep									
User Tokens	Anonymous Server Facet User Name Password Server Facet <table border="1" data-bbox="833 1079 1195 1191"> <thead> <tr> <th></th> <th>Username</th> <th>Password</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>user1</td> <td>password</td> </tr> <tr> <td>2</td> <td>user2</td> <td>password1</td> </tr> </tbody> </table>		Username	Password	1	user1	password	2	user2	password1
	Username	Password								
1	user1	password								
2	user2	password1								
Server Capabilities										
Max sessions	2									
Max subscriptions per session	2									
Max monitored items per subscription	100									
Min publishing interval	500ms									
Min sampling interval	250ms									

2.1.2 OPC UA PubSub

The OPC UA PubSub specifications for this sample software are as shown in Table 2.2. Communication with SKS Server is currently not supported.

Table 2.2. OPC UA PubSub Specifications

Items	
PubSub Interface	
Layout	UADP Periodic Fixed Layout UADP Dynamic Layout
SecurityPolicy	None PubSub-Aes128-CTR PubSub-Aes256-CTR
SecurityMode	None Sign SignAndEncrypt

2.1.3 Other Protocols

This sample software supports the protocols shown in Table 2.3. For details on each protocol, please refer to the chapter described in the Details section.

Table 2.3. Sample Software Support Protocols

Protocol	Details
SNTP Client	Get time information from NTP server when the device starts up
TFTP Server	Chapter 9.2
LLDP Agent	Chapter 9.3
SNMP Agent	Chapter 9.3

2.1.4 Security

Various files used for security functions are managed by the file system (FreeRTOS + FAT) function and read from a USB flash drive connected to the evaluation board. You can also write files to a USB flash drive via Ethernet using TFTP communication. The file names used are shown in Table 2.4. Files with “✓” in the “Attached to Package” column are stored in “keyfiles.zip” in the package as a sample.

The `cr1_1.pem` attached to this package contains the revocation information for `cert_client_1.der`. Please be careful not to write the CRL file except when checking the operation of the certificate revocation list.

When writing files, please store them in the `<USB_ROOT>/passw0rd/` folder on the USB flash drive.

Table 2.4. Key Files

File	File Name	Attached to Package
Server Certificate	<code>cert_server.der</code>	✓
Server Private Key	<code>pkey_server.der</code>	✓
Client Certificate (TrustList)	<code>cert_client_1.der</code> <code>cert_client_2.der</code> :	✓ -
IssuerList	<code>issuer_1.der</code> <code>issuer_2.der</code> :	-
CRL	<code>cr1_1.pem</code> <code>cr1_2.pem</code> :	✓ -
PubSub Encryption Key for AES128	<code>pubsub_aes128_key.bin</code>	✓
PubSub Encryption Key for AES256	<code>pubsub_aes256_key.bin</code>	✓

✓: attached, -: not attached

Please refer to chapter 9.6 for how to change the maximum number of TrustList, CRL and IssuerList and chapter 9.2 for how to write files to a USB flash drive using TFTP.

It is also possible to perform security operations without a USB flash drive connected. In this case, please refer to chapter 9.6.

2.2 Package folder structure

The folder structure for this sample software is shown below.

Table 2.5. RZ/T2M Folder structure

Item	Description
RZT2M_OPC_RSK_rev0410	
├── common	Common files for all projects
└── project	Projects
├── CR52_dual	Dual core project
├── e2studio	e ² studio project
├── RZT2M_RSK_OPC_Primary_0	For CR52_0 (primary core)
└── RZT2M_RSK_OPC_Secondary_1	For CR52_1 (secondary core)
└── ewarm	EWARM project
├── RZT2M_RSK_OPC_Primary_0	For CR52_0 (primary core)
└── RZT2M_RSK_OPC_Secondary_1	For CR52_1 (secondary core)

Table 2.6. RZ/N2L Folder structure

Item	Description
RZN2L_OPC_RSK_rev0410	
├── common	Common files for all projects
└── project	Projects
├── CR52_single	Single core project
├── e2studio	e ² studio project
└── RZN2L_RSK_OPC_Primary_0	For CR52_0 (primary core)
└── ewarm	EWARM project
└── RZN2L_RSK_OPC_Primary_0	For CR52_0 (primary core)

Table 2.7. RZ/T2H Folder structure

Item	Description
RZT2H_OPC_EVB_rev0410	
├── common	Common files for all projects
└── project	Projects
├── CA55_dual	Dual core project
├── e2studio	e ² studio project
├── RZT2H_EVB_OPC_CA55_dual_CR52_0_Primary_0	For CR52_0 (primary core)
└── RZT2H_EVB_OPC_CA55_dual_CA55_2_Secondary_1	For CA55_2 (secondary core)
└── ewarm	EWARM project
├── RZT2H_EVB_OPC_CA55_dual_CR52_0_Primary_0	For CR52_0 (primary core)
└── RZT2H_EVB_OPC_CA55_dual_CA55_2_Secondary_1	For CA55_2 (secondary core)
├── CR52_dual	Dual core project
├── e2studio	e ² studio project
├── RZT2H_EVB_OPC_CR52_dual_CR52_0_Primary_0	For CR52_0 (primary core)
└── RZT2H_EVB_OPC_CR52_dual_CR52_1_Secondary_1	For CR52_1 (secondary core)
└── ewarm	EWARM project
├── RZT2H_EVB_OPC_CR52_dual_CR52_0_Primary_0	For CR52_0 (primary core)
└── RZT2H_EVB_OPC_CR52_dual_CR52_1_Secondary_1	For CR52_1 (secondary core)

Table 2.8. RZ/N2H Folder structure

Item	Description
RZN2H_OPC_EVB_rev0410	
├── common	Common files for all projects
├── project	Projects
│ ├── CA55_dual	Dual core project
│ │ ├── e2studio	e ² studio project
│ │ │ ├── RZN2H_EVB_OPC_CA55_dual_CR52_0_Primary_0	For CR52_0 (primary core)
│ │ │ └── RZN2H_EVB_OPC_CA55_dual_CA55_2_Secondary_1	For CA55_2 (secondary core)
│ │ └── ewarm	EWARM project
│ │ ├── RZN2H_EVB_OPC_CA55_dual_CR52_0_Primary_0	For CR52_0 (primary core)
│ │ └── RZN2H_EVB_OPC_CA55_dual_CA55_2_Secondary_1	For CA55_2 (secondary core)
│ └── CR52_dual	Dual core project
│ ├── e2studio	e ² studio project
│ │ ├── RZN2H_EVB_OPC_CR52_dual_CR52_0_Primary_0	For CR52_0 (primary core)
│ │ └── RZN2H_EVB_OPC_CR52_dual_CR52_1_Secondary_1	For CR52_1 (secondary core)
│ └── ewarm	EWARM project
│ ├── RZN2H_EVB_OPC_CR52_dual_CR52_0_Primary_0	For CR52_0 (primary core)
│ └── RZN2H_EVB_OPC_CR52_dual_CR52_1_Secondary_1	For CR52_1 (secondary core)

Table 2.9. Common folder structure

Item	Description
common	Common files for all projects
├── oss	Open Source Software
│ ├── MBEDTLS	Mbed TLS
│ ├── OPC_UA_SERVER	open62541
│ ├── amazon-freertos	FreeRTOS
│ └── lwip	lwIP
├── renesas	Renesas Software
│ ├── application	User OPC UA Application, KeyFiles
│ └── module	Modules
│ ├── ether_netif	NETIF module
│ ├── freertos_plus_fat	FreeRTOS+FAT module
│ ├── lwip_lldp	LLDP module
│ ├── lwip_port	Port module, SNMP/MIB module
│ └── serial_io	Serial interface module
└── oss_deps	OSS dependencies
├── amazon-freertos	FreeRTOS dependency
├── lwip	lwIP dependency
└── mbedtls	Mbed TLS dependency

3. Requirements (Software&Hardware)

This project has been developed and tested on these environments using the following boards and tools.

3.1 RZ/T2M

Table 3.1. RZ/T2M environment

Category	Name	Version	Description
Board	RZ/T2M RSK Board	-	Renesas RZ/T2M-RSK - Renesas Starter Kit Plus for RZ/T2M Renesas
IDE	EWARM	9.60.3	IAR Systems IAR Embedded Workbench for Arm IAR
	e ² studio	2025-12	RZ FSP
Configurator	FSP Smart Configurator	2025-12	GitHub - renesas/rz-fsp: Flexible Software Package (FSP) for Renesas RZ series · GitHub
Flexible Software Package	FSP	4.0.0	
GCC Compiler	GNU ARM Embedded Toolchain	13.3.1.arm-13-24	
Emulator	J-Link™	8.60	SEGGER SEGGER - The Embedded Experts - Downloads - J-Link / J-Trace
	I-jet	-	IAR Systems IAR debug probes IAR

3.2 RZ/N2L

Table 3.2. RZ/N2L environment

Category	Name	Version	Description
Board	RZ/N2L RSK Board	-	Renesas RZ/N2L-RSK - Renesas Starter Kit+ for RZ/N2L Renesas
IDE	EWARM	9.60.3	IAR Systems IAR Embedded Workbench for Arm IAR
	e ² studio	2025-12	RZ FSP
Configurator	FSP Smart Configurator	2025-12	GitHub - renesas/rz-fsp: Flexible Software Package (FSP) for Renesas RZ series · GitHub
Flexible Software Package	FSP	4.0.0	
GCC Compiler	GNU ARM Embedded Toolchain	13.3.1.arm-13-24	
Emulator	J-Link™	8.60	SEGGER SEGGER - The Embedded Experts - Downloads - J-Link / J-Trace
	I-jet	-	IAR Systems IAR debug probes IAR

3.3 RZ/T2H

Table 3.3. RZ/T2H environment

Category	Name	Version	Description
Board	RZ/T2H Evaluation Board	-	Renesas RZ/T2H-EVKIT - Evaluation Board Kit for RZ/T2H Renesas
IDE	EWARM	9.60.3	IAR Systems IAR Embedded Workbench for Arm IAR Patch for RZ/T2H, N2H "EWARM_Patch_for_RZT2H_N2H_rev1.0.zip" is required
	e ² studio	2026-04.1	RZ FSP
Configurator	FSP Smart Configurator	2026-04.1	GitHub - renesas/rz-fsp: Flexible Software Package (FSP) for Renesas RZ series · GitHub
Flexible Software Package	FSP	4.1.0	
GCC Compiler	GNU ARM Embedded Toolchain	13.3.1.arm-13-24	
	GNU ARM A-Profile (AArch64 bare-metal)	13.2.1.20231009	
Emulator	J-Link™	8.60	SEGGER SEGGER - The Embedded Experts - Downloads - J-Link / J-Trace
	I-jet	-	IAR Systems IAR debug probes IAR

3.4 RZ/N2H

Table 3.4. RZ/N2H environment

Category	Name	Version	Description
Board	RZ/N2H Evaluation Board	-	Renesas RZ/N2H-EVKIT - Evaluation Board Kit for RZ/N2H Renesas
IDE	EWARM	9.60.3	IAR Systems IAR Embedded Workbench for Arm IAR Patch for RZ/T2H, N2H "EWARM_Patch_for_RZT2H_N2H_rev1.0.zip" is required
	e ² studio	2026-04.1	RZ FSP
Configurator	FSP Smart Configurator	2026-04.1	GitHub - renesas/rz-fsp: Flexible Software Package (FSP) for Renesas RZ series · GitHub
Flexible Software Package	FSP	4.1.0	
GCC Compiler	GNU ARM Embedded Toolchain	13.3.1.arm-13-24	
	GNU ARM A-Profile (AArch64 bare-metal)	13.2.1.20231009	
Emulator	J-Link™	8.60	SEGGER SEGGER - The Embedded Experts - Downloads - J-Link / J-Trace
	I-jet		IAR Systems IAR debug probes IAR

3.5 Common

Table 3.5. Common environment

Category	Name	Version	Link	Notes
USB Flash Drive	-	-	-	Used as file storage for file system Formatting to FAT32 format required *Can be operated without USB Flash Drive.
OPC UA Client Tool	UaExpert	2.0.1	OPC UA Clients - Unified Automation (unified-automation.com)	
Packet analyzer	Wireshark	4.4.7	Wireshark · Download	
OPC Communication Generic Tool	OpcCmd Utility	-	OpcCmd Utility Download - OPC Labs Knowledge Base	Using as OPC UA Pub/Sub Subscriber
OPC UA Publisher Tool	UADemoPublisher	-	OPC UA Demo Publisher Download - OPC Labs Knowledge Base	
Low-code development tool	Node-RED	4.0.3	Node-RED (nodered.org) Node.js — Run JavaScript Everywhere (nodejs.org)	Using as OPC UA Client Graphical display of Node value

4. Hardware Setup

This document describes the major hardware. For more information about the boards, refer to the respective evaluation board user manuals and schematics.

4.1 RZ/T2M RSK Board

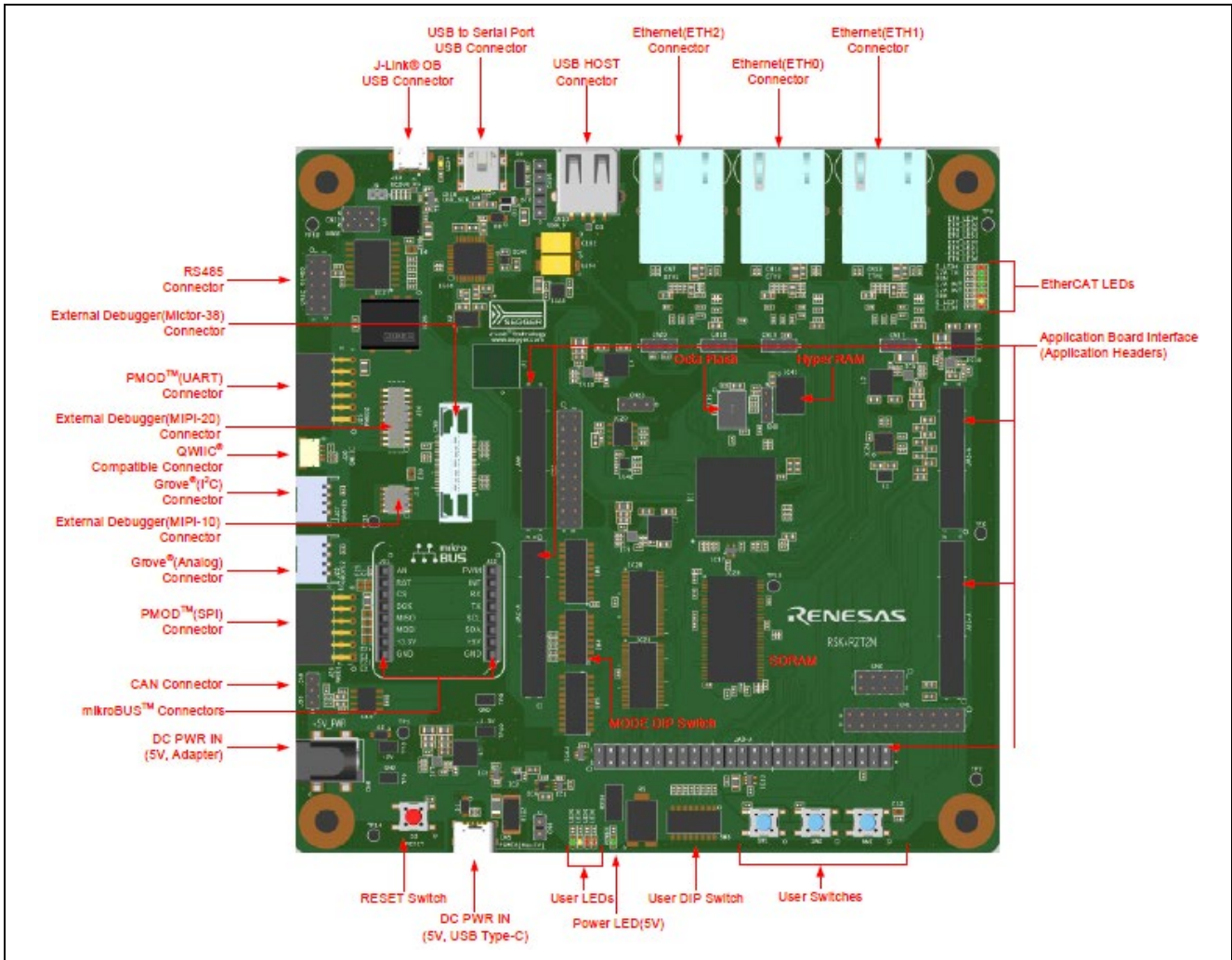


Figure 4.1. RZ/T2M RSK board layout

The text in red in the table indicates settings that need to be changed from the evaluation board's factory default settings.

Table 4.1. Jumper and Switch Configuration

Reference	Jumper Position	Description
CN8	Short 1-2	Use Octa Flash
	Short 2-3	Use QSPI Serial Flash
CN17	Short 1-2	VCC1833_2 Use power supply at 3.3V (Use SDRAM)
	Short 2-3	VCC1833_2 Use power supply at 1.8V
CN18	Short 1-2	Use 3 ports in the same PHY mode
	Short 2-3	Use ports 0, 1 in the same PHY mode, use port 2 in different PHY modes
CN19	Short 1-2	Use 3 ports in the same PHY mode
	Short 2-3	Use ports 0, 1 in the same PHY mode, use port 2 in different PHY modes
CN20	Short 1-2	Use 3 ports in the same PHY mode
	Short 2-3	Use ports 0, 1 in the same PHY mode, use port 2 in different PHY modes
CN21	Short 1-2	Use RS485 transmission method in full duplex
	Short 2-3	Use RS485 transmission method in half duplex
CN22	Short 1-2	Use RS485 transmission method in full duplex
	Short 2-3	Use RS485 transmission method in half duplex
CN23	Short 1-2	Not use CS5#
	Short 2-3	Use CS5#
J9	Open	Use J-Link OB
	Short	Use External Debugger

Table 4.2. SW4 Settings

SW4	Setting	Description
SW4-1	ON	16bit Bus boot mode (NOR Flash ROM Boot).
SW4-2	OFF	
SW4-3	ON	
SW4-4	ON	MDD=0, JTAG Authentication by Hash is disabled.
SW4-5	OFF	MDW=1, ACTM 1 wait, should be set when TCM is used with CPU operating frequencies above 400MHz
SW4-6	OFF	
SW4-7	OFF	
SW4-8	OFF	

Table 4.3. SW5 Setting.

SW5	Setting	Description
SW5-1	OFF	-
SW5-2	OFF	-
SW5-3	ON	Enable the "SCI_RTS" signal.
SW5-4	OFF	
SW5-5	ON	Enable the "SCI_RXD" signal.
SW5-6	OFF	
SW5-7	OFF	
SW5-8	OFF	Enable the "SCK3" signal.
SW5-9	ON	
SW5-10	OFF	

Table 4.4. SW6 Setting

SW6	Setting	Description
SW6-1	ON	Enable external bus
SW6-2	OFF	-
SW6-3	ON	TRACE_CTL signal is enabled
SW6-4	OFF	
SW6-5	OFF	SCI_TXD signal is enabled
SW6-6	ON	
SW6-7	OFF	MB_RST# signal is enabled
SW6-8	ON	
SW6-9	OFF	CAN_RX_OB signal is enabled
SW6-10	ON	

4.1.1 Board Setup

Figure 4.2 shows a connection diagram when running the sample software. Connect the Ethernet cable, J-Link OB debugger, and 5V DC cables to the RZ/T2M RSK board.

You can connect the Ethernet cable to the ETH0 or 1 connector. When using the debugger J-Link OB on the RSK board, open J9 and connect the USB Micro cable. When using I-jet, short J9 and connect I-jet to J20.

This sample software uses SNTP for time synchronization and requires a connection to an NTP Server. A Windows PC is used as the NTP Server during the operation check.

If you use FreeRTOS+FAT for managing key files used by the OPC UA security function, a USB flash drive connection to the RSK board is required.

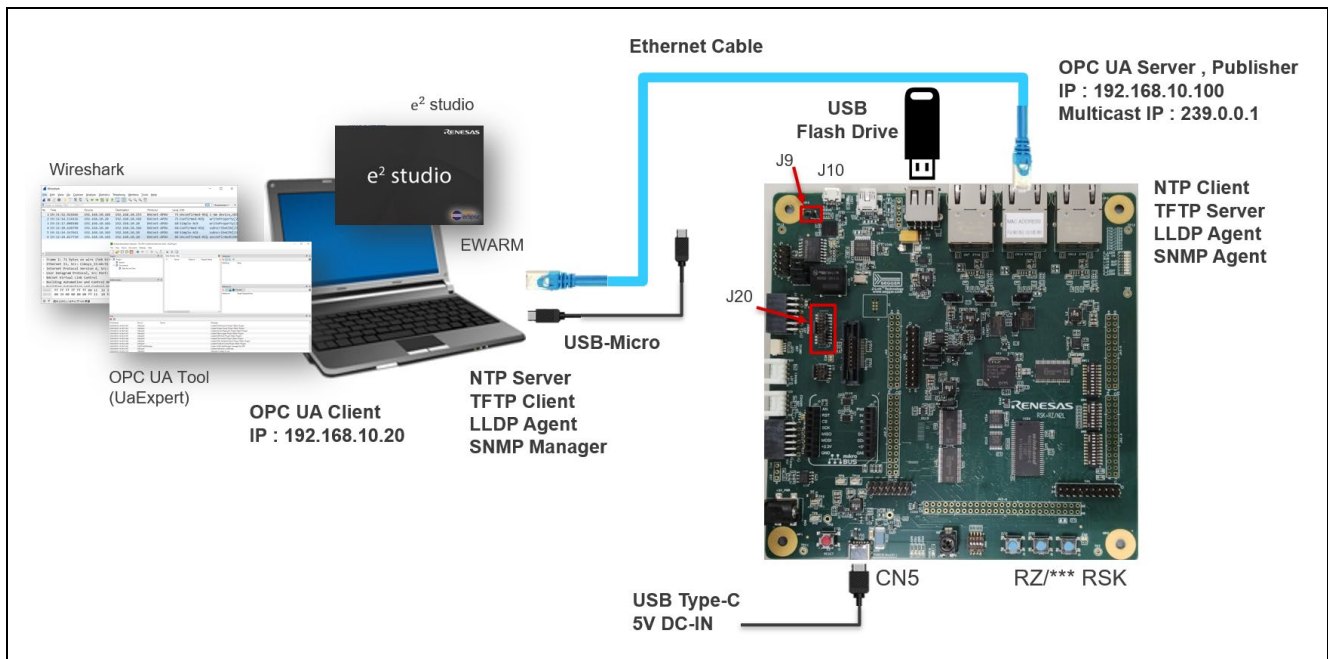


Figure 4.2. RZ/T2M RSK board OPC UA Server hardware connection diagram

4.2 RZ/N2L RSK Board

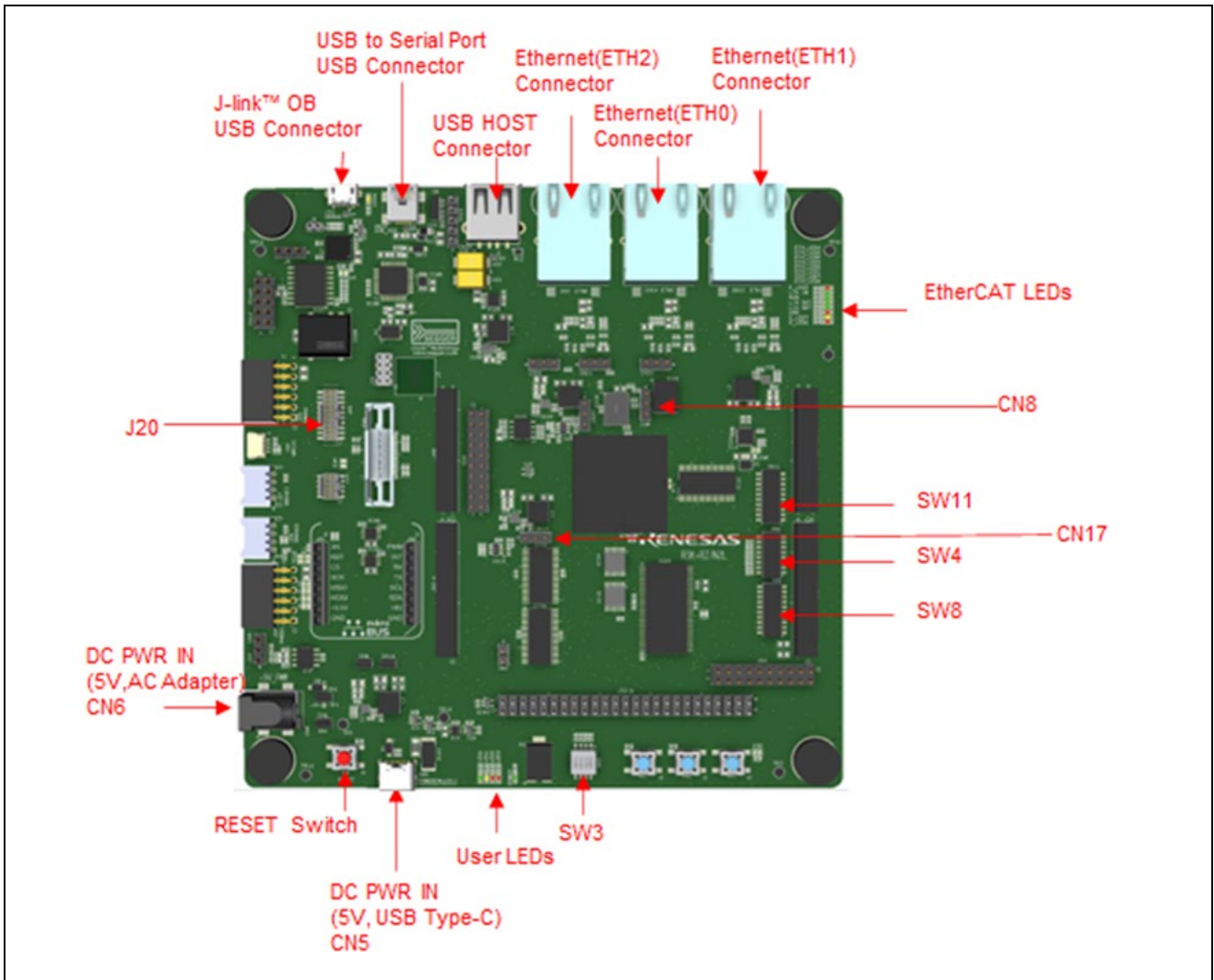


Figure 4.3. RZN2L RSK board layout

The text in red in the table indicates settings that need to be changed from the evaluation board's factory default settings.

Table 4.5. Jumper and Switch Configuration

Reference	Jumper Position	Description
CN8	Short 1-2	Use Octa Flash
	Short 2-3	Use QSPI Serial Flash
CN17	Short 1-2	VCC1833_2 Use power supply at 3.3V (Use SDRAM)
	Short 2-3	VCC1833_2 Use power supply at 1.8V
CN20	Short 1-2	Use 3 ports in the same PHY mode
	Short 2-3	Use ports 0, 1 in the same PHY mode, use port 2 in different PHY modes
CN21	Short 1-2	Use 3 ports in the same PHY mode
	Short 2-3	Use ports 0, 1 in the same PHY mode, use port 2 in different PHY modes
CN22	Short 1-2	Use 3 ports in the same PHY mode
	Short 2-3	Use ports 0, 1 in the same PHY mode, use port 2 in different PHY modes
CN24	Short 1-2	VCC1833_2 Use power supply at 3.3V (Use SDRAM)
	Short 2-3	VCC1833_2 Use power supply at 1.8V
CN25	Short 1-2	Use other than the SHOST interface
	Short 2-3	Use the SHOST interface
CN27	Short 1-2	Use HyperRAM
	Short 2-3	Use the SHOST interface
CN29	Short 1-2	Use the USB Serial
	Short 2-3	Use the SHOST interface
CN31	Short 1-2	Use RS485 transmission method in full duplex
	Short 2-3	Use RS485 transmission method in half duplex
CN32	Short 1-2	Use RS485 transmission method in full duplex
	Short 2-3	Use RS485 transmission method in half duplex
J9	Open	Use J-Link OB
	Short	Use External Debugger

Table 4.6. SW4 Settings

SW4	Setting	Description
SW4-1	ON	16bit Bus boot mode (NOR Flash ROM Boot)
SW4-2	OFF	
SW4-3	ON	
SW4-4	ON	MDD=0, JTAG Authentication by Hash is disabled.
SW4-5	OFF	MDW=1, ACTM 1 wait, should be set when TCM is used with CPU operating frequencies above 400MHz
SW4-6	OFF	Enables signals other than the trace signal. (Motor, RS485, etc)
SW4-7	OFF	Enables signals other than the external bus. (CAN, Emulator, I2C, etc.)
SW4-8	OFF	Enable SW3.

Table 4.7. SW8 Setting.

SW8	Setting	Description
SW8-1	OFF	Enable the "LED_GREEN" signal.
SW8-2	ON	
SW8-3	OFF	
SW8-4	ON	Enable the "LED5" signal.
SW8-5	OFF	
SW8-6	OFF	RS485_DE & M2_VN Configuration Switch Setting
SW8-7	ON	
SW8-8	OFF	CAN_TX & IRQ4 & P02_2 Configuration Switch Setting
SW8-9	OFF	
SW8-10	ON	

Table 4.8. SW11 Setting

SW11	Setting	Description
SW11-1	ON	Enable the "LED_RED2" signal.
SW11-2	OFF	
SW11-3	OFF	
SW11-4	OFF	RS485_RX & M2_UP Configuration Switch Setting
SW11-5	ON	
SW11-6	OFF	P21_5 & M2_VP Configuration Switch Setting
SW11-7	ON	
SW11-8	OFF	CAN_RX & ADTRG & P01_7 Configuration Switch Setting
SW11-9	OFF	
SW11-10	ON	

4.2.1 Board Setup

Figure 4.4 shows a connection diagram when running the sample software. Connect the Ethernet cable, J-Link OB debugger, and 5V DC cables to the RZ/N2L RSK board.

You can connect the Ethernet cable to the ETH0 or 1 connector. When using the debugger J-Link OB on the RSK board, open J9 and connect the USB Micro cable. When using I-jet, short J9 and connect I-jet to J20.

This sample software uses SNTP for time synchronization and requires a connection to an NTP Server. A Windows PC is used as the NTP Server during the operation check.

If you use FreeRTOS+FAT for managing key files used by the OPC UA security function, a USB flash drive connection to the RSK board is required.

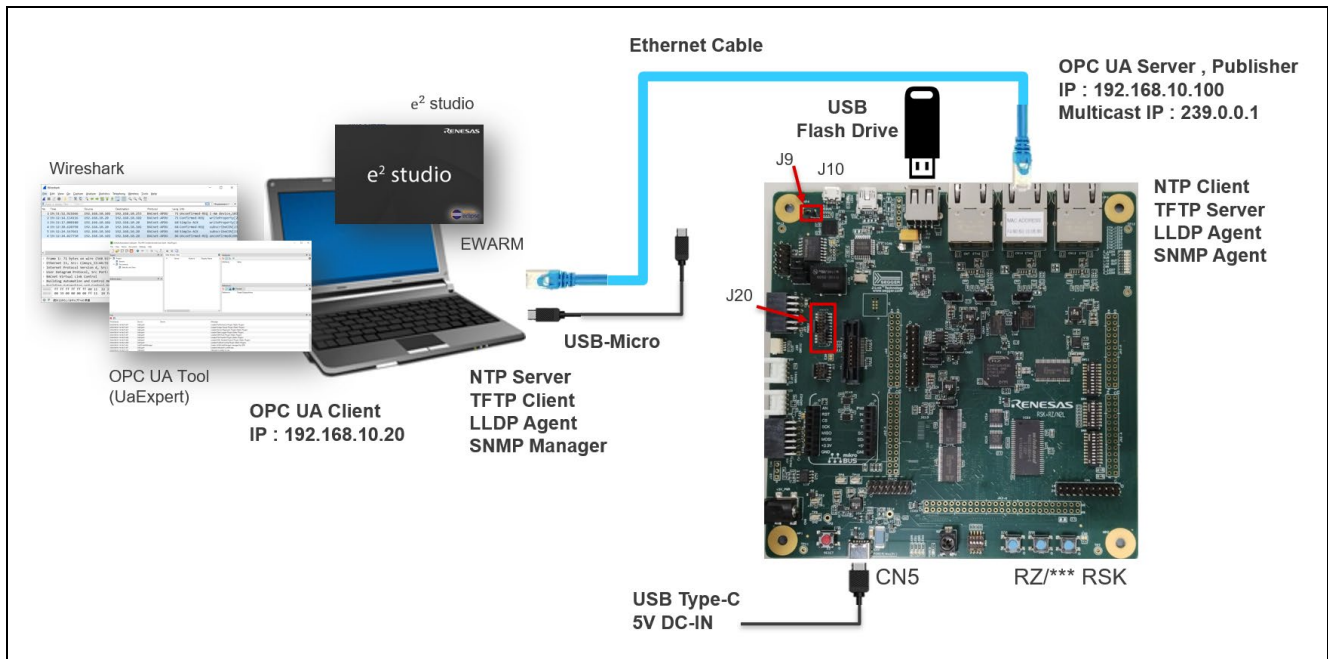


Figure 4.4. RZ/N2L RSK board OPC UA Server hardware connection diagram

4.3 RZ/T2H Evaluation Board

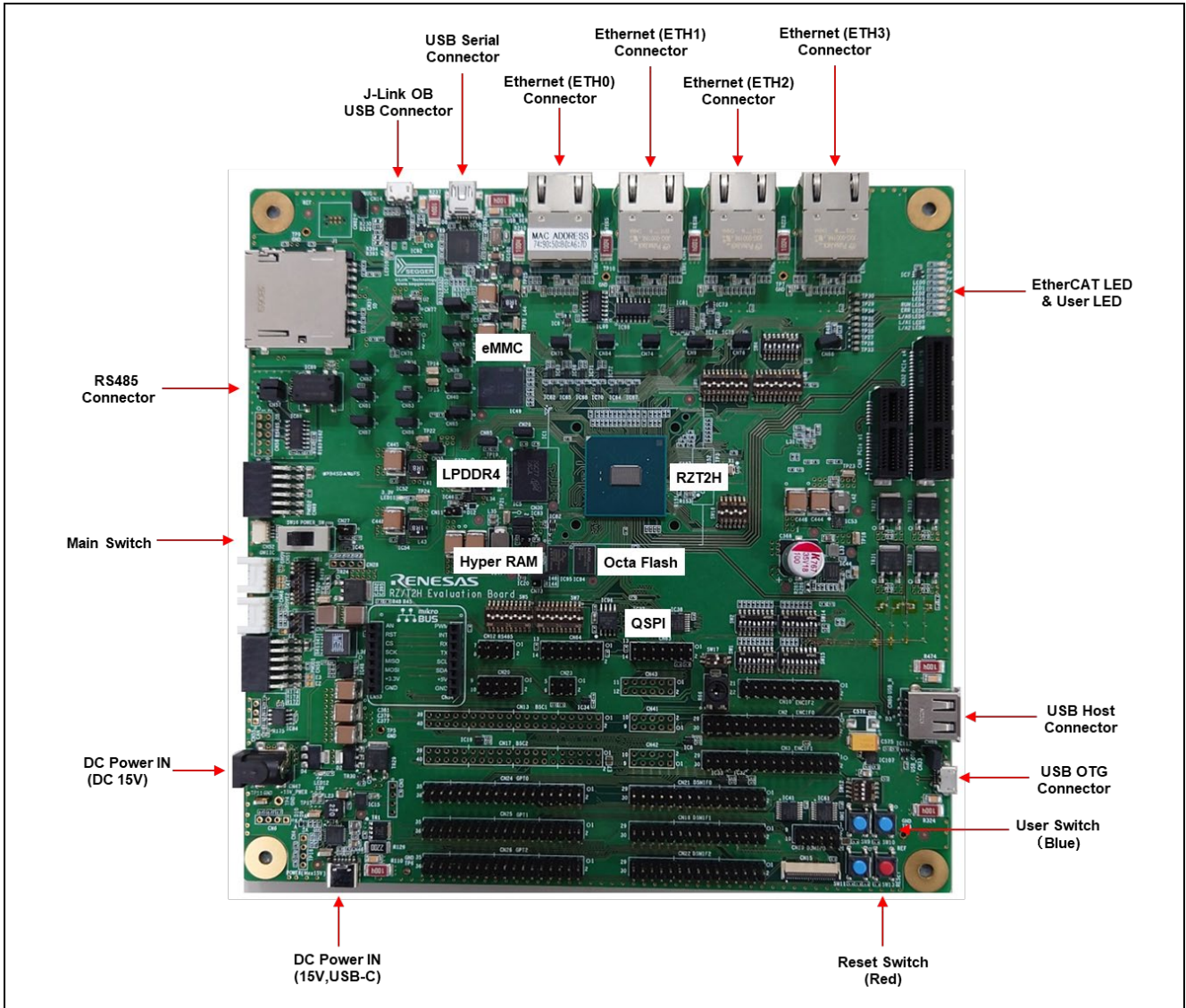


Figure 4.5. RZT2H Evaluation board layout

The text in red in the table indicates settings that need to be changed from the evaluation board's factory default settings.

Table 4.9. Jumper and Switch Configuration

Reference	Jumper Position	Description
CN62	Short	The on-board debugging function J-Link™ OB is disabled.
CN73	Open	PCIe reset is not included in the system reset factors.
CN9	Short 1-2	VCC1833_0 is supplied to VCC_ETH2_MDIO (SW2-6 is ON: When P21_4 and P21_5 are selected for MDIO).
	Short 2-3	VCC1833_2 is supplied to VCC_ETH2_MDIO (SW2-6 is OFF: When P30_5 and P30_6 are selected for MDIO).
CN37	Short 1-2	1.8-V power is supplied to VCC1833_0 (for Ethernet port 0).
	Short 2-3	3.3-V power is supplied to VCC1833_0 (for Ethernet port 0).
CN38	Short 1-2	1.8-V power is supplied to VCC1833_1 (for Ethernet port 1).
	Short 2-3	3.3-V power is supplied to VCC1833_1 (for Ethernet port 1).
CN39	Short 1-2	1.8-V power is supplied to VCC1833_2 (for Ethernet port 2).
	Short 2-3	3.3-V power is supplied to VCC1833_2 (for Ethernet port 2).
CN40	Short 1-2	1.8-V power is supplied to VCC1833_3 (for Ethernet port 3).
	Short 2-3	3.3-V power is supplied to VCC1833_3 (for Ethernet port 3).
CN77	Short 1-2	3.3-V power is supplied to VCC1833_7 (for SD1).
	Short 2-3	The output from the power-supply control IC for SD1 is supplied to VCC1833_7 (for SD1).
CN78	Short 1-2	3.3-V power is supplied to VCC1833_6 (for SD0).
	Short 2-3	The output from the power-supply control IC for SD0 is supplied to VCC1833_6 (for SD0).
	Short 5-6	1.8-V power is supplied to VCC1833_6 (for SD0).
CN56	Short 1-2	Full-duplex communication
CN57	Short 2-3	Half-duplex communication

Table 4.10. SW14 Settings

SW14	Setting	Description
SW14-1	ON	xSPI1 boot mode (x1 boot serial flash)
SW14-2	OFF	
SW14-3	ON	
SW14-4	OFF	CPU0 ATCM wait cycle = 1 wait cycle
SW14-5	OFF	CPU1 ATCM wait cycle = 1 wait cycle
SW14-6	OFF	Supply voltage of boot peripheral is 3.3 V
SW14-7	ON	JTAG mode = Normal mode
SW14-8	OFF	Not used

Table 4.11. SW1 Settings

SW1	Setting	Description
SW1-1	ON	XTALSEL = 'L' Select oscillator for RZ/T2H clock input.
SW1-2	OFF	(At the time of shipment = OFF)
SW1-3	ON	P35_3,4,5,6 are connected to SW12 and used as user DIPSW inputs.
SW1-4	OFF	P13_4, P13_5, and P14_0 are used as RXD3, TXD3, and DE3 of the RS485.
SW1-5	ON	P00_0,1,2 are used as USB power supply IC control signals.
SW1-6	ON	P01_0,1,2,4,5,6,7 and P02_0,1,2,3 are used as XSPI1 signals.
SW1-7	OFF	(At the time of shipment = OFF)
SW1-8	OFF	(At the time of shipment = OFF)

Table 4.12. SW2 Settings

SW2	Setting	Description
SW2-1	ON	P12_0 to 7, P13_0 to 2 are connected to eMMC.
SW2-2	ON	
SW2-3	ON	P17_4, P08_5, and P08_6 are used as SD1 control signals.
SW2-4	OFF	(At the time of shipment = OFF)
SW2-5	OFF	(At the time of shipment = OFF)
SW2-6	ON	GMAC0 (P21_4, P21_5) are connected to MDC/MDIO of Ethernet Port2.
SW2-7	ON	P29_1 to 7, P30_0 to 4, P31_2 to 5 are used as Ethernet Port2 control signals.
SW2-8	ON	P27_2, P33_2 to P33_7, P34_0 to P34_5, P34_7, and P35_0 to P35_2 are used as control signals for Ethernet port 3.

Table 4.13. SW4 Settings

SW4	Setting	Description
SW4-1	ON	P27_0 is used as ETH1_CRS.
SW4-2	OFF	
SW4-3	ON	P27_1 is used as ETH1_COL.
SW4-4	OFF	
SW4-5	ON	P27_4 is used as RXD0 of USB-to-serial conversion.
SW4-6	OFF	
SW4-7	ON	P27_5 is used as TXD0 of USB-to-serial conversion.
SW4-8	OFF	

Table 4.14. SW5 Settings

SW5	Setting	Description
SW5-1	OFF	P32_2 is used as USER_LED1.
SW5-2	ON	
SW5-3	OFF	When SW2-3 = ON, P08-6 is used as SD1_IOVS.
SW5-4	ON	
SW5-5	OFF	P07_5 is used as XSPI0_ECS# for OctaFlash.
SW5-6	ON	
SW5-7	OFF	P23_0 is used as ESC_LINKACT1.
SW5-8	ON	
SW5-9	OFF	P22_7 is used as ESC_LINKACT0.
SW5-10	ON	

Table 4.15. SW6 Settings

SW6	Setting	Description
SW6-1	OFF	P11_0 is used as ESC_RESETOUT2#.
SW6-2	OFF	
SW6-3	ON	
SW6-4	OFF	P11_0 is used as ESC_RESETOUT01#.
SW6-5	ON	
SW6-6	OFF	(At the time of shipment = OFF)
SW6-7	ON	P23_3 is used as ESC_I2CCLK.
SW6-8	OFF	
SW6-9	ON	P23_4 is used as ESC_I2CDATA.
SW6-10	OFF	

Table 4.16. SW7 Settings

SW7	Setting	Description
SW7-1	OFF	P24_4 is used as CAN_TX.
SW7-2	ON	
SW7-3	OFF	P24_3 is used as CAN_RX.
SW7-4	ON	
SW7-5	OFF	P23_5 is used as ESC_LINKACT2.
SW7-6	ON	
SW7-7	OFF	Use VUBUSIN for USB_Function.
SW7-8	ON	
SW7-9	OFF	P00_0 is used as USB_HF_VBUSEN.
SW7-10	ON	

Table 4.17. SW8 Settings

SW8	Setting	Description
SW8-1	ON	P18_1 is used as ESC_LED_ERR.
SW8-2	OFF	
SW8-3	ON	P18_0 is used as ESC_LED_RUN.
SW8-4	OFF	
SW8-5	ON	P16_3 is used as RXD5 of USB-to-serial conversion.
SW8-6	OFF	
SW8-7	ON	P16_4 is used as TXD5 of USB-to-serial conversion.
SW8-8	OFF	
SW8-9	ON	P23_1 is used as USER_LED0.
SW8-10	OFF	

Table 4.18. SW15 Settings

SW15	Setting	Description
SW15-1	ON	PCIe functions is used as Root Complex.
SW15-2	ON	PCIe L1 is used as a root complex.
SW15-3	OFF	The PCIe function is used in a configuration of 2 lanes × 1 port.
SW15-4	OFF	(At the time of shipment = OFF)
SW15-5	OFF	The 12-V power supply of the PCIe x4 connector CN32 is OFF.
SW15-6	OFF	The 3.3-V power supply of the PCIe x4 connector CN32 is OFF.
SW15-7	OFF	The 3.3-V power supply of the PCIe x1 connector CN8 is OFF.
SW15-8	OFF	The 12-V power supply of the PCIe x1 connector CN8 is OFF.

Table 4.19. SW17 Settings

SW17	Setting	Description
SW17-1	ON	AN000 is connected to potentiometer.
SW17-2	OFF	

Table 4.20. SW18 Settings

SW18	Setting	Description
SW18-1	OFF	AN100 is connected to MikroBUS.
SW18-2	ON	
SW18-3	OFF	AN101 is connected to Grove2.
SW18-4	ON	
SW18-5	OFF	AN102 is connected to Grove2.
SW18-6	ON	

4.3.1 Board Setup

Figure 4.6 shows a connection diagram when running the sample software. Connect the Ethernet cable, J-Link OB debugger, and 15V DC cables to the RZ/T2H evaluation board.

You can connect the Ethernet cable to the ETH0 or 1 connector. When using the debugger J-Link OB on the evaluation board, open CN62 and connect the USB Micro cable. When using I-jet, short CN62 and connect I-jet to CN61.

This sample software uses SNTP for time synchronization and requires a connection to an NTP Server. A Windows PC is used as the NTP Server during the operation check.

If you use FreeRTOS+FAT for managing key files used by the OPC UA security function, a USB flash drive connection to the evaluation board is required.

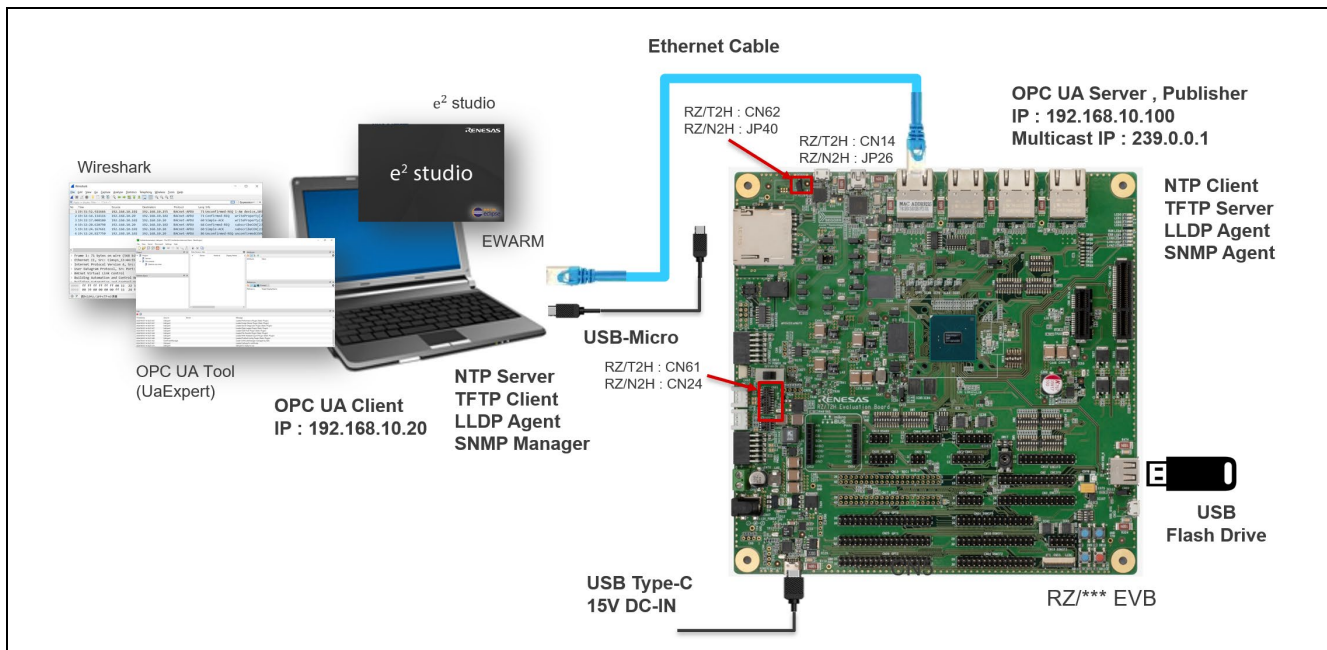


Figure 4.6. RZ/T2H EVB OPC UA Server hardware connection diagram

4.4 RZ/N2H Evaluation Board

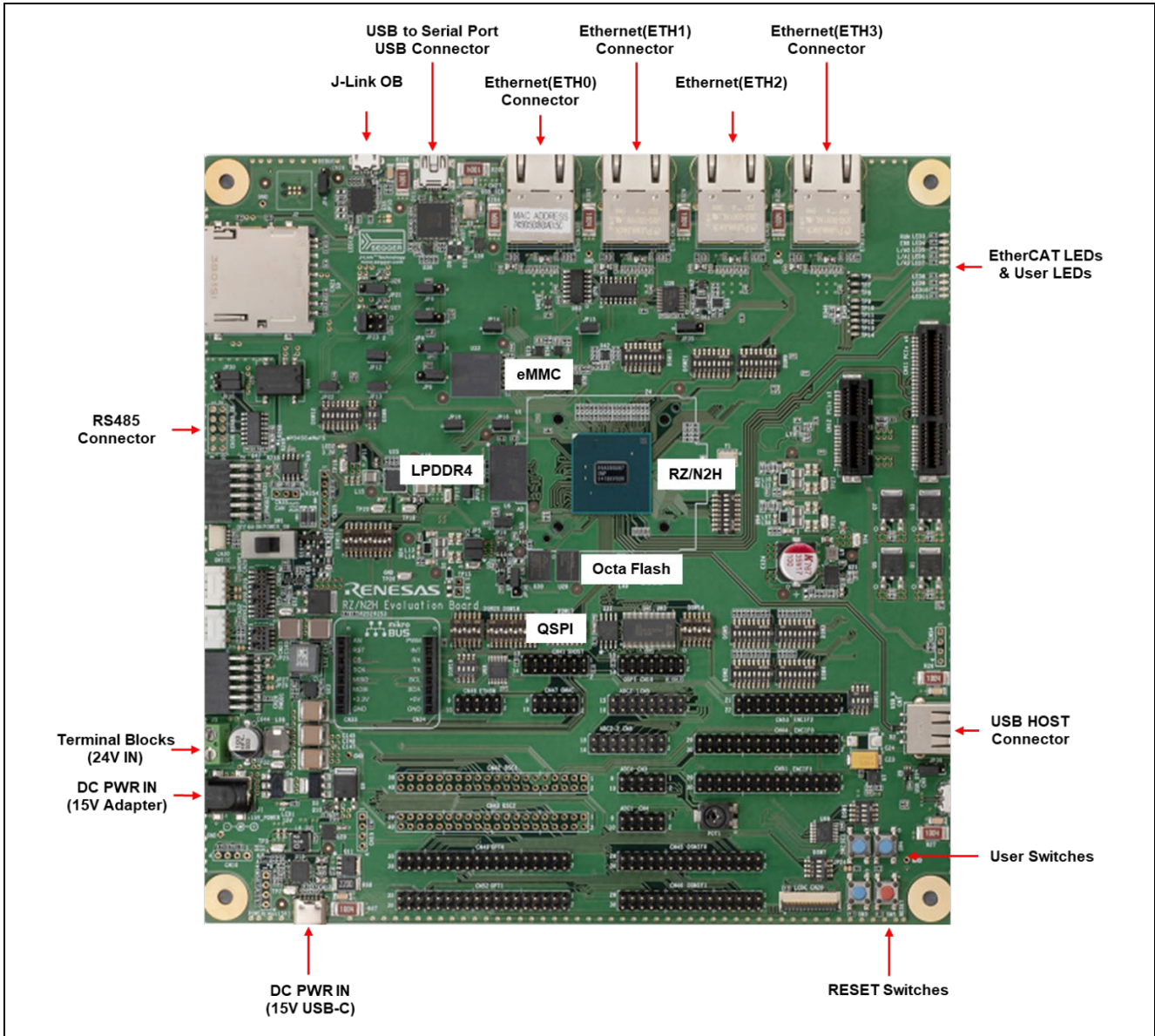


Figure 4.7. RZN2H Evaluation board layout

The text in red in the table indicates settings that need to be changed from the evaluation board's factory default settings.

Table 4.21. Jumper and Switch Configuration

Reference	Jumper Position	Description
JP6	Short 1-2	1.8-V power is supplied to VCC1833_0. (for Ethernet Port 0)
	Short 2-3	3.3-V power is supplied to VCC1833_0. (for Ethernet Port 0)
JP7	Short 1-2	1.8-V power is supplied to VCC1833_1. (for Ethernet Port 1)
	Short 2-3	3.3-V power is supplied to VCC1833_1. (for Ethernet Port 1)
JP8	Short 1-2	1.8-V power is supplied to VCC1833_1. (for Ethernet Port 2)
	Short 2-3	3.3-V power is supplied to VCC1833_1. (for Ethernet Port 2)
JP9	Short 1-2	1.8-V power is supplied to VCC1833_1. (for Ethernet Port 3)
	Short 2-3	3.3-V power is supplied to VCC1833_1. (for Ethernet Port 3)
JP21	Short 1-2	3.3-V power is supplied to VCC1833_7. (for SD1)
	Short 2-3	Power control IC output for SD1 is supplied to VCC1833_7. (for SD1)
JP23	Short 1-2	3.3-V power is supplied to VCC1833_6. (for SD0)
	Short 2-3	The output from the power-supply control IC for SD0 is supplied to VCC1833_6 (for SD0).
	Short 5-6	1.8-V power is supplied to VCC1833_6. (for SD0)
JP35	Short 1-2	VCC1833_0 is supplied to VCC_ETH2_MDIO (DSW5-6 is ON: When P21_4 and P21_5 are selected for MDIO).
	Short 2-3	VCC1833_2 is supplied to VCC_ETH2_MDIO. (DSW5-6 is OFF: When P30_5 and P30_6 are selected for MDIO)
JP40	Open	The on-board debugging function J-Link® OB is enabled.
	Short	The on-board debugging function J-Link™ OB is disabled. Connect an external emulator to CN23 or CN24 at debugging.
JP30	Short 1-2	Full-duplex communication
JP31	Short 2-3	Half-duplex communication

Table 4.22. SW3 Settings

SW3	Setting	Description
SW3-1	ON	xSPI1 boot mode (x1 boot serial flash)
SW3-2	OFF	
SW3-3	ON	
SW3-4	OFF	The number of ATCM wait cycles of CPU0 in the Cortex-R52 is 1 wait cycle.
SW3-5	OFF	The number of ATCM wait cycles of CPU1 in the Cortex-R52 is 1 wait cycle.
SW3-6	OFF	The power-supply voltage of the boot peripheral is 3.3 V.
SW3-7	ON	JTAG mode = Normal mode
SW3-8	OFF	(At the time of shipment = OFF)

Table 4.23. SW2 Settings

SW2	Setting	Description
SW2-1	ON	XTALSEL = 'L' Select oscillator for RZ/N2H clock input.
SW2-2	OFF	(At the time of shipment = OFF)
SW2-3	ON	P27_2, P27_3, P27_6, and P31_3 are used as inputs to user DIP switches.
SW2-4	OFF	P13_4, P13_5, and P14_0 are used as RXD3, TXD3, and DE3 of the RS485.
SW2-5	ON	P00_0 to P00_2 are used as control signals for the USB power-supply IC. In this case, set DSW14-1, DSW14-3, and DSW14-5 to ON and DSW14-2, DSW14-4, and DSW14-6 to OFF.
SW2-6	ON	P01_0, P01_2, P01_4 to P01_7, and P02_0 to P02_3 are used as XSPI1 signals.
SW2-7	OFF	(At the time of shipment = OFF)
SW2-8	OFF	(At the time of shipment = OFF)

Table 4.24. SW5 Settings

SW5	Setting	Description
SW5-1	ON	P12_0 to 7, P13_0 to 2 are connected to eMMC.
SW5-2	ON	
SW5-3	ON	P08_6 and P17_4 are used as SD1 control signal.
SW5-4	OFF	(At the time of shipment = OFF)
SW5-5	OFF	(At the time of shipment = OFF)
SW5-6	ON	MDC and MDIO of Ethernet port 2 are connected to GMAC0 (P21_4 and P21_5).
SW5-7	ON	P29_1 to P29_7, P30_0 to P30_4, P30_7, P31_2, P31_4, and P31_5 are used as control signals for Ethernet Port 2.
SW5-8	OFF	P00_0 to P00_2 are used as control signals for USB interface.

Table 4.25. SW8 Settings

SW8	Setting	Description
SW8-1	ON	P03_1_GMAC_RESETOUT2# is used as RESET for Ethernet Port 2.
SW8-2	OFF	

Table 4.26. SW12 Settings

SW12	Setting	Description
SW12-1	OFF	P00_3 is used as P00_3_ETH3_COL of Ethernet Port 3.
SW12-2	ON	
SW12-3	OFF	P11_0 is used as P11_0_ESC_RESETOUT# of Ethernet Port 0 and 1.
SW12-4	ON	
SW12-5	OFF	P03_2 is used as P03_2_GMAC_RESETOUT3# of Ethernet Port 3.
SW12-6	ON	
SW12-7	OFF	P03_1 is used as P03_1_GMAC_RESETOUT2# of Ethernet Port 2. In this case, set DSW8-1 to ON and DSW8-2 to OFF.
SW12-8	ON	

Table 4.27. SW13 Settings

SW13	Setting	Description
SW13-1	ON	P26_7 is used as P26_7_ETH1_RXER of Ethernet Port 1.
SW13-2	OFF	
SW13-3	ON	P27_0 is used as P27_0_ETH1_CRIS of Ethernet Port 1.
SW13-4	OFF	
SW13-5	ON	P27_1 is used as P27_1_ETH1_COL of Ethernet Port 1.
SW13-6	OFF	
SW13-7	OFF	P13_7 is used as MDINT of Ethernet Port 2.
SW13-8	ON	

Table 4.28. SW15 Settings

SW15	Setting	Description
SW15-1	OFF	P22_6 is used as P22_6_SD0_WP.
SW15-2	ON	
SW15-3	OFF	P22_5 is used as P22_5_SD0_CD.
SW15-4	ON	
SW15-5	OFF	P14_7 is used as P14_7_USER_LED1(LED9).
SW15-6	ON	
SW15-7	OFF	- (At the time of shipment = OFF)
SW15-8	OFF	P14_6 is used as P14_6_USER_LED0(LED8).
SW15-9	OFF	
SW15-10	ON	

Table 4.29. SW17 Settings

SW17	Setting	Description
SW17-1	OFF	P03_0 is used as USER_LED3(LED11).
SW17-2	ON	
SW17-3	OFF	P02_7 is used as USER_LED2(LED10).
SW17-4	ON	
SW17-5	OFF	P02_6 is used as P02_6_SD0_IOVS.
SW17-6	ON	
SW17-7	OFF	- (At the time of shipment = OFF)
SW17-8	ON	P02_5 is used as P02_5_SD0_PWEN.

Table 4.30. SW18 Settings

SW18	Setting	Description
SW18-1	ON	P22_7 is used as ESC_LINKACT0(LED5).
SW18-2	OFF	
SW18-3	ON	P23_0 is used as ESC_LINKACT1(LED6).
SW18-4	OFF	
SW18-5	ON	P14_3 is used as ESC_LINKACT2(LED7).
SW18-6	OFF	
SW18-7	ON	P31_6 is used as ESC_LED RUN(LED3).
SW18-8	OFF	
SW18-9	ON	P18_1 is used as ESC_LEDERR(LED4).
SW18-10	OFF	

4.4.1 Board Setup

Figure 4.8 shows a connection diagram when running the sample software. Connect the Ethernet cable, J-Link OB debugger, and 15V DC cables to the RZ/N2H evaluation board.

You can connect the Ethernet cable to the ETH0 or 1 connector. When using the debugger J-Link OB on the evaluation board, open JP40 and connect the USB Micro cable. When using I-jet, short JP40 and connect I-jet to CN24.

This sample software uses SNTP for time synchronization and requires a connection to an NTP Server. A Windows PC is used as the NTP Server during the operation check.

If you use FreeRTOS+FAT for managing key files used by the OPC UA security function, a USB flash drive connection to the evaluation board is required.

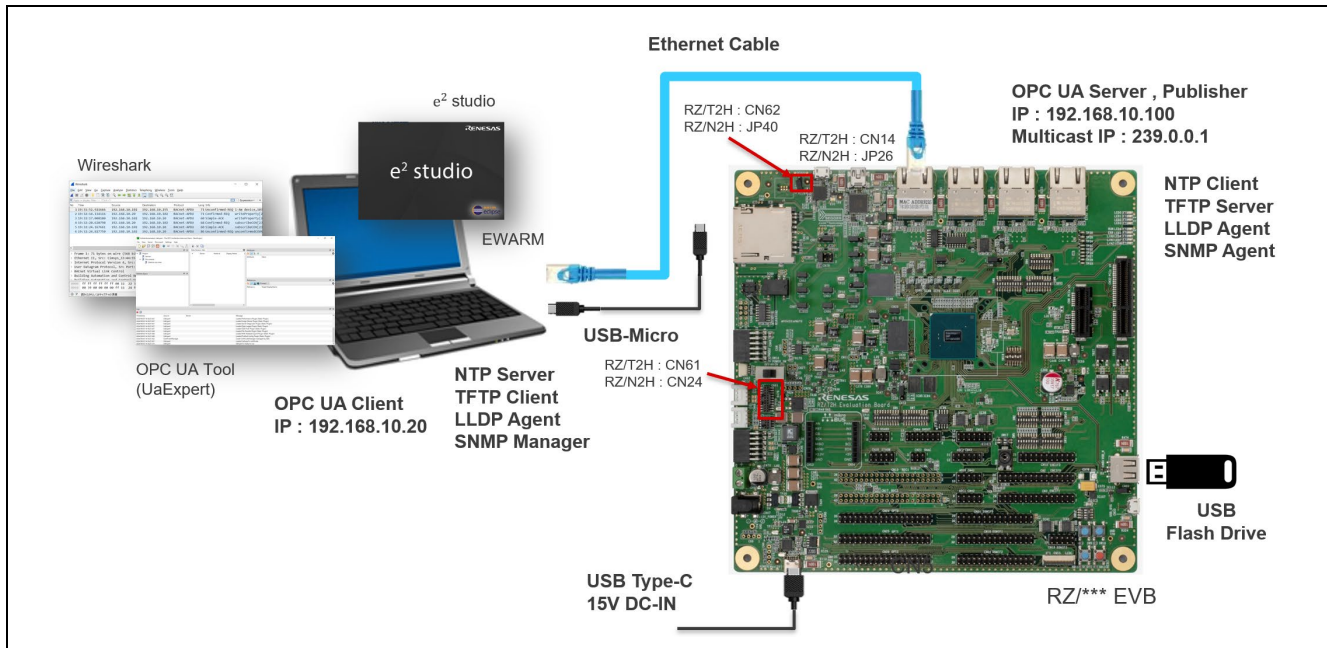


Figure 4.8. RZ/N2H EVB OPC UA Server hardware connection diagram

5. Set up the Host

5.1 Host IP Address

Set the address of the Ethernet on the PC that serves as the OPC UA Client.

Open Control panel. Configure the IP address as follows.

Control panel > Network and Internet > Change adapter options > Ethernet > Properties > Internet Protocol Version 4 (TCP/IPv4) > Properties

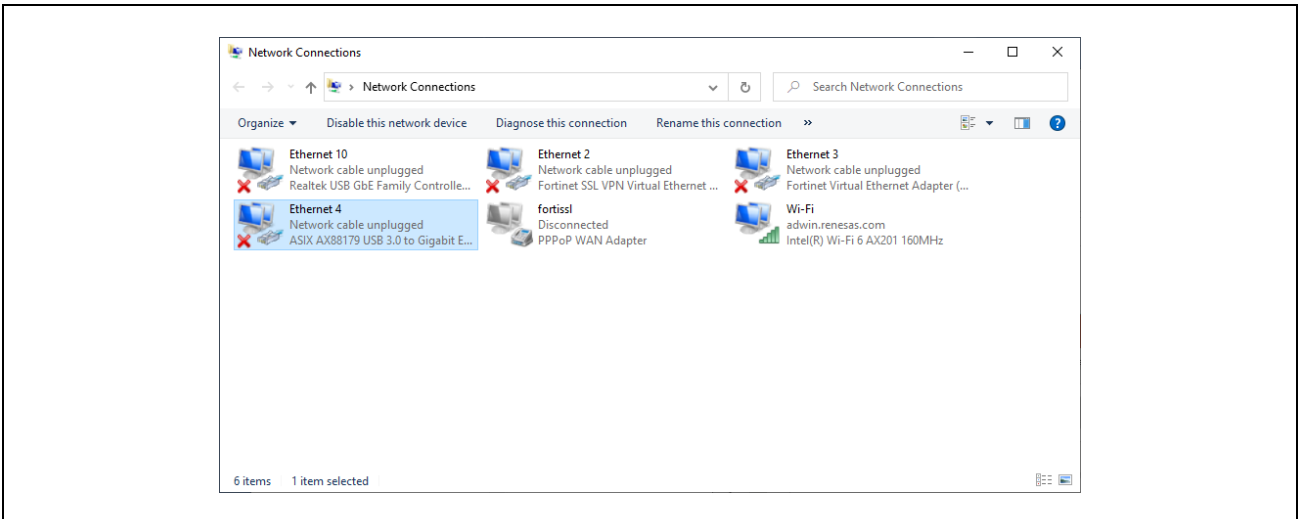


Figure 5.1. Network connection

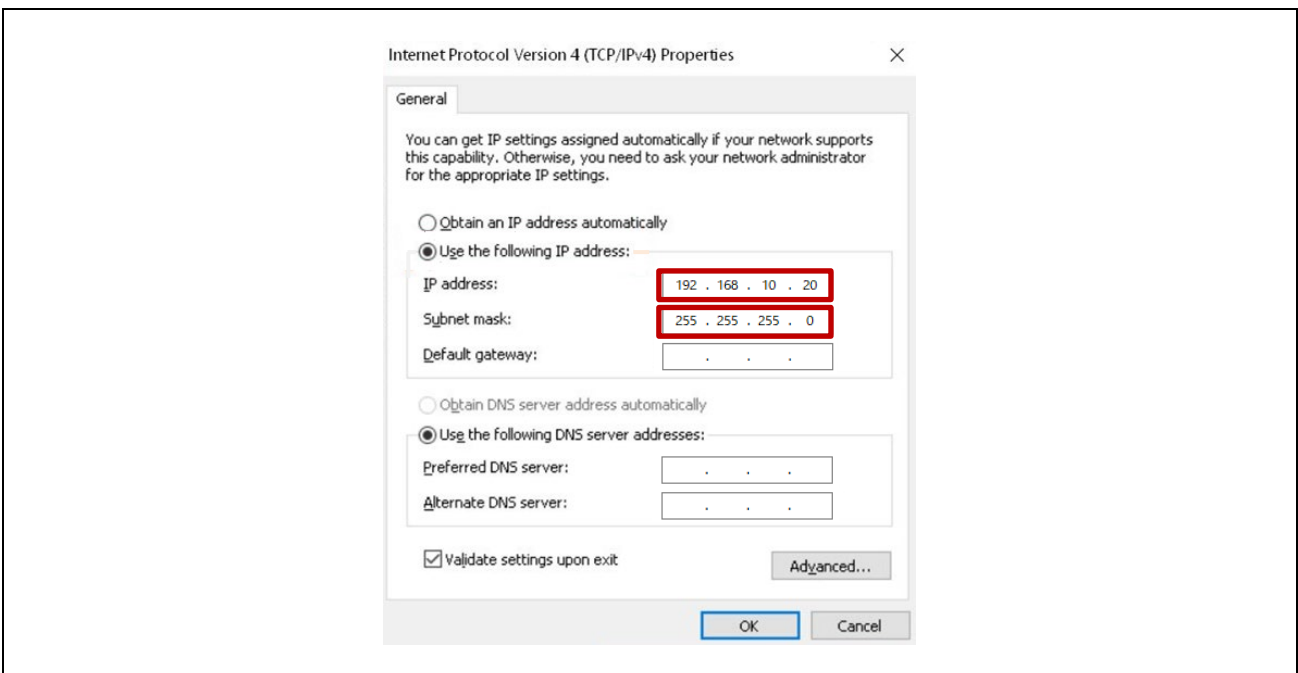


Figure 5.2. TCP/IPv4 properties

The IP address of the evaluation board set in the OPC UA server sample software is 192.168.10.100. The IP address of the PC needs to be set to 192.168.10.***. This sample software sets the NTP server IP address to 192.168.10.20 by default. Therefore, if you want to use a Windows PC as the NTP server, set the PC's IP address to 192.168.10.20.

5.2 Installation of EWARM environment

If developing in the e² studio environment, skip this chapter.

- 1) Download the EWARM installer file for the version listed in chapter 3.
- 2) Click “Install IAR Embedded Workbench® for Arm”, and follow the instructions to install.
- 3) Download the FSP Smart Configurator installer file for the version listed in chapter 3.
- 4) Run the installer file, and follow the instructions to install.

5.3 Installation of e² studio environment

If developing in the EWARM environment, skip this chapter.

- 1) Download the e² studio installer file for the version listed in chapter 3.
- 2) Run the installer file, and follow the instructions to install.

5.4 UaExpert

UaExpert is an OPC UA Client tool. In this document, it is used to connect to the OPC UA Server to access the object nodes.

Download the version listed in Table 3.5 from the website and install it on your PC. Before downloading, you must register on the Unified Automation website and activate your account. All content is provided free of charge, but by downloading or installing the software from this web page, you automatically accept the Unified Automation Software License Agreement (SLA). For license terms for software and information, please refer to the following link.

<https://www.unified-automation.com/products/sdk-overview/licenses.html#c341>

Please check the above conditions of use before usage.

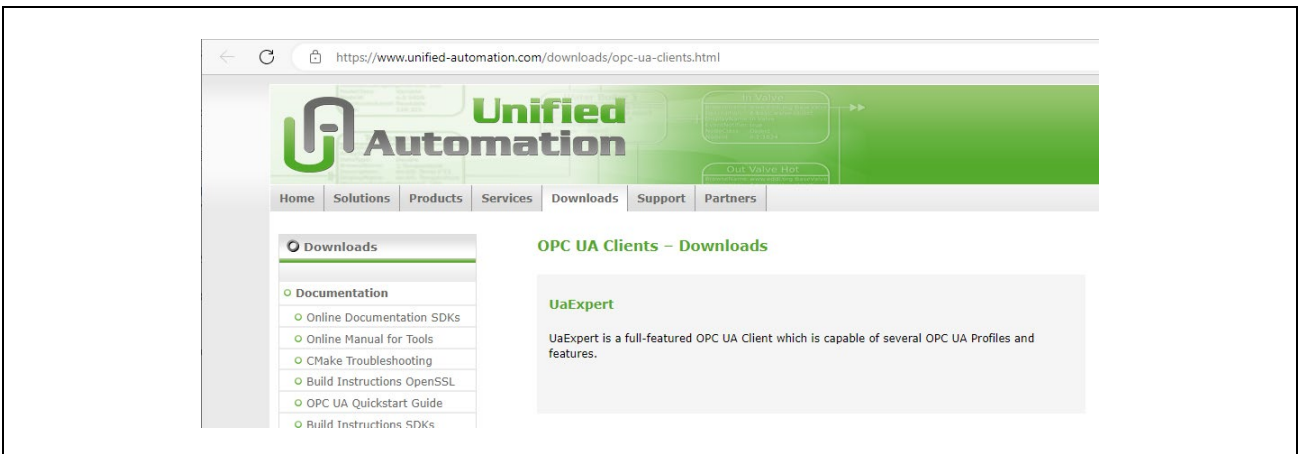


Figure 5.3. UaExpert

5.5 Wireshark

Wireshark is a free network protocol analyzer. Download and install Wireshark from the link in Table 3.5.

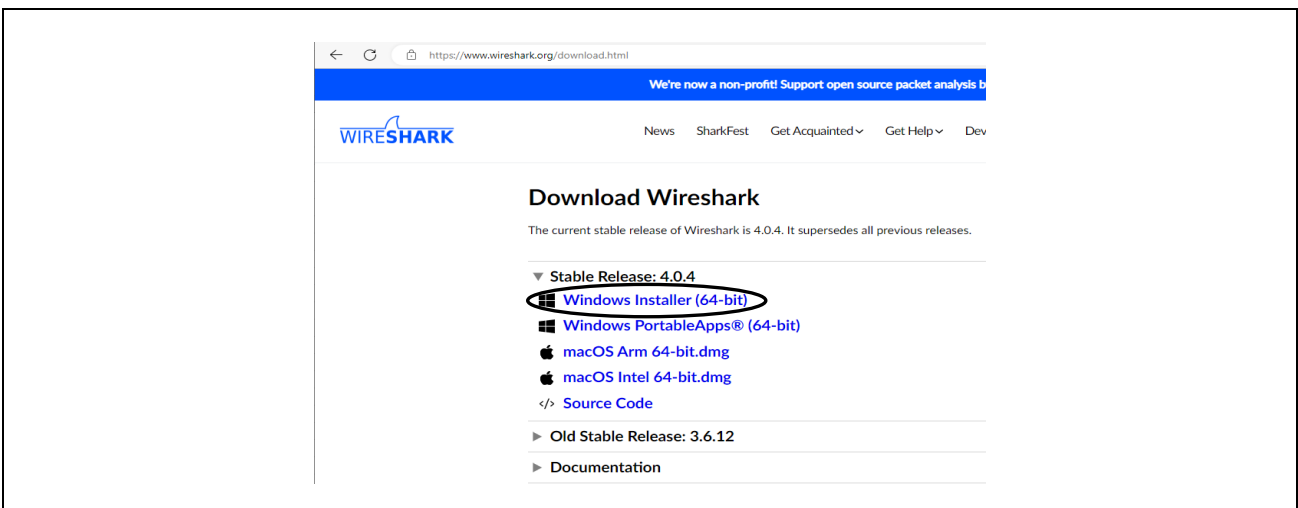


Figure 5.4. Download Wireshark

5.6 OpcCmd Utility

OpcCmd Utility is a general-purpose OPC communication tool that can be used with the command line. For this sample software, this tool is used as a Subscriber of OPC UA PubSub. Download from the link in Table 3.5 and unzip to any folder. No installation is required. License terms are Zero-Clause BSD (0BSD).

For detailed instructions on how to use this tool, please refer to the link below.

[Using OpcCmd Utility as OPC UA PubSub Subscriber - OPC Labs Knowledge Base](#)

Target platform and requirements	Version	Binaries	ClickOnce
Windows, Linux or macOS .NET 9.0	Current or Preview ^[1]	ZIP file: Download TGZ file: Download	
Windows .NET Framework 4.7.2 (or later)	Current or Preview ^[1]	ZIP file: Download EXE file: Download ^[2]	Download & launch Install page ^[3]

Figure 5.5. Download OpcCmd Utility

5.7 OPC UA Demo Publisher

OPC UA Demo Publisher is an OPC UA Publisher tool that can be used with the command line. Download from the link in Table 3.5 and unzip to any folder. No installation is required. License terms are Zero-Clause BSD (0BSD).

For detailed instructions on how to use this tool, please refer to the link below.

[UADemoPublisher Basics - OPC Labs Knowledge Base](#)

Target platform and requirements	Version	Binaries	ClickOnce
Windows, Linux or macOS .NET 9.0	Current or Preview ^[1]	ZIP file: Download TGZ file: Download	
Windows .NET Framework 4.7.2 (or later)	Current or Preview ^[1]	ZIP file: Download EXE file: Download ^[2]	Download & launch Install page ^[3]

Figure 5.6. Download OPC UA Demo Publisher

5.8 Node-RED

Node-RED is a browser-based programming tool that allows users to create flows using various nodes and deploy them to the execution environment with a single click. In this project, it will be used to monitor OPC UA Node changes over time.

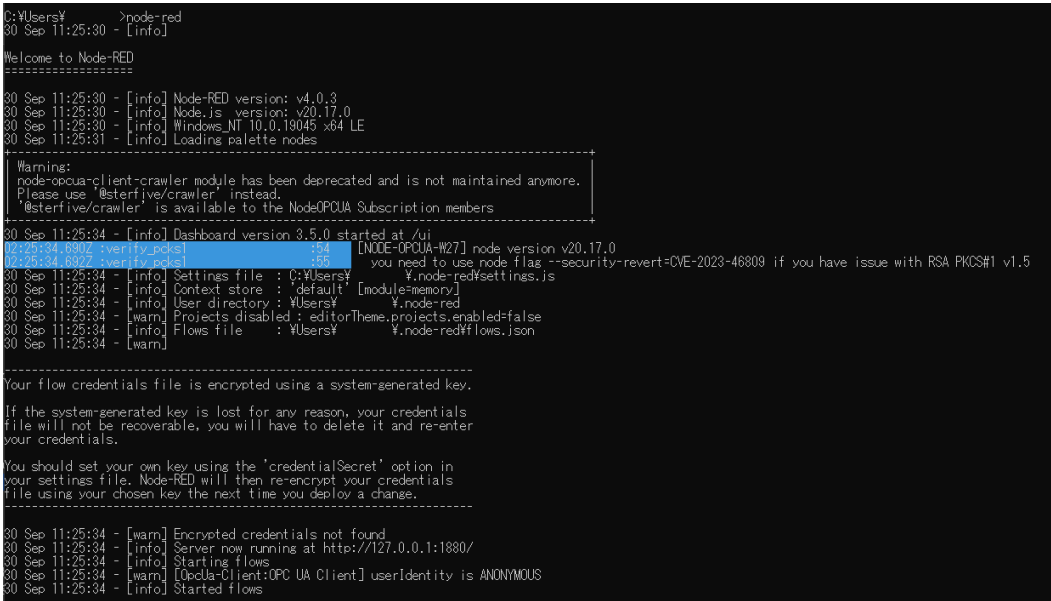
Install Node.js from the link listed in Table 3.5. After installation, launch Command prompt with administrator privileges and enter the following command

```
npm install -g --unsafe-perm node-red
npm install node-red-contrib-opcua
npm i node-red-dashboard
```

Launch Command prompt again without administrator privileges and enter the following command.

```
node-red
```

If Node-RED is launched successfully, you will see a screen like Figure 5.7. Do not close this Command prompt while using Node-RED.



```
C:\Users¥>node-red
30 Sep 11:25:30 - [info]
Welcome to Node-RED
-----
30 Sep 11:25:30 - [info] Node-RED version: v4.0.3
30 Sep 11:25:30 - [info] Node.js version: v20.17.0
30 Sep 11:25:30 - [info] Windows_NT 10.0.19045 x64 LE
30 Sep 11:25:31 - [info] Loading palette nodes

Warning:
node-opcua-client-crawler module has been deprecated and is not maintained anymore.
Please use '@sterfive/crawler' instead.
@sterfive/crawler is available to the NodeOPCUA Subscription members
-----
30 Sep 11:25:34 - [info] Dashboard version 3.5.0 started at /ui
30 Sep 11:25:34 - [warn] [NODE-OPCUA-W27] you need to use node flag --security-revert=CVE-2023-46809 if you have issue with RSA PKCS#1 v1.5
30 Sep 11:25:34 - [info] Settings file : C:\Users¥\%.node-red\settings.js
30 Sep 11:25:34 - [info] Context store : 'default' [module=memory]
30 Sep 11:25:34 - [info] User directory : %Users¥\%.node-red
30 Sep 11:25:34 - [warn] Projects disabled : editorTheme.projects.enabled=false
30 Sep 11:25:34 - [info] Flows file : %Users¥\%.node-red\flows.json
30 Sep 11:25:34 - [warn]

Your flow credentials file is encrypted using a system-generated key.

If the system-generated key is lost for any reason, your credentials
file will not be recoverable, you will have to delete it and re-enter
your credentials.

You should set your own key using the 'credentialSecret' option in
your settings file. Node-RED will then re-encrypt your credentials
file using your chosen key the next time you deploy a change.
-----
30 Sep 11:25:34 - [warn] Encrypted credentials not found
30 Sep 11:25:34 - [info] Server now running at http://127.0.0.1:1880/
30 Sep 11:25:34 - [info] Starting flows
30 Sep 11:25:34 - [warn] [OpCua-Client:OPC UA Client] userIdentity is ANONYMOUS
30 Sep 11:25:34 - [info] Started flows
```

Figure 5.7. Run Node-RED

Enter the following URL into the browser, and if the screen shown in Figure 5.8 is displayed, Node-RED has been successfully launched.

<http://localhost:1880>

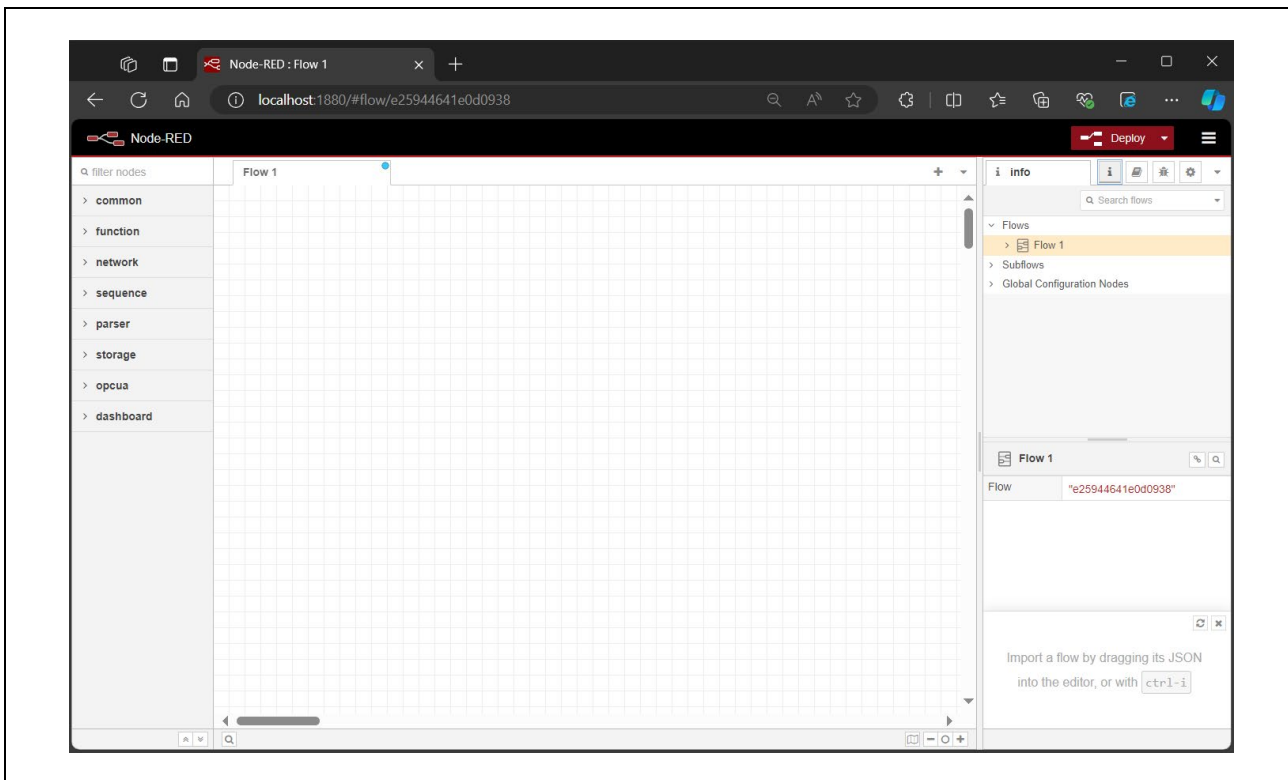


Figure 5.8. Start Node-RED

6. Running the Sample Application

This chapter describes how to download and run the program.

First, unzip the archived package of this sample software and store it in any folder. Because e² studio cannot recognize a project properly if the file path is too long, place it in shorter path. Also, do not use multi-byte character, such as Japanese, in the folder path.

In the Dual-core project, there are two projects: one that flashes the yellow LED on the evaluation board (RZ***_EVB(RSK)_OPC_***_*_Primary_0) and one that operates OPC UA (RZ***_EVB(RSK)_OPC_***_*_Secondary_1). Hereafter, these will be referred to as the primary project and the secondary project, respectively.

6.1 When using EWARM

Start EWARM and click "Open Workspace..." on the File tag.

CR52_single project : RZ***_OPC_EVB(RSK)_rev****\project\CR52_single\ewarm\

CR52_dual project : RZ***_OPC_EVB(RSK)_rev****\project\CR52_dual\ewarm\

CA55_dual project : RZ***_OPC_EVB(RSK)_rev****\project\CA55_dual\ewarm\

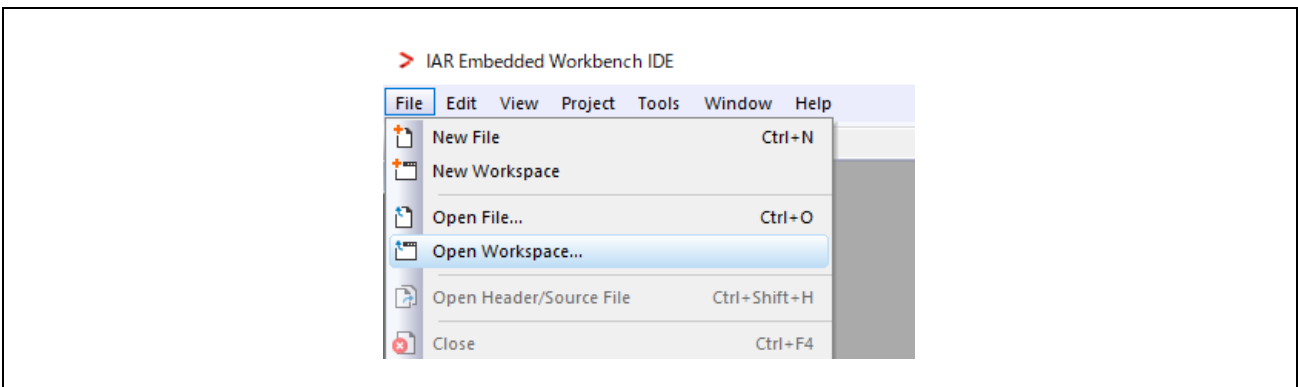


Figure 6.1. Open Workspace

Select the workspace file (.eww) and click the "Open" button.

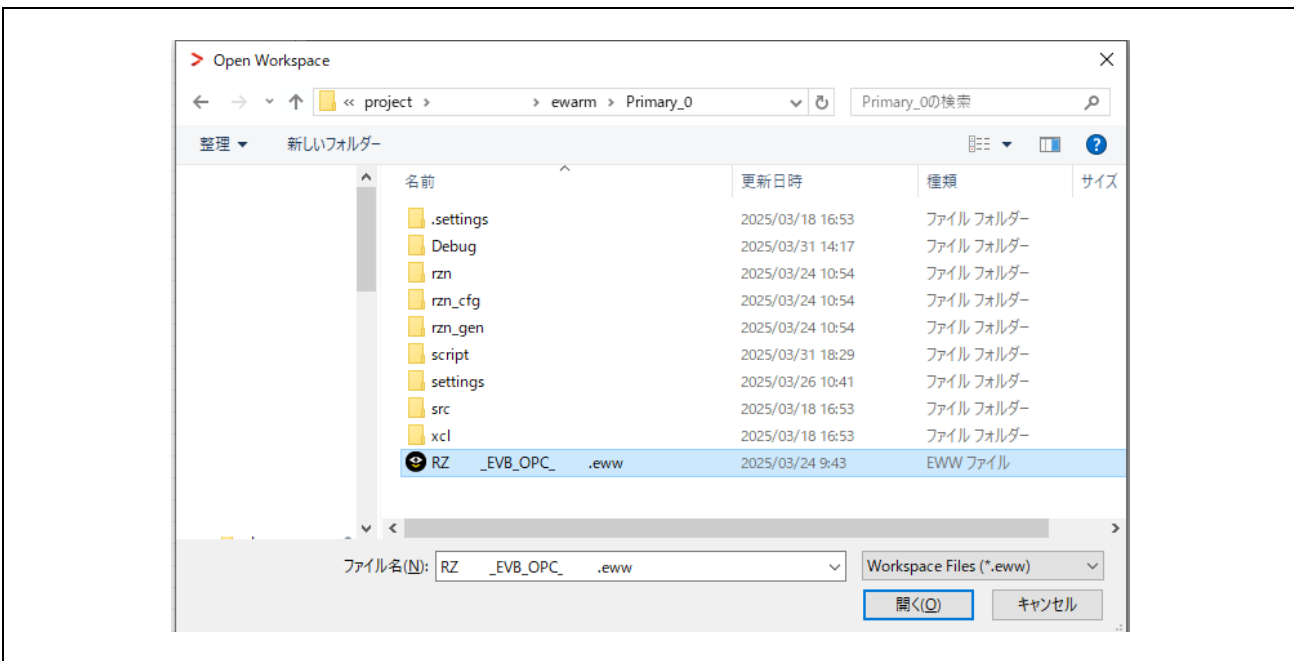


Figure 6.2. Open project file

Subsequent steps vary depending on the project used.

6.1.1 For Dual core project

6.1.1.1 Build

* Please refer to the guide in Chapter 9.6.2 when using FSP v4.1.0 or later for RZ/T2M, or when using FSP v4.2.0 or later for RZ/T2H or RZ/N2H.

Open the primary project in EWARM and click “FSP Smart Configurator” in the Tools tab. If this button is not displayed or if an error appears after clicking it, refer to chapter 9.5.

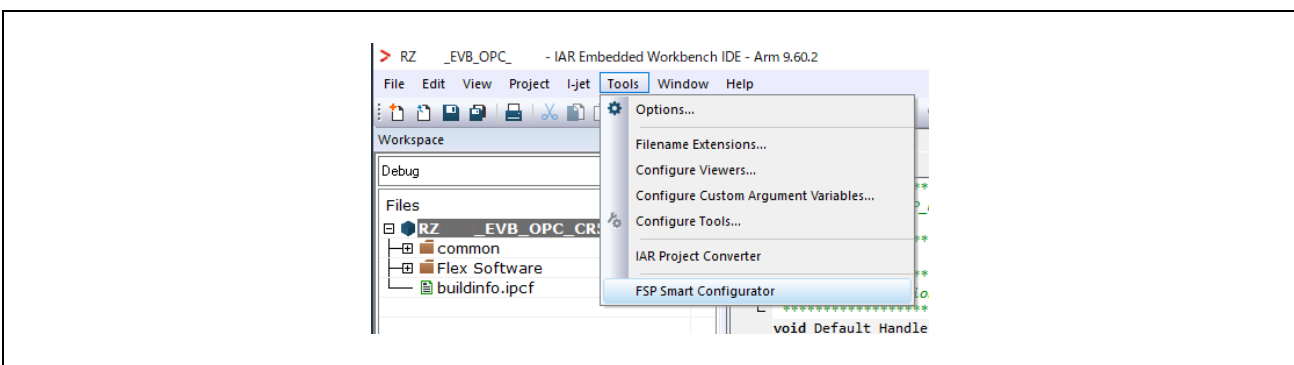


Figure 6.3. Tools tag

Clicking the “Generate Project Content” button on the FSP Smart Configurator generates the code.

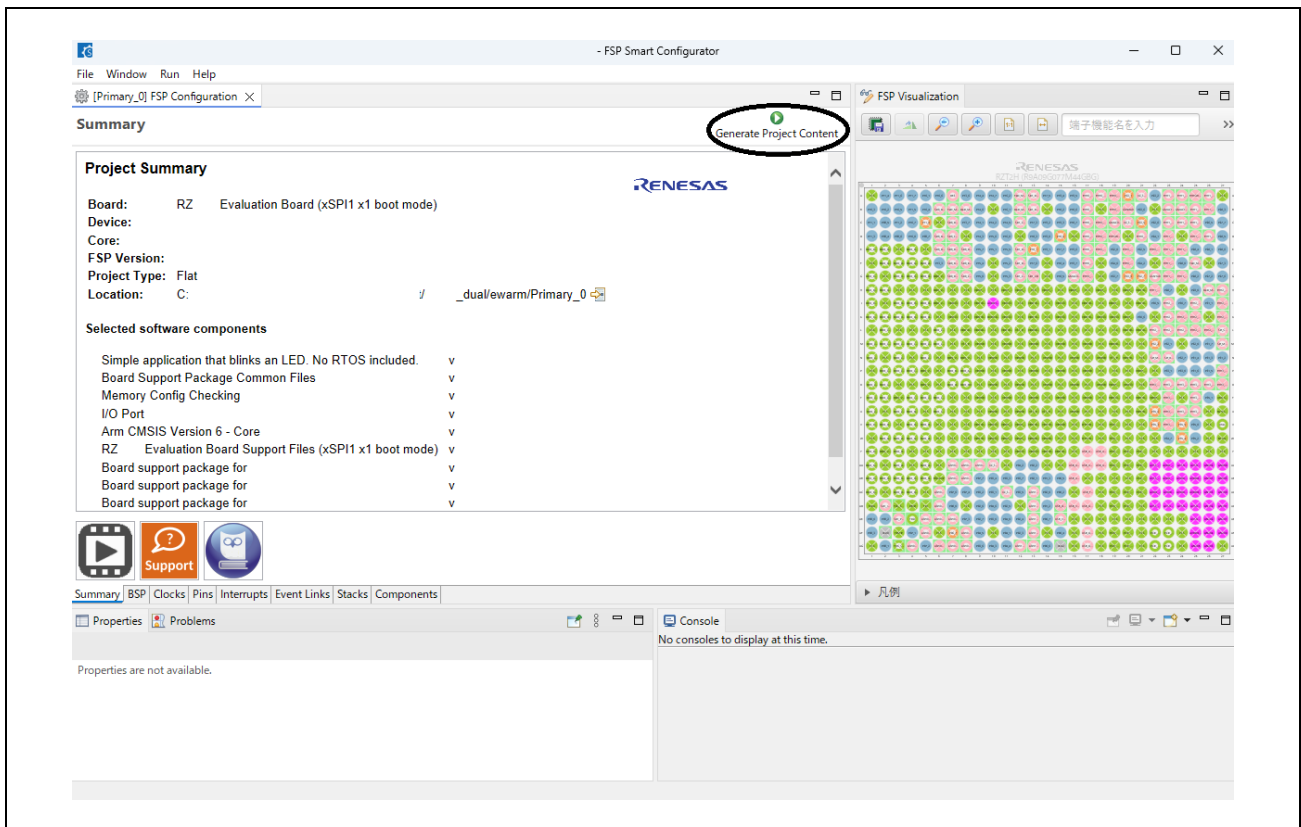


Figure 6.4. Generate Project Content

When debugging using a debugger, add loop processing at the location below.

“(Primary Project Location)\src\hal_entry.c”

```

BSP_ATTRIBUTE_STACKLESS void R_BSP_WarmStart_StackLess(void)
{
  /* The very beginning of the startup process. */
  #if 1 // Software loops are only needed when debugging.
    __asm volatile (
      " mov r0, #0          \n"
      " movw r1, #0x68bf    \n"
      " movt r1, #0x478     \n"
      "software_loop:      \n"
      " adds r0, #1         \n"
      " cmp r0, r1         \n"
      " bne software_loop  \n"
      ::: "memory");
  #endif
  /* Do not delete. Required to return to system_init. */
  #if (0 == BSP_LP64_SUPPORT)
    __asm volatile ("BX lr");
  #else
    __asm volatile ("BR lr");
  #endif
}

```

For RZ/T2H and N2H only, change the device tag name defined in buildinfo.ipcf as follows.

Table 6.1. FSP SC Newly Created Project Debug Settings

Device name	Primary Core: CR52_0
RZ/T2H	R9A09G077M44_R52_0
RZ/N2H	R9A09G087M44_R52_0

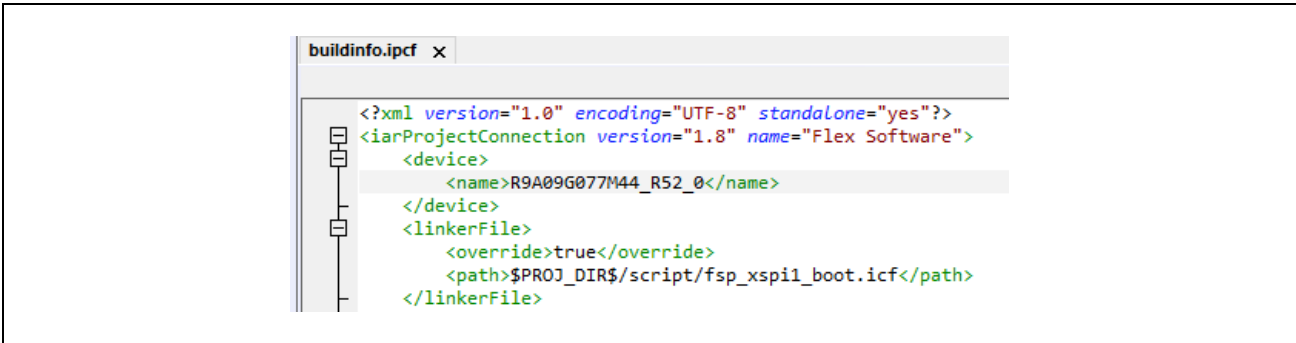


Figure 6.5. IAR EWARM Project File

Click the Make button to build. When the build is complete, a build message will appear in the build console window, showing the compile target file and the number of errors/warnings.

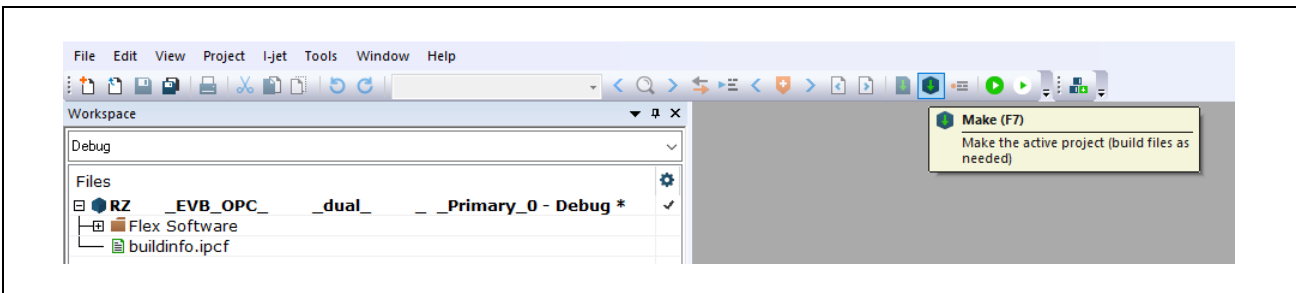


Figure 6.6. Make Primary project

Open the secondary project and click “FSP Smart Configurator” in the Tools tab.

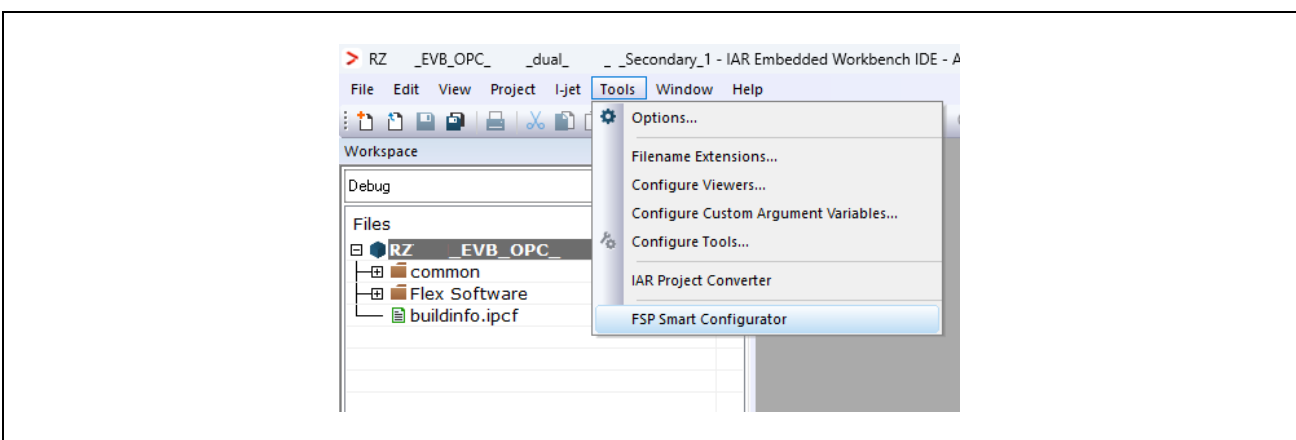


Figure 6.7. Open FSP SC

*If you wish to change any settings in the sample software from their default values, please configure them at this time by referring to chapter 9.6.

Clicking the “Generate Project Content” button on the FSP Smart Configurator generates the code.

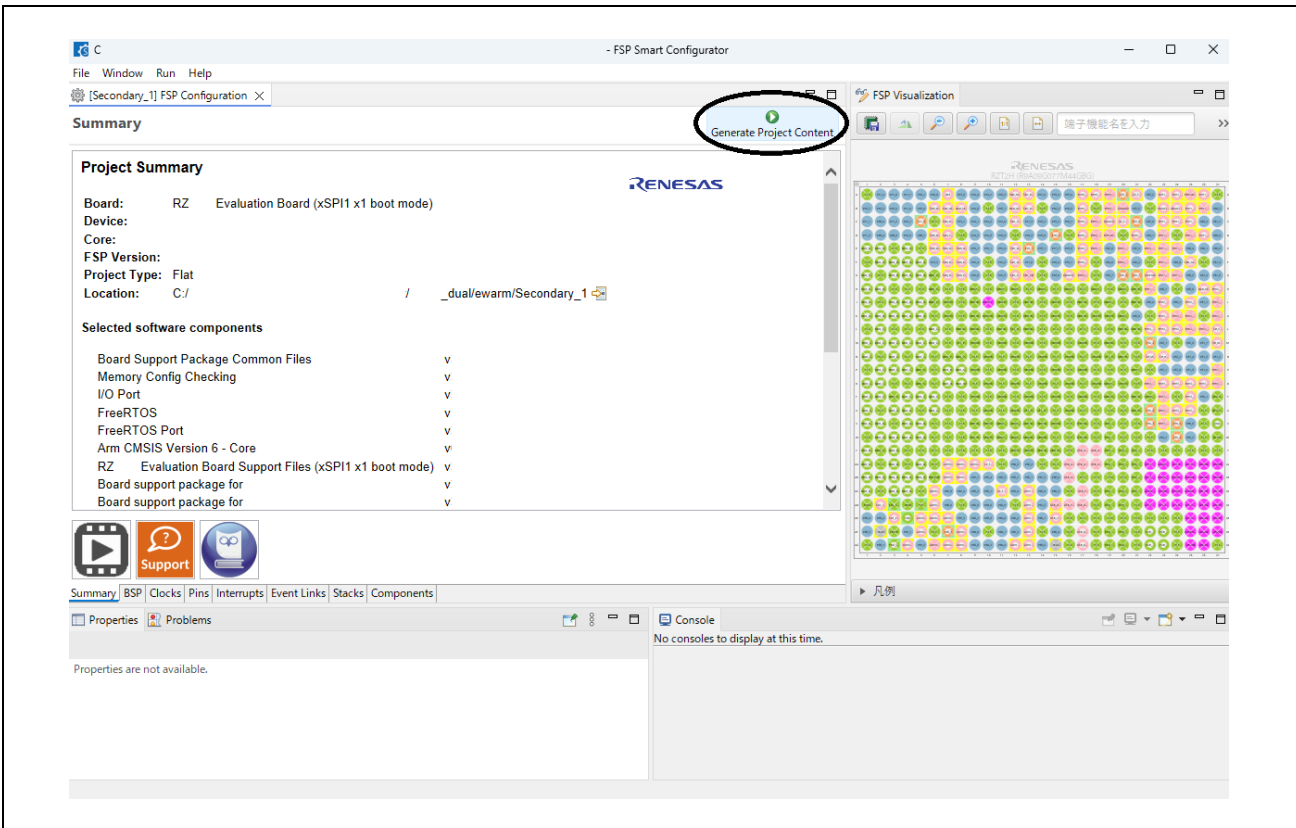


Figure 6.8. Generate Project Content

For RZ/T2H and N2H only, change the device tag name defined in buildinfo.ipcf as follows.

Table 6.2 FSP SC Newly Created Project Debug Settings

Device name	Secondary Core: CR52_1	Secondary Core: CA55_2
RZ/T2H	R9A09G077M44_R52_1	R9A09G077M44_A55
RZ/N2H	R9A09G087M44_R52_1	R9A09G087M44_A55

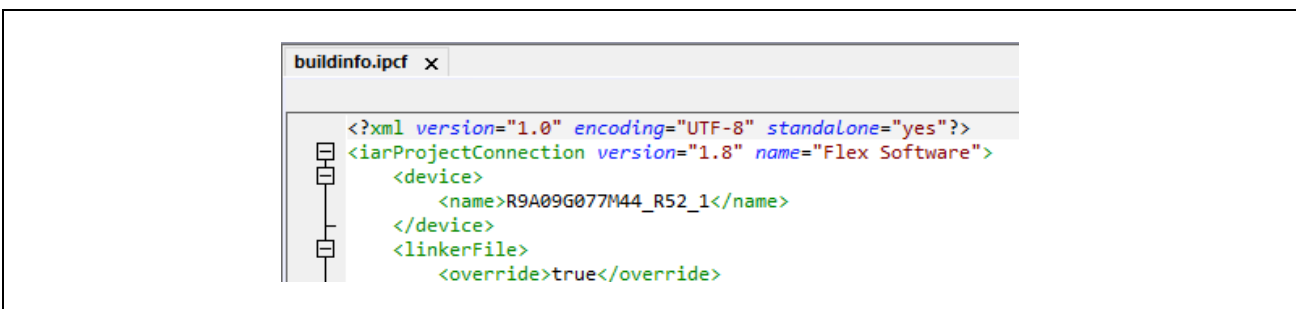


Figure 6.9. IAR EWARM Project File

Click the Make button to build. When the build is complete, a build message will appear in the build console window, showing the compile target file and the number of errors/warnings.

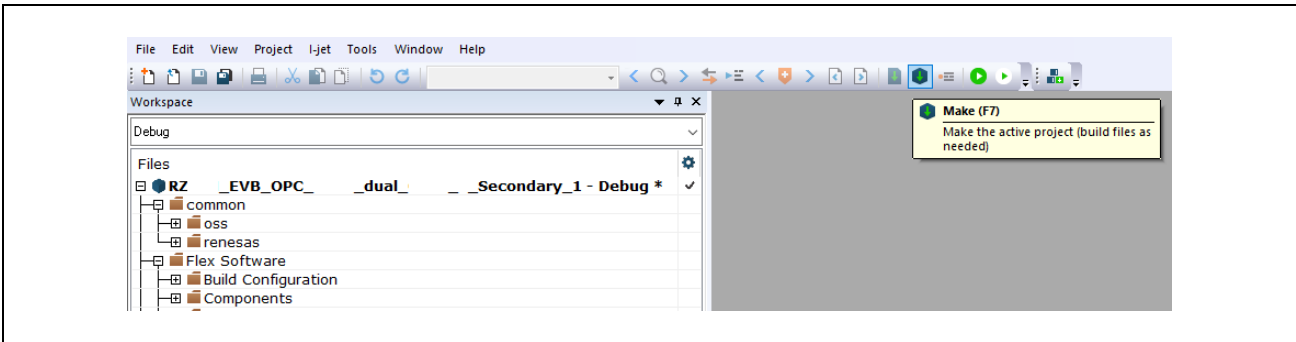


Figure 6.10. Make Secondary project

Reopen the primary project, run Clean, then click the Make button to build.

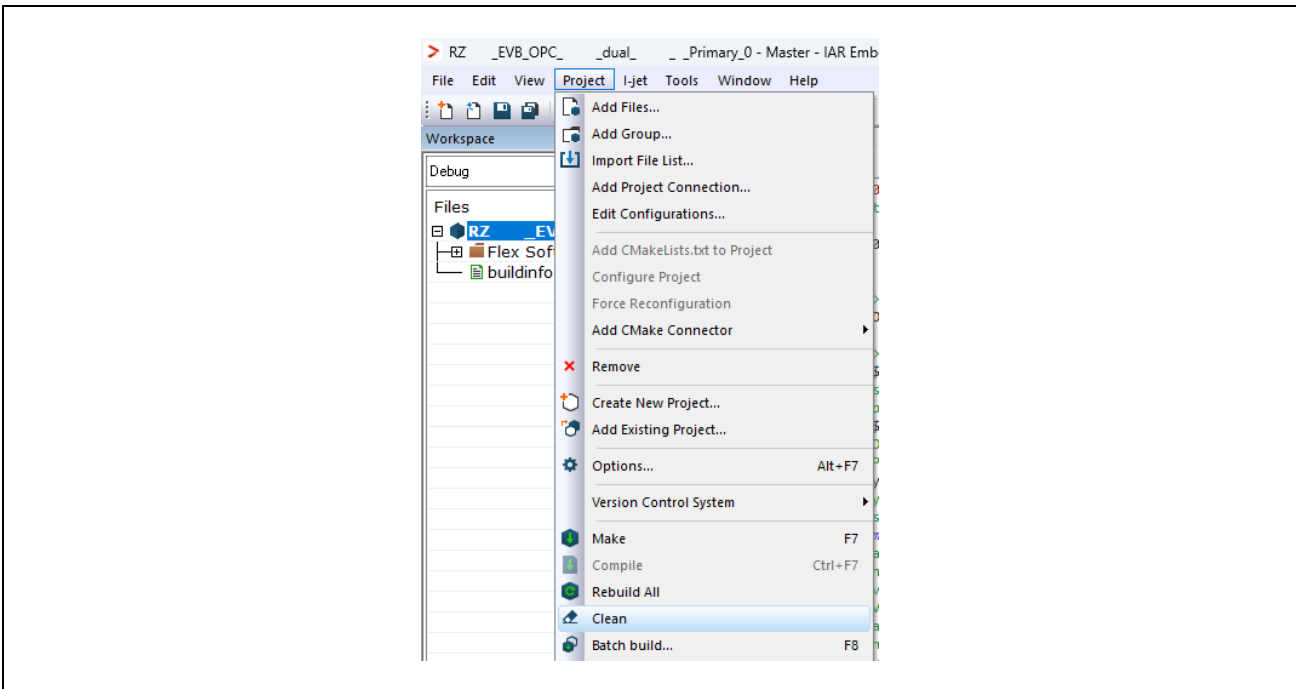


Figure 6.11. Clean Primary project

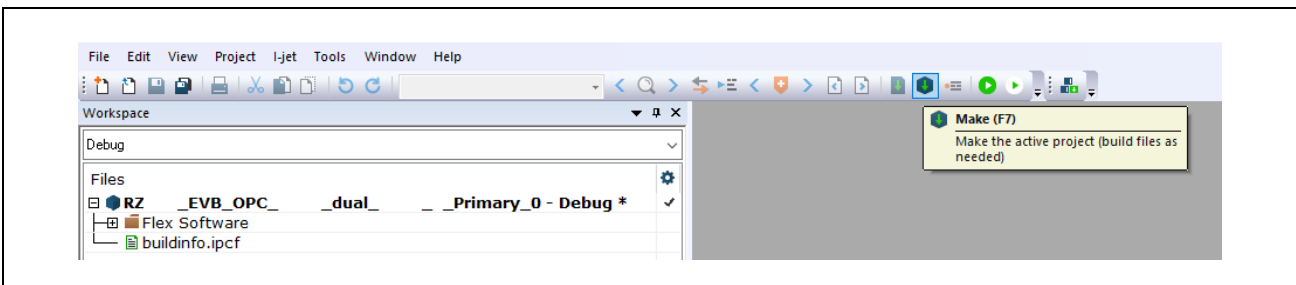


Figure 6.12. Make Primary project

6.1.1.2 Flash writing, debug

Open options of the primary project and set “Asymmetric multicore” to “Disabled” from the Multicore tag in the Debug category.

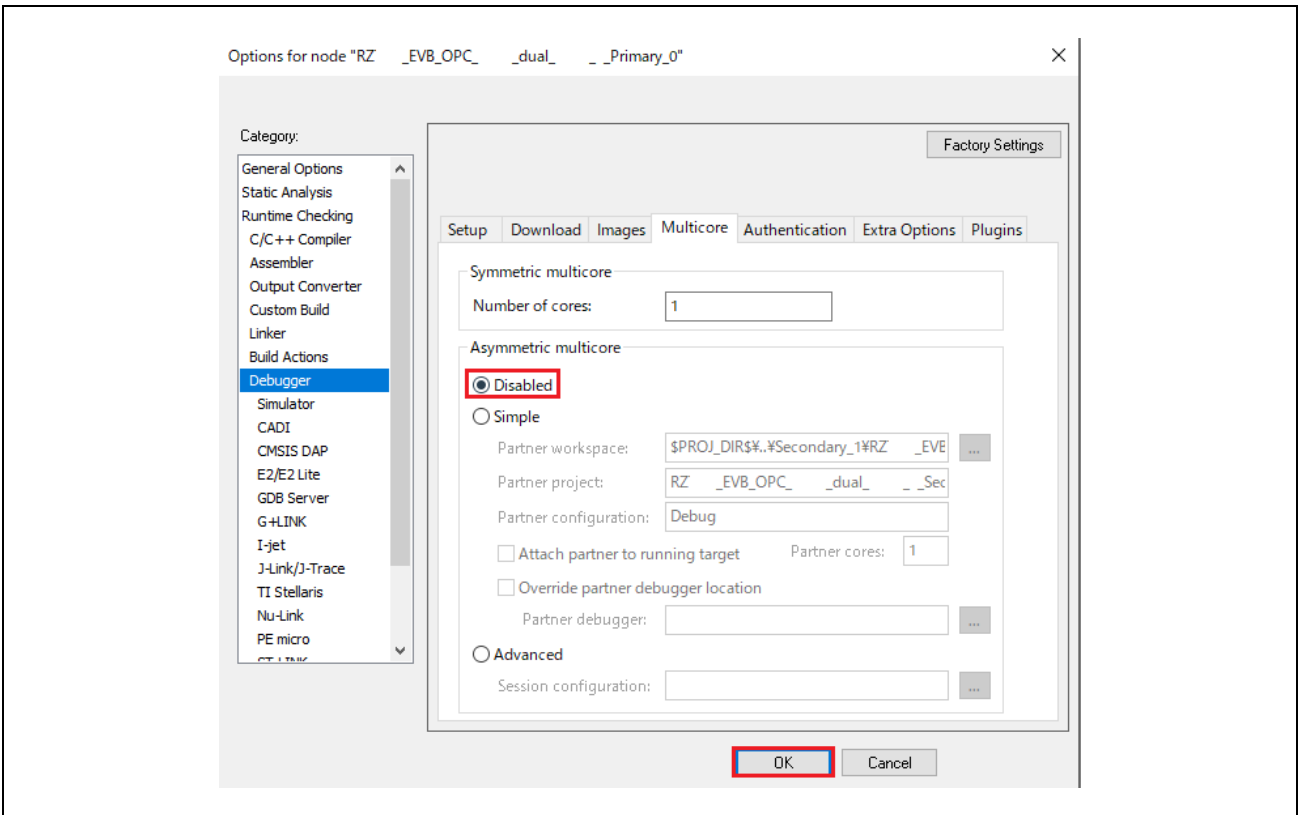


Figure 6.13. Asymmetric multicore setting

Click Download>Download file.... from the Project tag

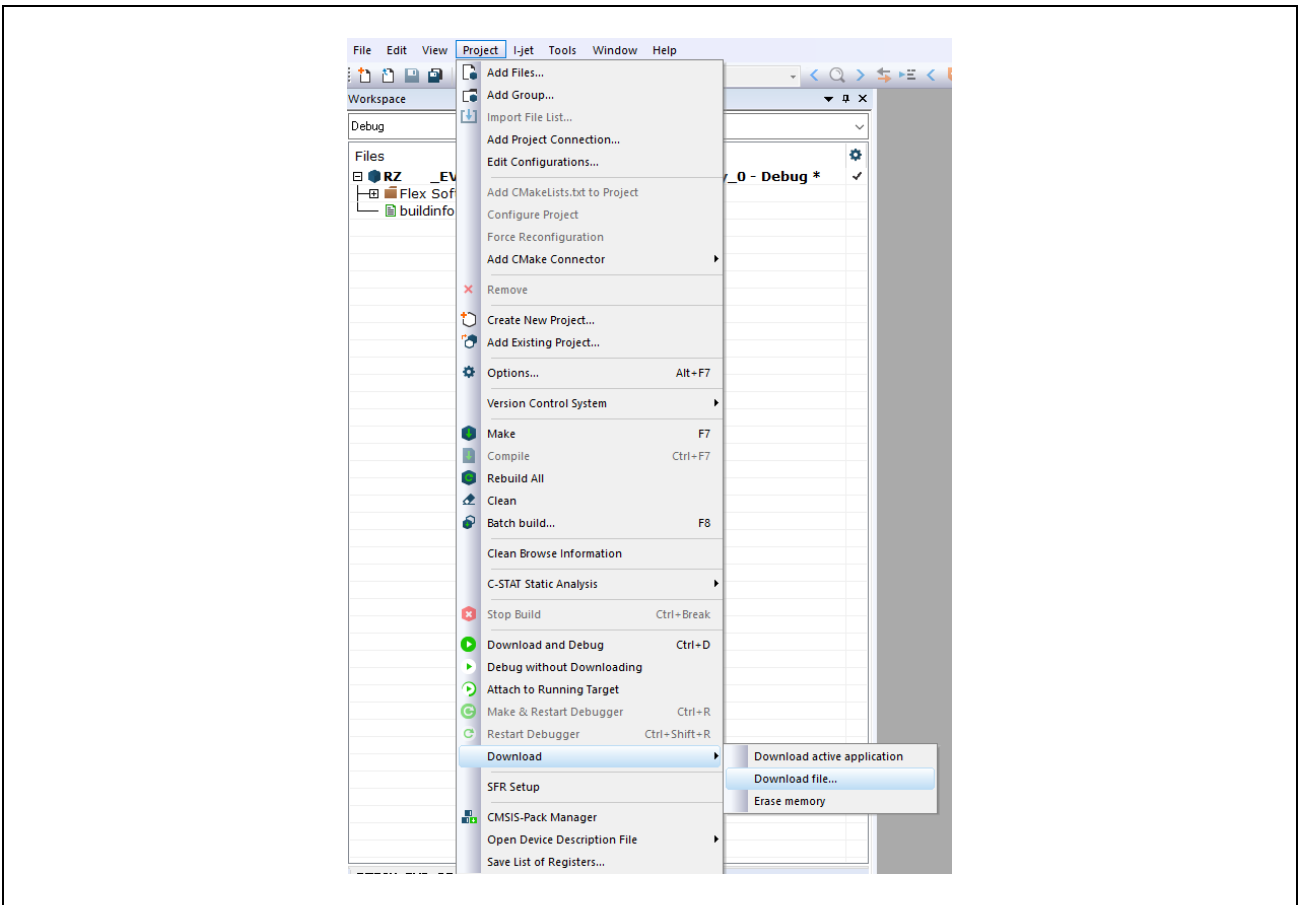


Figure 6.14. Download file...

Select \\(Primary Project Location)\\Debug\\Exe\\RZ***_EVB(RSK)_OPC_*****_Primary_0.out to download the program to flash memory.

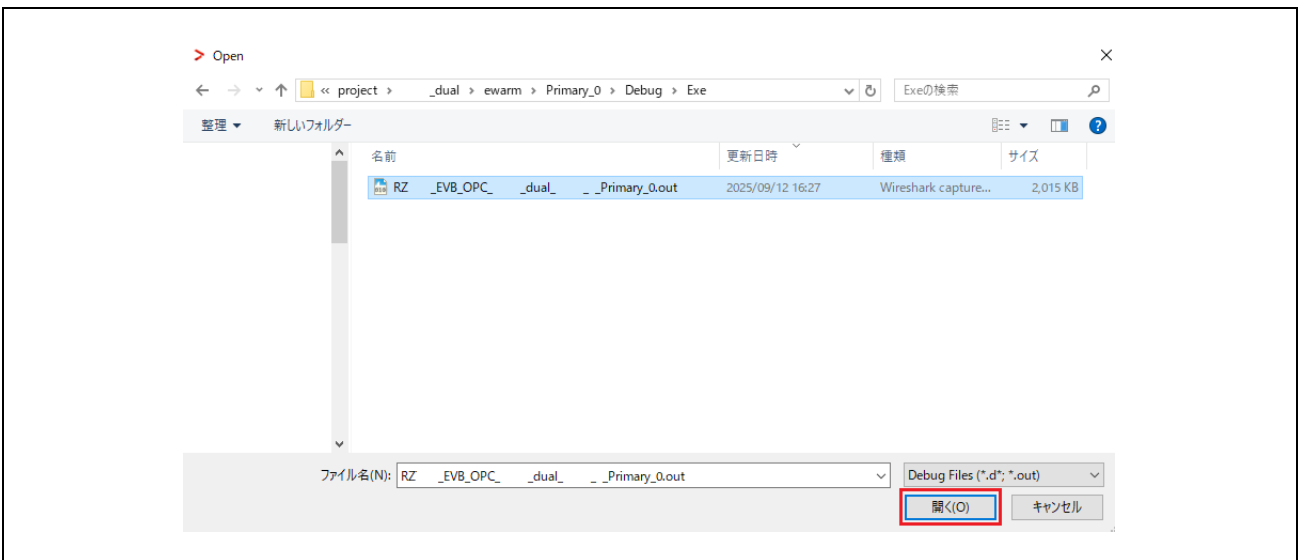


Figure 6.15. Open .out file

To operate the evaluation board alone without using the debugger, turn off the board power here, disconnect the debugger cable, and turn the power on again.

To use the debugger, open the options and select “Simple” from “Asymmetric multicore” from the Multicore tag in the Debug category, and set as follows.

Partner workspace : \$PROJ_DIR\$\..\(Secondary project name)\(Secondary project name).eww

Partner project : (Secondary project name)

Partner configuration : Debug

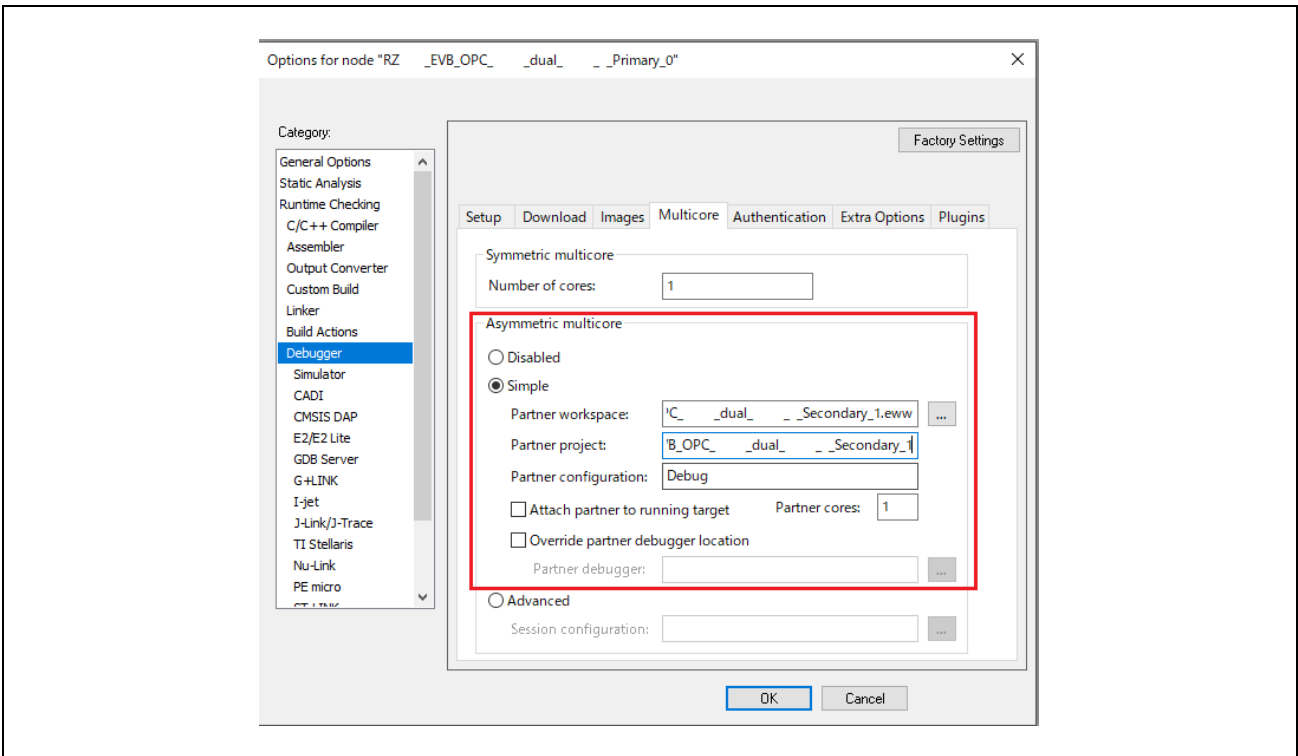


Figure 6.16. Asymmetric multicore setting

After setting, click “Debug without Downloading” to open the debugger in separate windows for primary and secondary.

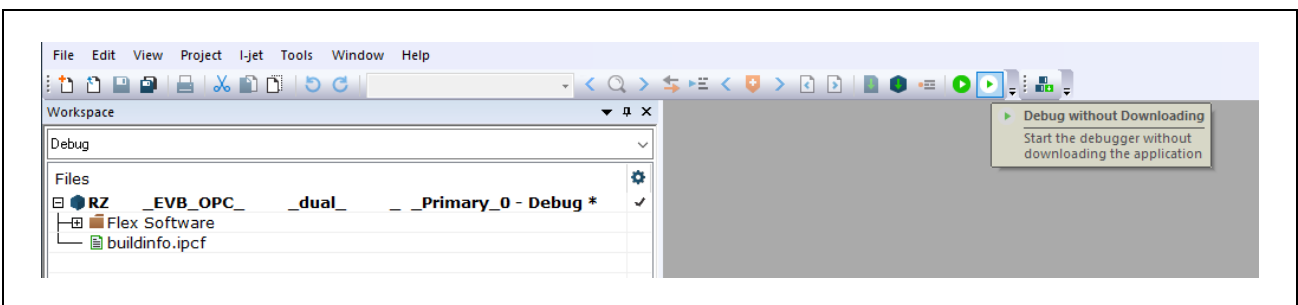


Figure 6.17. Debug without Downloading

6.1.2 For Single core project

6.1.2.1 Build

* Please refer to the guide in Chapter 9.6.2 when using FSP v4.1.0 or later for RZ/N2L.

Open the project in EWARM and click “FSP Smart Configurator” in the Tools tab. If this button is not displayed or if an error appears after clicking it, refer to chapter 9.5.

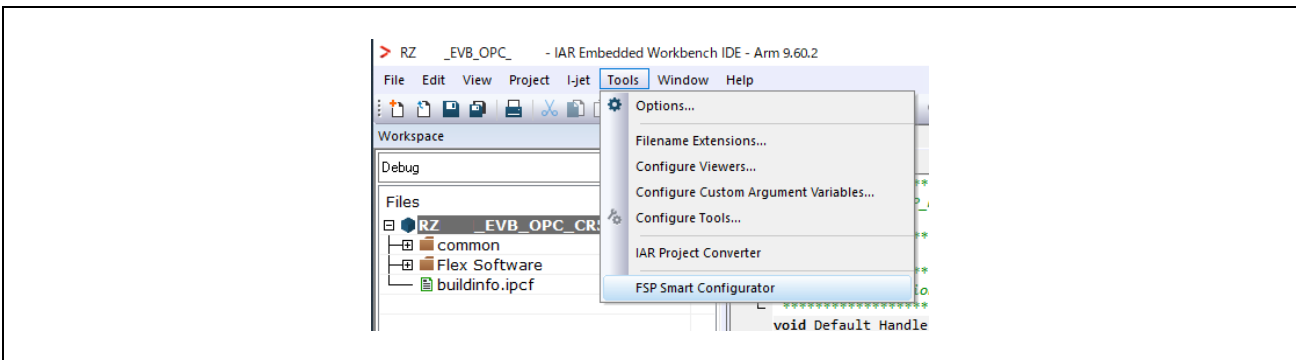


Figure 6.18. Tools tag

*If you wish to change any settings in the sample software from their default values, please configure them at this time by referring to chapter 9.6.

Clicking the “Generate Project Content” button on the FSP Smart Configurator generates the code.

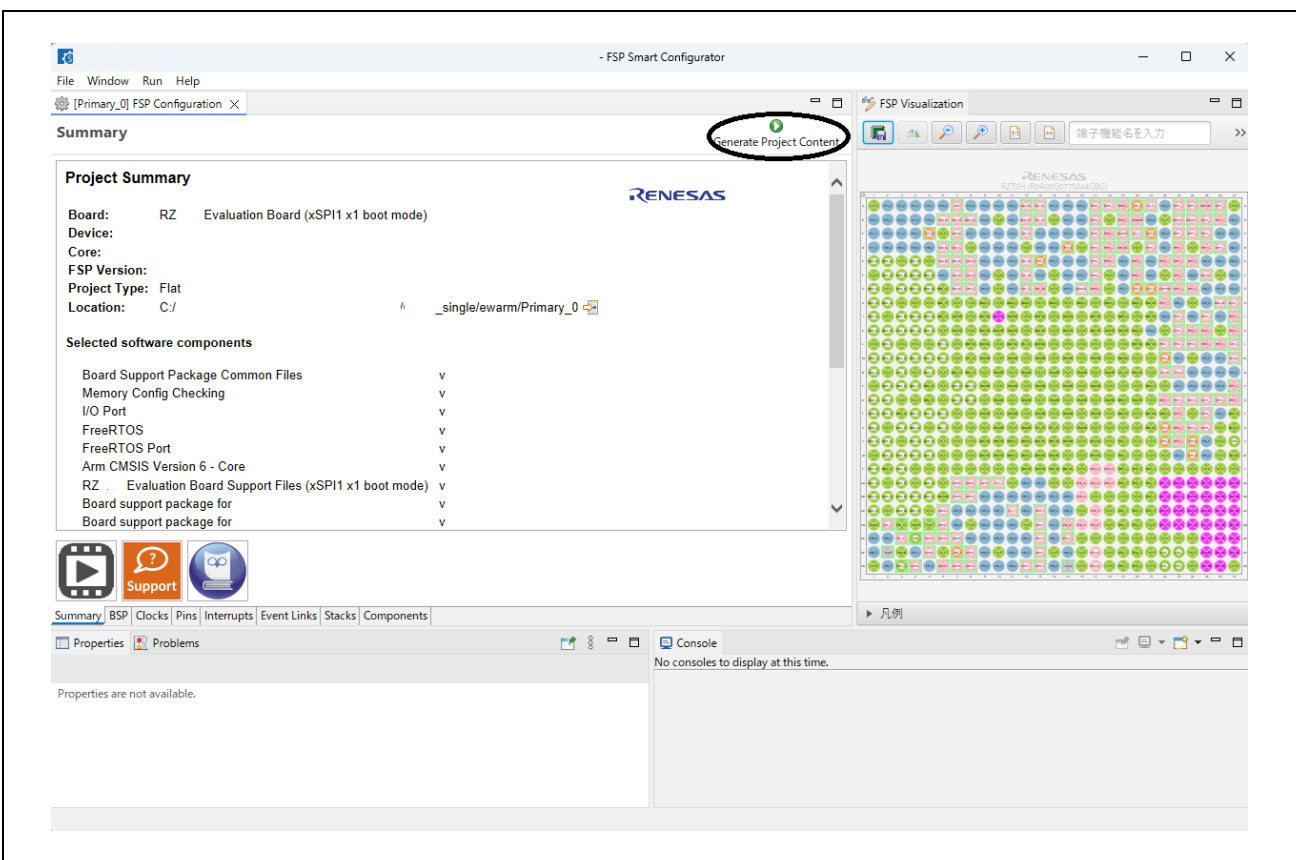


Figure 6.19. Generate Project Content

When debugging using a debugger, add loop processing appropriate for the core at the location below.

“(Project Location)\src\hal_entry.c “

```
BSP_ATTRIBUTE_STACKLESS void R_BSP_WarmStart_StackLess(void)
{
  /* The very beginning of the startup process. */
  #if 1 // Software loops are only needed when debugging.
    __asm volatile (
      "  mov r0, #0      \n"
      "  movw r1, #0x68bf \n"
      "  movt r1, #0x478  \n"
      "software_loop:  \n"
      "  adds r0, #1     \n"
      "  cmp r0, r1     \n"
      "  bne software_loop \n"
      ::: "memory");
  #endif
  /* Do not delete. Required to return to system_init. */
  #if (0 == BSP_LP64_SUPPORT)
    __asm volatile ("BX lr");
  #else
    __asm volatile ("BR lr");
  #endif
}
```

Then click the Make button in EWARM to build. When the build is complete, build messages are displayed in the build console window, showing the compile target files and the number of errors/warnings.

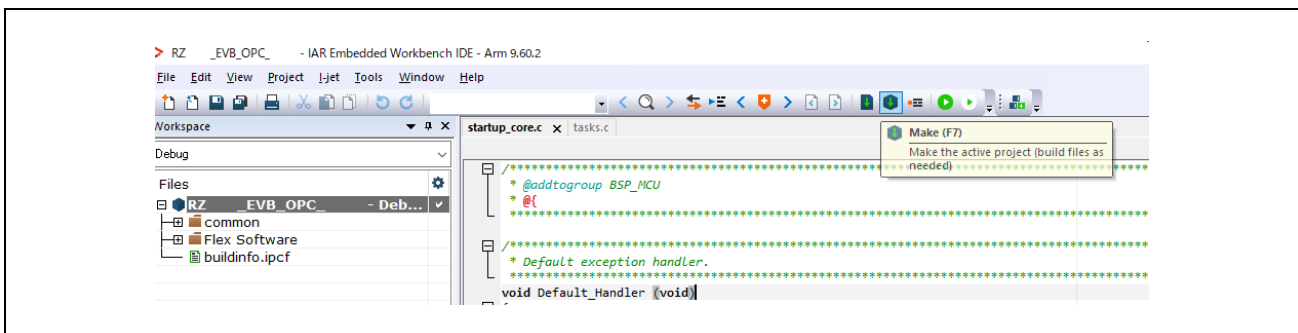


Figure 6.20. Make button

6.1.2.2 Flash writing, debug

Click the "Download and Debug" button to download the built program to the Flash memory on the evaluation board and start debugging.

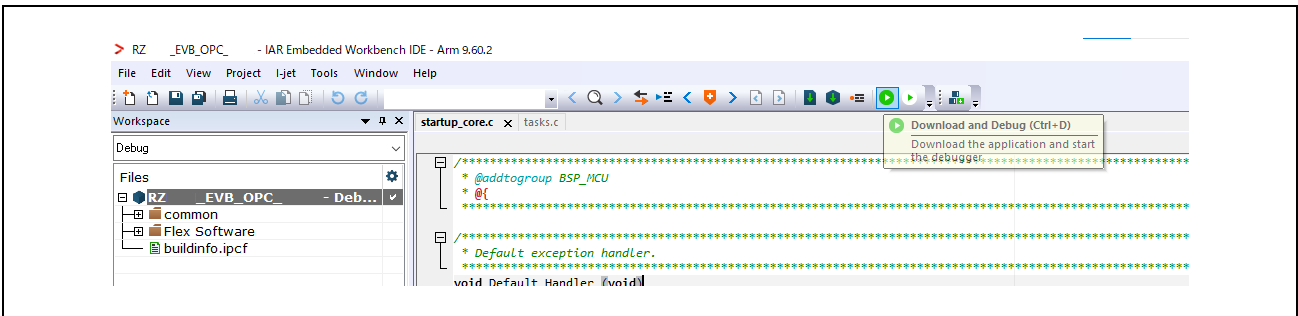


Figure 6.21. Download and Debug

To run the evaluation board alone without using the debugger, click "Stop Debugging" to disconnect the debugger, then turn off the board and turn it on again.

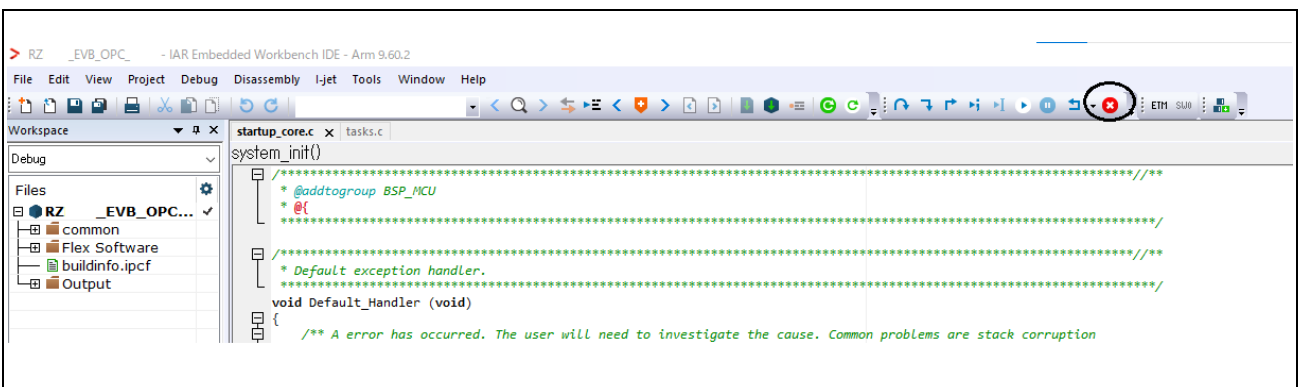


Figure 6.22. Stop Debugging

6.2 When using e² studio

Execute "e2studio.exe" to start e² studio in the following folder (default case) installed:

\Renasas\rz\le2studio_v20**-**_fsp_v*.*\eclipse\le2studio.exe

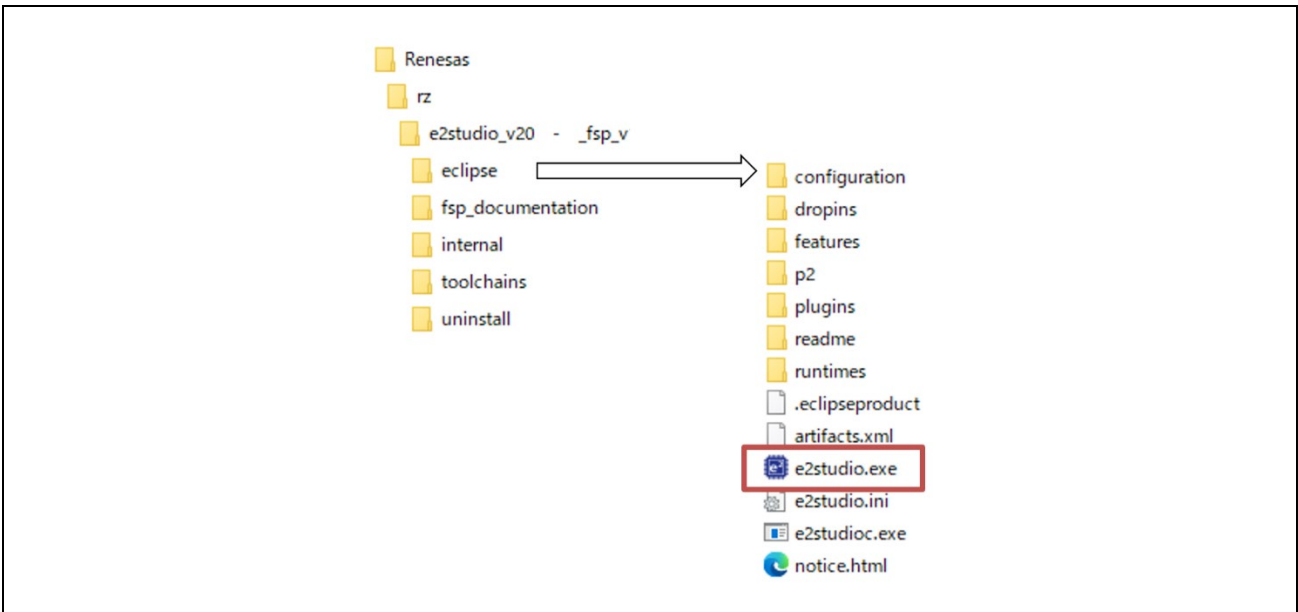


Figure 6.23. Launch project (1)

Import project

Enter any workspace directory and click “Launch”.

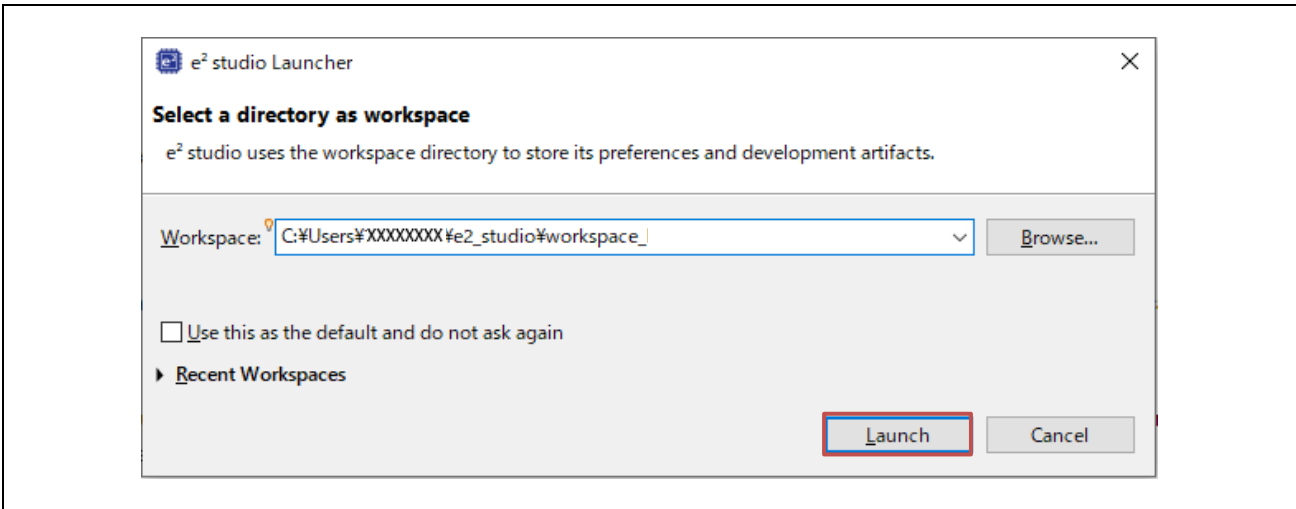


Figure 6.24. Launch project (2)

- Select “Import existing projects”

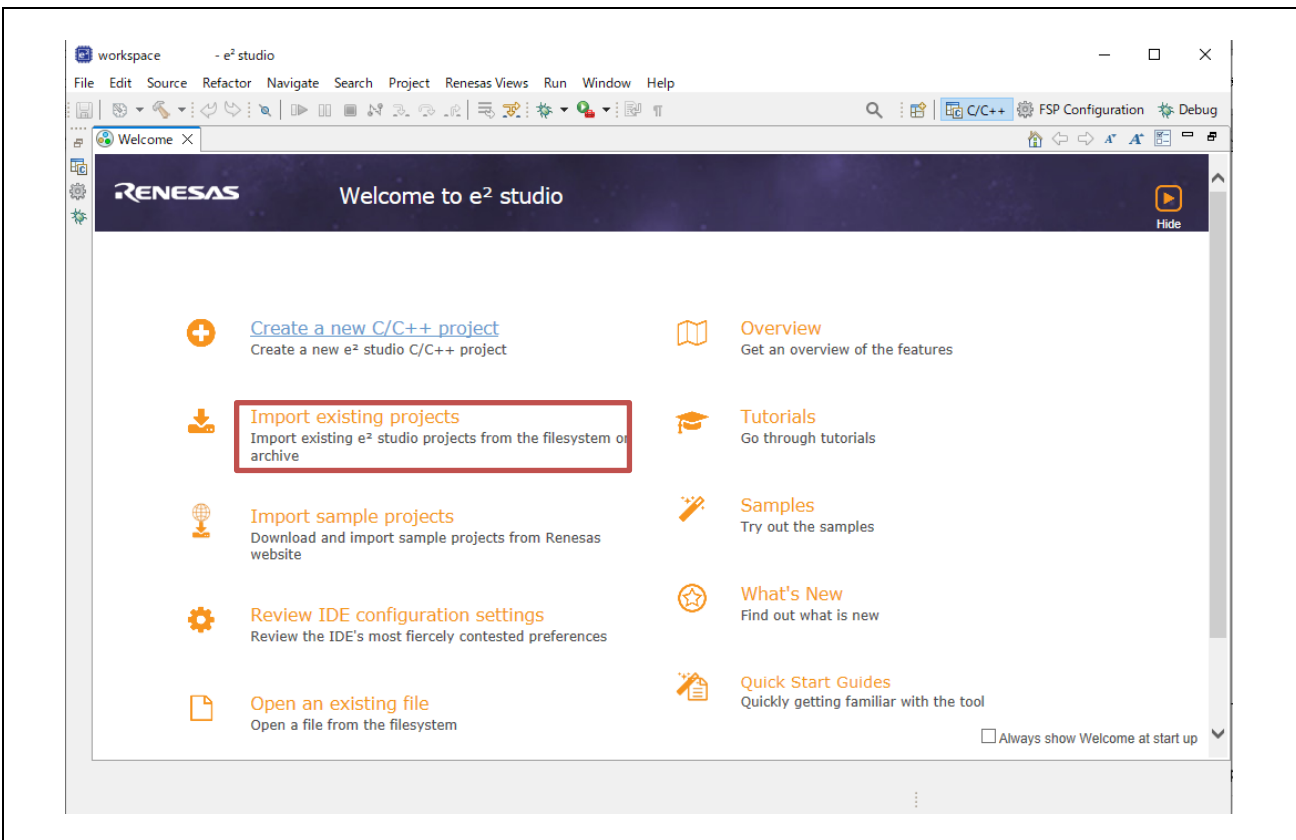


Figure 6.25. Launch project (3)

Click “Browse...” at “Select root directory” and enter the project folder to be imported. For dual-core projects, two projects are displayed.

Single core (CR52) project : RZ***_OPC_EVB(RSK)_rev****\project\CR52_single\e2studio\

Dual core (CR52-CR52) project : RZ***_OPC_EVB(RSK)_rev****\project\CR52_dual\e2studio\

Dual core (CR52-CA55) project : RZ***_OPC_EVB(RSK)_rev****\project\CA55_dual\e2studio\

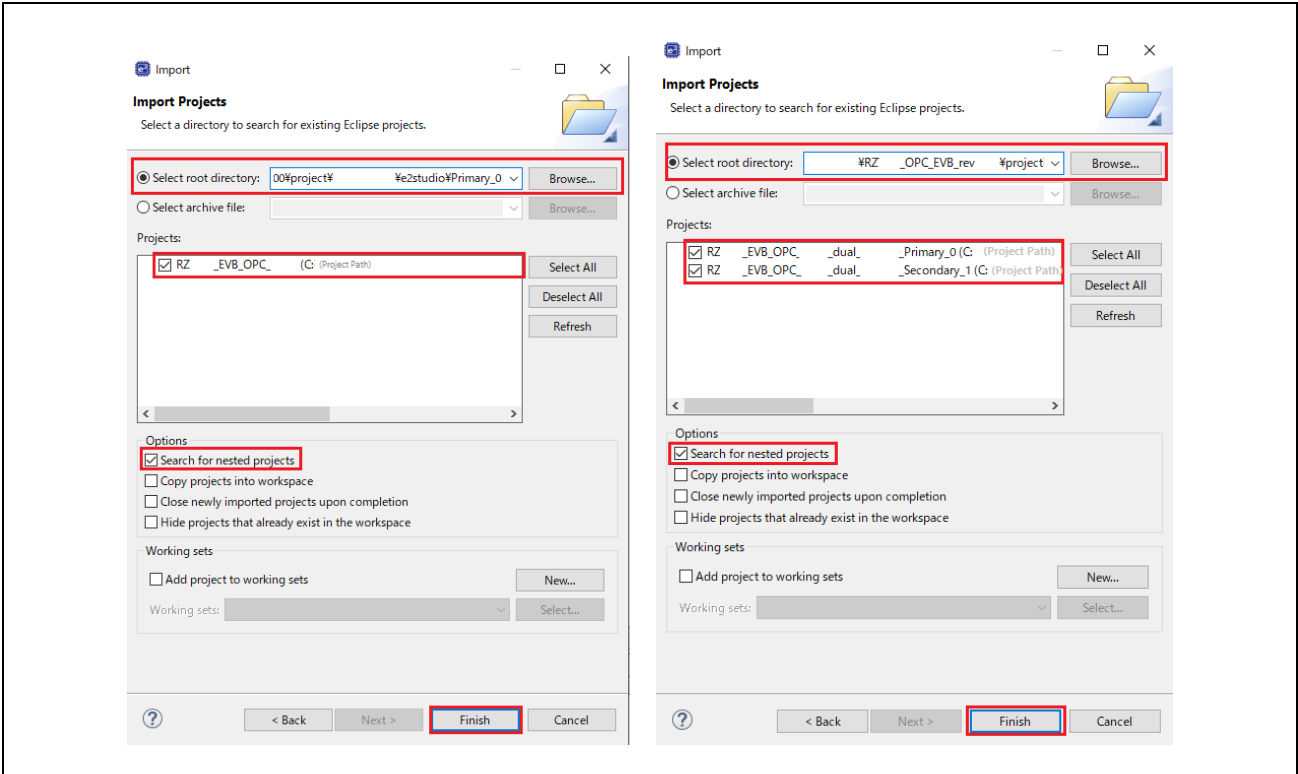


Figure 6.26. Launch project (4)

Clicking “Finish” in Figure 6.26 will start the project import, and the screen will automatically change when finished.

Subsequent steps vary depending on the project used.

6.2.1 For Dual core project

6.2.1.1 Build

* Please refer to the guide in Chapter 9.6.2 when using FSP v4.1.0 or later for RZ/T2M, or when using FSP v4.2.0 or later for RZ/T2H or RZ/N2H.

Double-click the primary project's configuration.xml in the Project Explorer window to open the Smart Configurator.

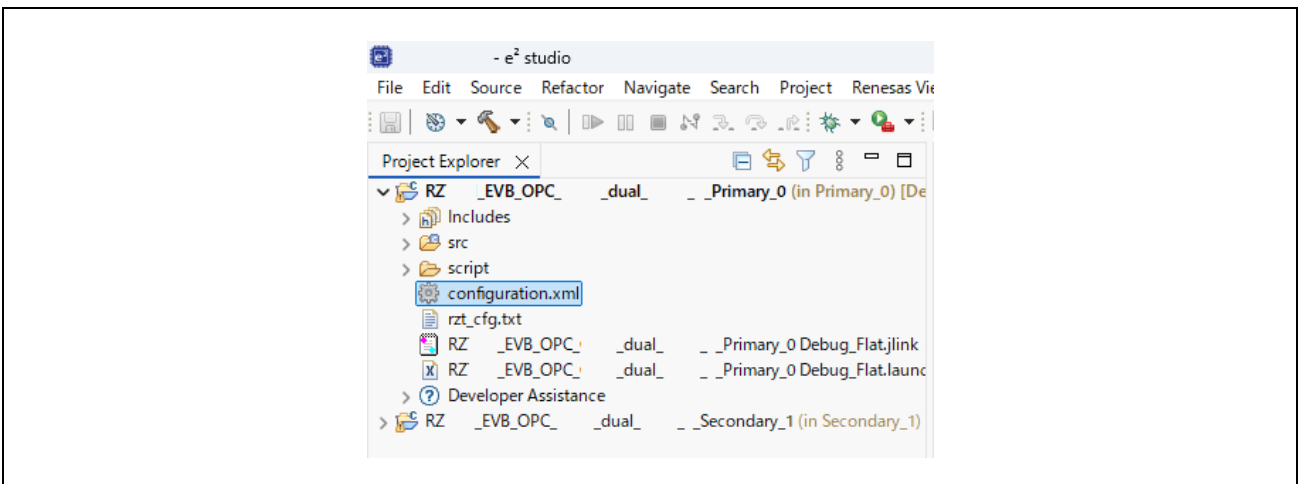


Figure 6.27. Open Smart configurator

Click “Generate Project Content” to generate the source code.

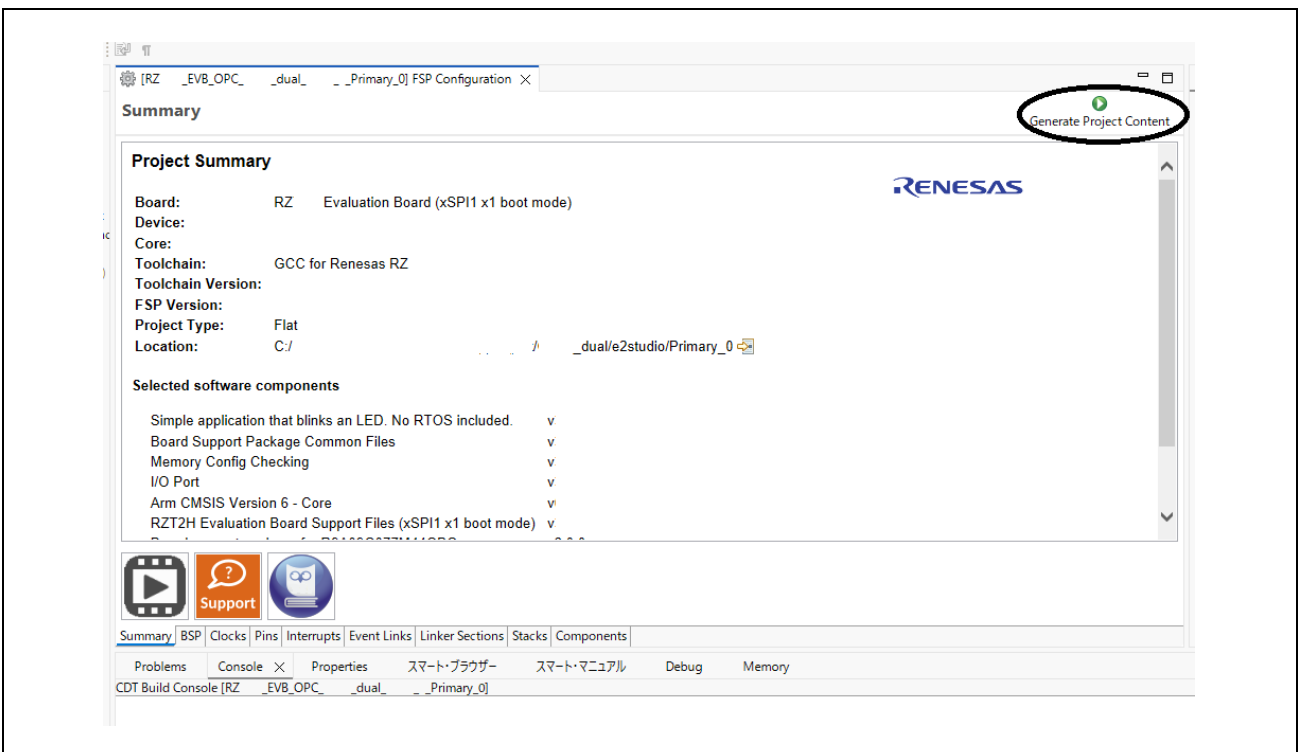


Figure 6.28. Generate Project Content

When debugging using a debugger, add a loop process to the following location.

“(Primary Project Location)\src\hal_entry.c “

```
BSP_ATTRIBUTE_STACKLESS void R_BSP_WarmStart_StackLess(void)
{
  /* The very beginning of the startup process. */
  #if 1 // Software loops are only needed when debugging.
    __asm volatile (
      " mov r0, #0          \n"
      " movw r1, #0x68bf    \n"
      " movt r1, #0x478     \n"
      "software_loop:      \n"
      " adds r0, #1         \n"
      " cmp r0, r1          \n"
      " bne software_loop  \n"
      ::: "memory");
  #endif
  /* Do not delete. Required to return to system_init. */
  #if (0 == BSP_LP64_SUPPORT)
    __asm volatile ("BX lr");
  #else
    __asm volatile ("BR lr");
  #endif
}
```

Select the primary project in the Project Explorer window and click "Clean..." in the Project menu.

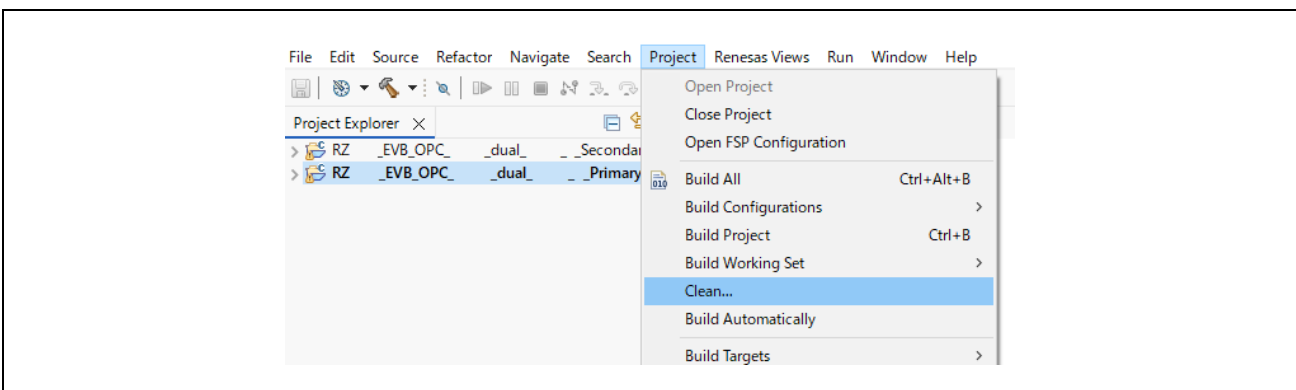


Figure 6.29. Open project Clean...

Select the followings and click Clean to start build.

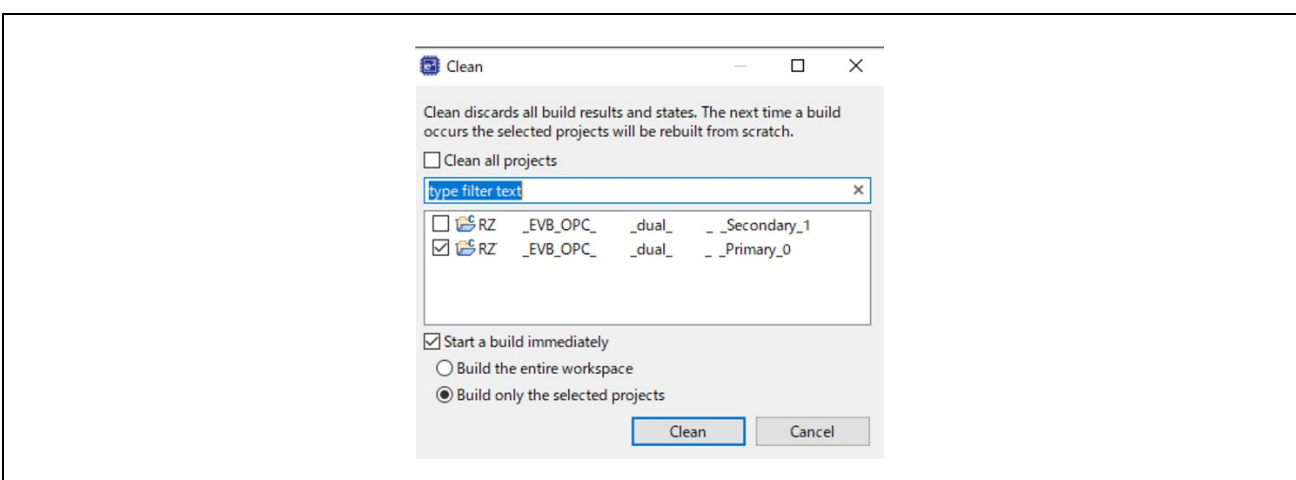


Figure 6.30. Clean and rebuild Primary project

Open the configuration.xml file for the secondary project from the Project Explorer window.

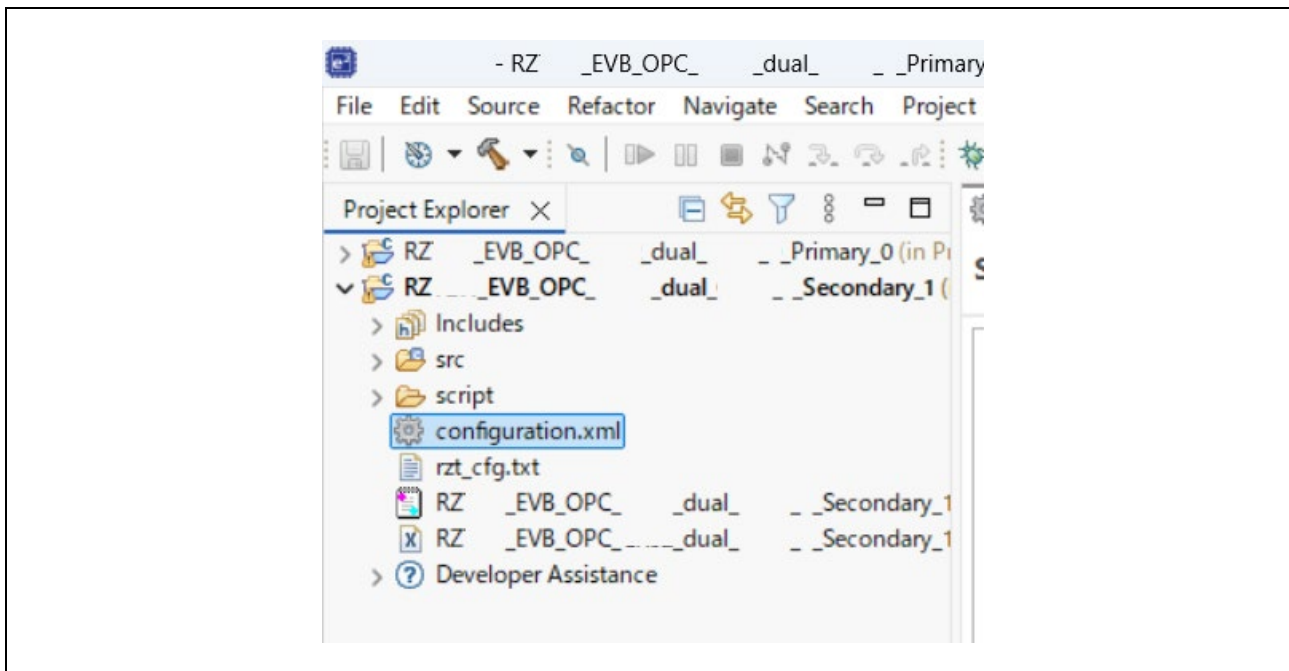


Figure 6.31. Open Smart configurator

※If you wish to change any settings in the sample software from their default values, please configure them at this time by referring to chapter 9.6.

Click “Generate Project Content” to generate the source code.

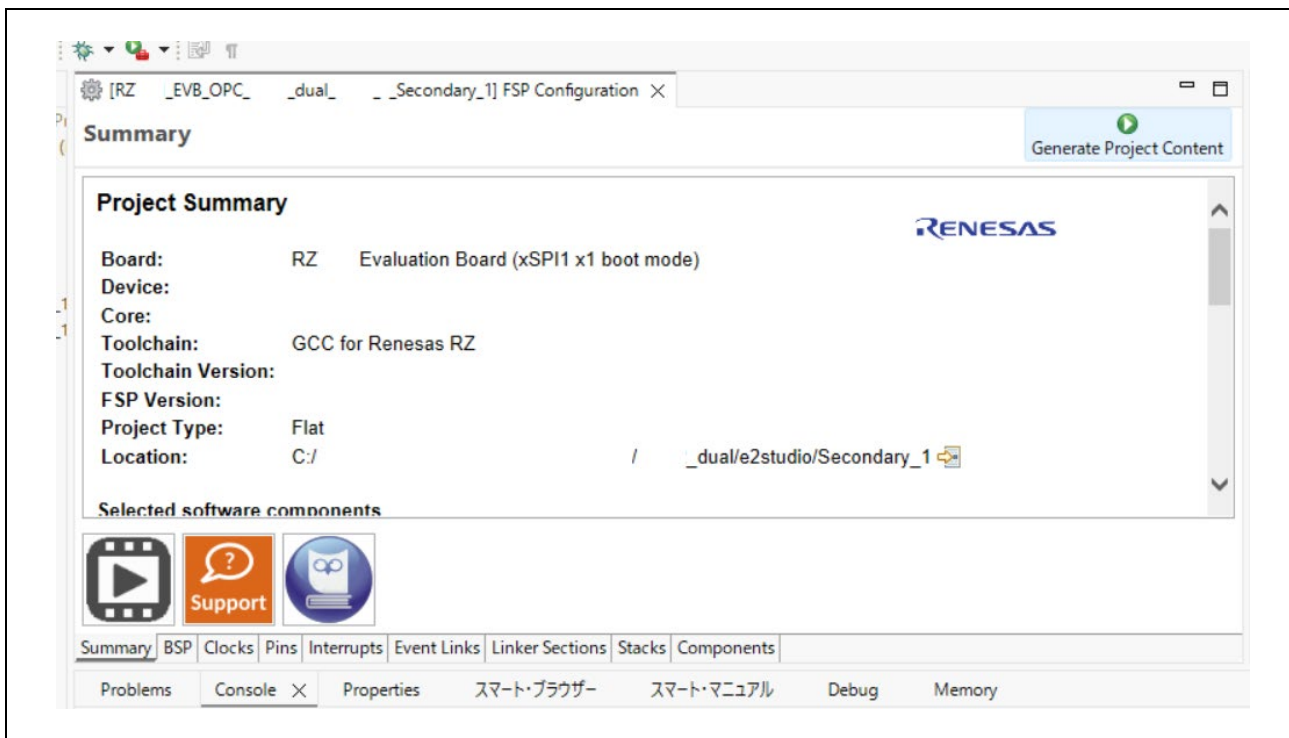


Figure 6.32. Generate Project Content

When debugging using a debugger, add loop processing appropriate for the core at the location below.

“(Secondary Project Location)\src\hal_entry.c “

CR52	<pre> BSP_ATTRIBUTE_STACKLESS void R_BSP_WarmStart_StackLess(void) { /* The very beginning of the startup process. */ #if 1 // Software loops are only needed when debugging. __asm volatile (" mov r0, #0 \n" " movw r1, #0x68bf \n" " movt r1, #0x478 \n" "software_loop: \n" " adds r0, #1 \n" " cmp r0, r1 \n" " bne software_loop \n" ::: "memory"); #endif /* Do not delete. Required to return to system_init. */ #if (0 == BSP_LP64_SUPPORT) __asm volatile ("BX lr"); #else __asm volatile ("BR lr"); #endif } </pre>
CA55	<pre> BSP_ATTRIBUTE_STACKLESS void R_BSP_WarmStart_StackLess(void) { /* The very beginning of the startup process. */ #if 1 // Software loops are only needed when debugging. __asm volatile ("WFI \n" "WFI \n" "WFI \n" "WFI \n"); #endif /* Do not delete. Required to return to system_init. */ #if (0 == BSP_LP64_SUPPORT) __asm volatile ("BX lr"); #else __asm volatile ("BR lr"); #endif } </pre>

After selecting the secondary project, click Clean... in the Project menu.

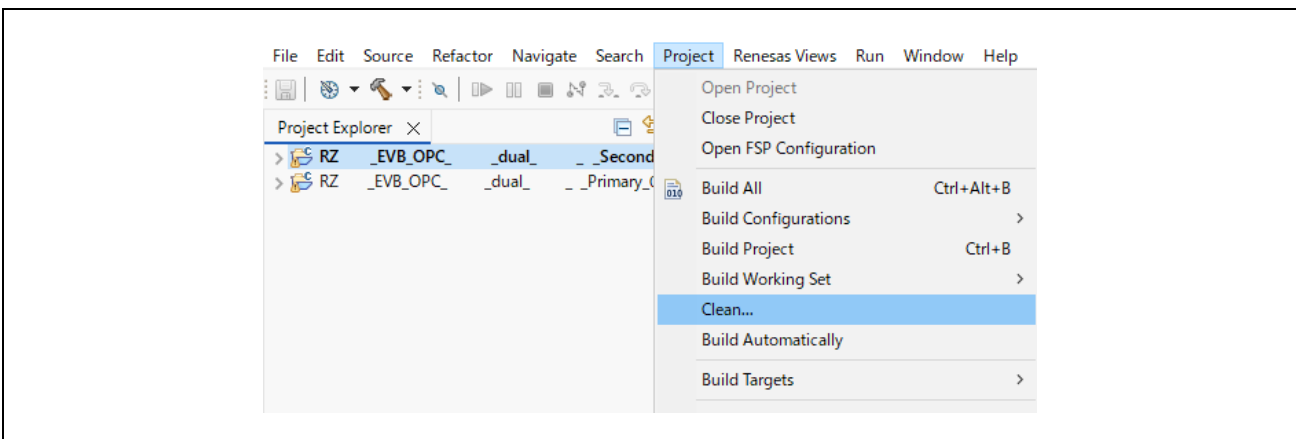


Figure 6.33. Open project Clean...

After configuring the settings as shown below and clicking Clean, the build will begin.

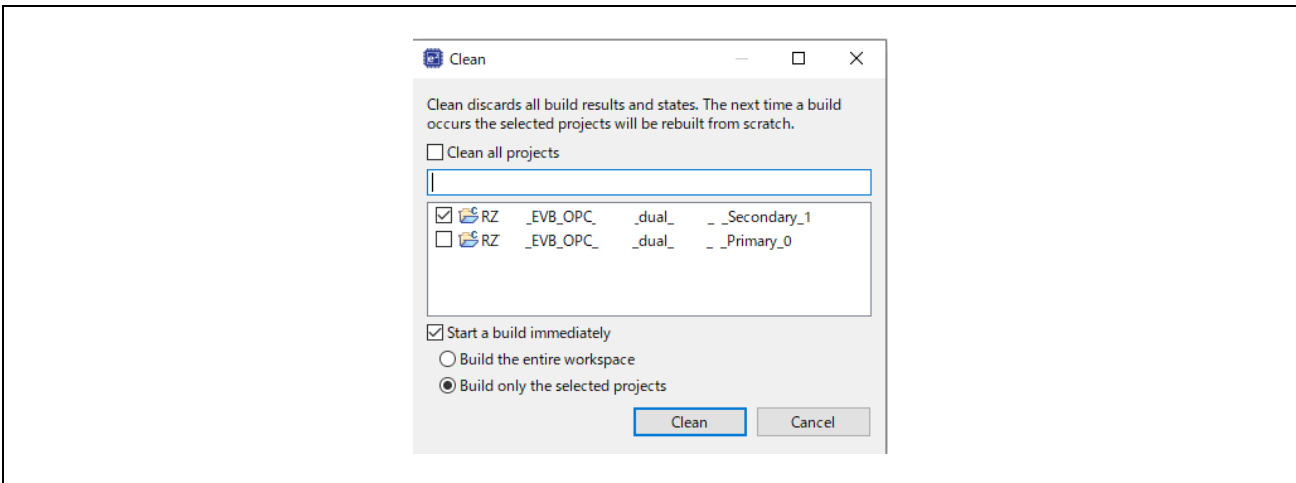


Figure 6.34. Clean and rebuild Secondary project

After confirming that the secondary project's build results show 0 errors, select the primary project in the Project Explorer window and click Clean... in the Project menu.

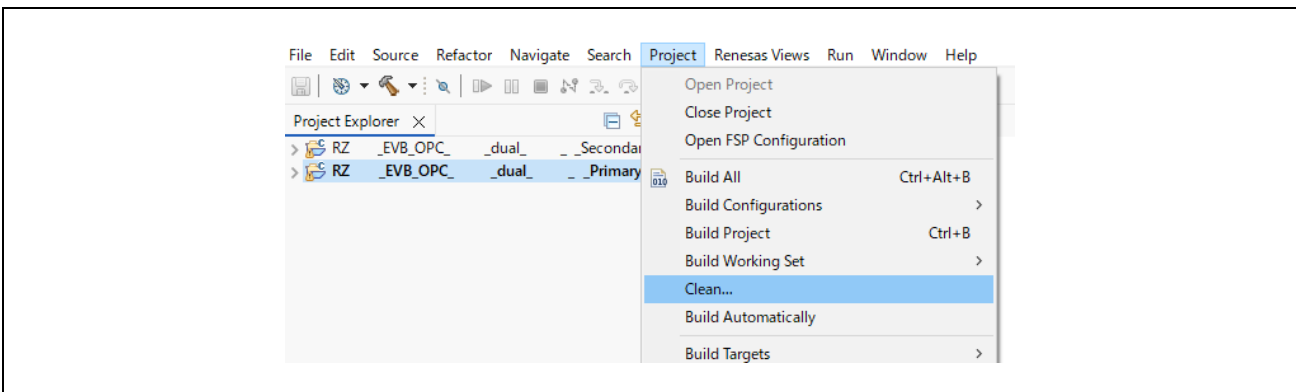


Figure 6.35. Open project Clean...

Select the following and click Clean to start the full build.

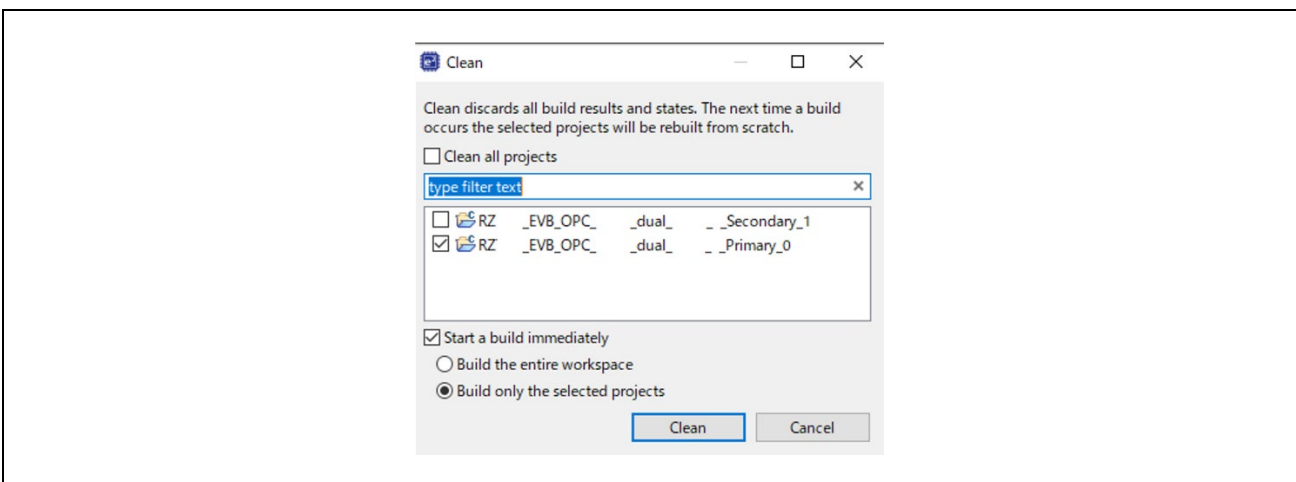


Figure 6.36. Clean and rebuild Primary project

6.2.1.2 Flash writing, debug

The download procedure after the build is completed is shown below.

Select the primary project and click the debug icon to download the program to Flash memory.

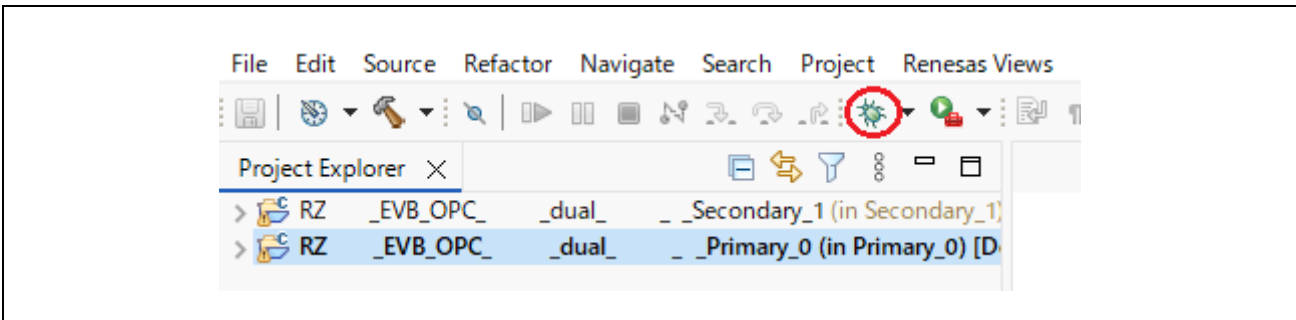


Figure 6.37. Debug Primary

Figure 6.38 window will appear, select “No”.

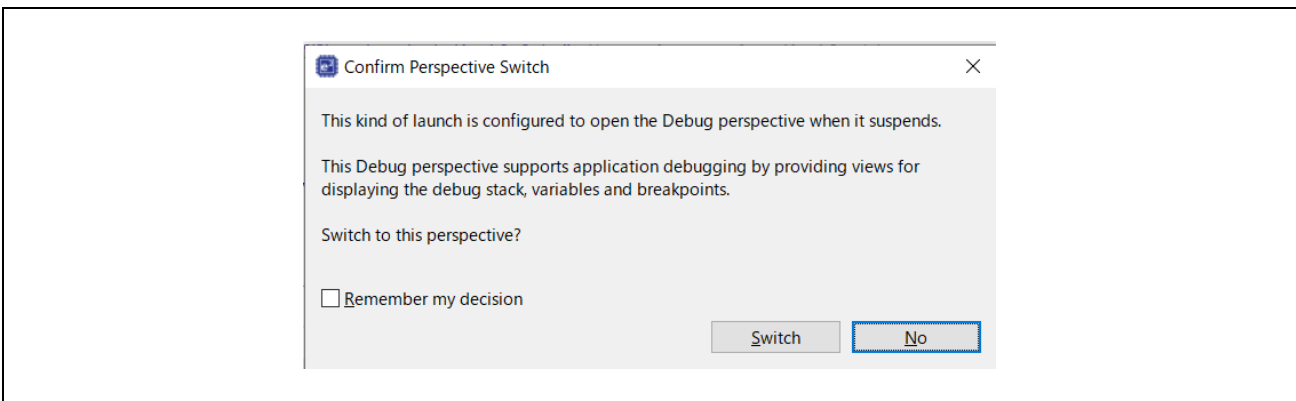


Figure 6.38. Perspective Switch

In case of operating the evaluation board alone without using the debugger, turn off the board power supply, disconnect the debugger cable, and then turn on the board power supply again.

When using the debugger, please follow the steps below.

(1) For CR52_dual project

Select the secondary project and click the debug icon.

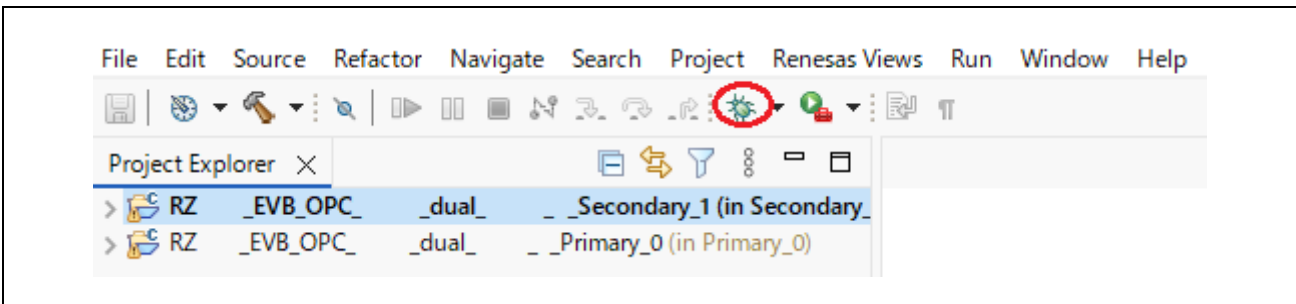


Figure 6.39. Debug Secondary

Figure 6.40 window will appear, select “No”.

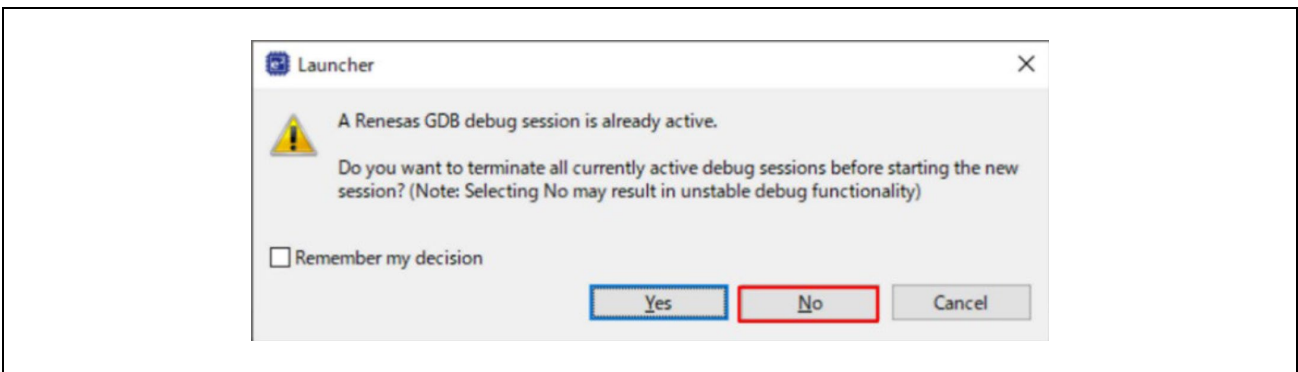


Figure 6.40. Warning Window of Starting Debug Session

Figure 6.41 window will appear, select “Yes”.

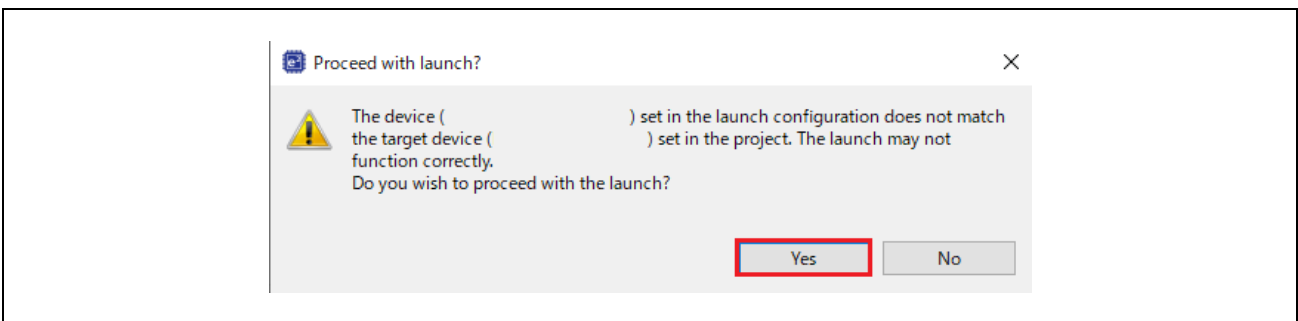


Figure 6.41. Warning Window of Device Name

Figure 6.42 window will appear, select “Switch”.

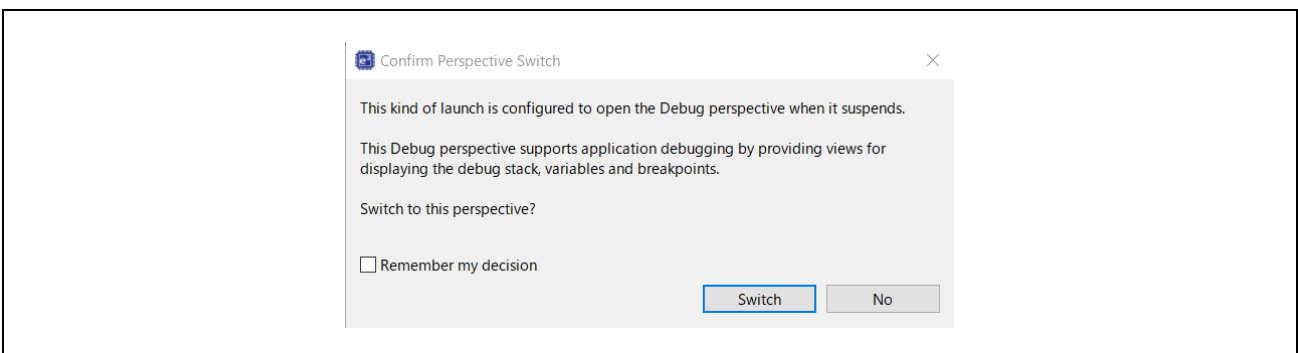




Figure 6.42. Perspective Switch

After selecting a project for each CPU from the Debug tag, click the Resume  icon to run the program and break it with main(). Resume  again for each project will start the program running on each CPU.

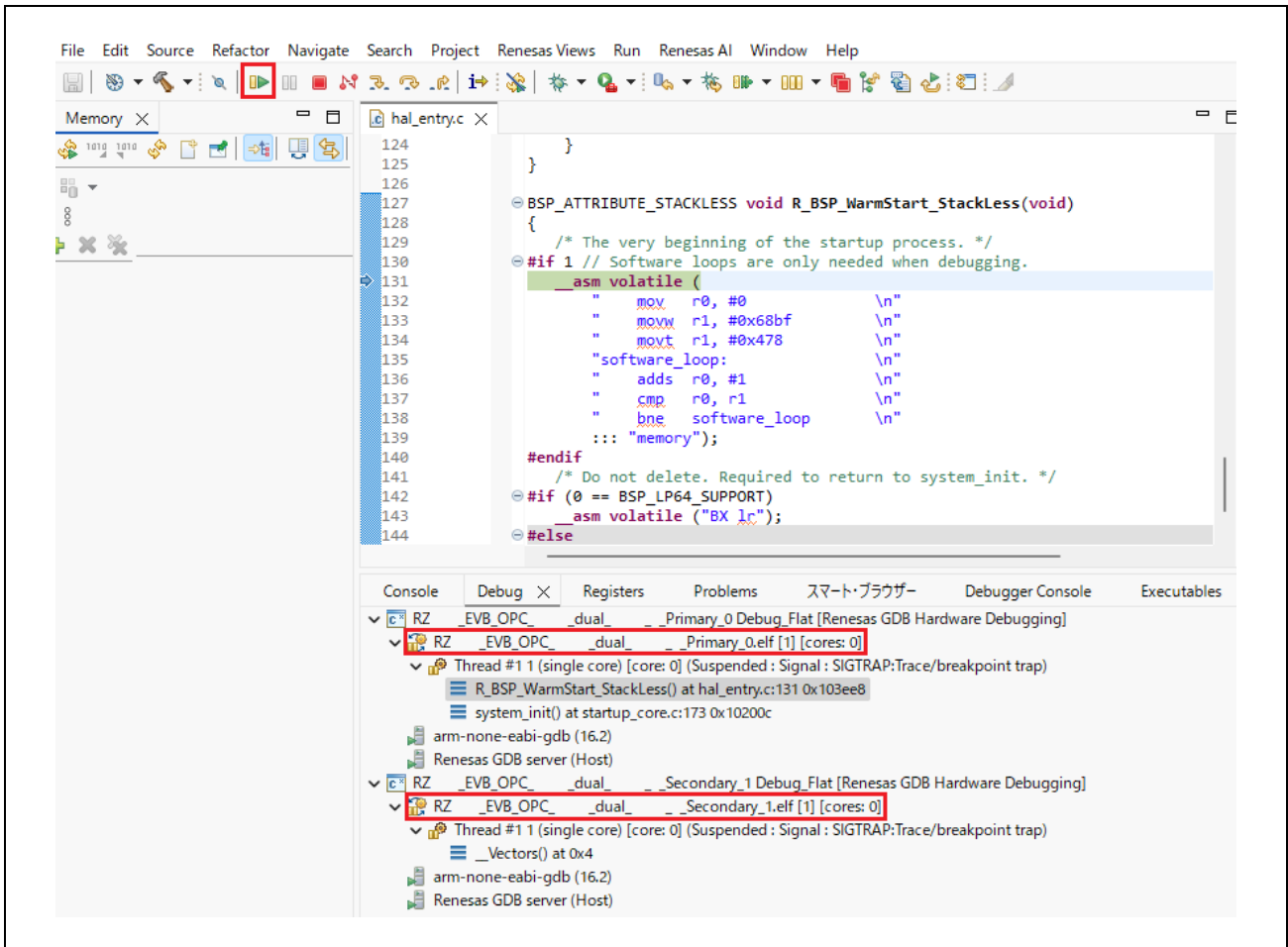


Figure 6.43. Debug

(2) For CA55_dual project

Clicking the Resume icon runs the primary project's program and breaks at main().

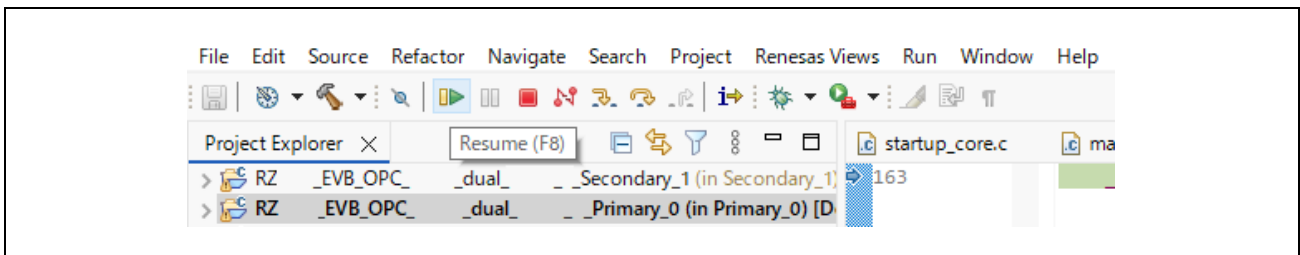


Figure 6.44. Resume Primary project

Select the secondary project and click the debug icon.

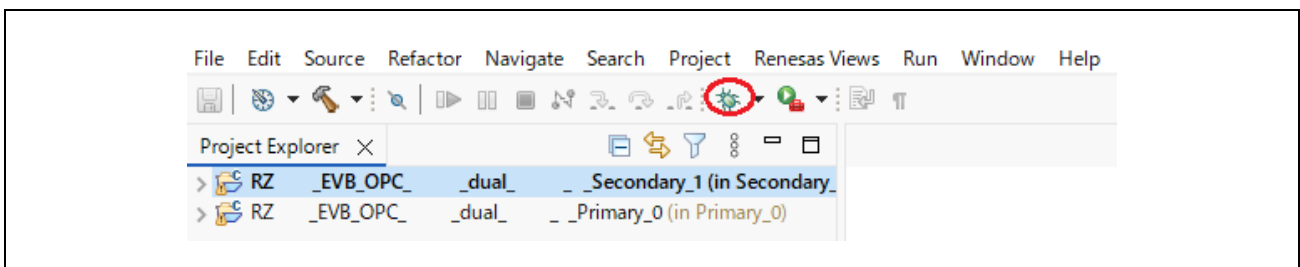


Figure 6.45. Debug Secondary project

Figure 6.46 window will appear, select “No”.

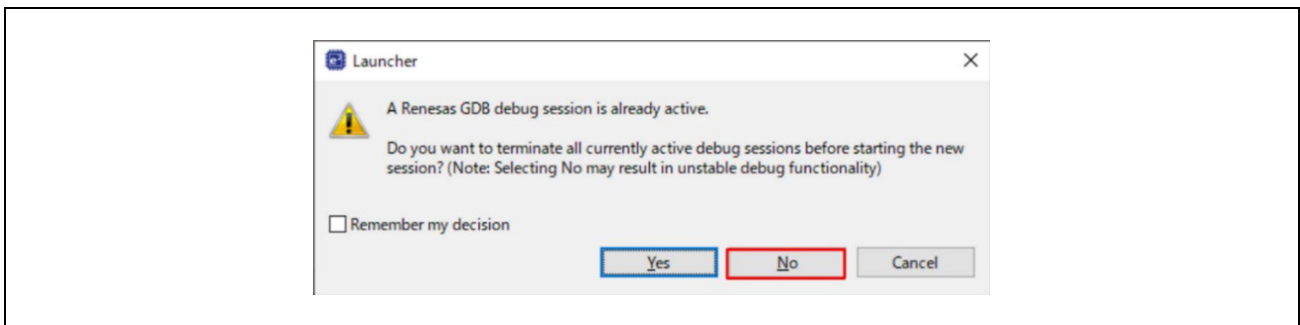


Figure 6.46. Warning Window of Starting Debug Session

Figure 6.47 window will appear, select “Yes”.

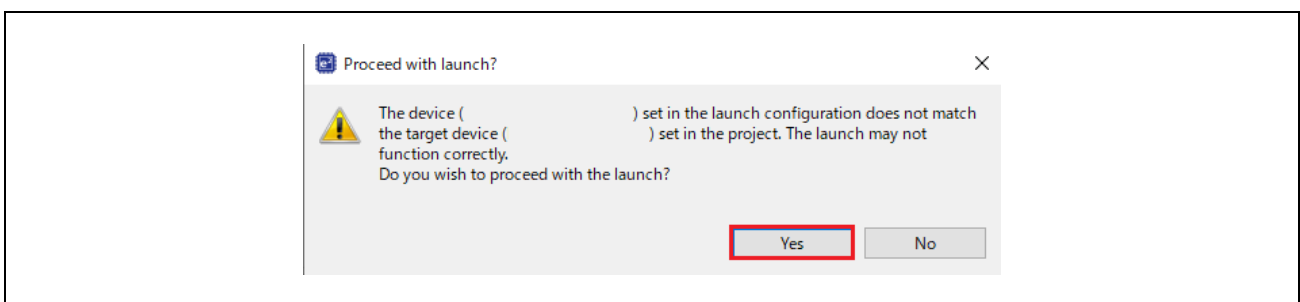


Figure 6.47. Warning Window of Device Name

Figure 6.48 window will appear, select “Switch”.

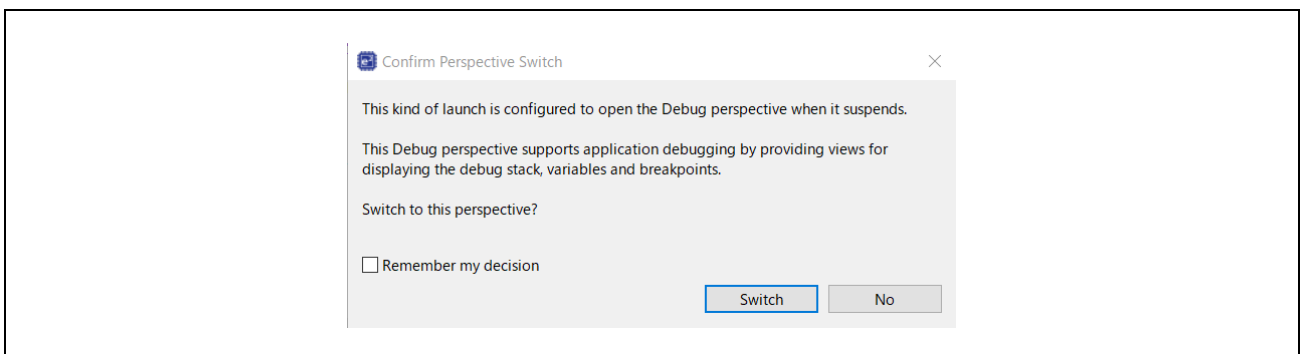



Figure 6.48. Perspective Switch

After selecting the project for each CPU from the Debug tab, click the Resume  icon to run the program.

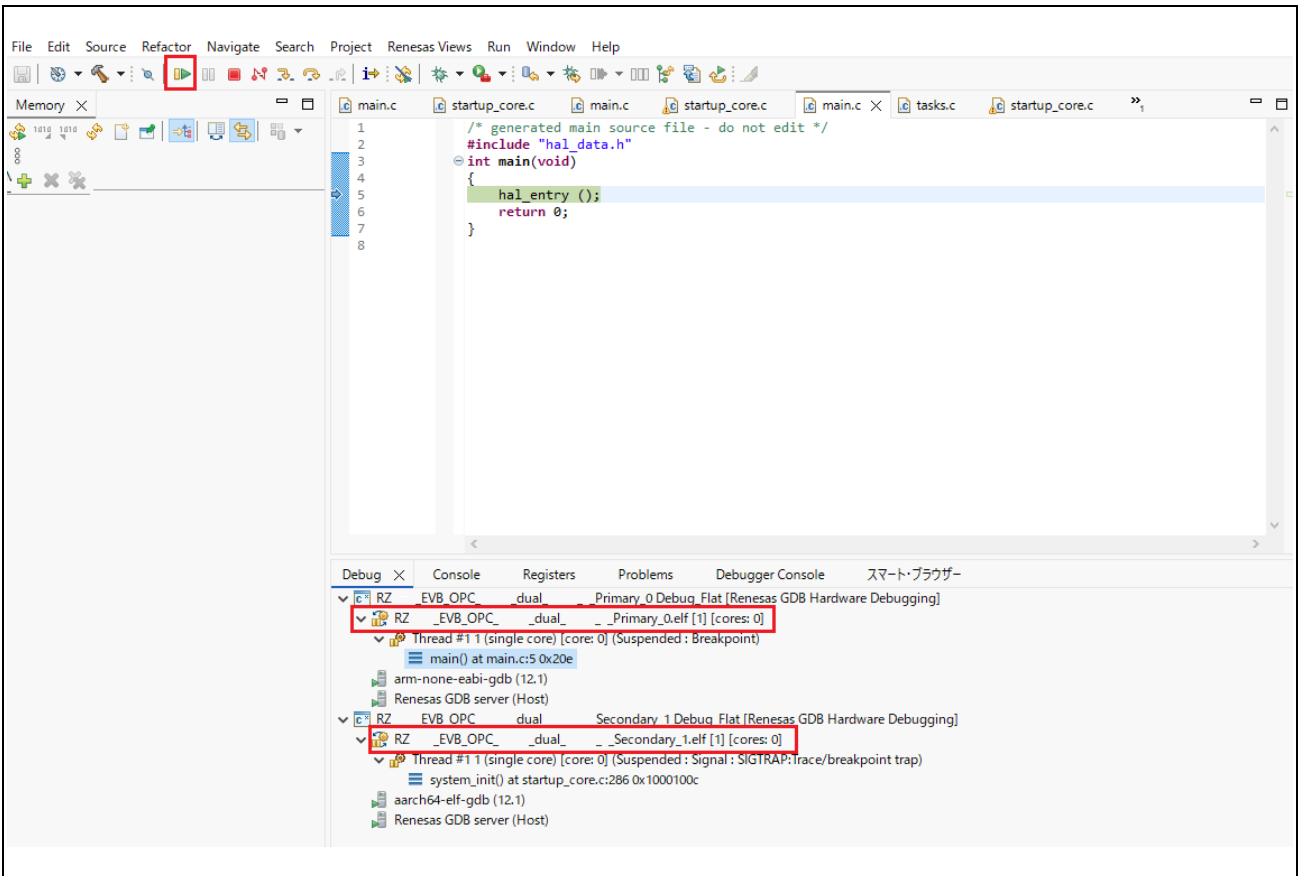


Figure 6.49. Debug

When debugging using a debugger, add loop processing appropriate for the core at the location below.

“(Project Location)\src\hal_entry.c “

```
BSP_ATTRIBUTE_STACKLESS void R_BSP_WarmStart_StackLess(void)
{
  /* The very beginning of the startup process. */
  #if 1 // Software loops are only needed when debugging.
  __asm volatile (
    " mov r0, #0          \n"
    " movw r1, #0x68bf    \n"
    " movt r1, #0x478     \n"
    "software_loop:      \n"
    " adds r0, #1         \n"
    " cmp r0, r1         \n"
    " bne software_loop  \n"
    ::: "memory");
  #endif
  /* Do not delete. Required to return to system_init. */
  #if (0 == BSP_LP64_SUPPORT)
  __asm volatile ("BX lr");
  #else
  __asm volatile ("BR lr");
  #endif
}
```

Select the project name in the “Project Explorer” window and click "Clean..." in the Project menu.

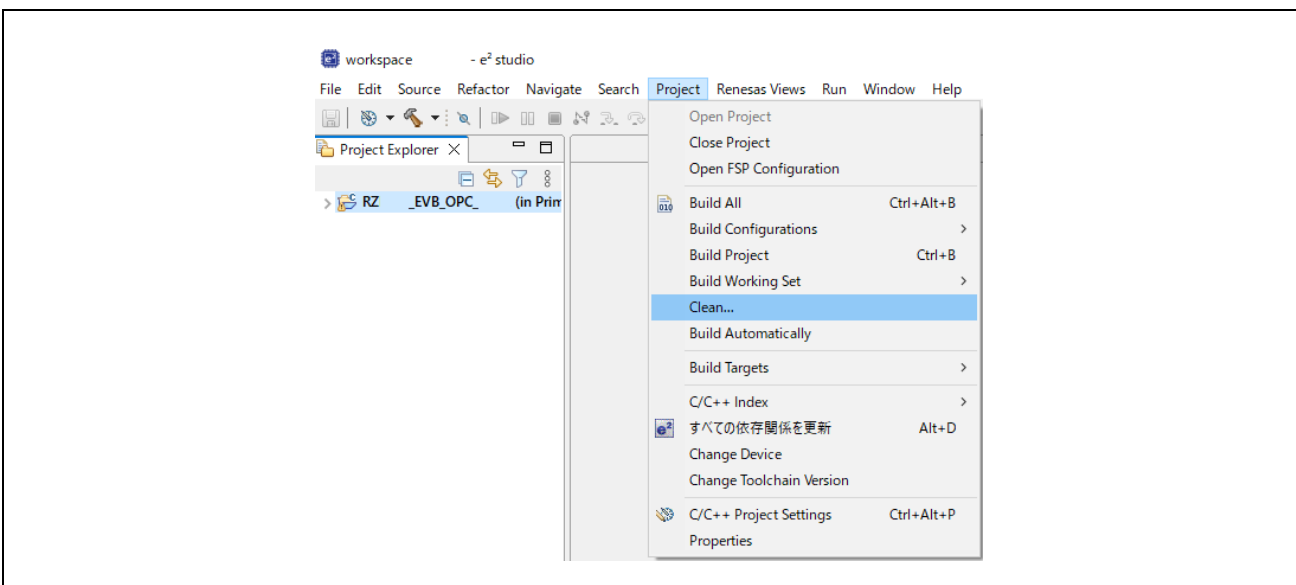


Figure 6.52. Open project Clean...

Select as shown in the figure below and click "Clean" to start build.

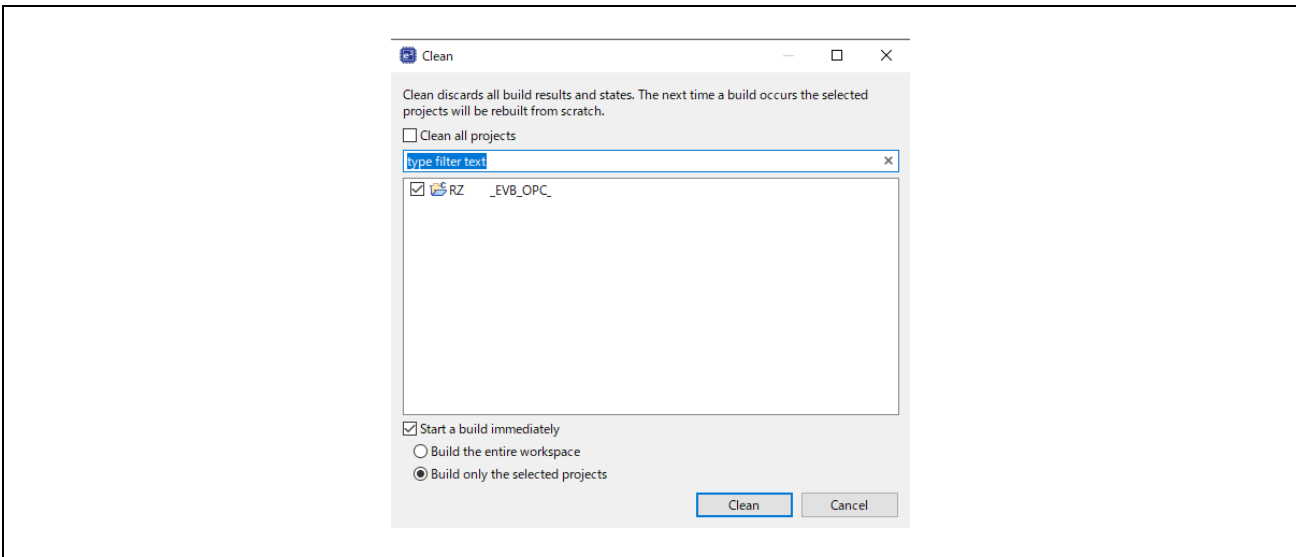


Figure 6.53. Clean and rebuild

6.2.2.2 Flash writing, debug

The download procedure after the build is shown below.

Select a project from “Project Explore” and click the debug icon to download the program to flash memory.

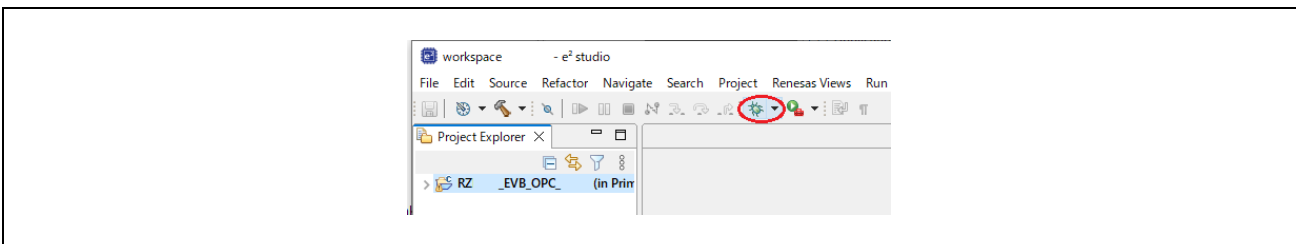


Figure 6.54. Run menu Debug As

Click Switch to change to debug view.

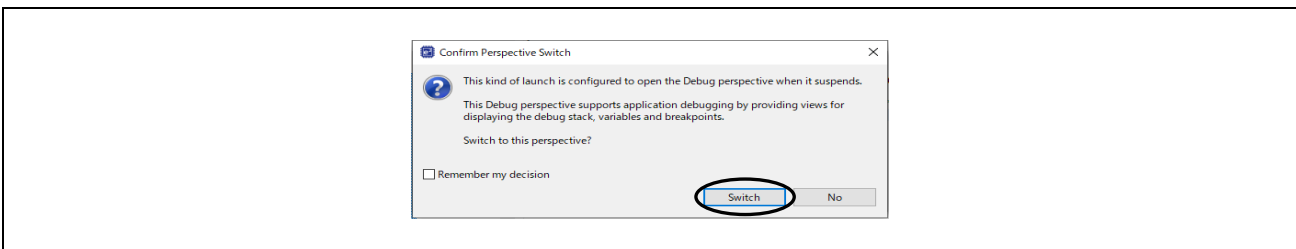



Figure 6.55. Perspective Switch

In case of operating the evaluation board alone without using the debugger, turn off the board power supply, disconnect the debugger cable, and then turn on the board power supply again.

When using the debugger, click the "resume"  after switching to the Debug screen.

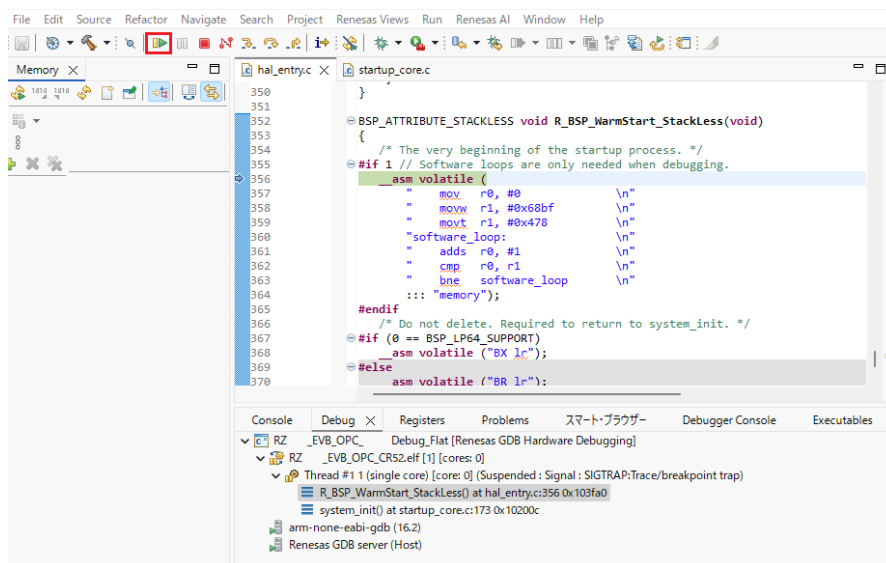


Figure 6.56. Debug view

7. Demonstration of the Sample Application

7.1 Application Behavior

This sample software consists of the OPC UA Server and the sample application that periodically reads from and writes to its Node. For detailed specifications of the software configuration, refer to chapter 8.1.

7.2 OPC UA Operation

This chapter explains how to verify the operation of OPC UA functions.

7.2.1 Server

The role of each device when checking OPC UA Server operation is shown in Figure 7.1.

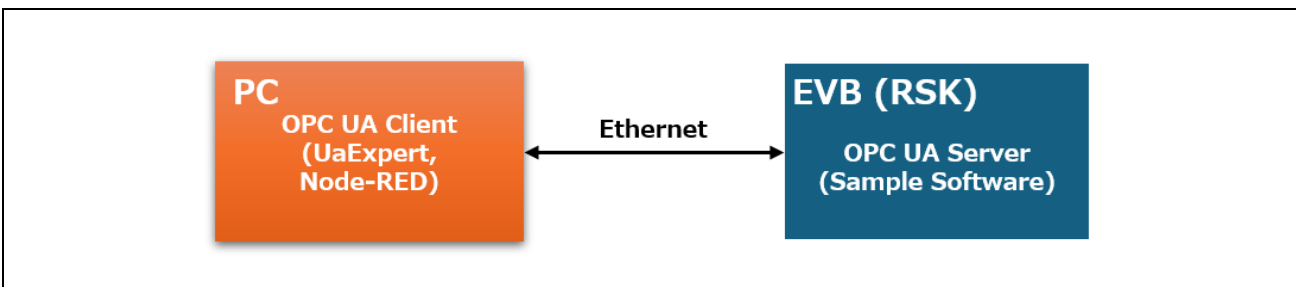


Figure 7.1. Connection Block Diagram for OPC UA Server

7.2.1.1 Without security function

(1) When using UaExpert

After turning on the power of evaluation board, wait until the time synchronization by NTP communication and the initialization are completed. It takes about 15 seconds after power-on. The Green LED (T2M, N2L, T2H:LED0, N2H:LED3) on the evaluation board lights up when the time synchronization is completed.

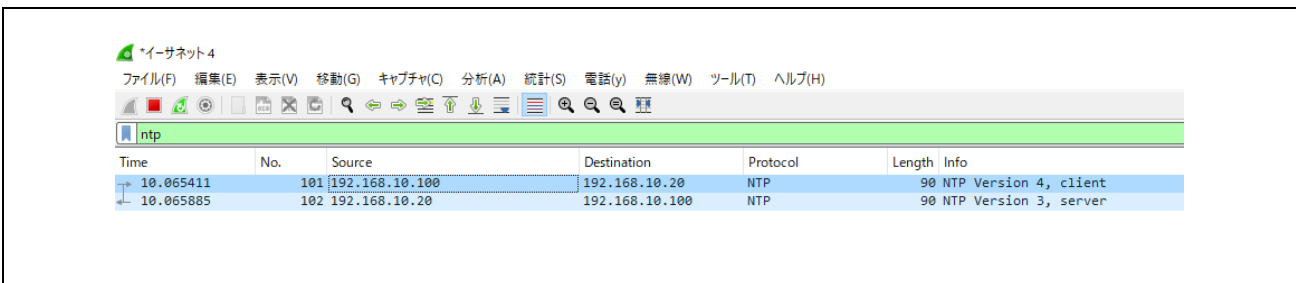


Figure 7.2. NTP Communication

Launch UaExpert and click  on the tool bar in UaExpert.

Open the Advanced tag, set the "Endpoint Url" to "opc.tcp://192.168.10.100:4840", select "Anonymous". Check "Connect Automatically" and then click OK at the end.

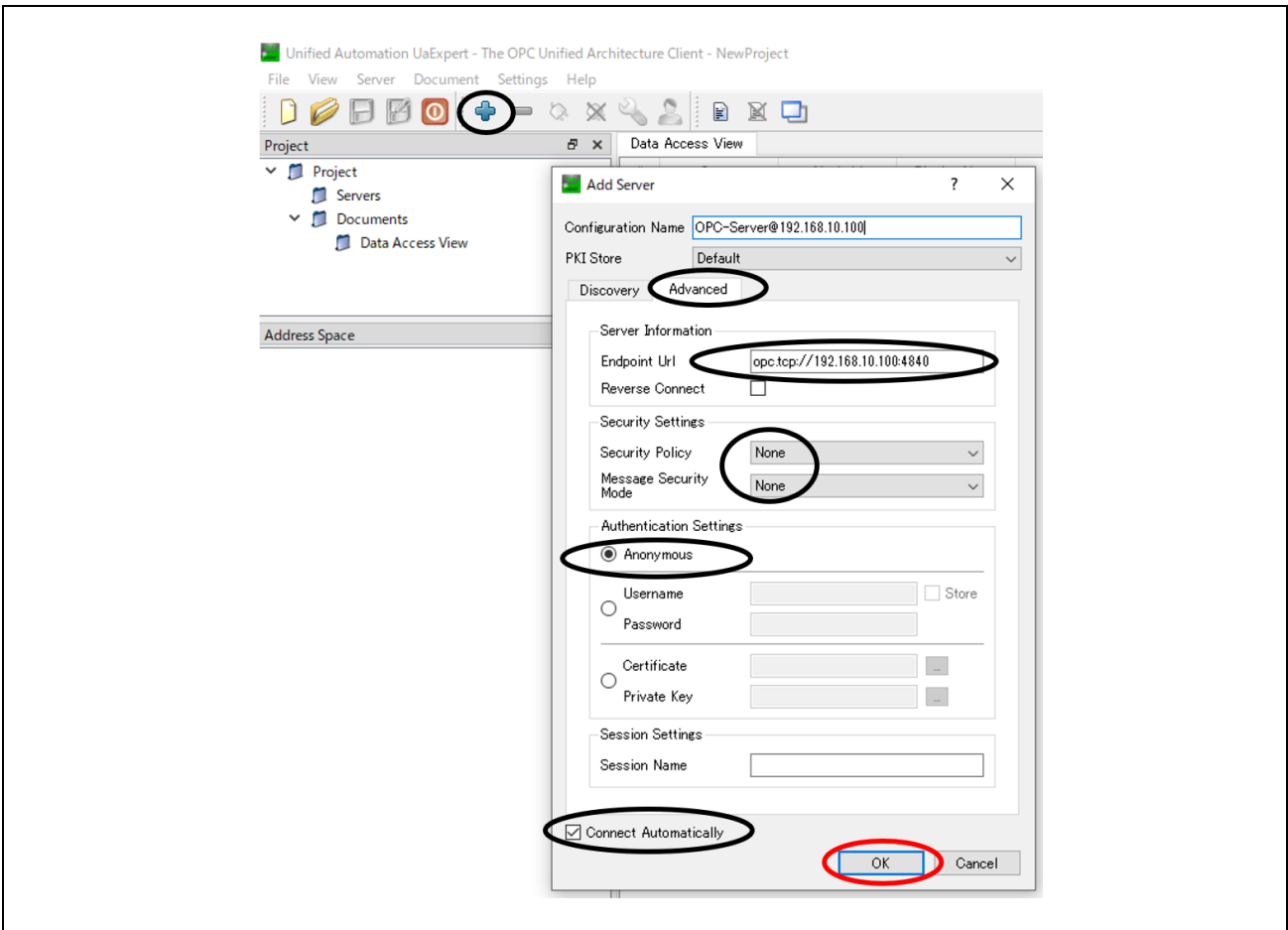


Figure 7.3. UaExpert Add server

When the OPC UA Server is connected, an indicator icon is displayed in the “Project” window to show that the server is connected. “Renesas_RZ” displayed under the Object tree in the “Address Space” window is a Node of OPC UA server.

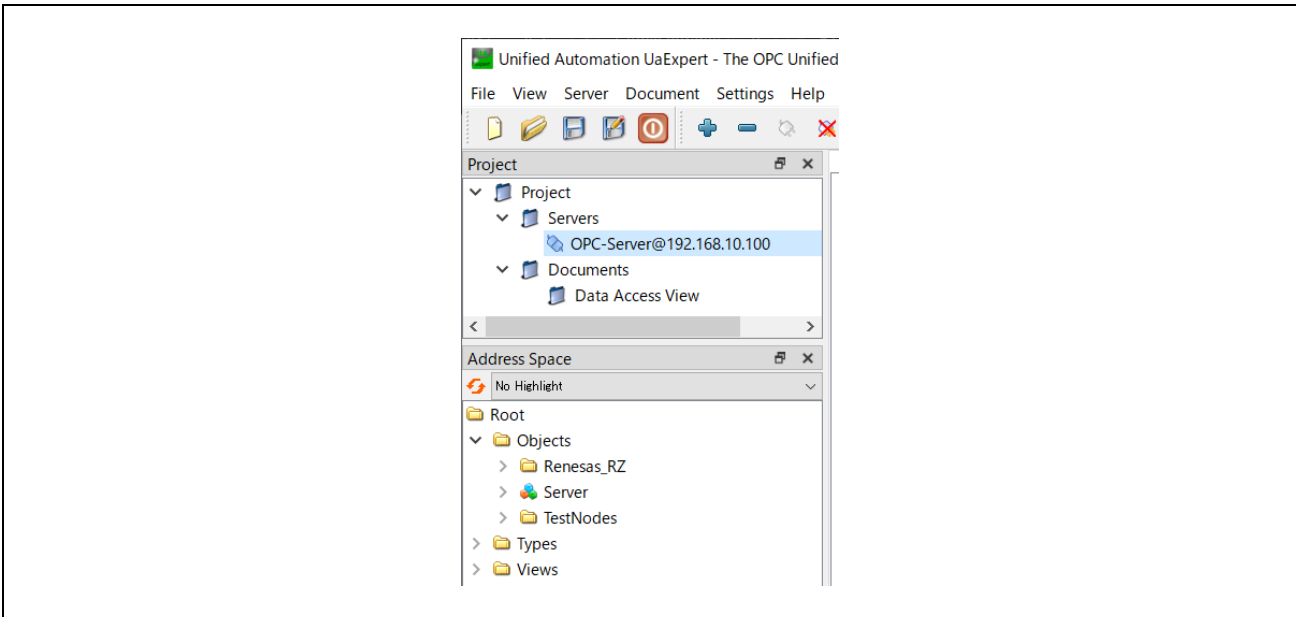


Figure 7.4. UaExpert OPC UA Server connection

As shown in Figure 7.5, drag and drop the *Root>Objects>Renesas_RZ* node in the “Address Space” window to the “Data Access View” window to read the values of each Nodes. See chapter 8.1 for the specification of each Node Value.

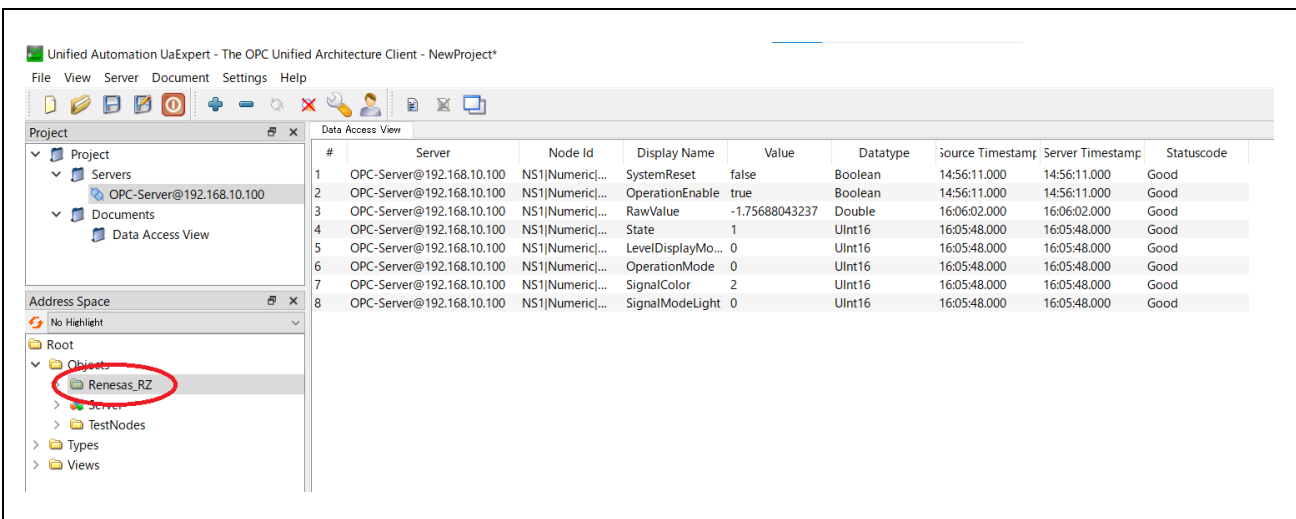


Figure 7.5. Reading Nodes

(2) When using Node-RED

Launch Node-RED following the same procedure as in section 5.8. Click Import from the menu button.

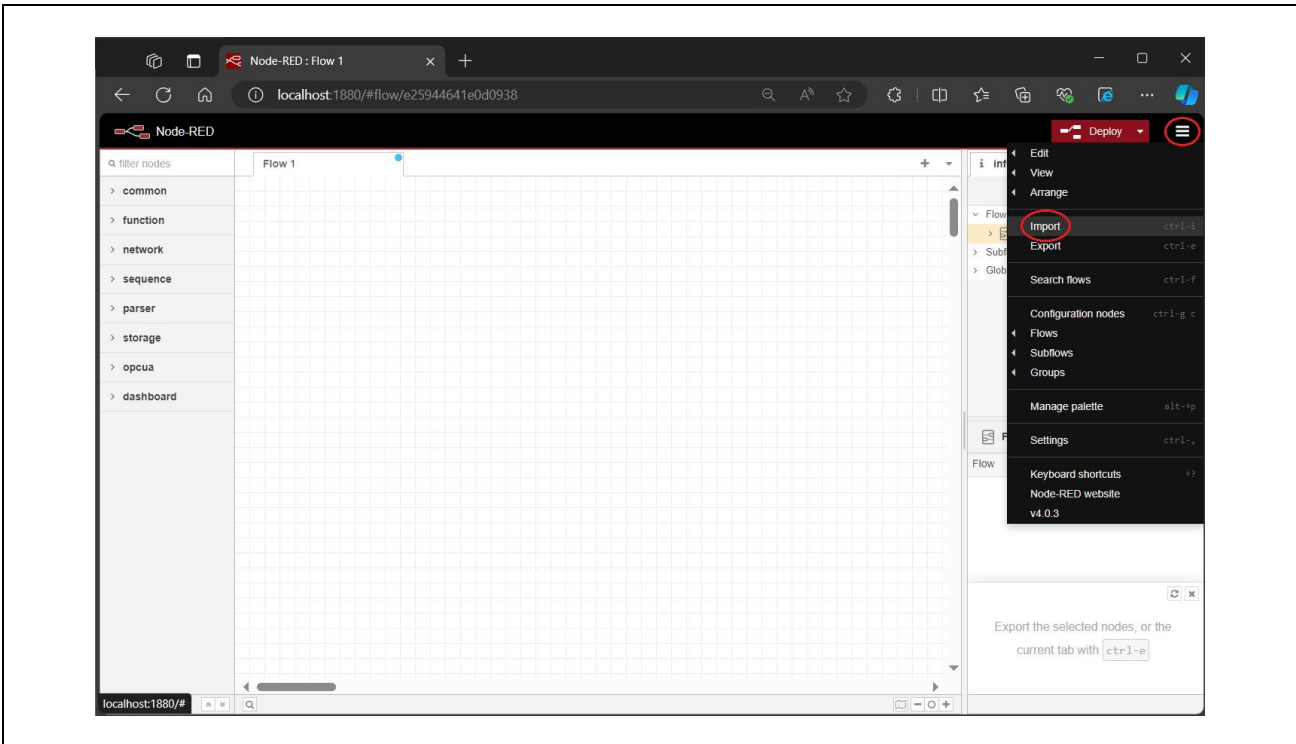


Figure 7.6. Import

Click “select a file to import” and select “node-red_opcua_v2.1.json” included in the package, then click the Import button.

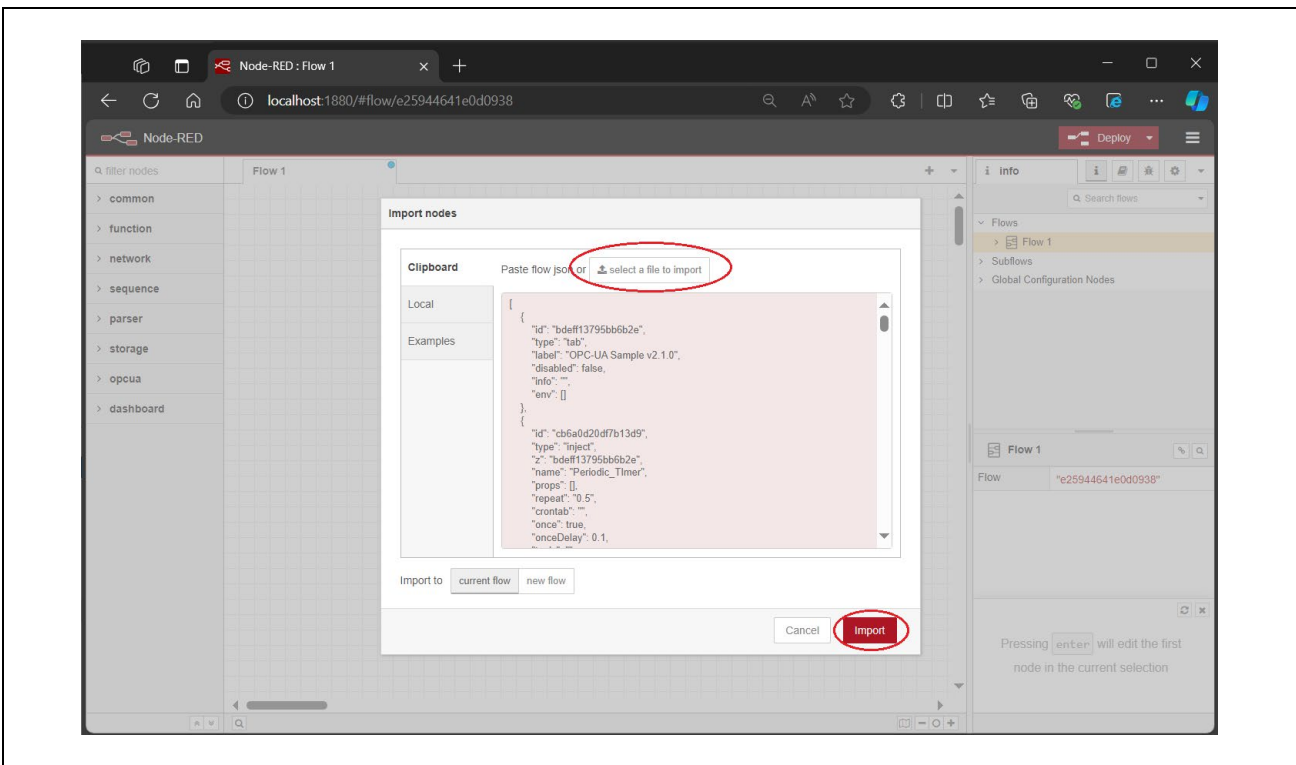


Figure 7.7. Import .json file

After importing the flow, click “Deploy” in the upper right corner of the screen.

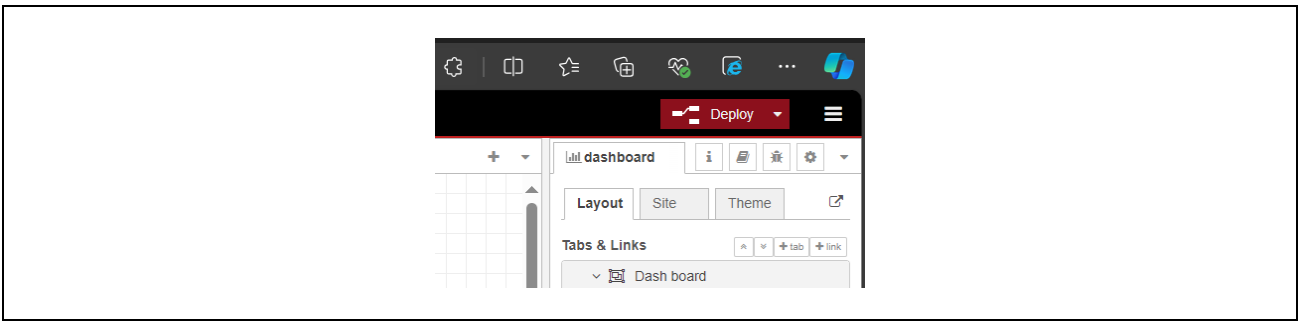


Figure 7.8. Deploy

If the connection with the OPC UA Server is successful, “active reading” is displayed under the OPC UA Client Node.

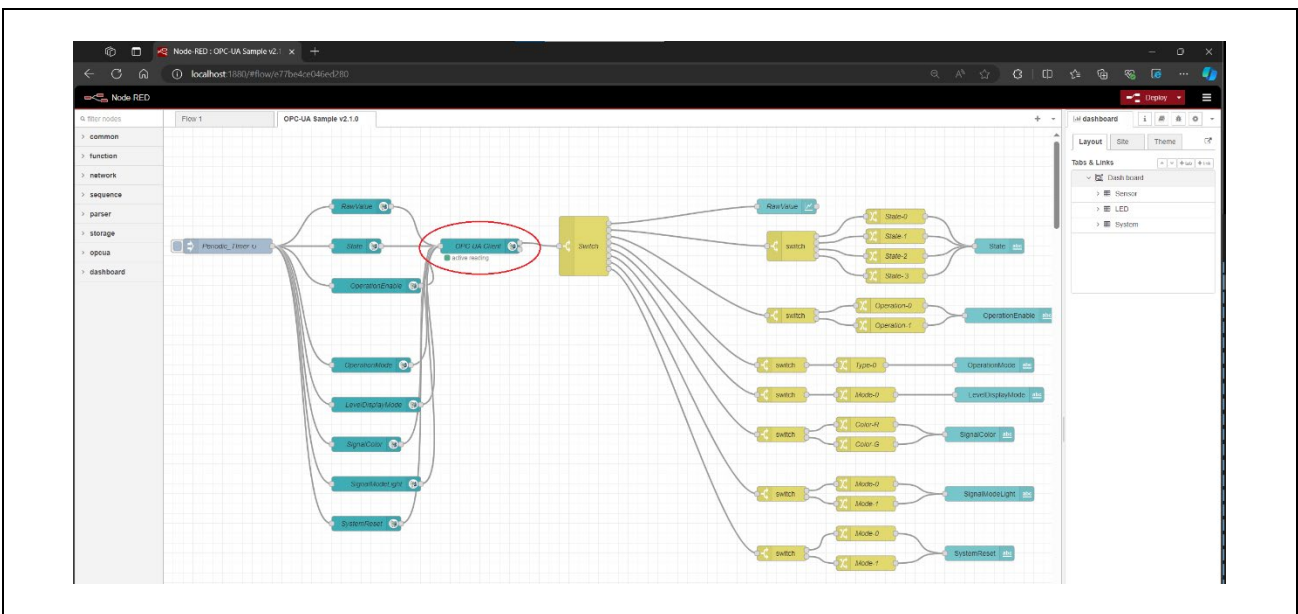



Figure 7.9. Connection Successful

Click on the Dashboard from  icon in the upper right corner of the screen.

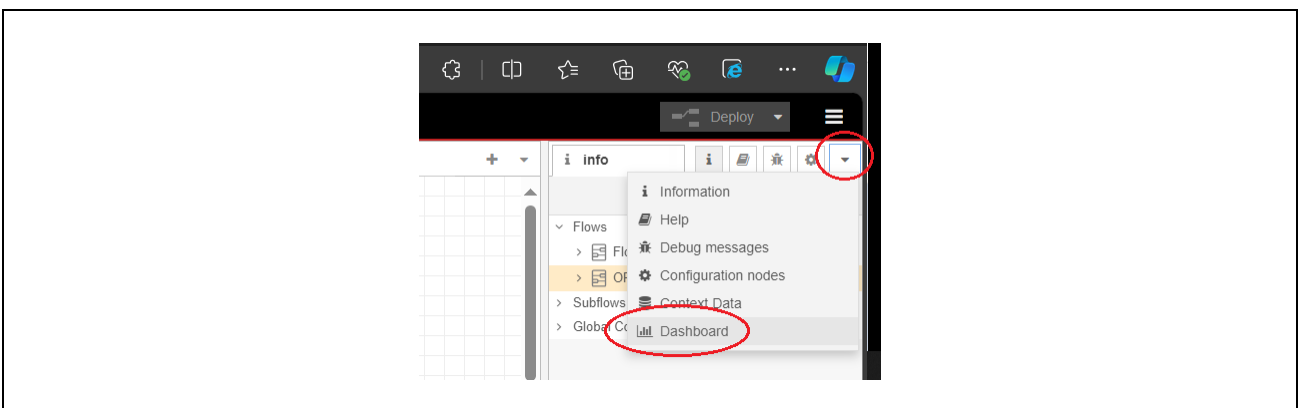



Figure 7.10. Open Dashboard (1)

Click  icon on the upper right corner of the screen.

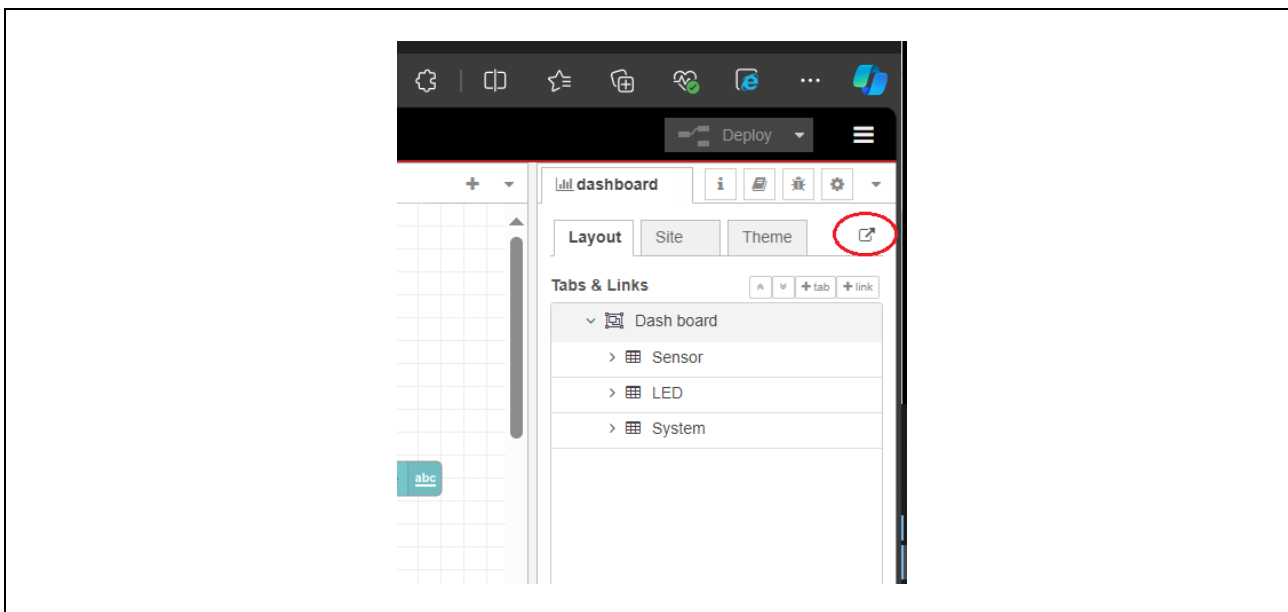


Figure 7.11. Open Dashboard (2)

The Dashboard will open in a separate window, displaying the value of each Node.

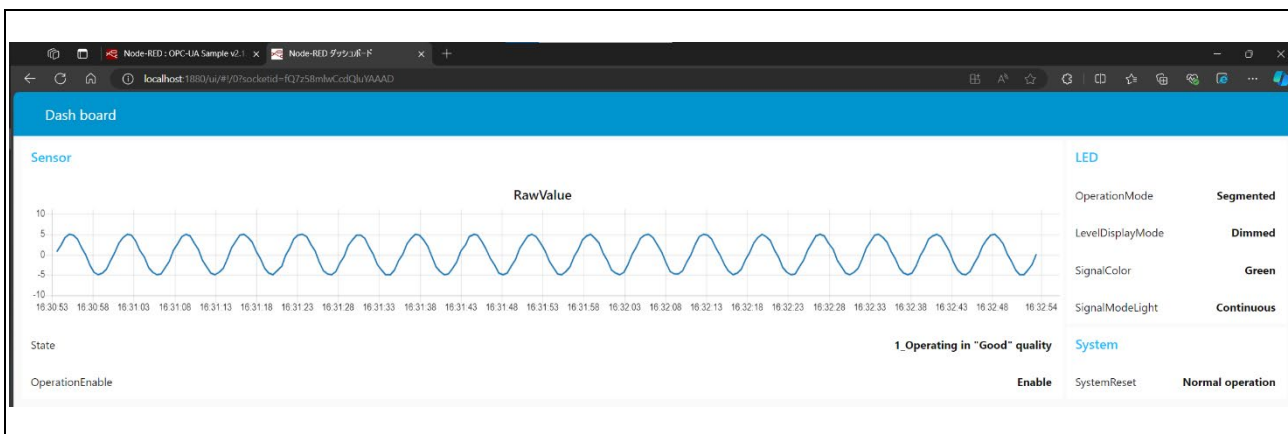


Figure 7.12. Dashboard

7.2.1.2 With security function

To use the security feature, connect a USB flash drive with the private key and public key certificate to evaluation board or use software built with ENABLE_FREERTOS_PLUS_FAT:0 set.

The three files that need to be written to the USB flash drive are “cert_server.der”, “pkey_server.der” and “cert_client_1.der”. Please store the files in <USB_ROOT>/passw0rd folder. If you wish to write these files to the USB flash drive using the TFTP function of this project, please refer to section 9.2. After writing, perform a system reset or turn the evaluation board power off and then on.

After turning on the power of evaluation board, wait until the time synchronization by NTP communication and the initialization are completed. It takes about 15 seconds after power-on. The green LED (T2M, N2L, T2H:LED0, N2H:LED3) on the evaluation board lights up when the time synchronization is completed.

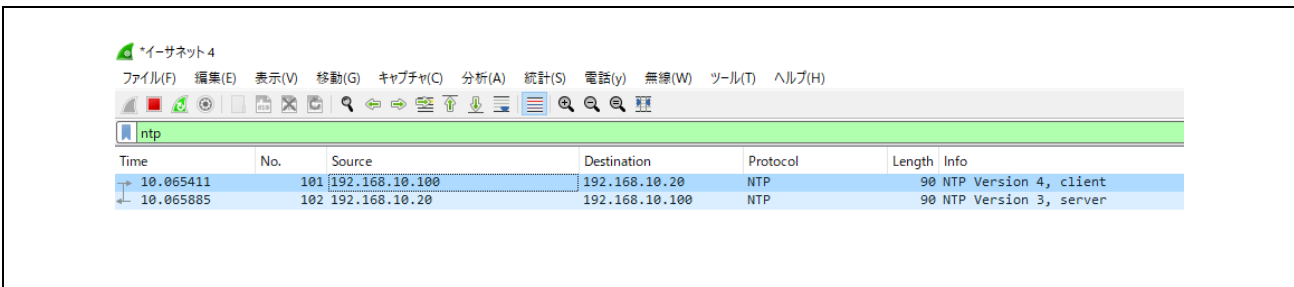


Figure 7.13. NTP Communication

Copy the “uaexpert.der” file to the \unifiedautomation\uaexpert\PKI\own\certs folder, and copy the “uaexpert_key.pem” file to the \unifiedautomation\uaexpert\PKI\own\private folder. These files are in “keyfiles.zip” attached with the package.

In UaExpert, click on the toolbar. In the Advanced tag, set the “Endpoint Url” to “opc.tcp://192.168.10.100:4840” and select the desired Security Policy and Security Mode for Security Setting. For “Authentication Settings”, please select any option other than “Certificate”. If you select Username/Password, enter the username and password pair listed in Table 2.1. Check the “Connect Automatically” box, then click OK.

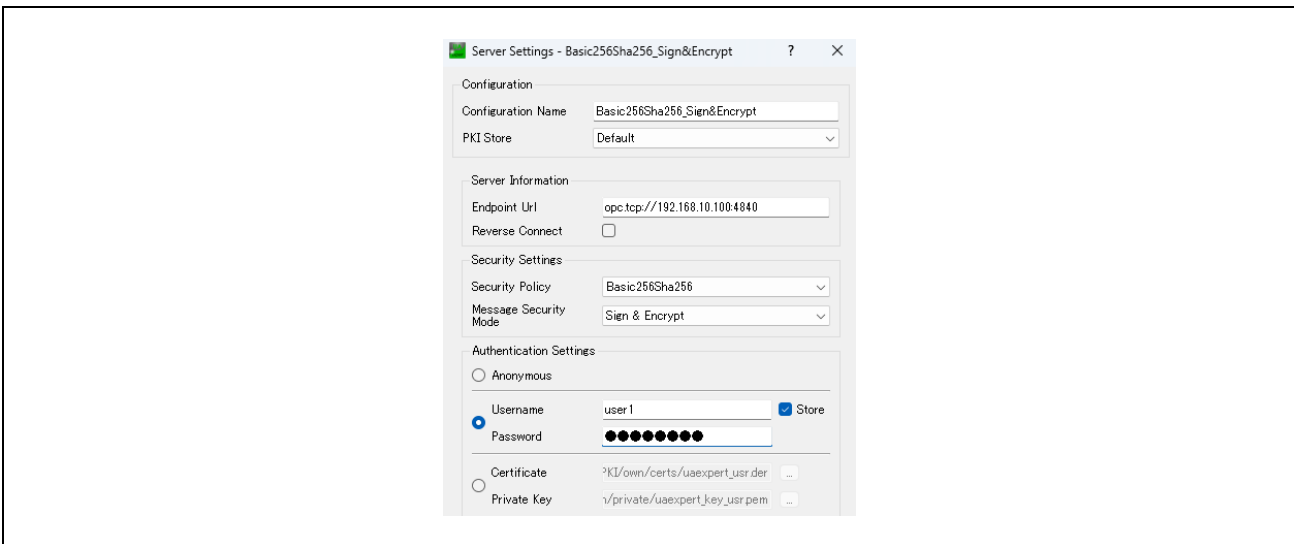


Figure 7.14. UaExpert Add server

When connecting for the first time, the window shown in Figure 7.15 will appear. Click “Trust Server Certificate” and “Continue”.

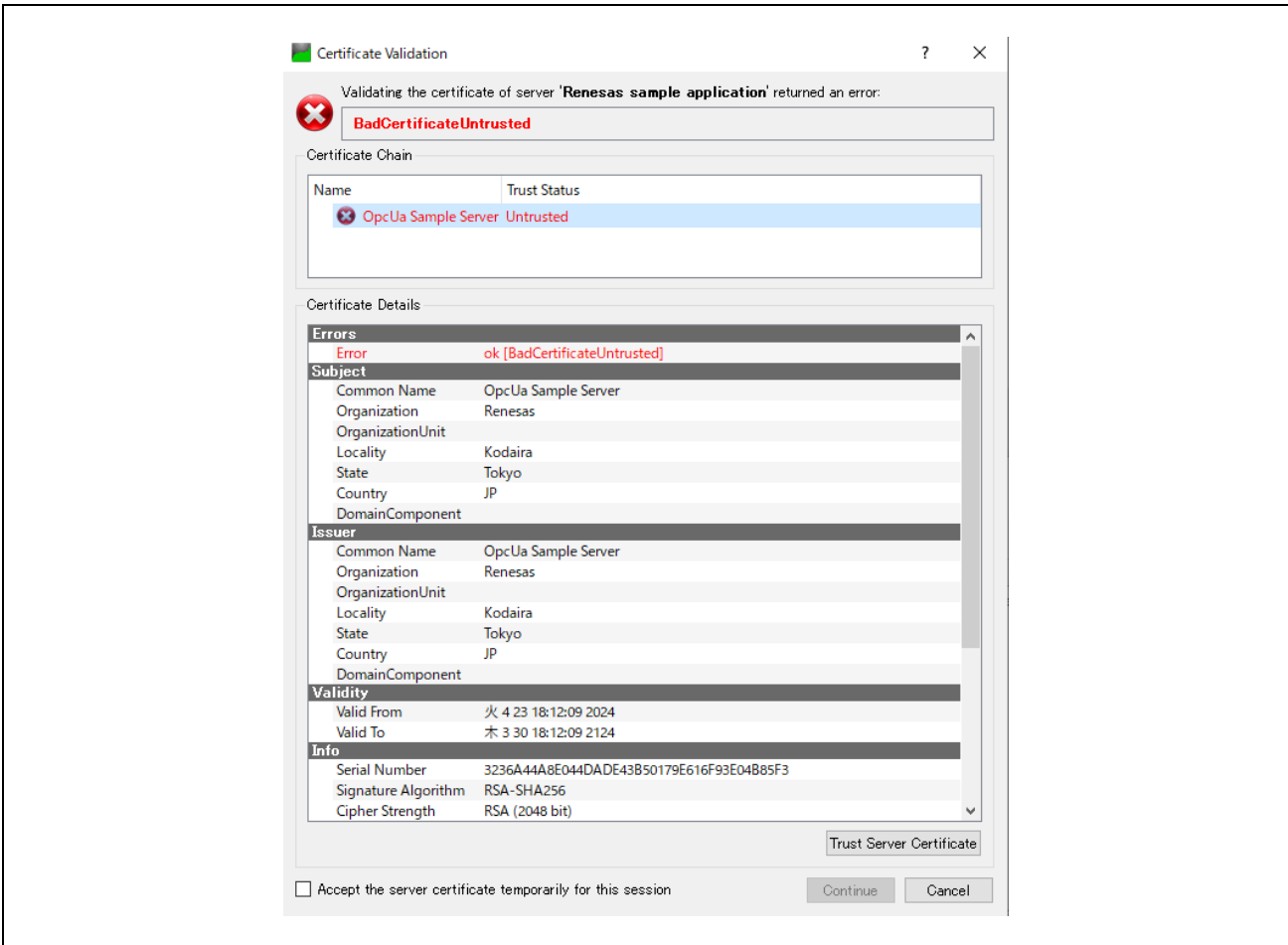


Figure 7.15. Certificate Validation

If a timeout occurs during Connect, go to "Settings" > "Configure UaExpert..." and increase the value of "General.ConnectTimeout"

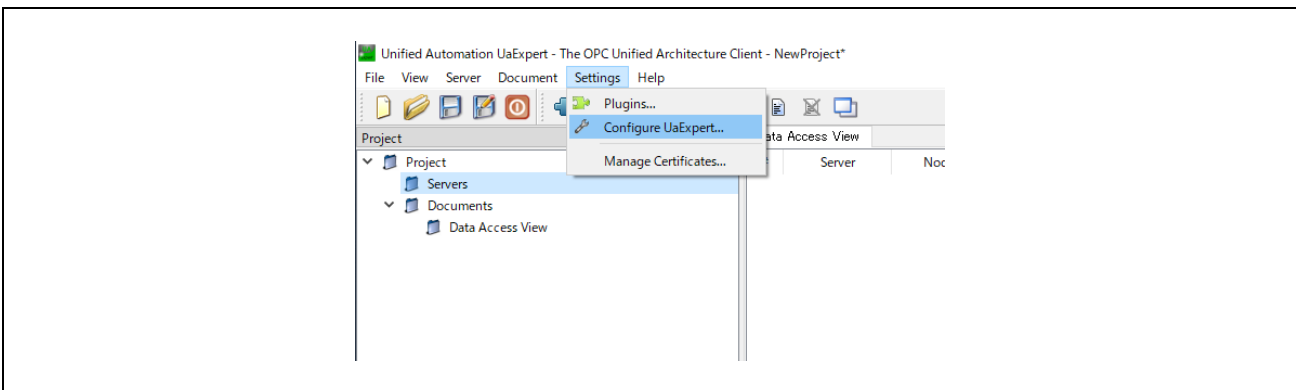


Figure 7.16. Configure UaExpert

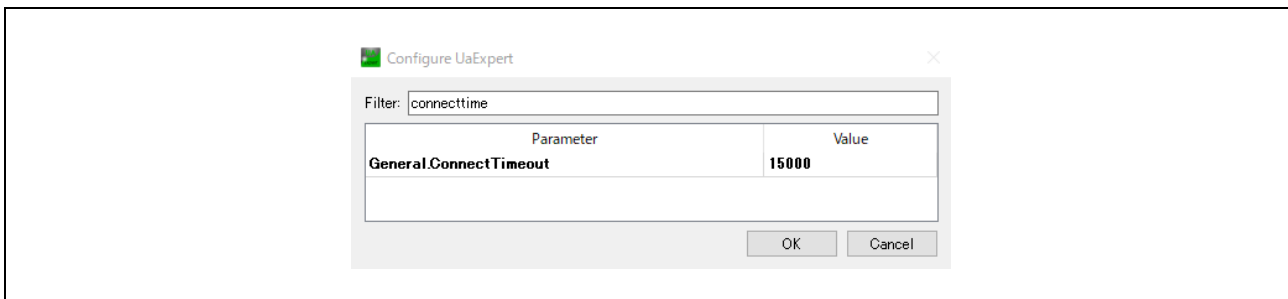


Figure 7.17. UaExpert ConnectTimeout Setting

Operation check after connection is the same as “chapter 7.2.1.1 Without security function”.

7.2.2 Publisher

This is the operation check for the given configuration.

Layout: Dynamic Layout

Security Policy: PubSub-Aes128-CTR

The role of each device when checking OPC UA Publisher operation is shown in Figure 7.18.

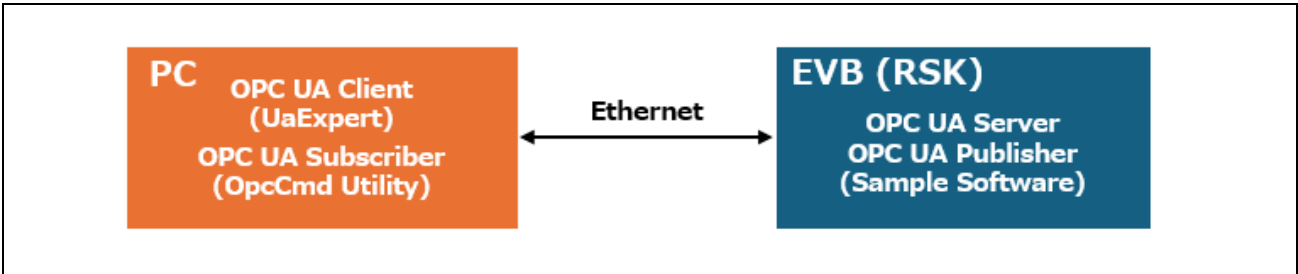


Figure 7.18. Connection Block Diagram for OPC UA Publisher

After powering on the evaluation board, launch Command prompt and change directory to the OpcCmd Utility folder. Enter the following command. This command is used to subscribe to messages encrypted with AES128 and published to “opc.udp://239.0.0.1” and decrypt it using the specified key. The key specified by “key” in this command represents the SigningKey in the upper 32 bytes, the EncryptingKey in the next 16 bytes, and the KeyNonce in the next 4 bytes.

```
OpcCmd uaSubscriber subscribeDataSet opc.udp://239.0.0.1:4840 --SecurityKeyServiceUri
static:?key=000102030405060708090A0B0C0D0E0F101112131415161718191A1B1C1D1E1F202122232425262728292A2B2C2
D2E2F30313233 --SecurityGroupId TestGroup --SecurityMode SecuritySignAndEncrypt -cni "(Network interface name)"
```

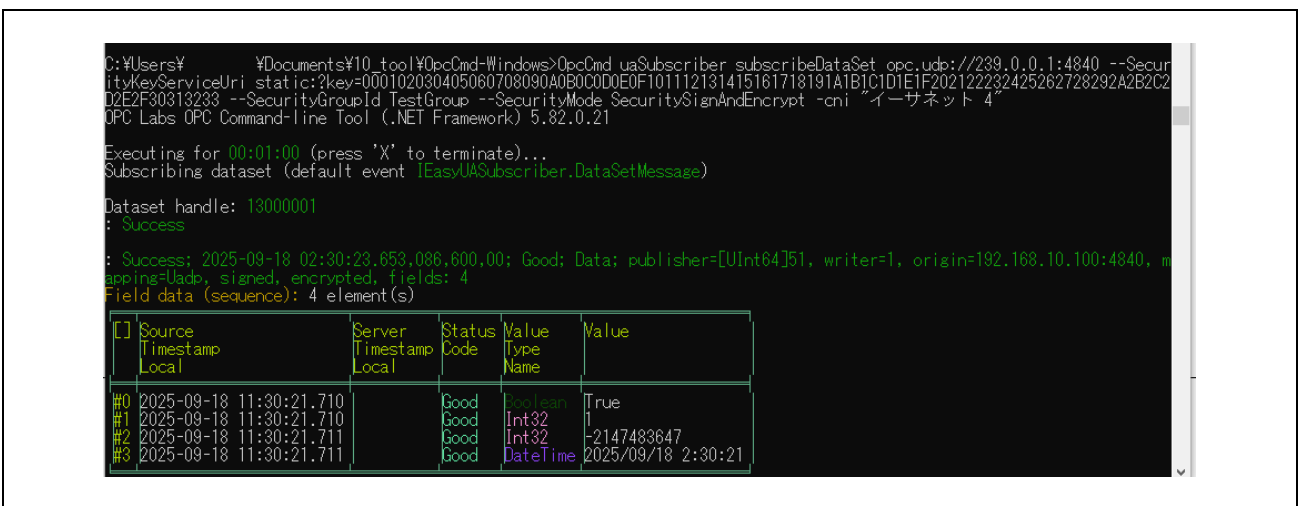


Figure 7.19. Command Execution Result

7.2.3 Subscriber

This is the operation check for the given configuration.

Layout: Dynamic Layout

Security Policy: PubSub-Aes128-CTR

The role of each device when checking OPC UA Subscriber operation is shown in Figure 7.20.

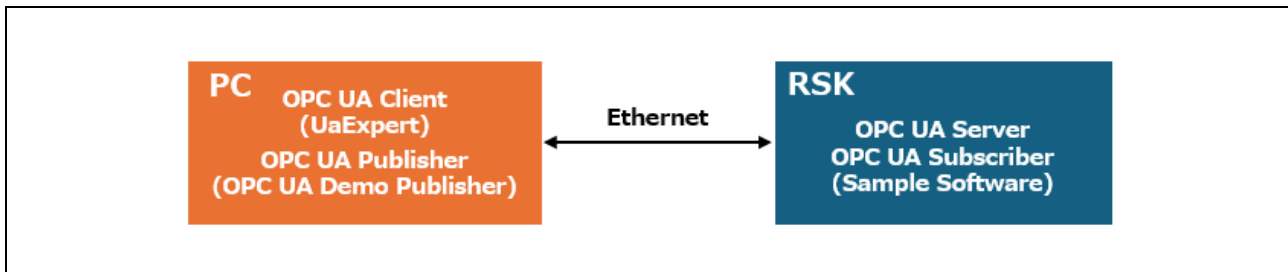


Figure 7.20. Connection Block Diagram for OPC UA Subscriber

After powering on the evaluation board, launch Command prompt and change directory to the UADemoPublisher folder. Enter the following command. This command is used to publish messages encrypted with AES128 using the specified key to “opc.udp://239.0.0.1”. The key specified by “key” in this command represents the SigningKey in the upper 32 bytes, the EncryptingKey in the next 16 bytes, and the KeyNonce in the next 4 bytes.

```
UADemoPublisher publish -cru opc.udp://239.0.0.1 -ewg DynamicLayoutGroup -edsw SimpleWriter --
SecurityKeyServiceUri
static:?key=000102030405060708090A0B0C0D0E0F101112131415161718191A1B1C1D1E1F20212223
2425262728292A2B2C2D2E2F30313233 --SecurityGroupId TestGroup --SecurityMode SignAndEncrypt -
cni "(Network interface name)"
```

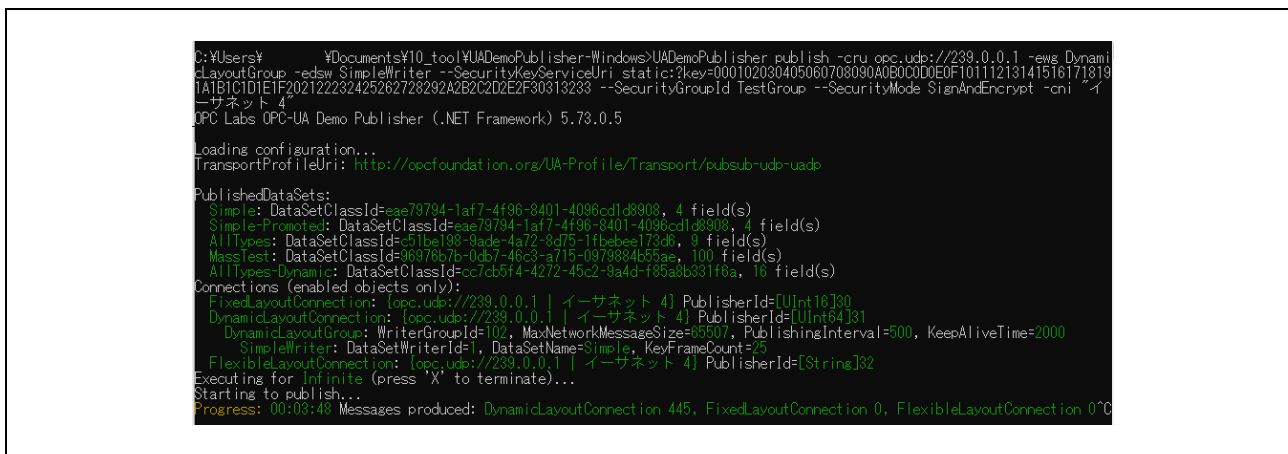


Figure 7.21. Command Execution Result

After that, use UaExpert to verify that the “Subscribed_Variables_Simple” node exists.

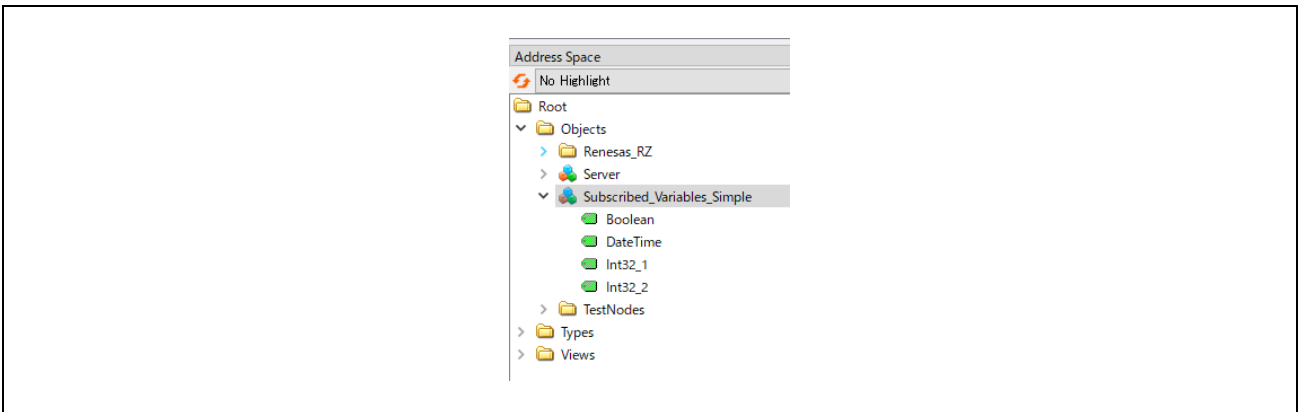


Figure 7.22. “Subscribed_Variables_Simple” Node

Checking these Nodes in the Data Access View, we can confirm that the values are updated periodically and that they are successfully subscribed.

Data Access View					
#	Server	Node Id	Display Name	Value	
1	SecurityNone@...	NS1 Numeric 50000	Boolean	true	Bo
2	SecurityNone@...	NS1 Numeric 50003	DateTime	2025-09-18T02:31:34.606Z	Da
3	SecurityNone@...	NS1 Numeric 50001	Int32_1	13	Int:
4	SecurityNone@...	NS1 Numeric 50002	Int32_2	2787	Int:

Figure 7.23. Check the Node Values

8. Software Specifications

8.1 Software Structure

8.1.1 Overview of Software Components

Figure 8.1 shows the architecture diagram of this sample software. This sample software uses FreeRTOS as its operating system.

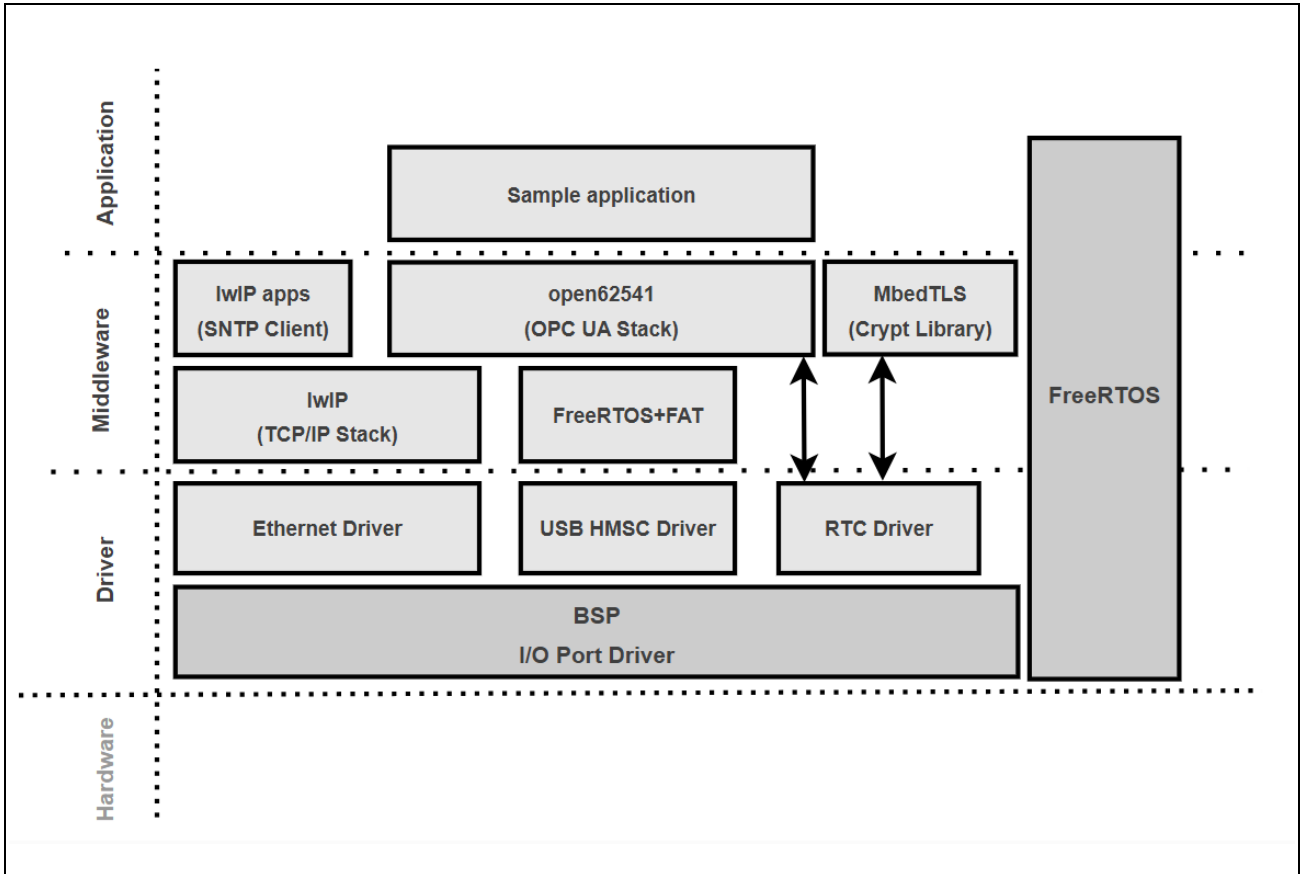


Figure 8.1. Software Architecture Diagram

8.1.2 Overview of Each Component

8.1.2.1 Driver

The drivers used in this software are generated by FSP. The FSP Stacks being used are shown in Table 8.1. Please check the Smart Configurator for the detailed settings of each.

Table 8.1. FSP Stacks

Stack name	Purpose
g_ioport I/O Port Driver	Pin Settings, Control
g_ether0 Ethernet	Ethernet communication
g_uart0 UART	Serial communication for debug
FreeRTOS Heap 4	Allocating heap for FreeRTOS
g_rtc0 Realtime Clock	Realtime clock
FreeRTOS+FAT (USB Driver)	USB communication and Filesystem

8.1.2.2 lwIP (TCP/IP Stack)

This sample software uses lwIP as TCP/IP stack. The base version used incorporates changes up to commit revision "79cd89f99d1032cc5375569e5b24c375b9d230fa" in STABLE-2_1_0. Table 8.2 shows the options changed from the default settings.

Table 8.2. lwIP settings

Option name	Option value	Description
LWIP_NETIF_API	1	Support netif api
LWIP_POSIX_SOCKETS_IO_NAMES	0	Disable POSIX-style sockets functions names
LWIP_IGMP	1	Turn on IGMP module
LWIP_MULTICAST_TX_OPTIONS	1	Enable multicast TX support
LWIP_TCP_KEEPALIVE	1	Enable TCP KeepAlive
TCP_KEEPIDLE_DEFAULT	30000	Set default KeepAlive timer 30 sec.
TCP_KEEPINTVL_DEFAULT	5000	Set default KeepAlive interval 5 sec.
TCP_KEEPCNT_DEFAULT	3	Set default counter for KeepAlive probes 3 times

8.1.2.3 Mbed TLS (Crypt Library)

This sample software uses Mbed TLS as cryptographic library. The base version used is v3.6.4. For more information, please see [Releases · Mbed-TLS/mbedtls](#).

8.1.2.4 open62541 (OPC UA Stack)

This sample software uses the open source open62541 as the protocol stack for the OPC UA Server. For more information on open62541, refer to the following Link.

[open62541](#)

- Version

The base version of open62541 in this sample software is the following.

Base Version : v1.3.15

(Commit 3eed1a6d5c5b207c531b2d35ed88aa0a4a4541e5)

- License

The license terms for the open62541 are MPL v2.0.

Please refer to <https://www.mozilla.org/en-US/MPL/2.0/> for more information and comply with the license terms and conditions.

- open62541 files

To run open62541 in the environment of FreeRTOS + lwIP, the method to generate open62541.c and open62541.h files using CMake as described in the following link is applied. For more information, please refer to chapter 9.1 in the Appendix.

[Building open62541 — open62541 1.3.0-dirty documentation](#)

- Information models

To achieve interoperability among vendors and industries, OPC UA provides a unified data model called the “Information Model” in xml file format. It includes built-in models commonly used in OPC UA, companion models used by each industry or organization, and vendor-specific models that can be customized by each vendor. (Figure 8.2)

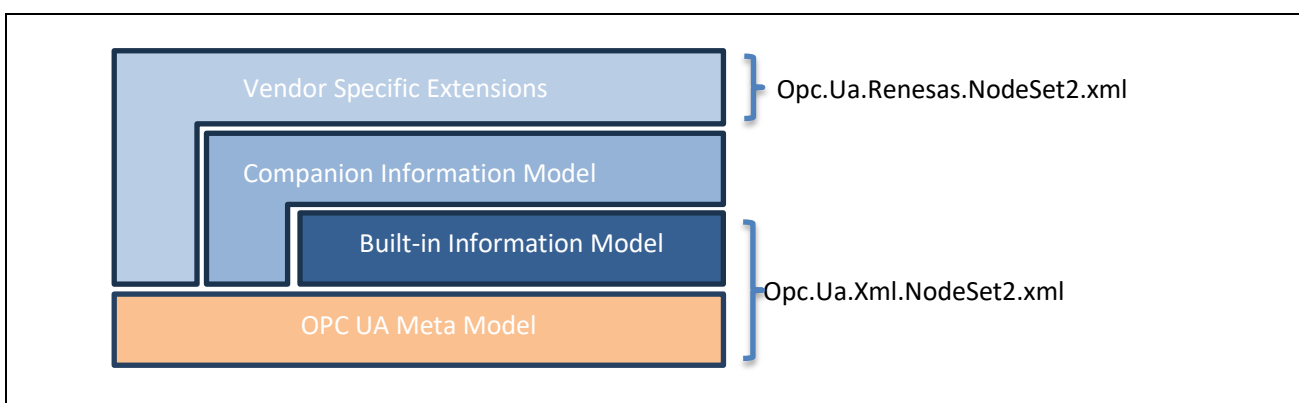


Figure 8.2. Information Model

- Opc.Ua.Xml.NodeSet2.xml

It provides the "Meta Model", which is a set of rules for describing the OPC UA information model, and the "Built-in Information Model", which is the basic information model of OPC UA described by the Meta Model.

Opc.Ua.Xml.NodeSet2.xml ([UA-Nodeset/XML/Opc.Ua.Xml.NodeSet2.xml at d1bb6a22125bd7cd986272b1ee98a18a91d76fff · OPCFoundation/UA-Nodeset · GitHub](https://github.com/OPCFoundation/UA-Nodeset))

- Opc.Ua.Renasas.NodeSet2.xml

This is the information model made for this sample software. The OPC UA modeler "SiOME" is used for creation. For details, please refer to the following link.

[Siemens OPC UA Modeling Editor \(SiOME\) - ID: 109755133 - Industry Support Siemens](#)

Renasas information model is structured as shown in Figure 8.3. Each Nodes are written and read as described in section 8.1.2.5.

Folder	Node	Type	NodeId	Data Type	array	AccessLevel	Meaning
Renasas_RZ		FolderType	ns=1, i=5001	-	-	-	-
	LED	FolderType	ns=1, i=5002	-	-	-	-
	OperationMode	BaseDataVariableType	ns=1, i=6013	UInt16	N	Read	0:Segmented (Used as stack of individual lights) 1:Levelmeter (Used as level meter) 2:Running_Light (The whole stack acts as a running light) 3:Other 4-:NotUsed
	LevelDisplayMode	BaseDataVariableType	ns=1, i=6014	UInt16	N	Read	0:Dimmed (Uses dimming to display fractions.) 1:Blinking (Uses blinking to display fractions.) 2:Other 3-:NotUsed
	SignalColor	BaseDataVariableType	ns=1, i=6008	UInt16	N	Read	0:Off 1:Red 2:Green 3:Blue 4:Yellow 5:Purple 6:Cyan 7:White 8-:NotUsed
	SignalModeLight	BaseDataVariableType	ns=1, i=6009	UInt16	N	Read	0:Continuous 1:Blinking 2:Flashing 3-:NotUsed
	Sensor	FolderType	ns=1, i=5003	-	-	-	-
	RawValue	BaseDataVariableType	ns=1, i=6010	Double	N	Read	-
	State	BaseDataVariableType	ns=1, i=6011	UInt16	N	Read	0:Before Operation 1:Operating in "Good" quality 2:Operating in "Bad" quality 3:Suspended Operation 4-:NotUsed
	OperationEnable	BaseDataVariableType	ns=1, i=6012	Boolean	N	Read&Write	0:Disable 1:Enable
	System	FolderType	ns=1, i=5004	-	-	-	-
	SystemReset	BaseDataVariableType	ns=1, i=6015	Boolean	N	Read&Write	0:Normal operation 1:Execute System Reset

Figure 8.3. Renasas Information Model

8.1.2.5 Sample Application

This project operates as a mock sensor and periodically writes to and reads from the OPC UA Nodes. The output value of the mock sensor is controlled according to its state, and the lighting status of the LEDs on the evaluation board also changes.

After the evaluation board is booted and time is synchronized by NTP, it transitions from State0 to State1, and the mock sensor processing begins. The acquired value of the mock sensor changes sinusoidally in State1, and in State2, the value is a sine wave with random noise and is written to the “RawValue” Node. The state transition between State1 and State2 is made by pressing the switch on the evaluation board.

When “0: Disable” is written to the “OperationEnable” Node from the OPC UA Client, it moves to State3 and the processing of the mock sensor stops. Writing “1: Enable” again returns to the previous state and restarts the processing of the mock sensor.

The LED lighting status for each state is shown below, and the respective values are written to the “SignalColor” Node and “SignalModeLight” Node.

- State0 : Red LED Lighting、 State1 : Green LED Lighting
- State2 : Green LED Blinking、 State3 : Red LED Blinking

These state transitions are shown in Figure 8.4.

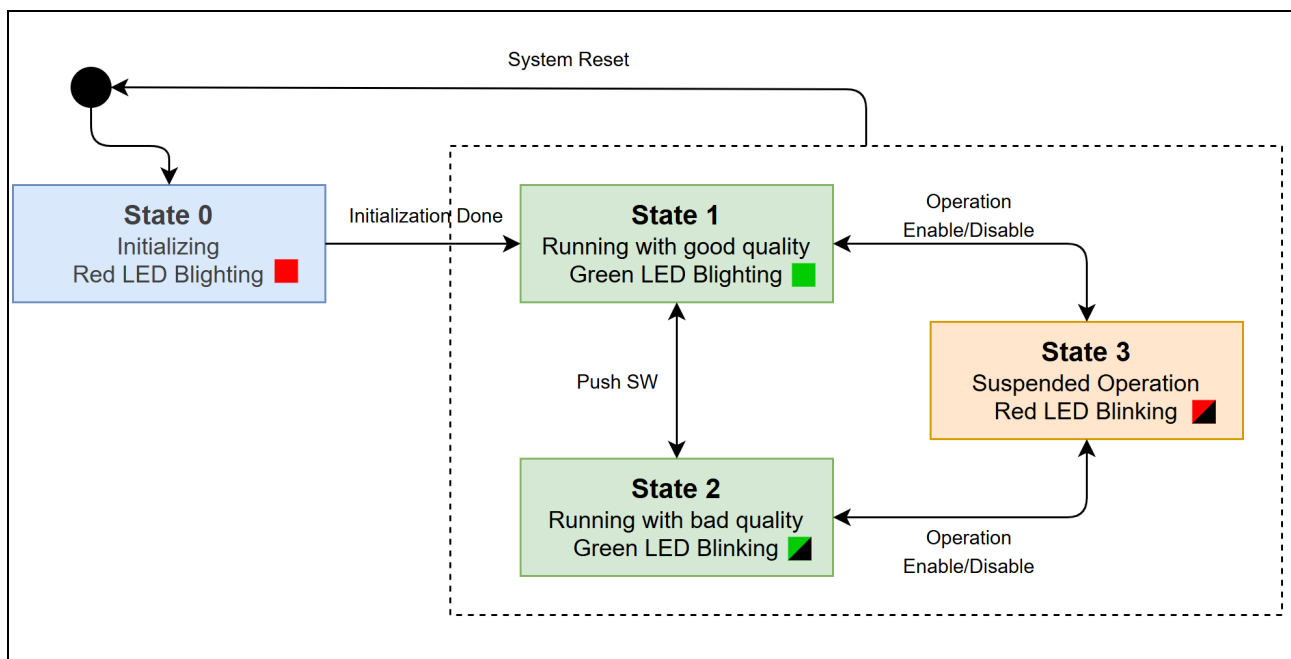


Figure 8.4. State Transition

In addition, when “1:Execute SystemReset” is written to the “SystemReset” node, the “Status” node (i=2259) changes to 4:Shutdown, and a 15-second countdown begins at the “SecondsTillShutdown” node (i=2992). After that, when the value reaches 0, a system reset is performed.

The above switch and LEDs are shown in Table 8.3.

Table 8.3. Hardware Information

	Switch	Red LED	Green LED
RZ/T2M, N2L	SW1	LED2	LED0
RZ/T2H	SW11	LED5	LED0
RZ/N2H	SW3	LED4	LED3

8.2 Task Structure

This chapter explains the RTOS tasks in the sample software.

8.2.1 Task List

Table 8.4 lists the tasks used in this sample software.

Table 8.4. Task List

Task name	Priority	Trigger Type	Description
Main Thread	2	Startup	Initialize modules and create tasks.
Ethernet Monitor Task	3	Periodic (1sec.)	Monitor the port link status.
Ethernet Reader Task	5	Event (Receive packet)	Notify lwIP of received packets.
Ethernet Writer Task	5	Event (Packet Sending Req)	Transmit the packet upon receiving a transmission request.
OPC_TASK	5	Periodic (Dynamic control)	Initialize and run open62541.
SAMPLE_APP_TASK	2	Periodic (10msec.)	Run sample application.
lwIP	6	Event (Receive message)	Packet transmission task for lwIP.
lwIP Port Launcher Task	3	Event (Receive LinkStatus)	lwIP Link Status Management.
lwIP Port Receiver Task	5	Event (Receive message)	Packet reception task for lwIP. Notify the application of received packets.
LLDP_timer_1, 2	2	Periodic (1sec.)	Manage the LLDP agent and periodically send LLDP packets.
LLDP_receive_1, 2	2	Event (Receive packet)	Perform reception processing of LLDP frames
LLDP_get_mib_1, 2	2	Event (Read Req)	Get LLDP-MIB information
LLDP_set_mib_1, 2	2	Event (Write Req)	Set LLDP-MIB information

Table 8.5. RTOS Max Priority

Item	Value
Max Priority	10

8.2.2 Task Operation

This chapter explains the processing of each task.

8.2.2.1 Startup

Figure 8.5 shows the sequence diagram for the startup process. The “Main Thread” task is the first task created during startup, primarily responsible for module initialization and creating other tasks.

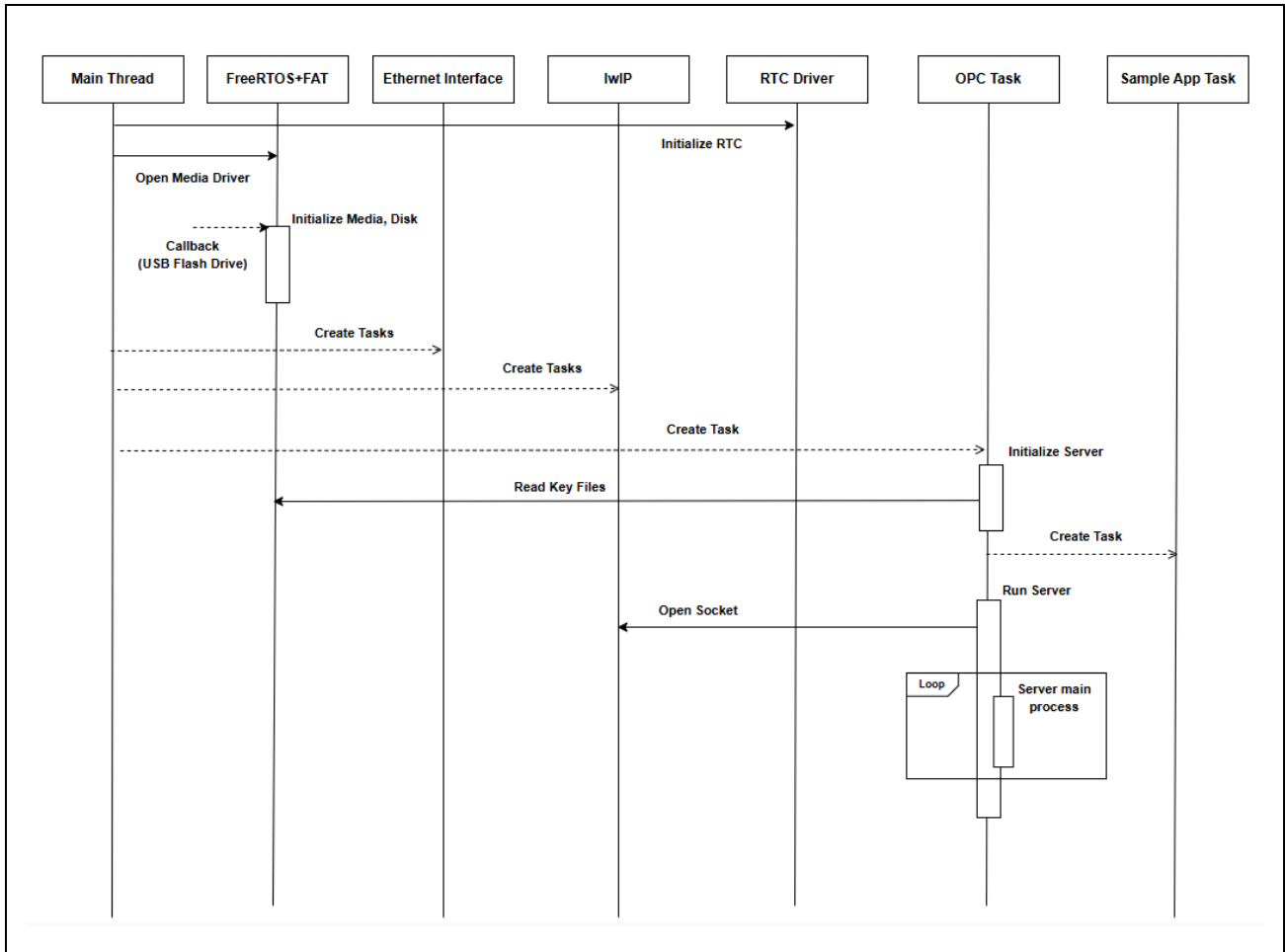


Figure 8.5. Startup

8.2.2.2 OPC UA communication

Figure 8.6 shows the sequence diagram of OPC UA transmission and reception processing. OPC UA data transmitted and received via lwIP is encrypted and decrypted using Mbed TLS.

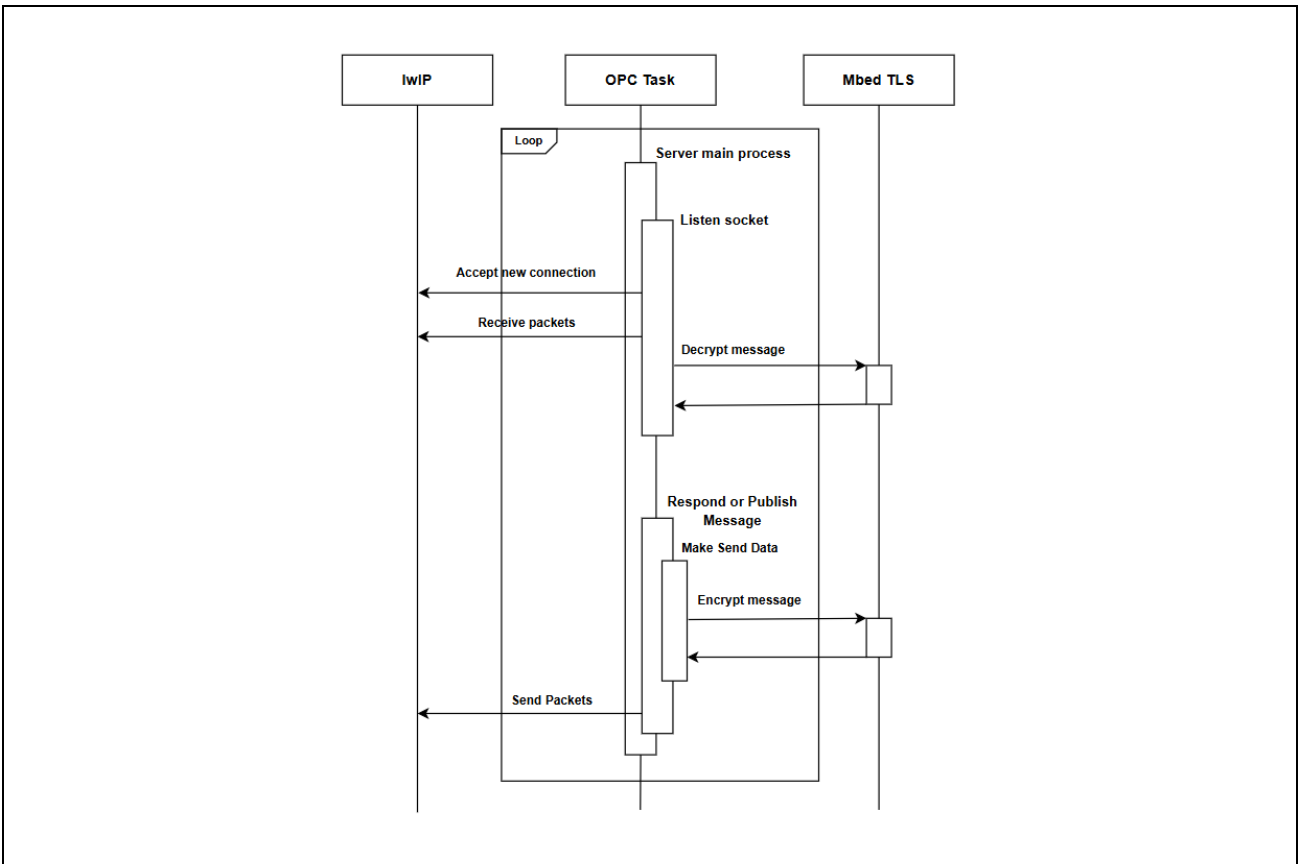


Figure 8.6. OPC UA communication

8.2.2.3 Sample application

Figure 8.7 shows the sequence diagram for the sample application. The sample application controls node values and LED outputs according to the specifications in chapter 8.1.2.5.

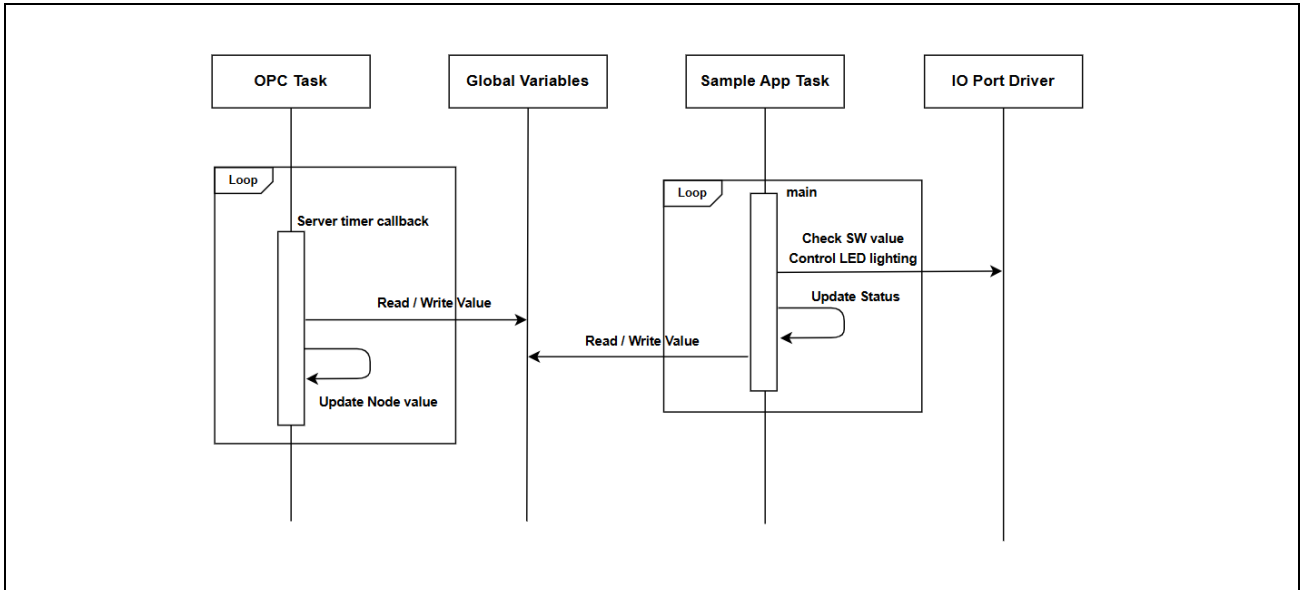


Figure 8.7. Sample application

8.2.2.4 Time synchronization

Figure 8.8 shows the sequence diagram for time synchronization processing. The time information received from the NTP server via SNTP communication is managed by the RTC, a function of the RZ device, and is used by various functions.

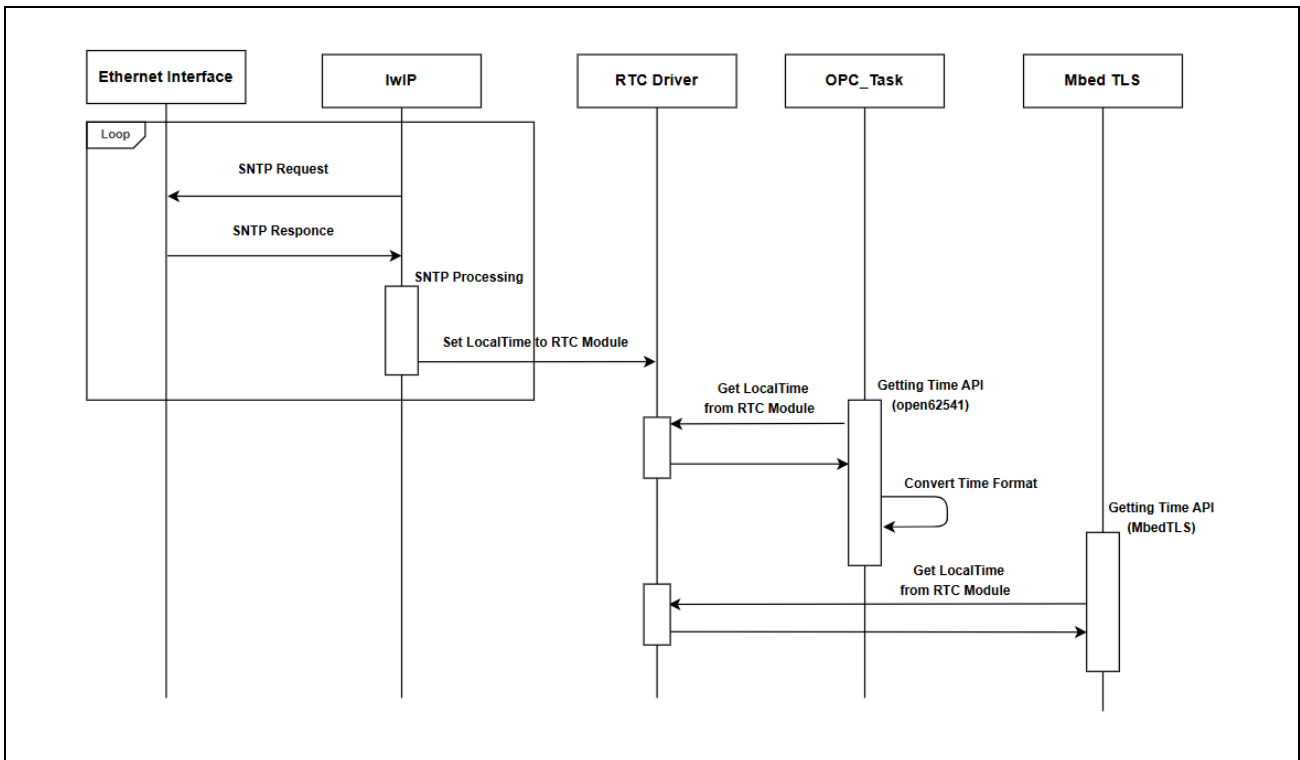


Figure 8.8. Time synchronization

8.3 Footprint (ROM and RAM Usage)

This chapter describes the memory footprint in each project.

8.3.1 RZ/T2M project

8.3.1.1 e² studio

(1) Primary project

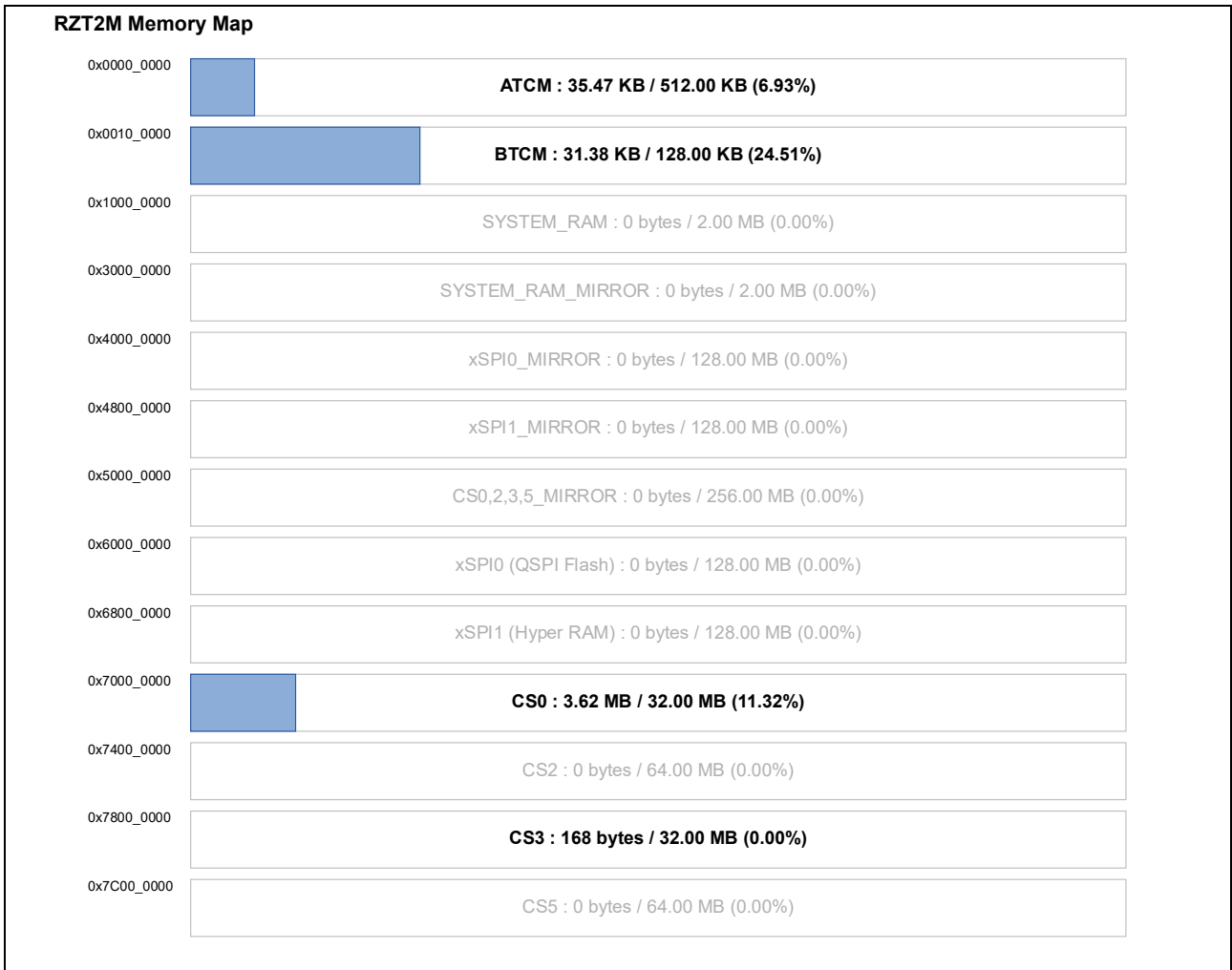


Figure 8.9. Memory footprint of the RZ/T2M Primary project (e² studio)

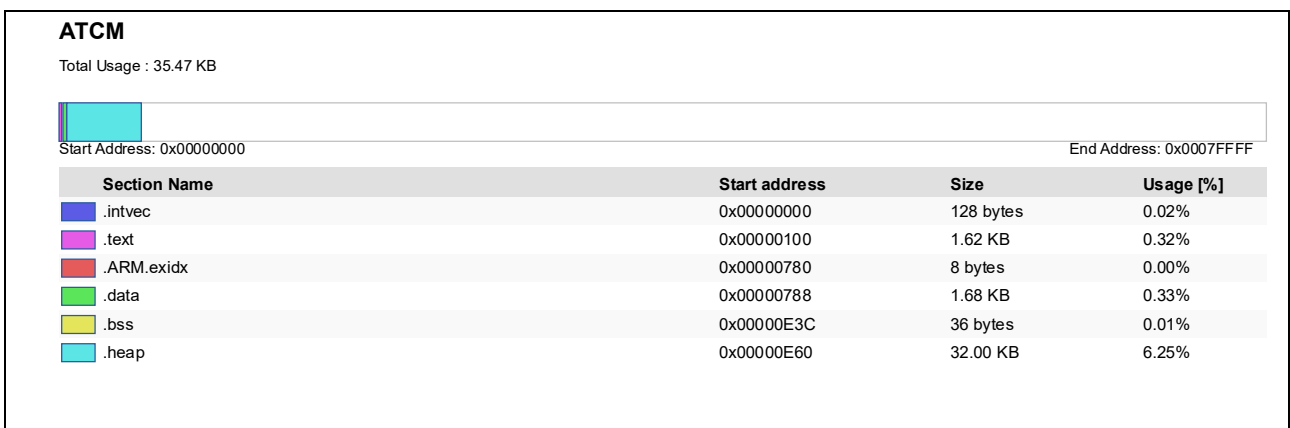


Figure 8.10. ATCM footprint of the RZ/T2M Primary project (e² studio)

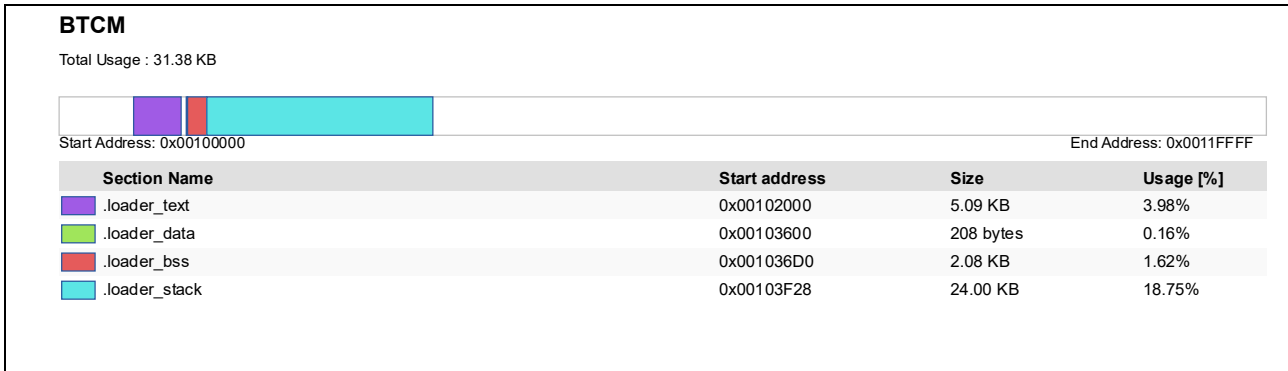


Figure 8.11. BTCM footprint of the RZ/T2M Primary project (e² studio)

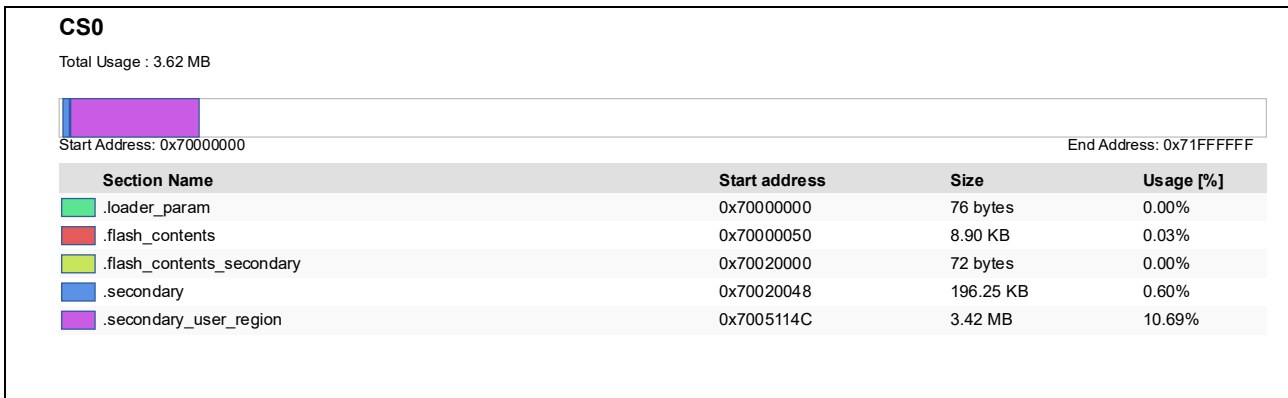


Figure 8.12. CS0 (NOR Flash) footprint of the RZ/T2M Primary project (e² studio)



Figure 8.13. CS3 (SDRAM) footprint of the RZ/T2M Primary project (e² studio)

(2) Secondary project

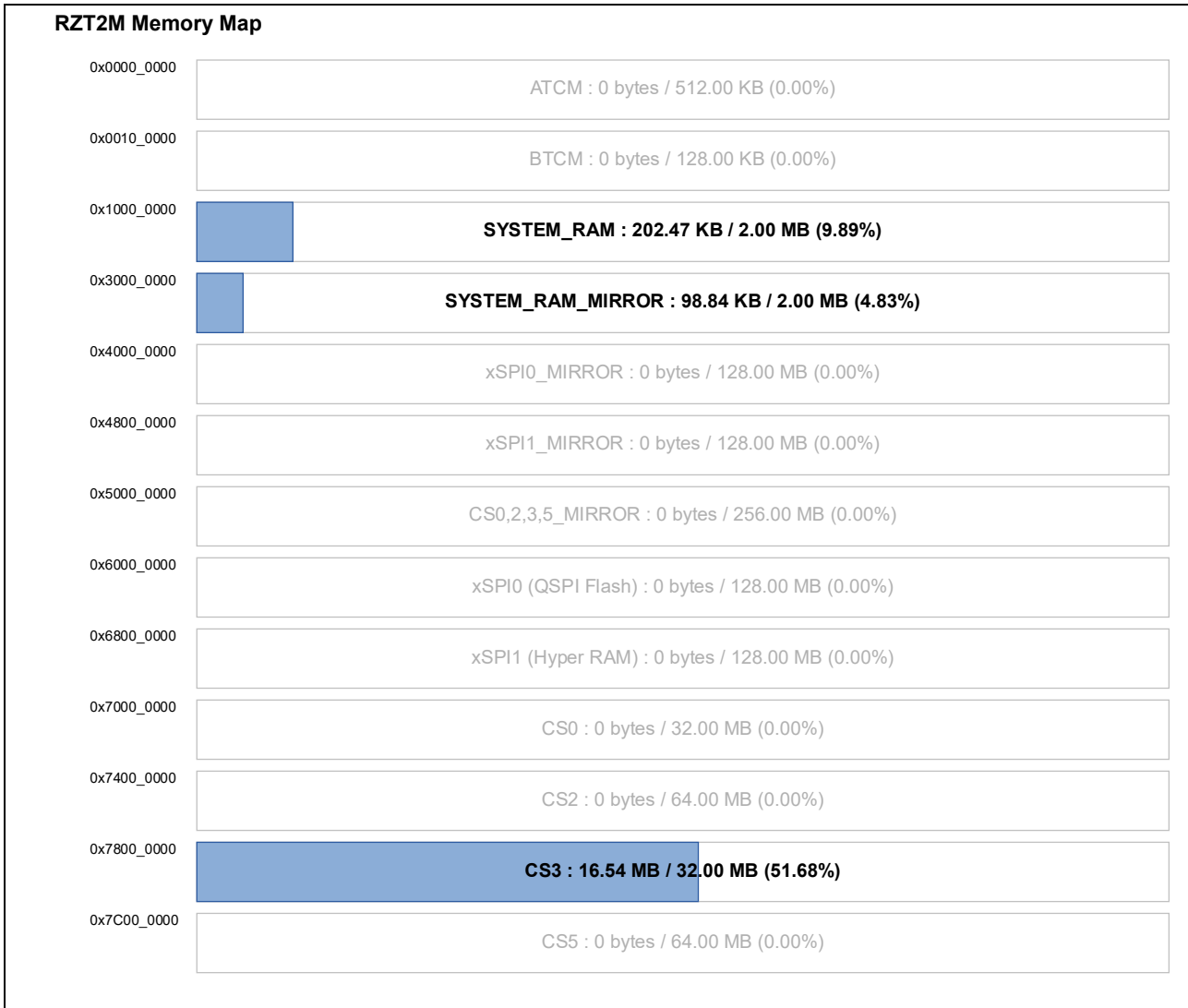


Figure 8.14. Memory footprint of the RZ/T2M Secondary project (e² studio)

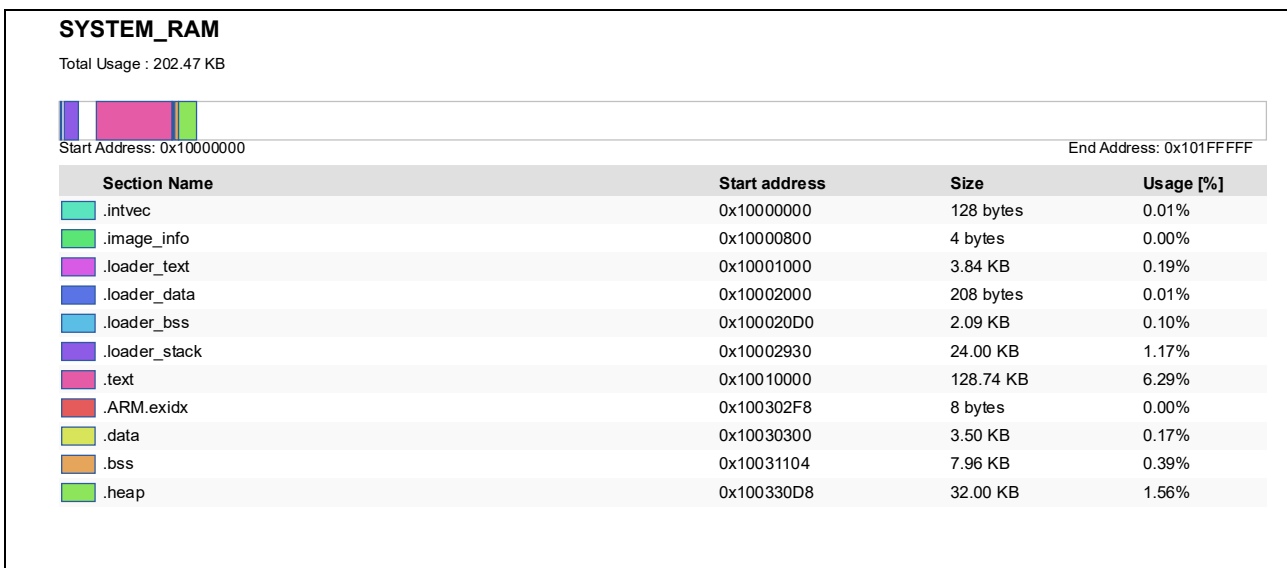


Figure 8.15. SYSTEM_RAM footprint of the RZ/T2M Secondary project (e² studio)



Figure 8.16. SYSTEM_RAM_MIRROR footprint of the RZ/T2M Secondary project (e² studio)

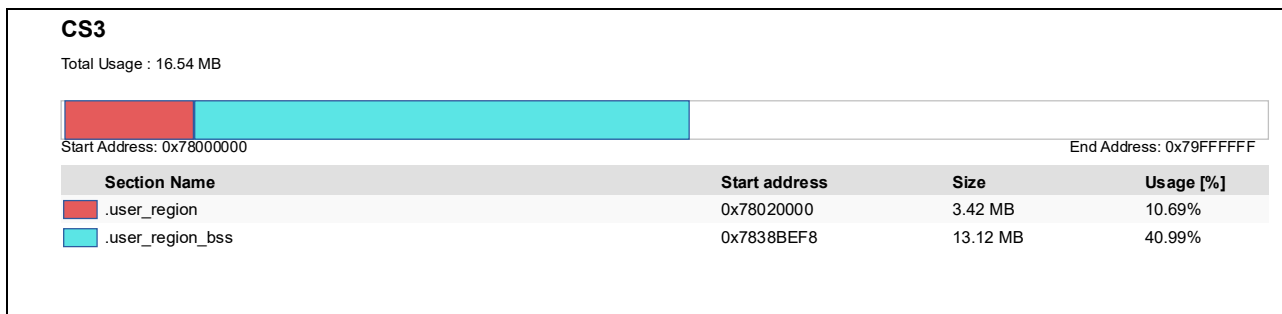


Figure 8.17. CS3 (SDRAM) footprint of the RZ/T2M Secondary project (e² studio)

8.3.1.2 EWARM

(1) Primary project

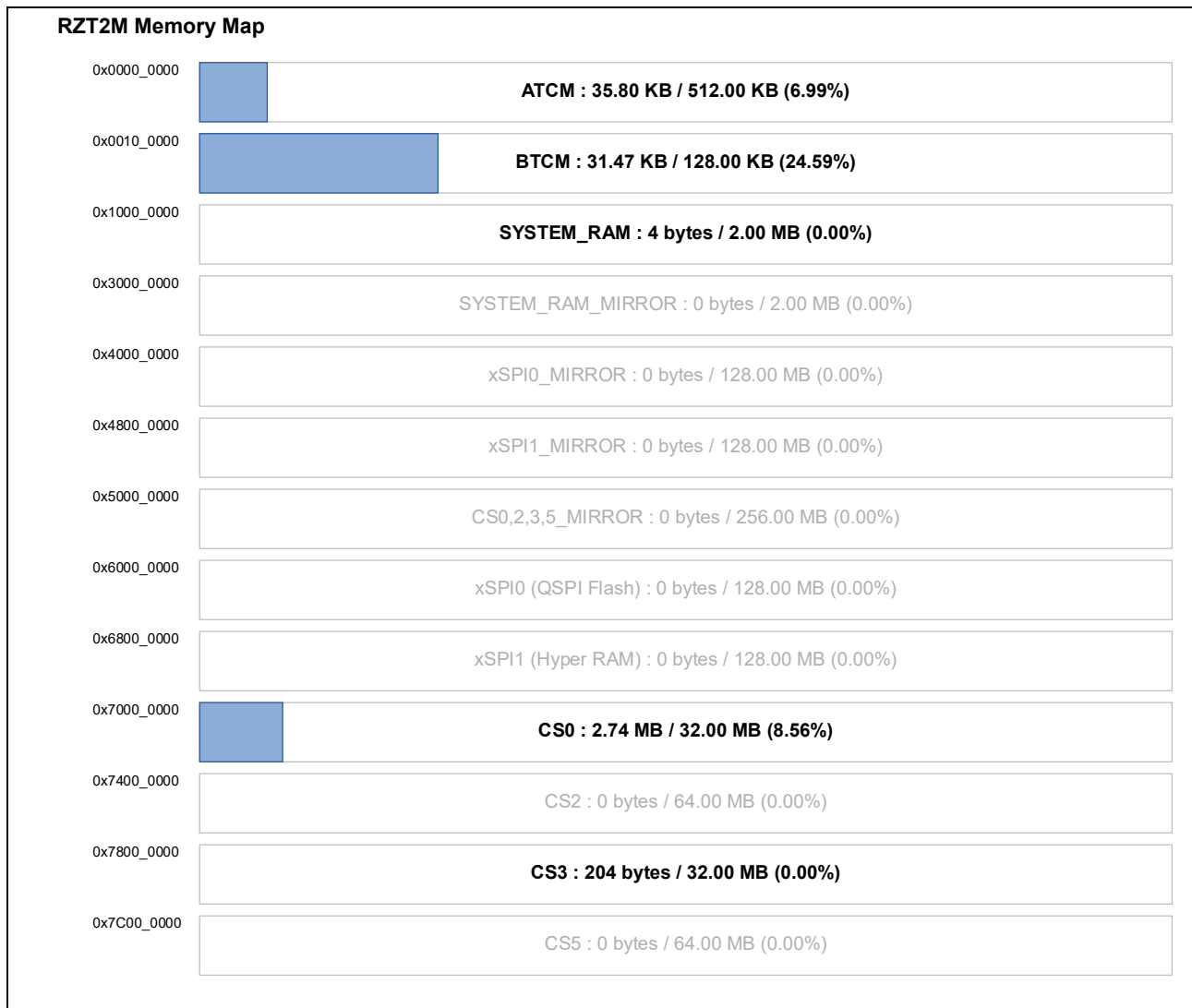


Figure 8.18. Memory footprint of the RZ/T2M Primary project (EWARM)

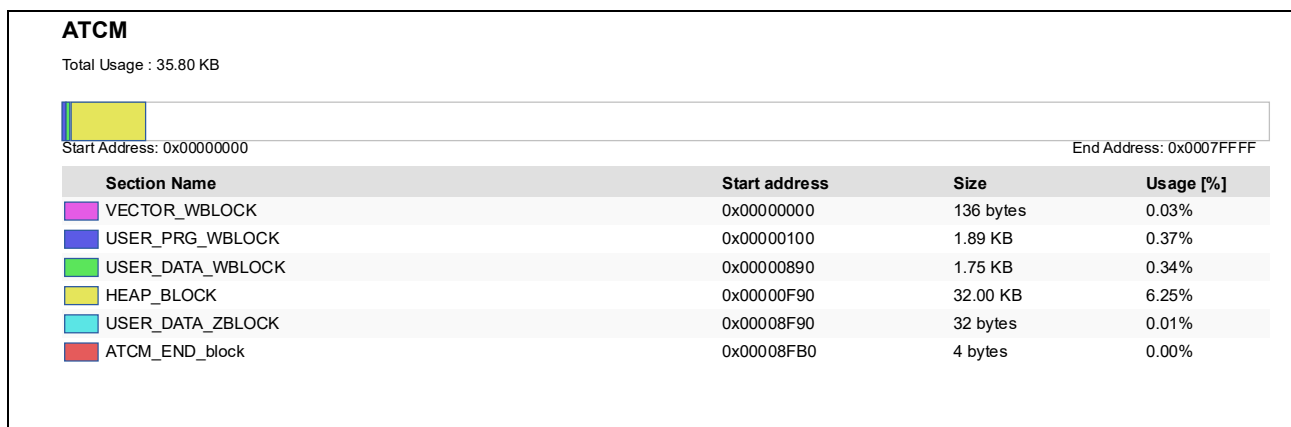


Figure 8.19. ATCM footprint of the RZ/T2M Primary project (EWARM)

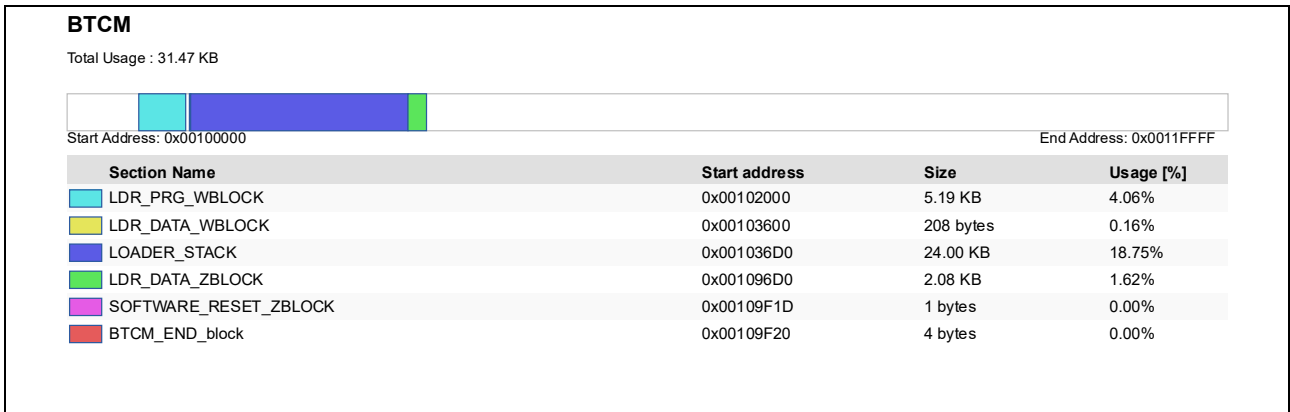


Figure 8.20. BTCM footprint of the RZ/T2M Primary project (EWARM)



Figure 8.21. SYSTEM_RAM footprint of the RZ/T2M Primary project (EWARM)

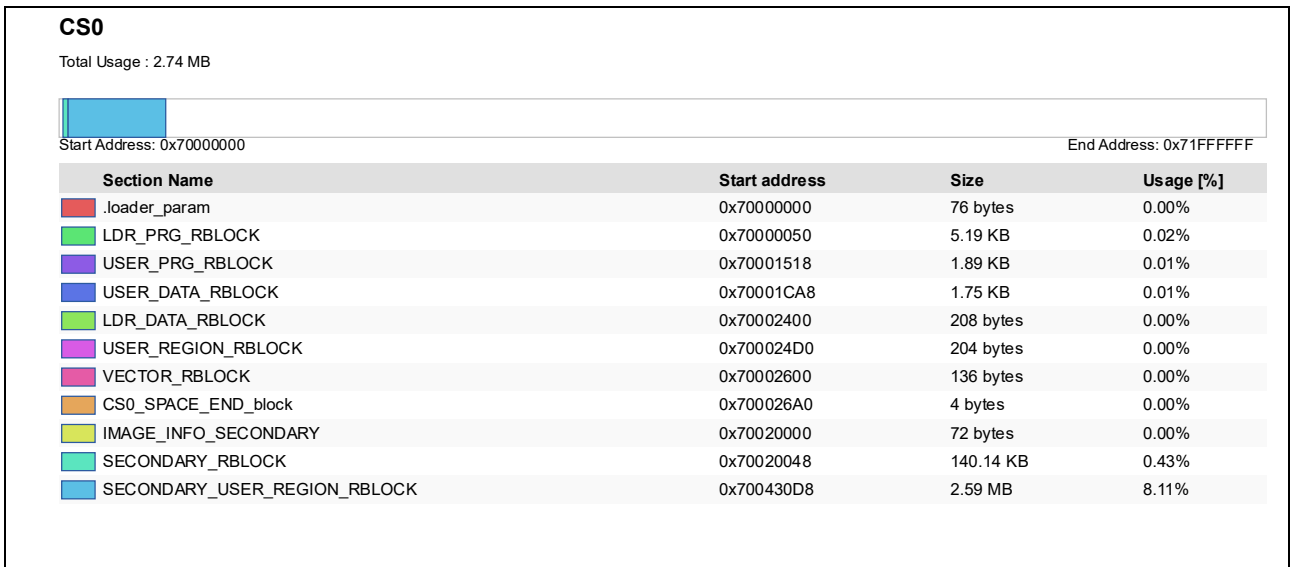


Figure 8.22. CS0 (NOR Flash) footprint of the RZ/T2M Primary project (EWARM)

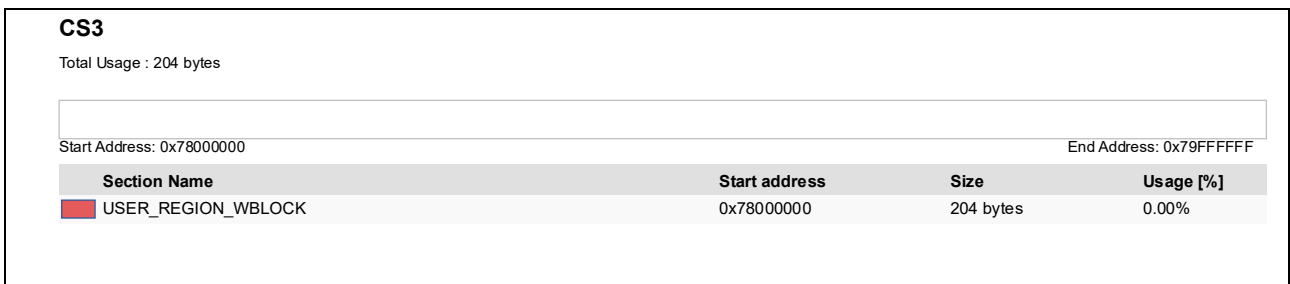


Figure 8.23. CS3 (SDRAM) footprint of the RZ/T2M Primary project (EWARM)

(2) Secondary project

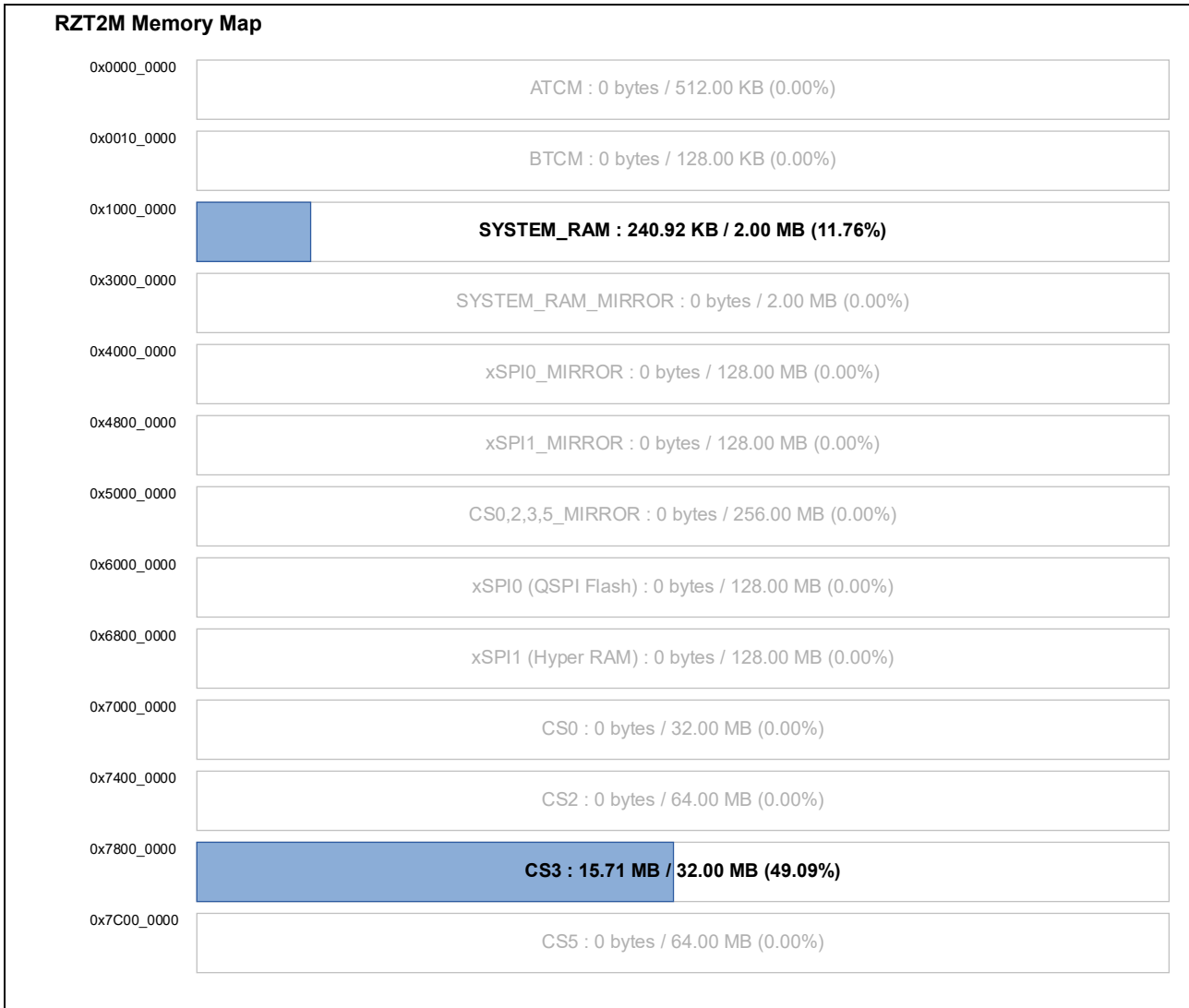


Figure 8.24. Memory footprint of the RZ/T2M Secondary project (EWARM)

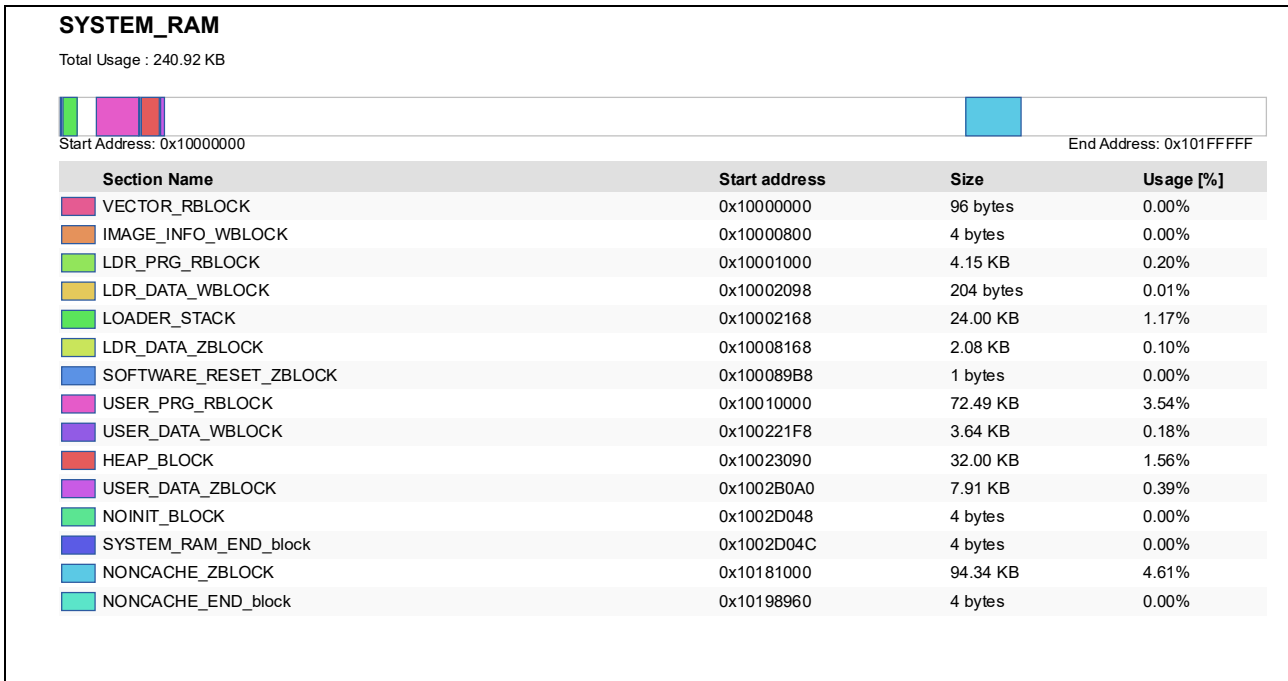


Figure 8.25. SYSTEM_RAM footprint of the RZ/T2M Secondary project (EWARM)

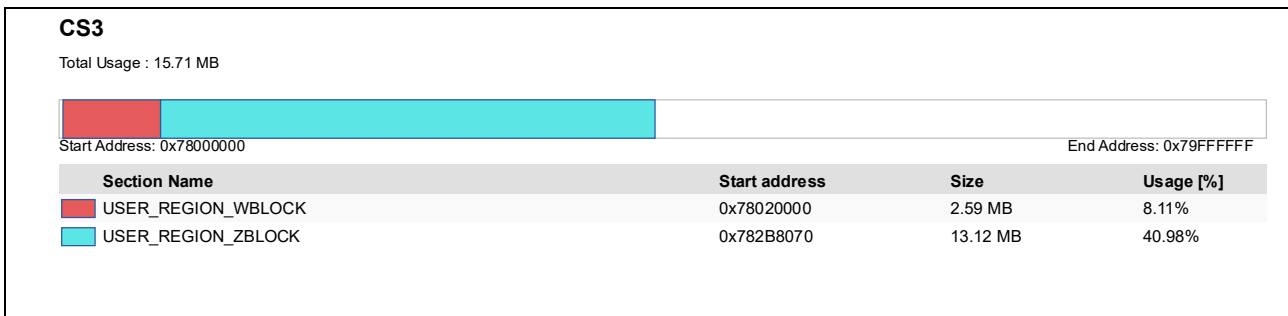


Figure 8.26. CS3 (SDRAM) footprint of the RZ/T2M Secondary project (EWARM)

8.3.2 RZ/N2L project

8.3.2.1 e² studio

(1) Primary project

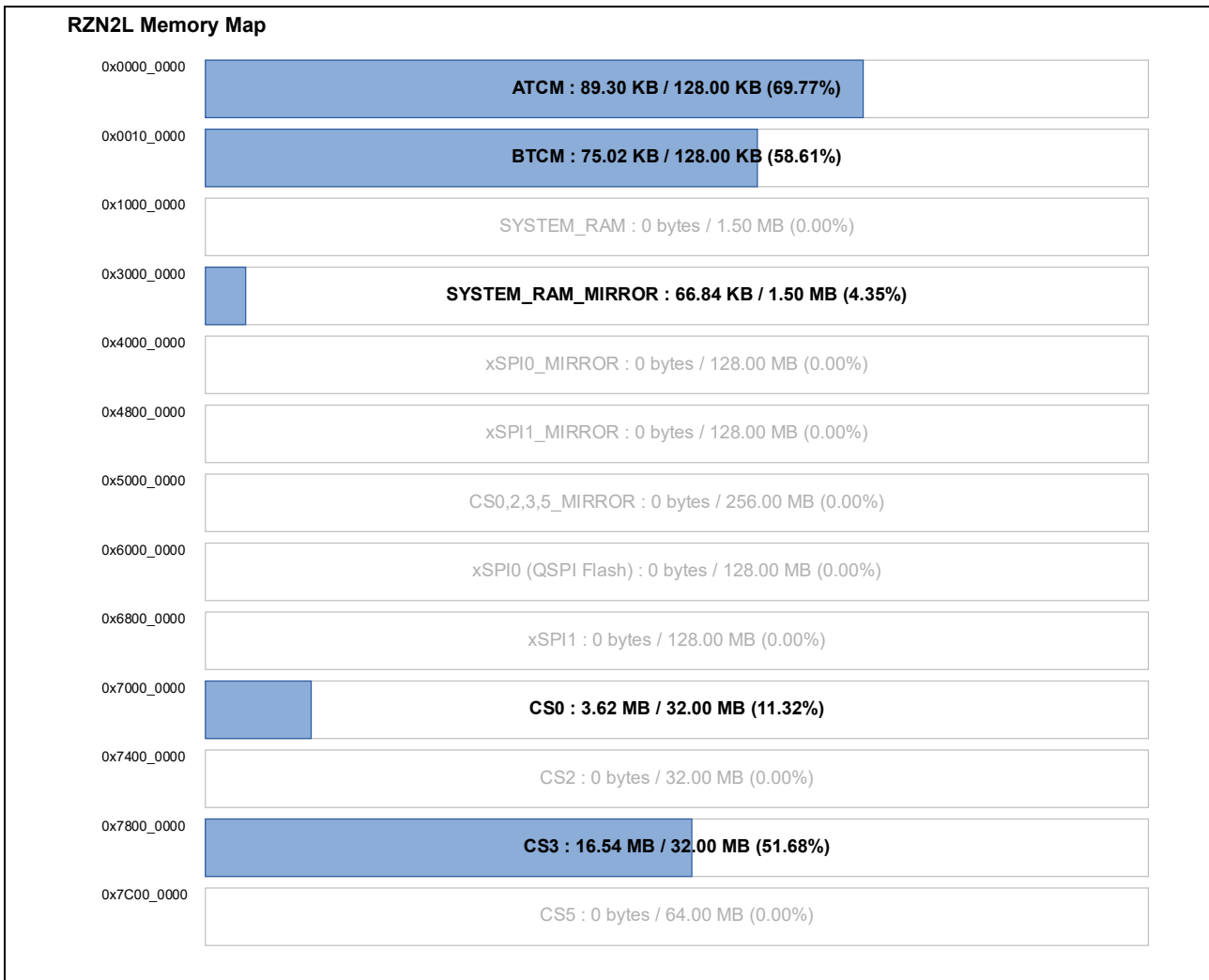


Figure 8.27. Memory footprint of the RZ/N2L Primary project (e² studio)

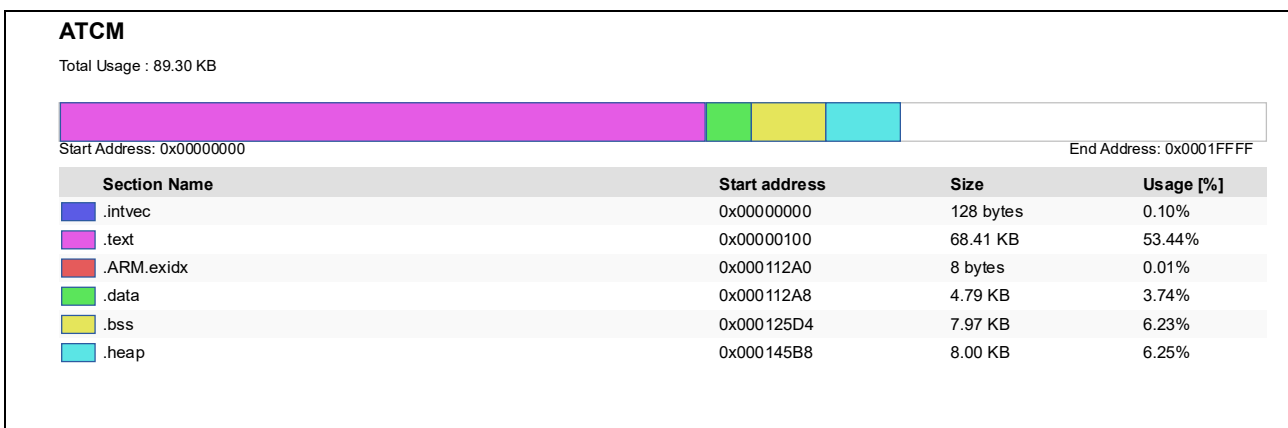


Figure 8.28. ATCM footprint of the RZ/N2L Primary project (e² studio)

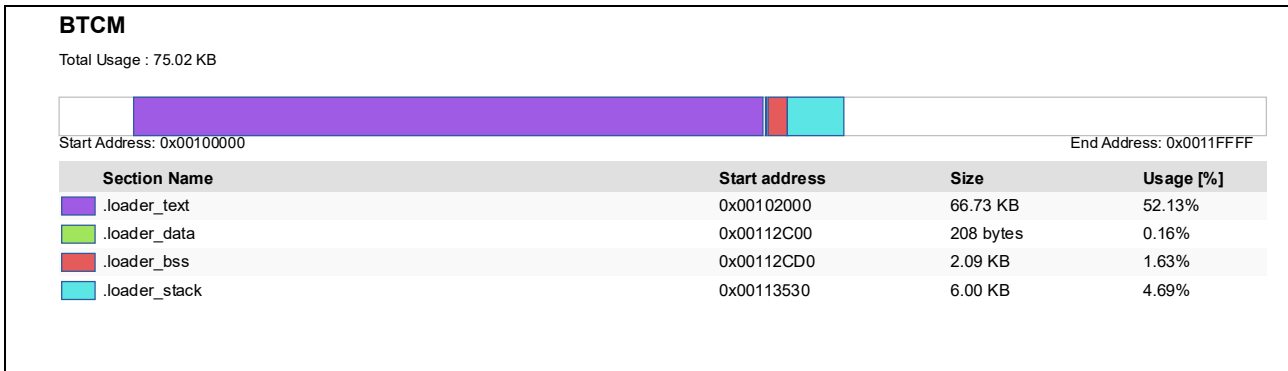


Figure 8.29. BTCM footprint of the RZ/N2L Primary project (e² studio)

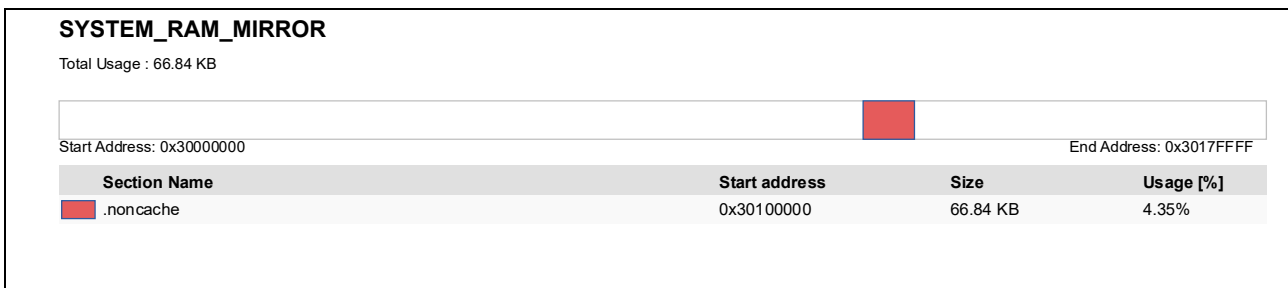


Figure 8.30. SYSTEM_RAM_MIRROR footprint of the RZ/N2L Primary project (e² studio)

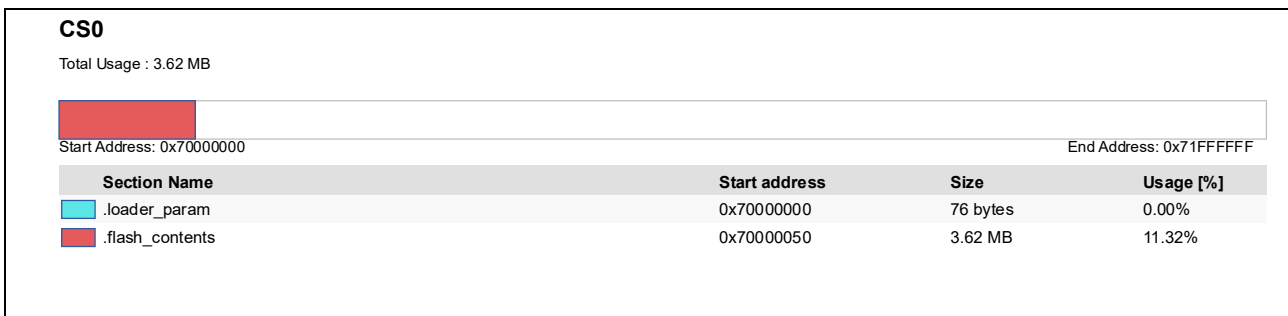


Figure 8.31. CS0 (NOR Flash) footprint of the RZ/N2L Primary project (e² studio)

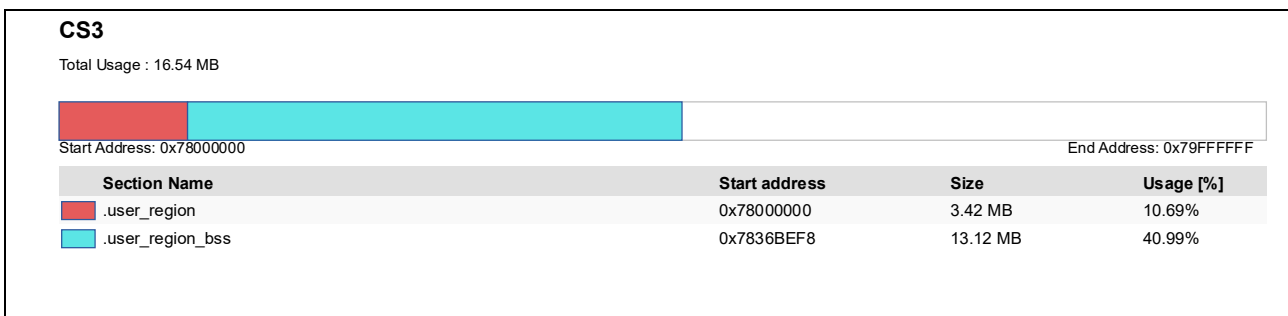


Figure 8.32. CS3 (SDRAM) footprint of the RZ/ N2L Primary project (e² studio)

8.3.2.2 EWARM

(1) Primary project

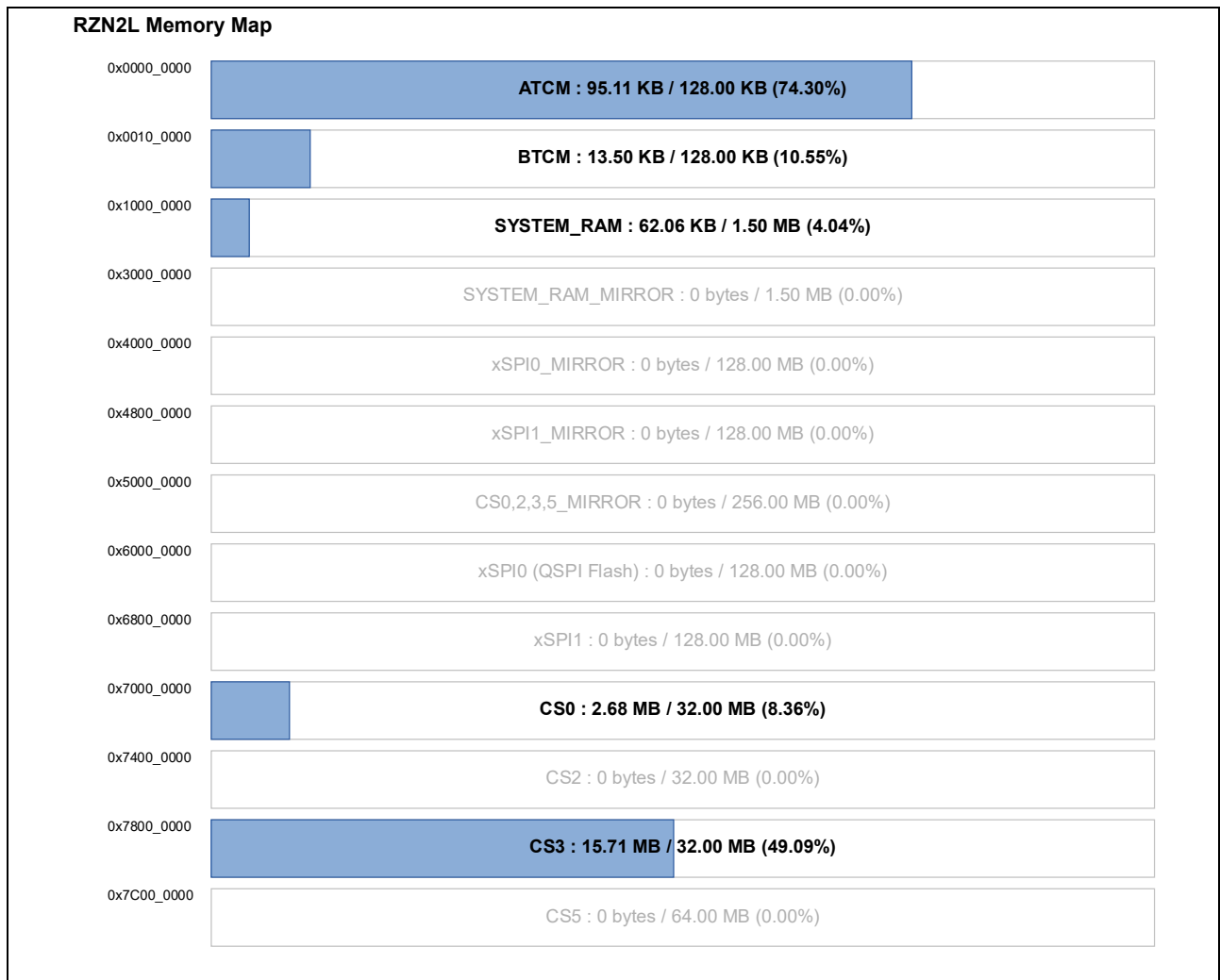


Figure 8.33. Memory footprint of the RZ/N2L Primary project (EWARM)

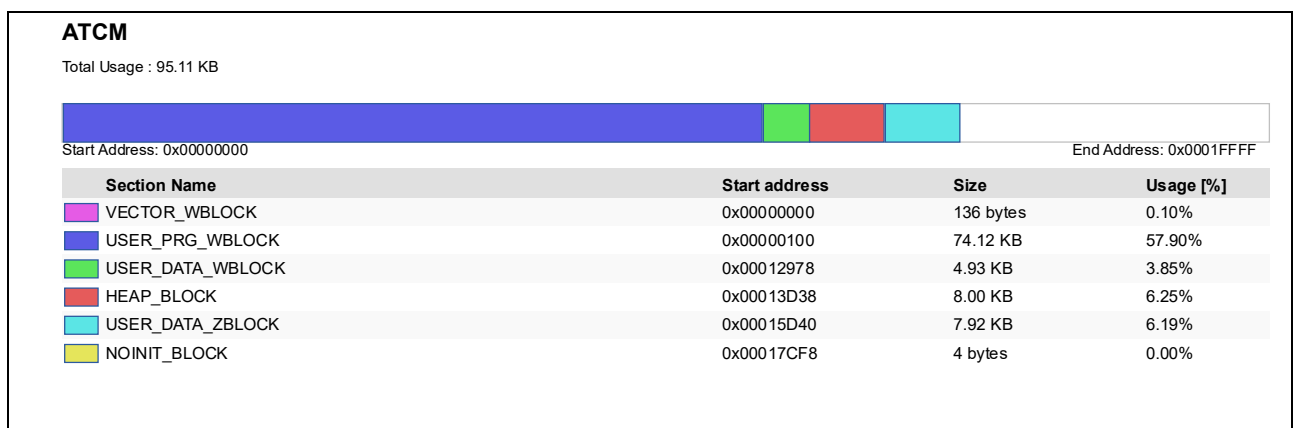


Figure 8.34. ATCM footprint of the RZ/N2L Primary project (EWARM)

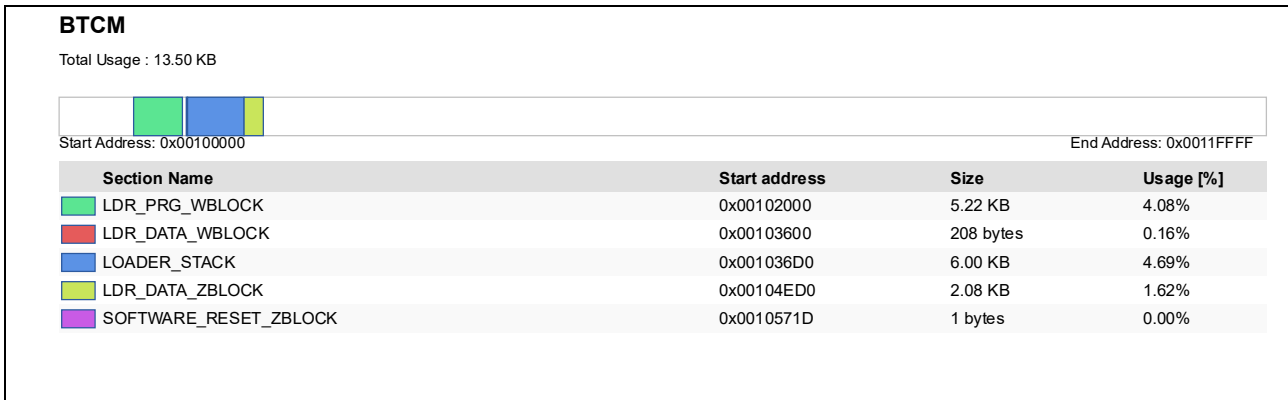


Figure 8.35. BTCM footprint of the RZ/N2L Primary project (EWARM)



Figure 8.36. SYSTEM_RAM footprint of the RZ/N2L Primary project (EWARM)

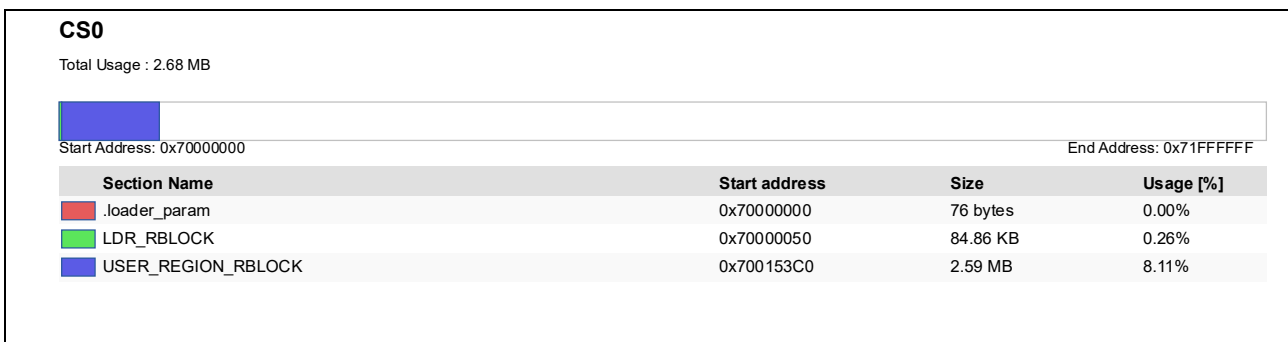


Figure 8.37. CS0 (NOR Flash) footprint of the RZ/N2L Primary project (EWARM)

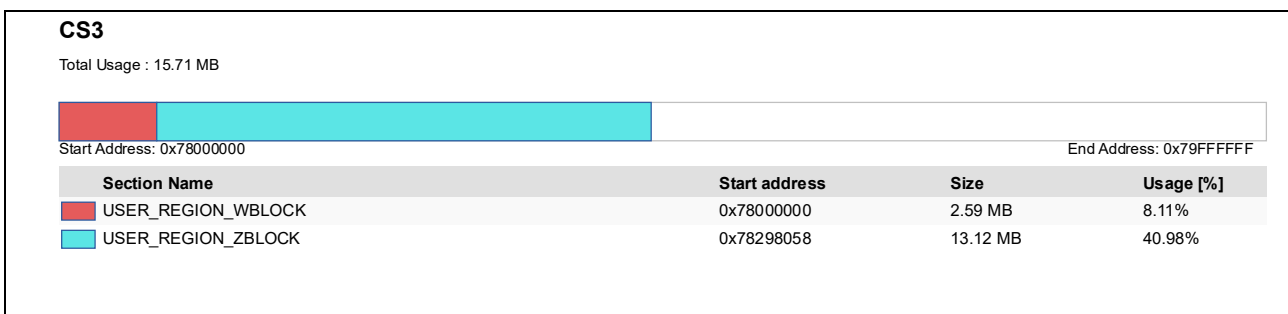


Figure 8.38. CS3 (SDRAM) footprint of the RZ/N2L Primary project (EWARM)

8.3.3 RZ/T2H, N2H project (CR52_dual)

* Since RZ/T2H and N2H are implemented with the same memory layout, the measurement results for RZ/T2H are presented here as representative.

8.3.3.1 e² studio

(1) Primary project

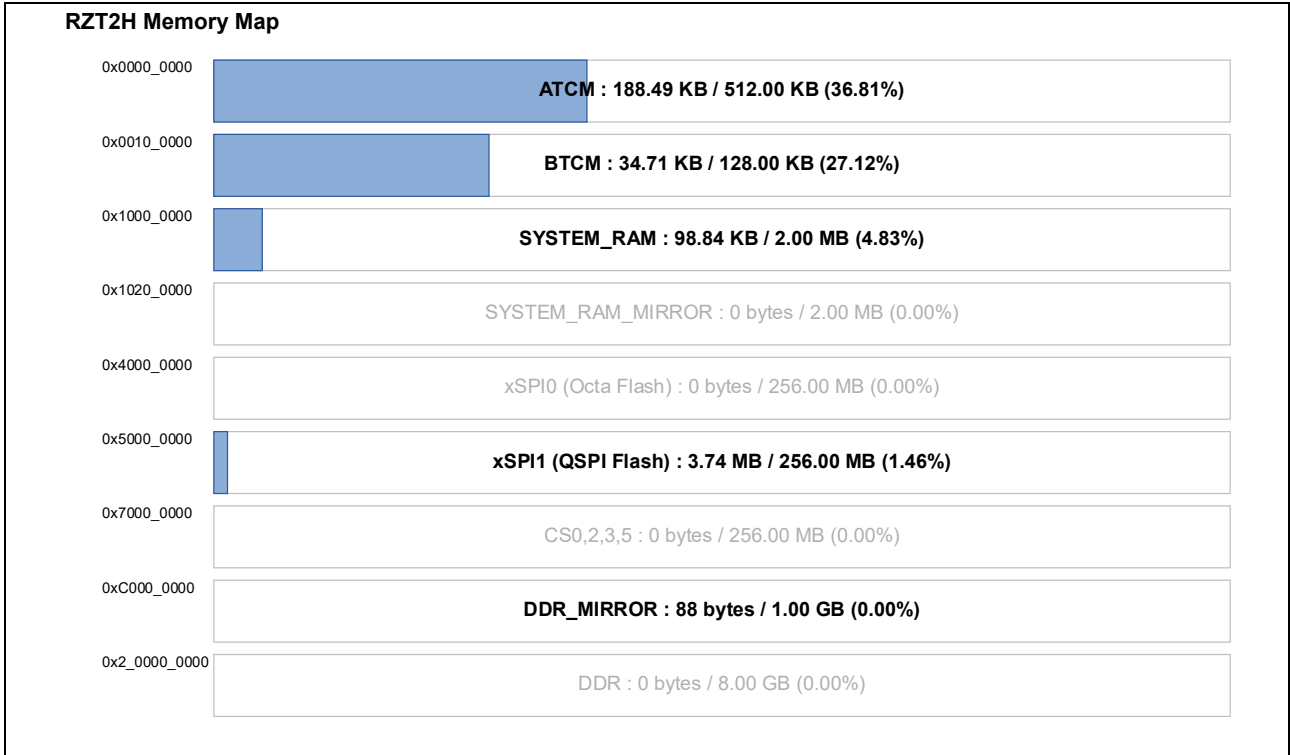


Figure 8.39. Memory footprint of the RZ/T2H, N2H (CR52_dual) Primary project (e² studio)

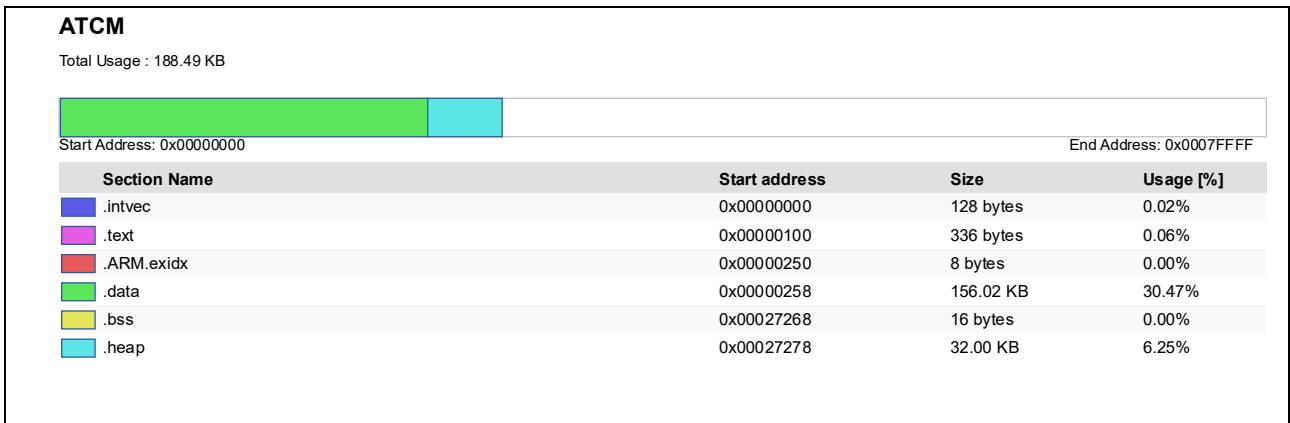


Figure 8.40. ATCM footprint of the RZ/T2H, N2H (CR52_dual) Primary project (e² studio)

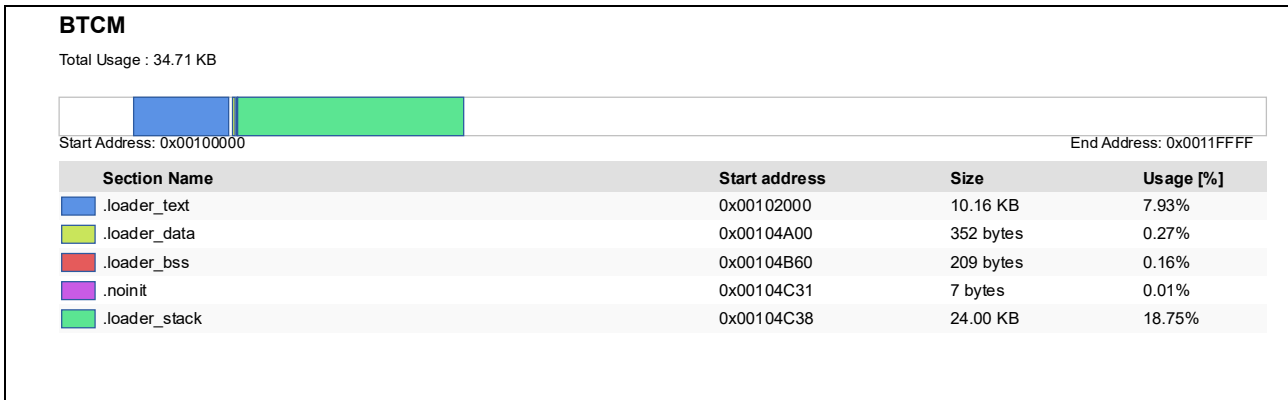


Figure 8.41. BTCM footprint of the RZ/T2H, N2H (CR52_dual) Primary project (e² studio)



Figure 8.42. SYSTEM_RAM footprint of the RZ/T2H, N2H (CR52_dual) Primary project (e² studio)

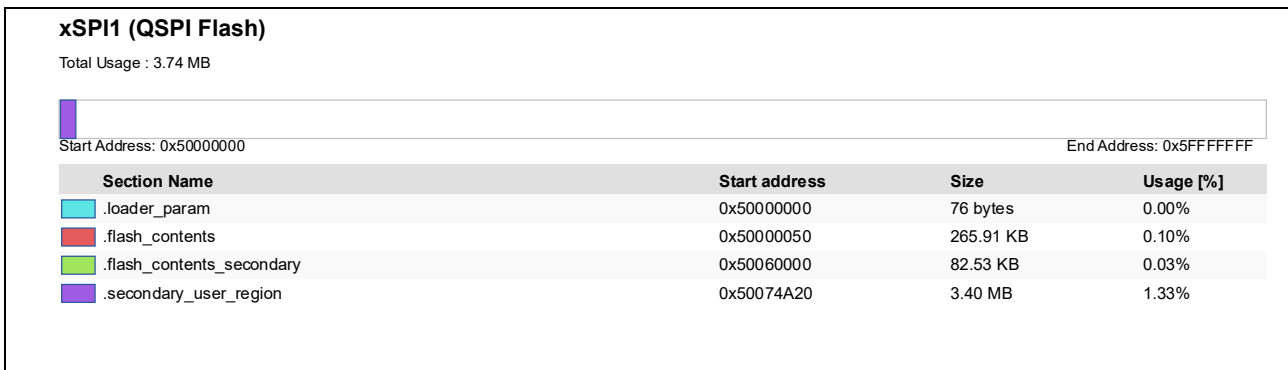


Figure 8.43. xSPI1 (QSPI Flash) footprint of the RZ/T2H, N2H (CR52_dual) Primary project (e² studio)



Figure 8.44. DDR_MIRROR footprint of the RZ/T2H, N2H (CR52_dual) Primary project (e² studio)

(2) Secondary project

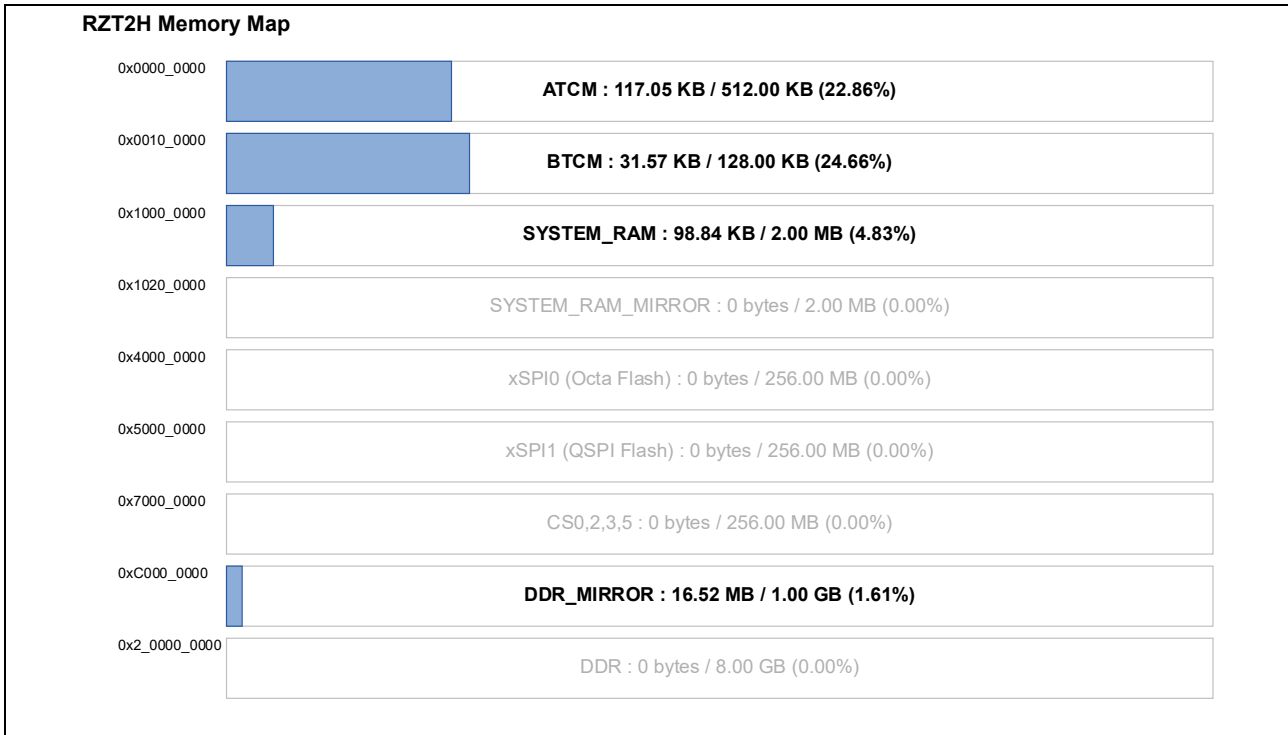


Figure 8.45. Memory footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (e² studio)

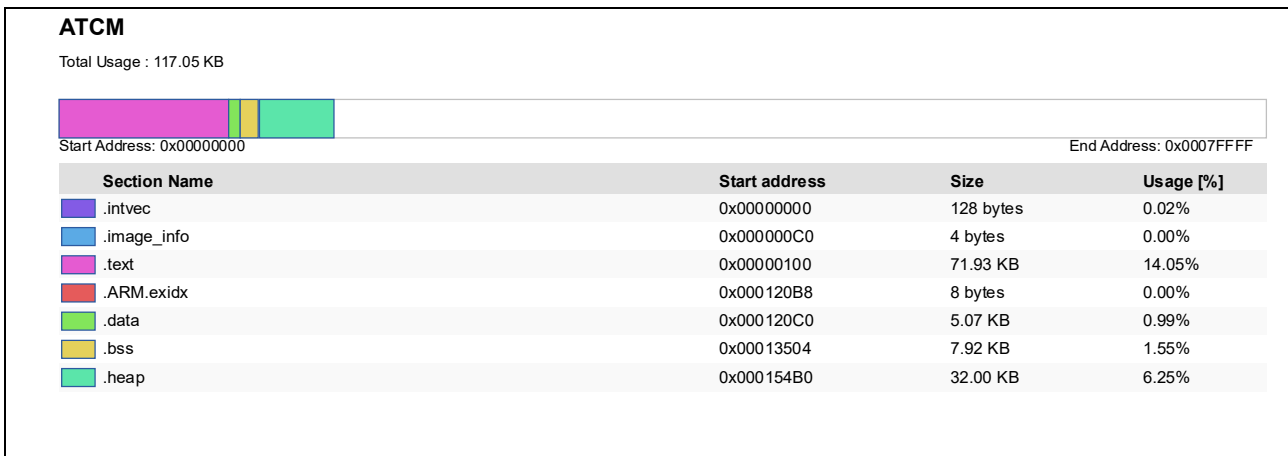


Figure 8.46. ATCM footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (e² studio)

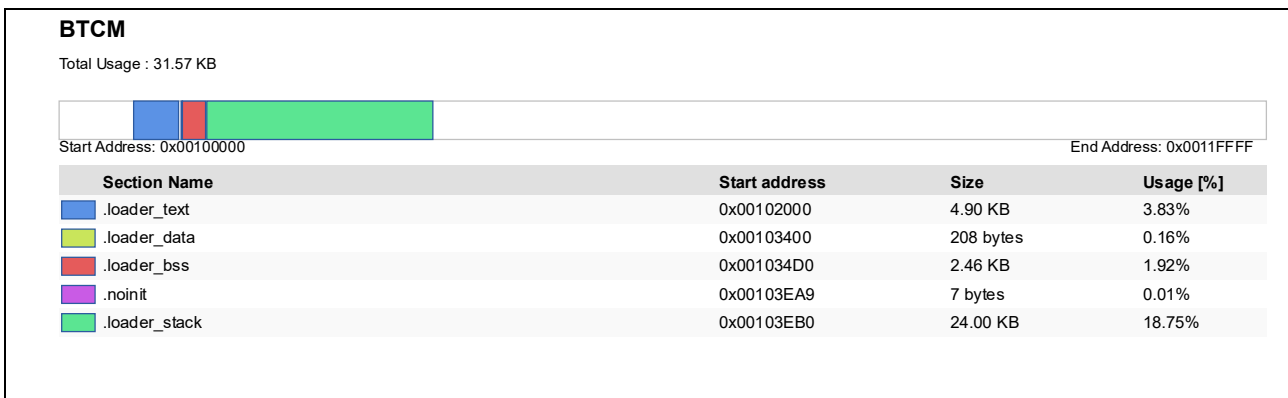


Figure 8.47. BTCM footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (e² studio)



Figure 8.48. SYSTEM_RAM footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (e² studio)

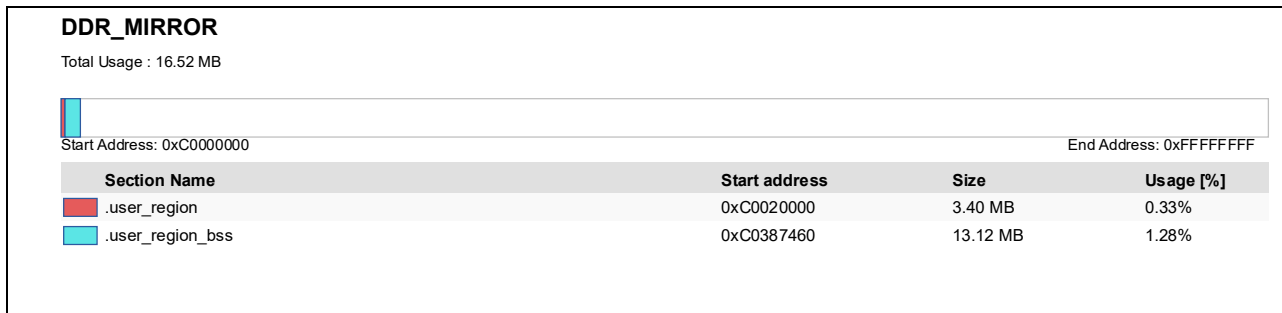


Figure 8.49. DDR_MIRROR footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (e² studio)

8.3.3.2 EWARM

(1) Primary project

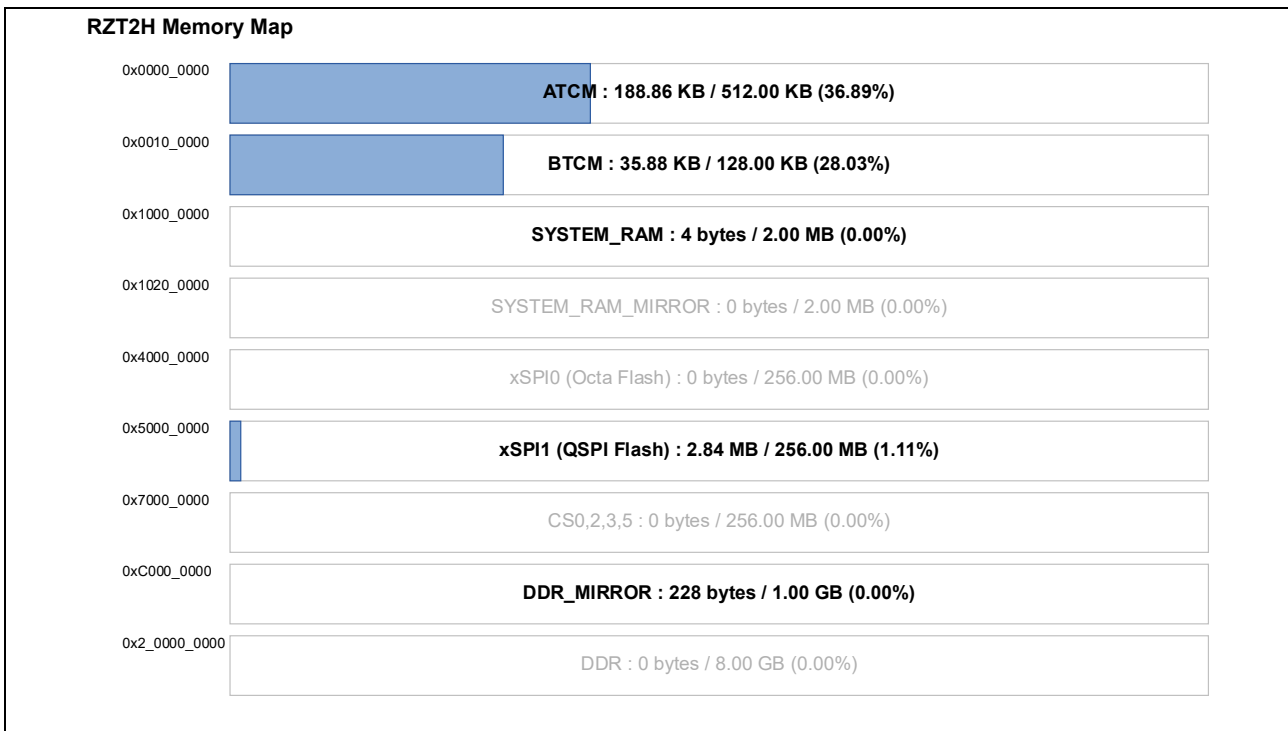


Figure 8.50. Memory footprint of the RZ/T2H, N2H (CR52_dual) Primary project (EWARM)

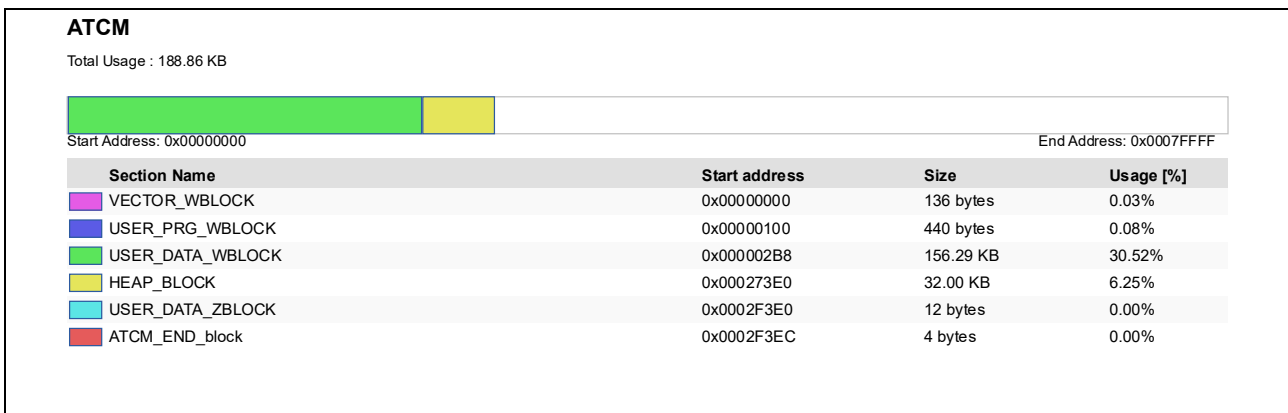


Figure 8.51. ATCM footprint of the RZ/T2H, N2H (CR52_dual) Primary project (EWARM)

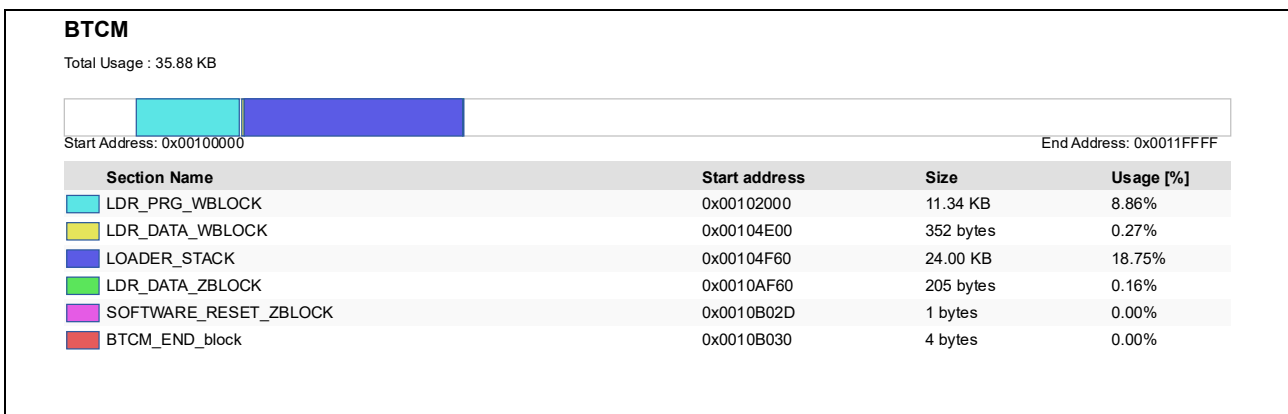


Figure 8.52. BTCM footprint of the RZ/T2H, N2H (CR52_dual) Primary project (EWARM)



Figure 8.53. SYSTEM_RAM footprint of the RZ/T2H, N2H (CR52_dual) Primary project (EWARM)

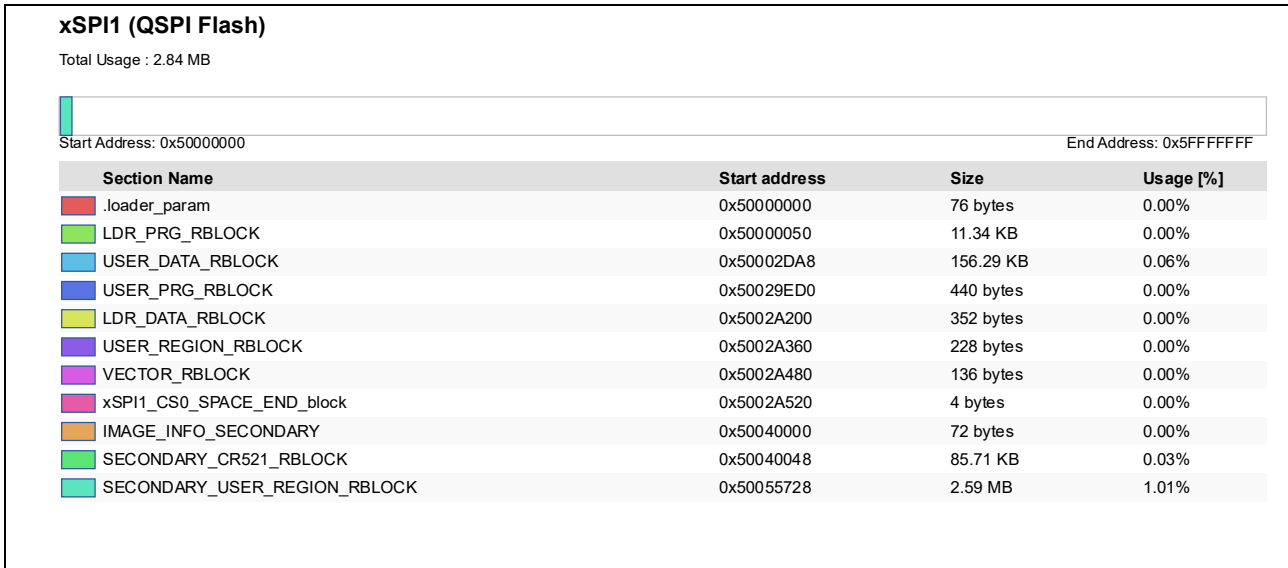


Figure 8.54. xSPI1 (QSPI Flash) footprint of the RZ/T2H, N2H (CR52_dual) Primary project (EWARM)



Figure 8.55. DDR_MIRROR footprint of the RZ/T2H, N2H (CR52_dual) Primary project (EWARM)

(2) Secondary project

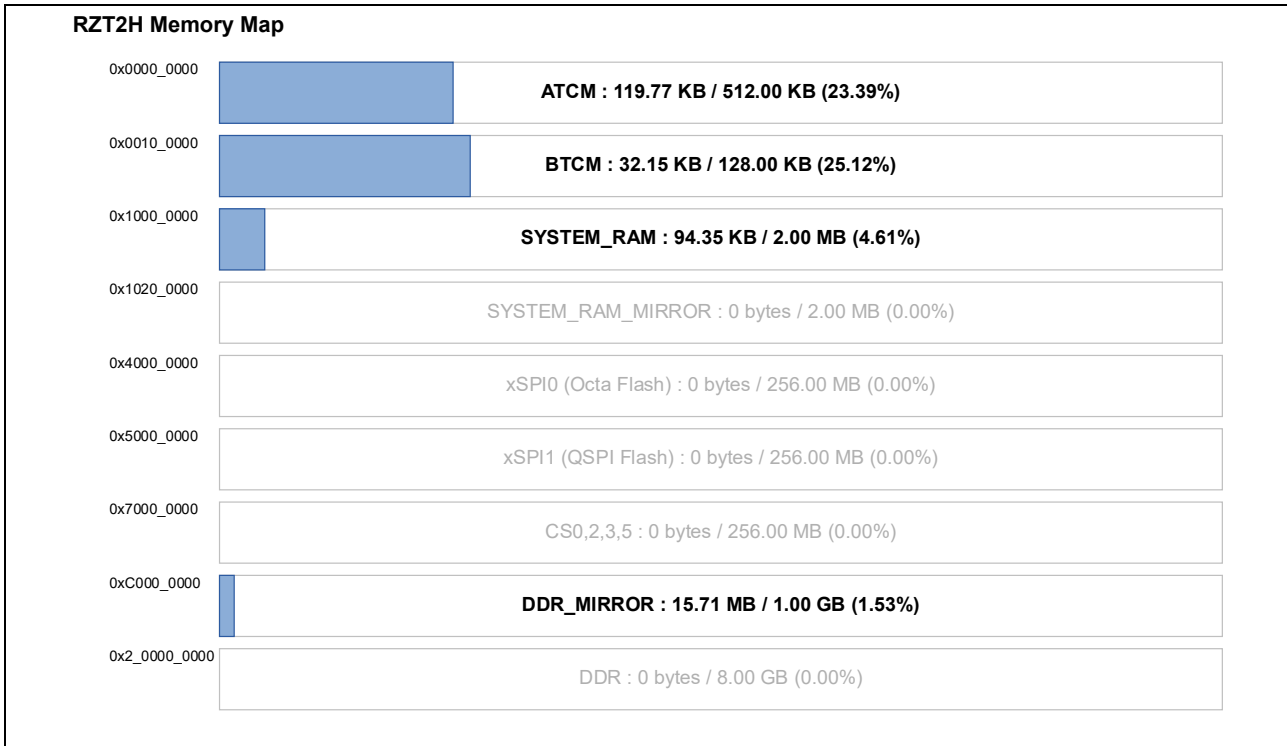


Figure 8.56. Memory footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (EWARM)

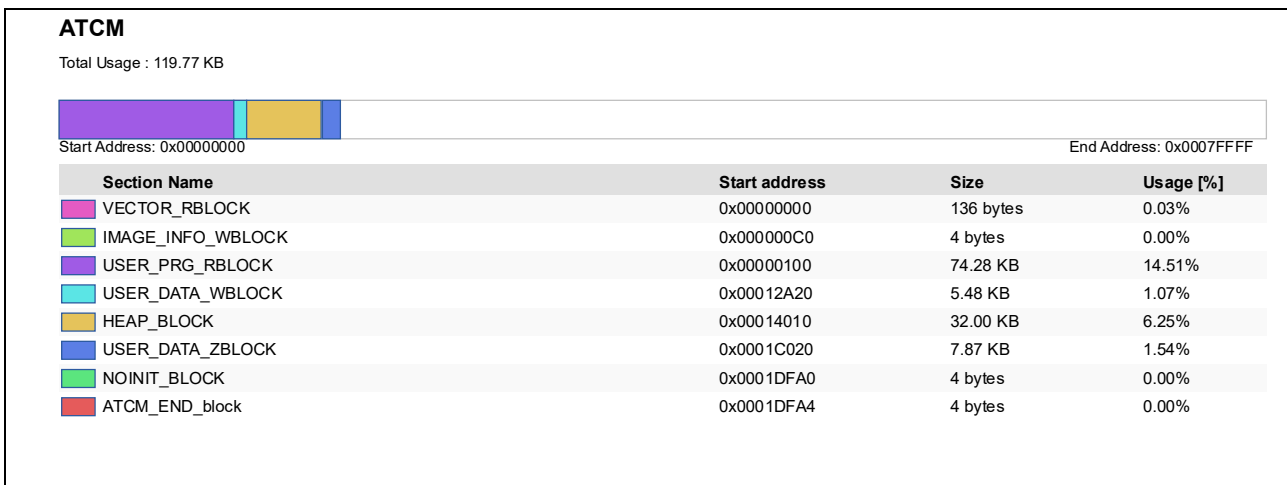


Figure 8.57. ATCM footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (EWARM)

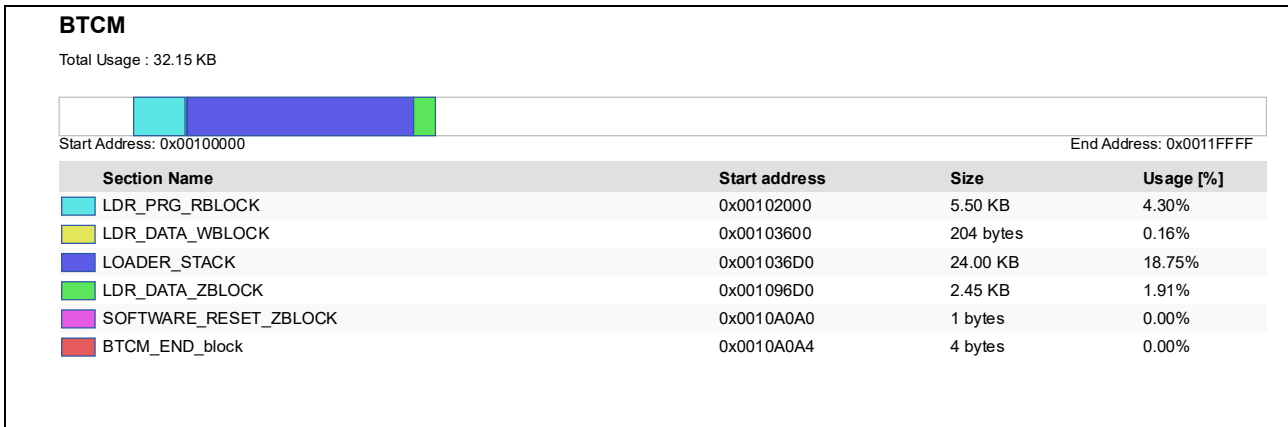


Figure 8.58. BTMCM footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (EWARM)

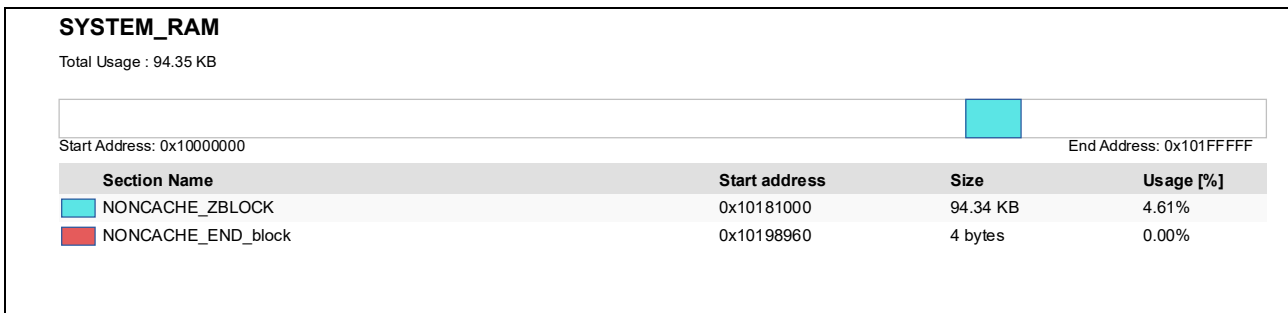


Figure 8.59. SYSTEM_RAM footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (EWARM)

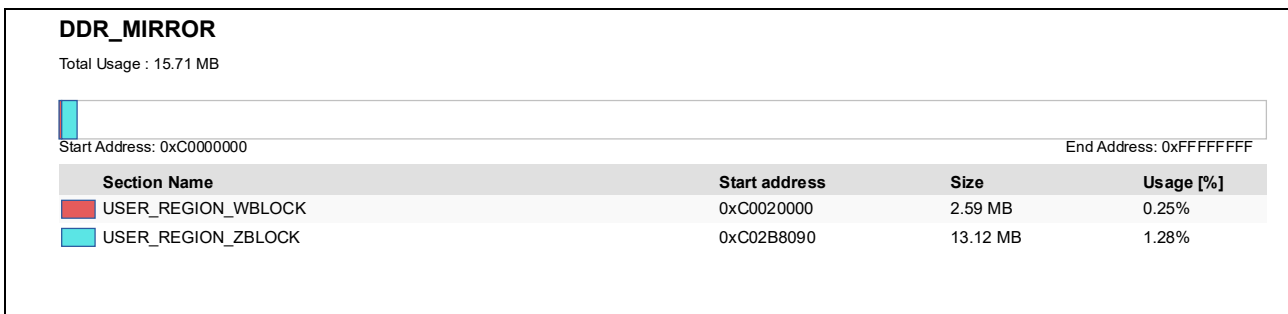


Figure 8.60. DDR_MIRROR footprint of the RZ/T2H, N2H (CR52_dual) Secondary project (EWARM)

8.3.4 RZ/T2H, N2H project (CA55_dual)

* Since RZ/T2H and N2H are implemented with the same memory layout, the measurement results for RZ/T2H are presented here as representative.

8.3.4.1 e² studio

(1) Primary project

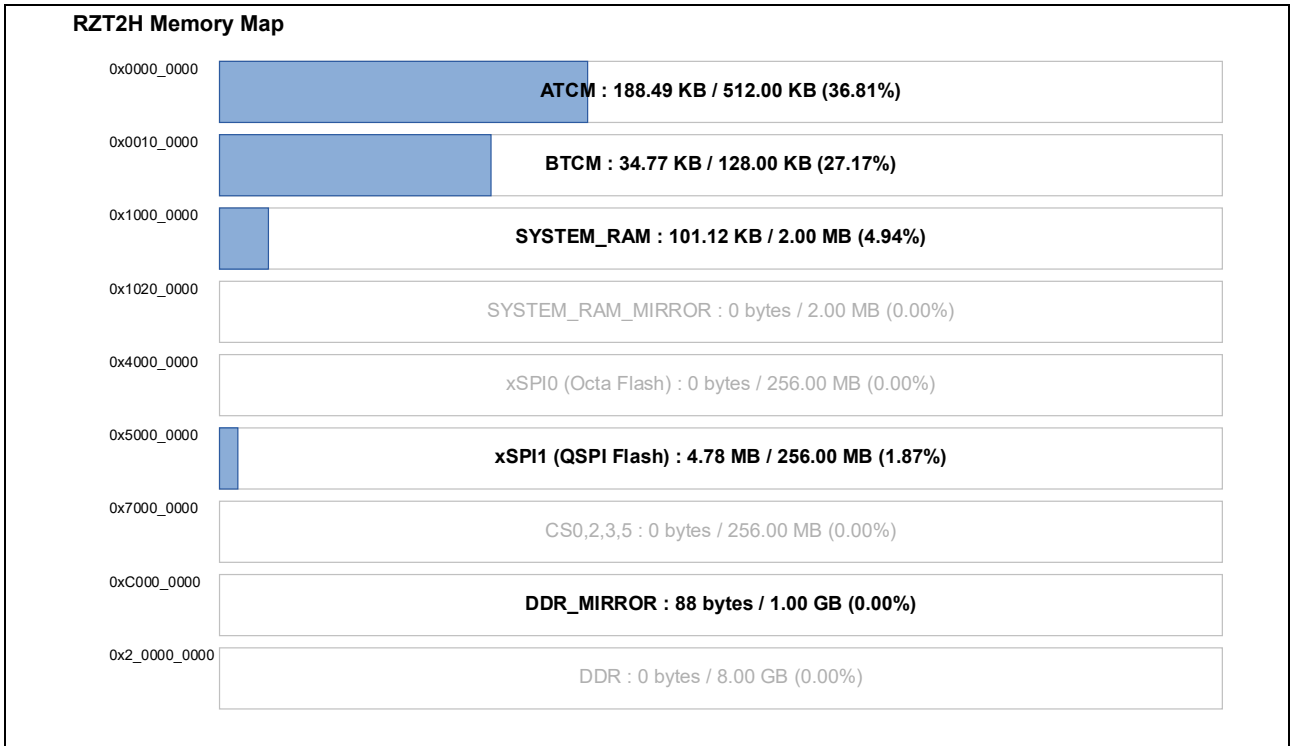


Figure 8.61. Memory footprint of the RZ/T2H, N2H (CA55_dual) Primary project (e² studio)

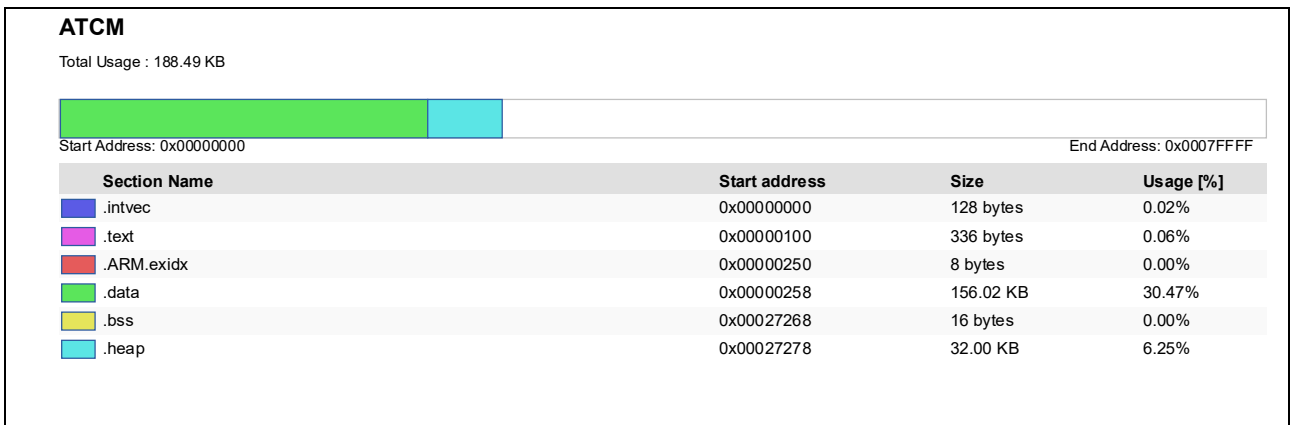


Figure 8.62. ATCM footprint of the RZ/T2H, N2H (CA55_dual) Primary project (e² studio)

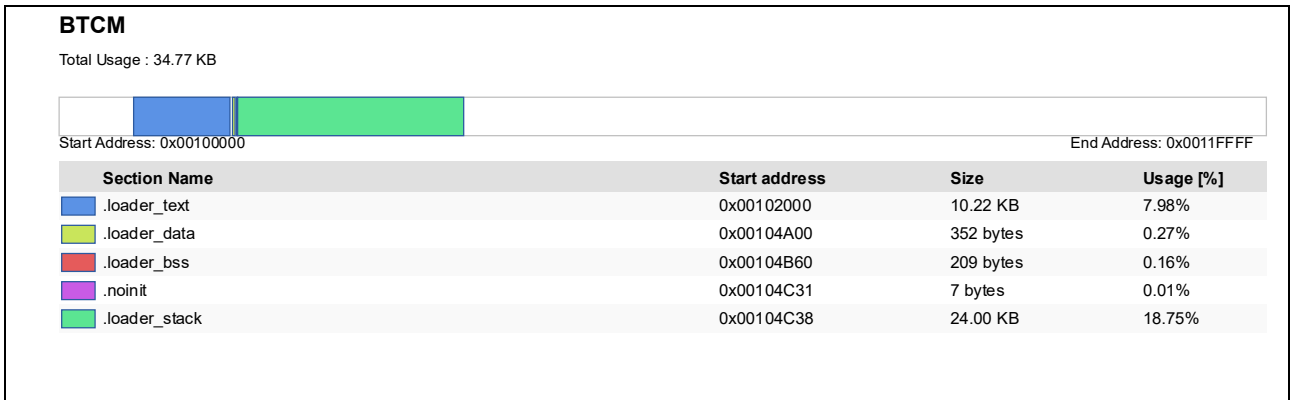


Figure 8.63. BTCM footprint of the RZ/T2H, N2H (CA55_dual) Primary project (e² studio)

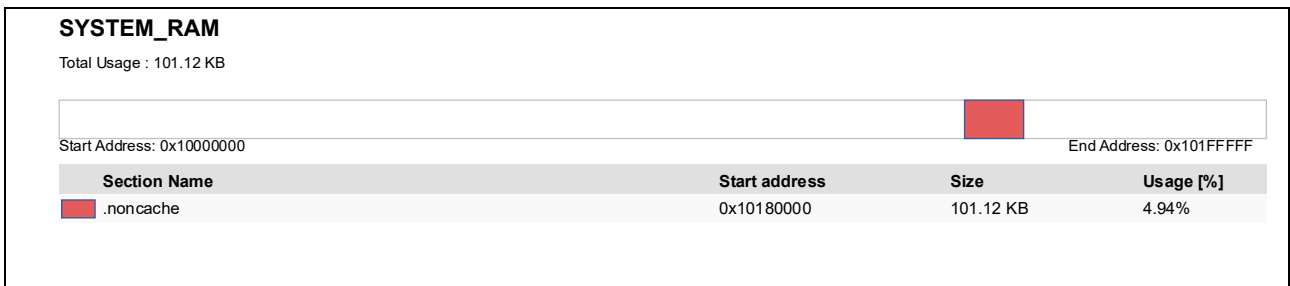


Figure 8.64. SYSTEM_RAM footprint of the RZ/T2H, N2H (CA55_dual) Primary project (e² studio)

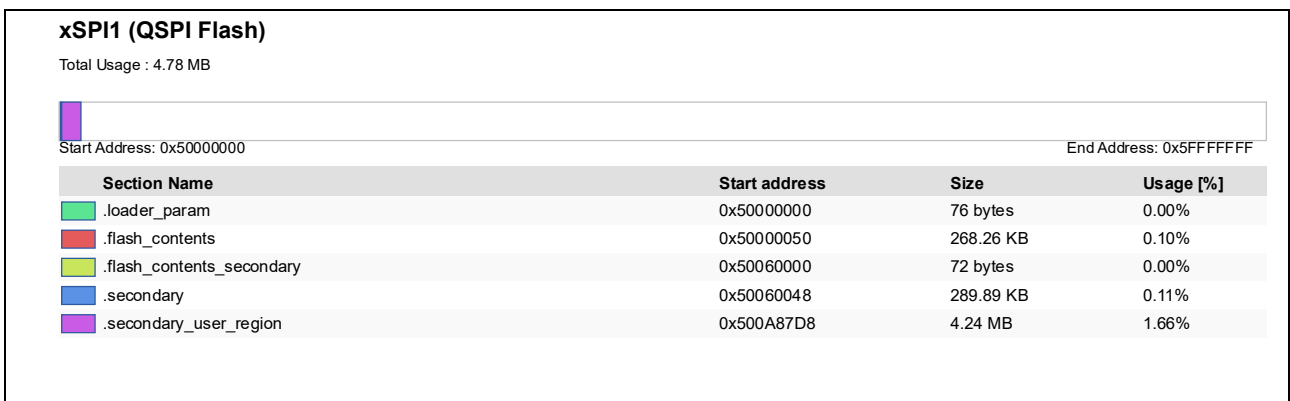


Figure 8.65. xSPI1 (QSPI Flash) footprint of the RZ/T2H, N2H (CA55_dual) Primary project (e² studio)



Figure 8.66. DDR_MIRROR footprint of the RZ/T2H, N2H (CA55_dual) Primary project (e² studio)

(2) Secondary project

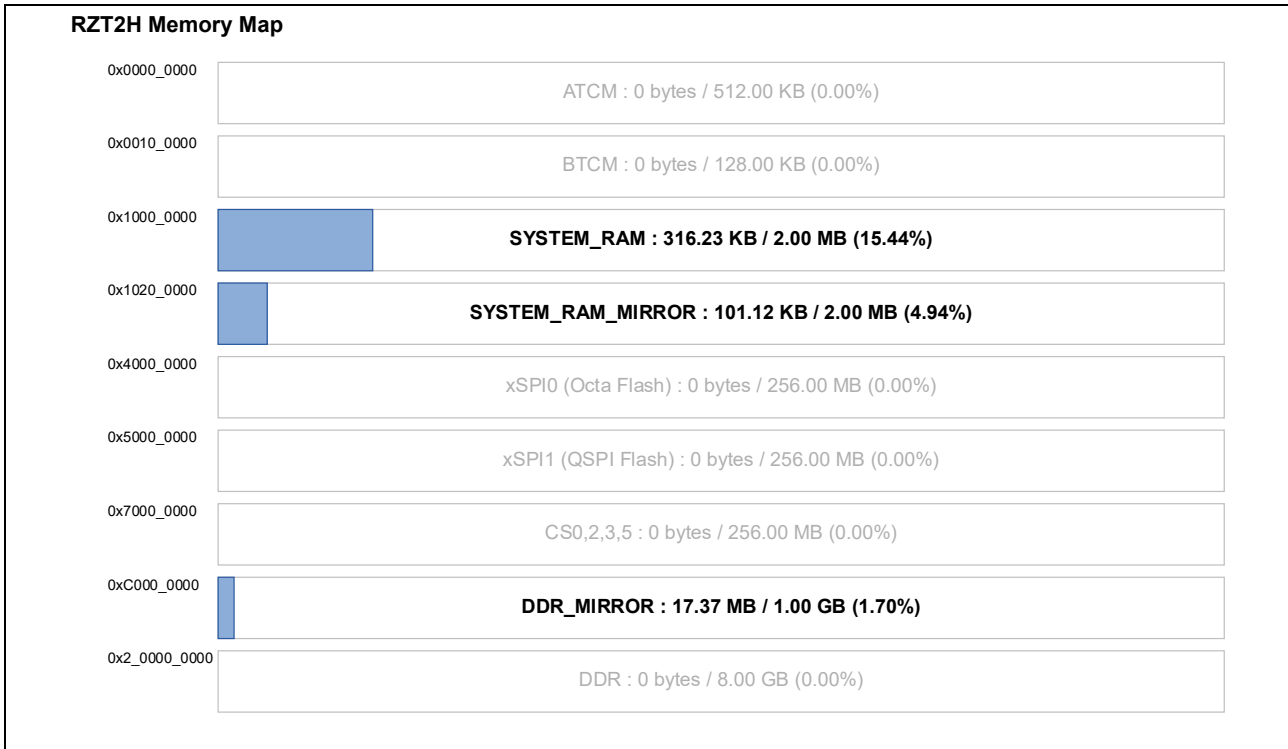


Figure 8.67. Memory footprint of the RZ/T2H, N2H (CA55_dual) Secondary project (e² studio)

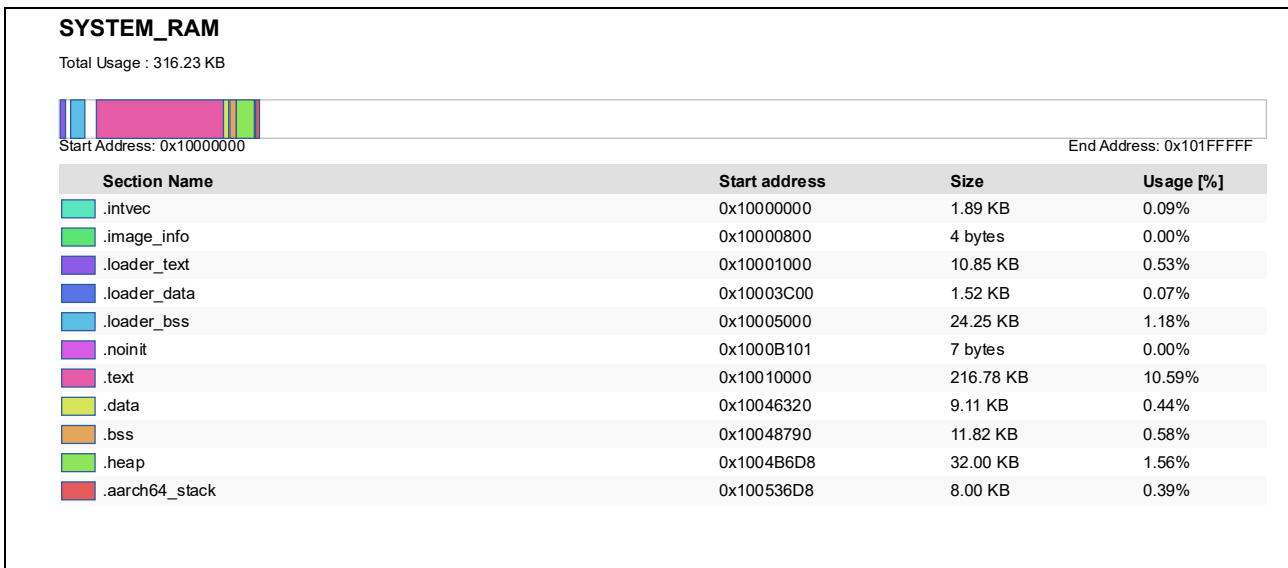


Figure 8.68. SYSTEM_RAM footprint of the RZ/T2H, N2H (CA55_dual) Secondary project (e² studio)



Figure 8.69. SYSTEM_RAM_MIRROR footprint of the RZ/T2H, N2H (CA55_dual) Secondary project (e² studio)

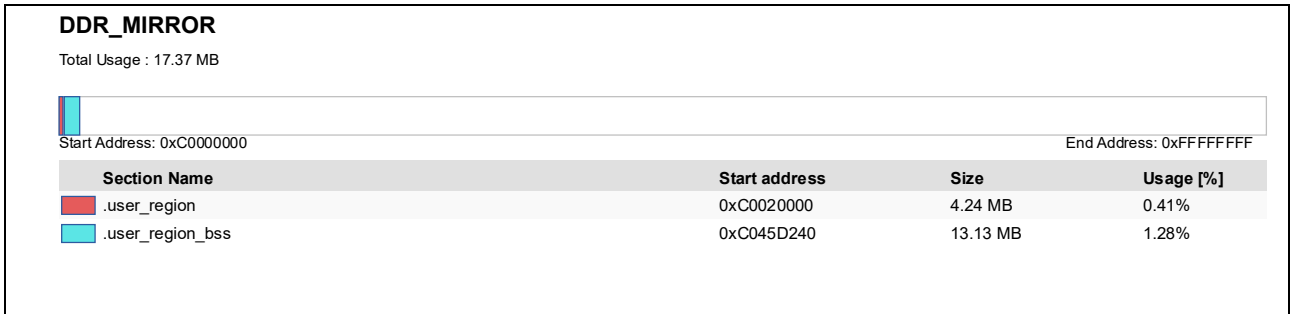


Figure 8.70. DDR_MIRROR footprint of the RZ/T2H, N2H (CA55_dual) Secondary project (e² studio)

8.3.4.2 EWARM

(1) Primary project

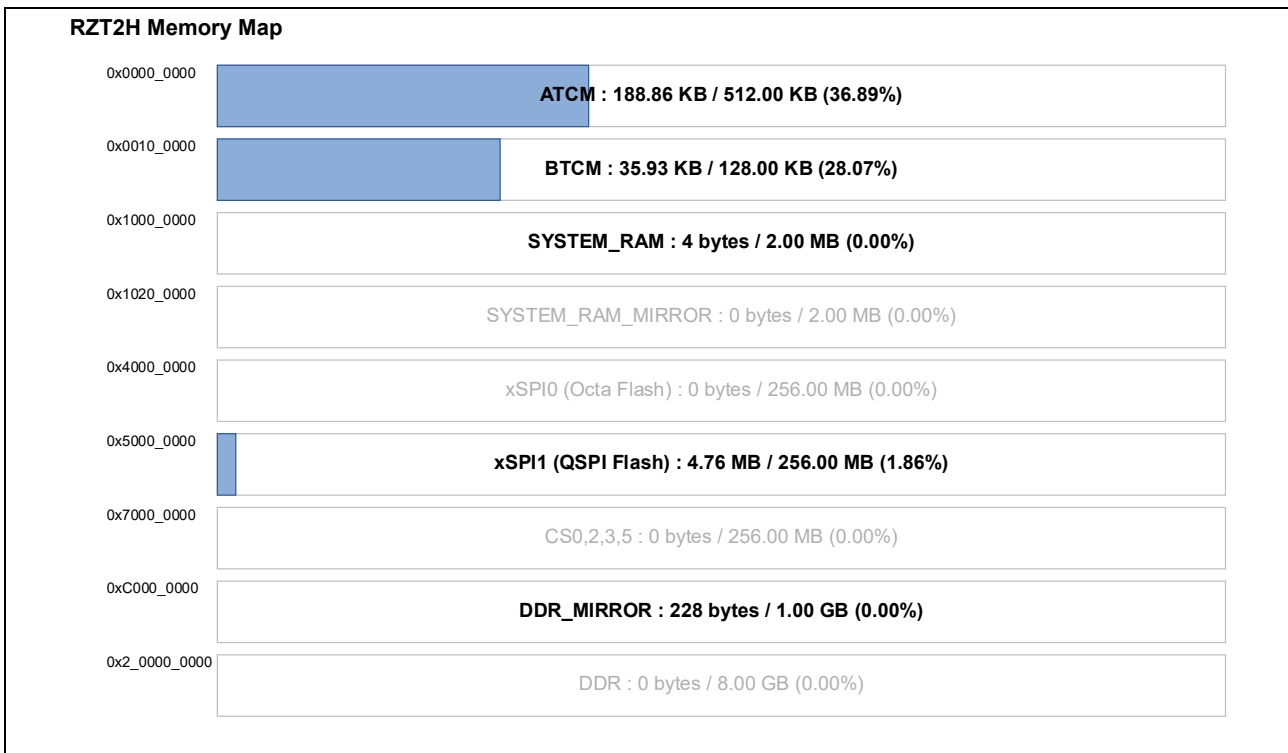


Figure 8.71. Memory footprint of the RZ/T2H, N2H (CA55_dual) Primary project (EWARM)

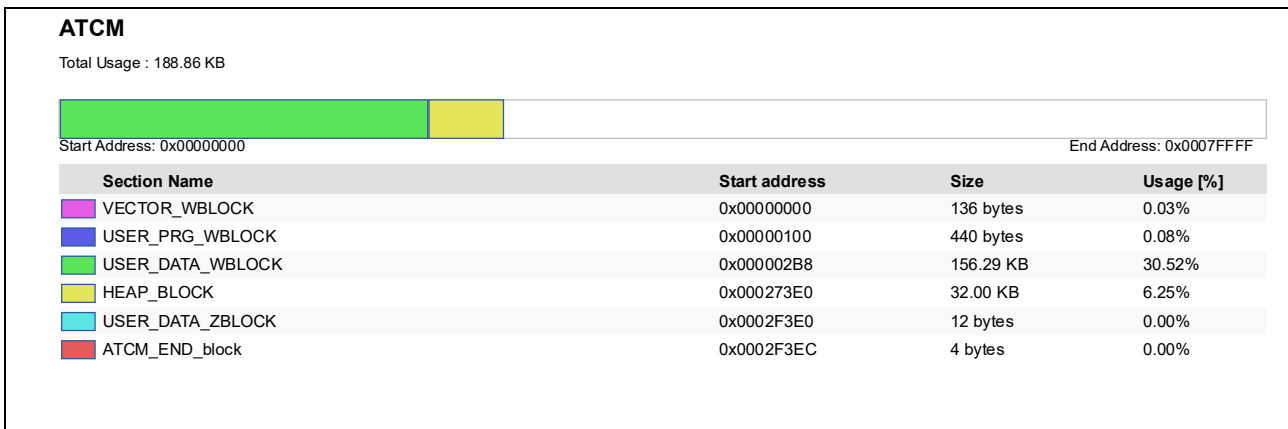


Figure 8.72. ATCM footprint of the RZ/T2H, N2H (CA55_dual) Primary project (EWARM)

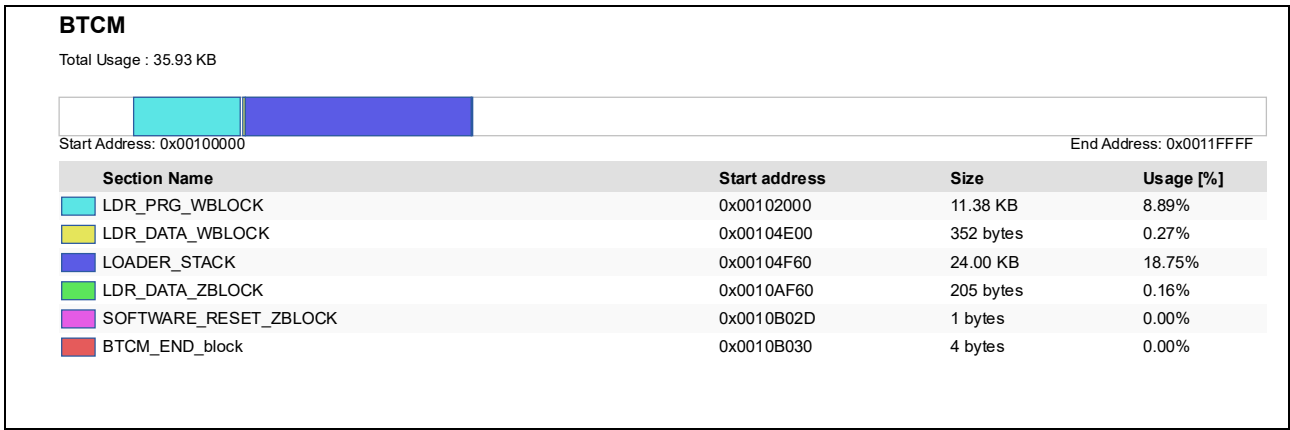


Figure 8.73. BTCM footprint of the RZ/T2H, N2H (CA55_dual) Primary project (EWARM)



Figure 8.74. SYSTEM_RAM footprint of the RZ/T2H, N2H (CA55_dual) Primary project (EWARM)

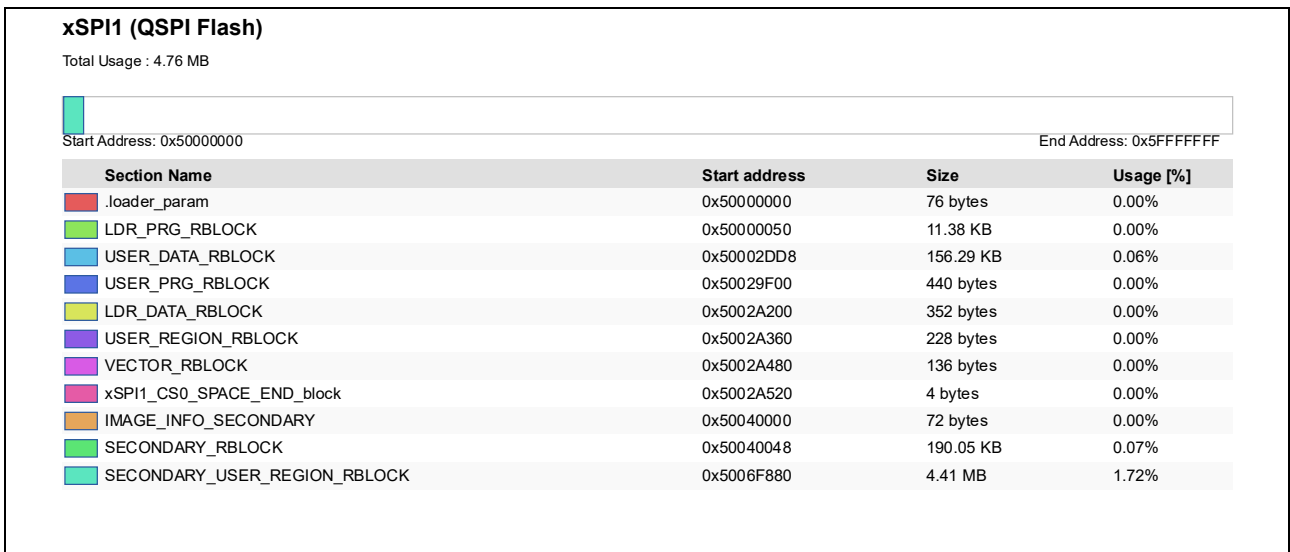


Figure 8.75. xSPI1 (QSPI Flash) footprint of the RZ/T2H, N2H (CA55_dual) Primary project (EWARM)



Figure 8.76. DDR_MIRROR footprint of the RZ/T2H, N2H (CA55_dual) Primary project (EWARM)

(2) Secondary project

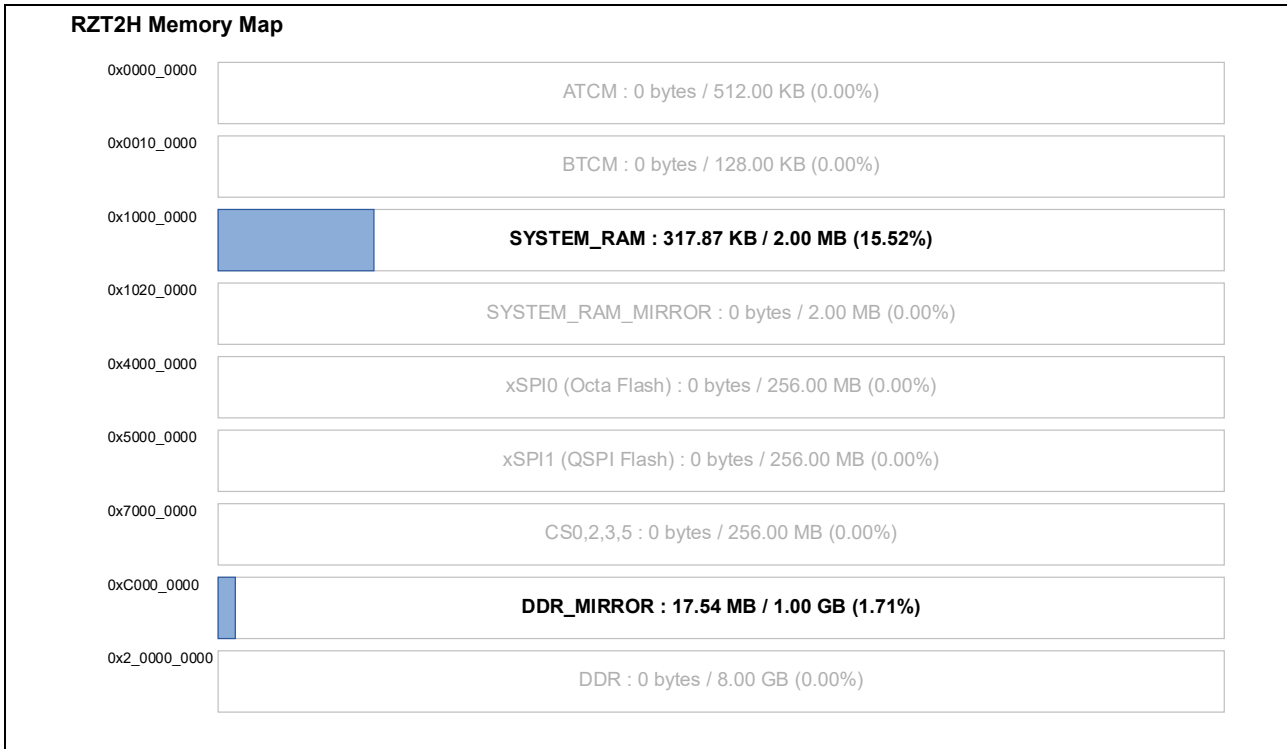


Figure 8.77. Memory footprint of the RZ/T2H, N2H (CA55_dual) Secondary project (EWARM)

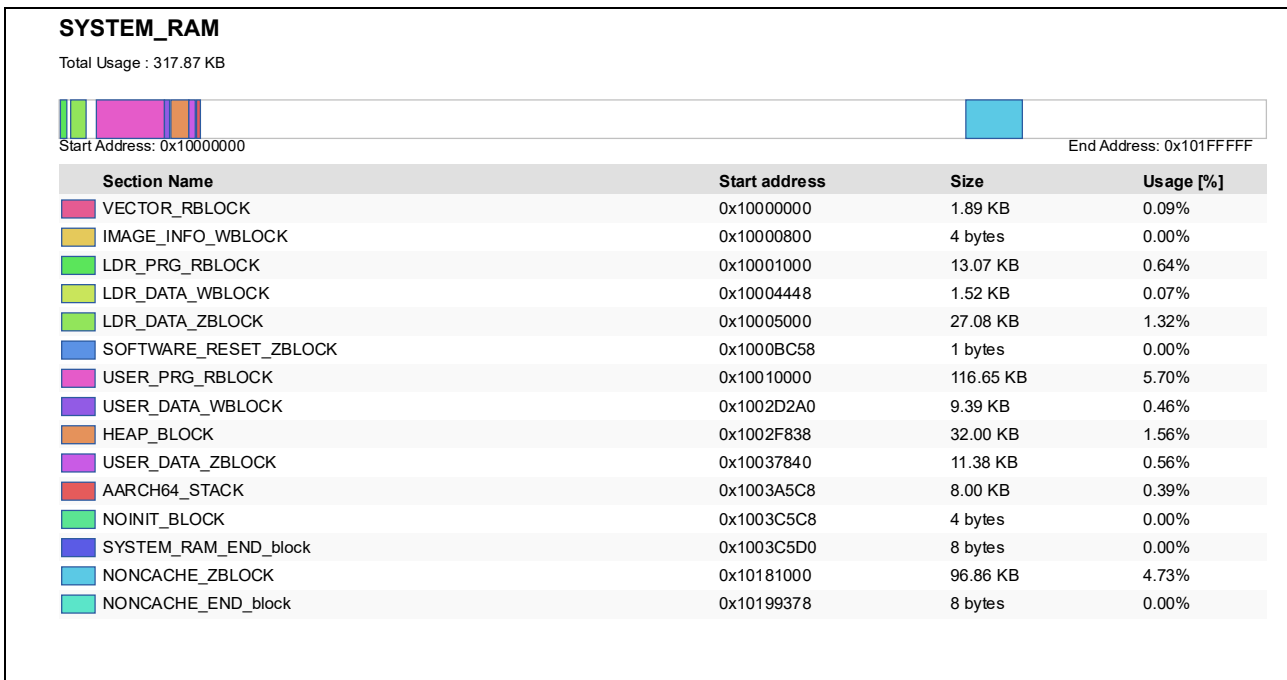


Figure 8.78. SYSTEM_RAM footprint of the RZ/T2H, N2H (CA55_dual) Secondary project (EWARM)

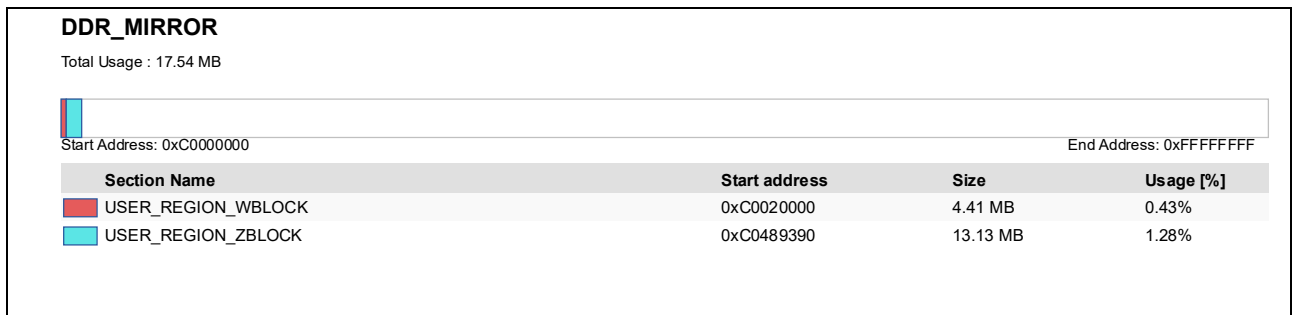


Figure 8.79. DDR_MIRROR footprint of the RZ/T2H, N2H (CA55_dual) Secondary project (EWARM)

9. Appendix

9.1 File Generation of open62541

The open source open62541 is used for the OPC UA stack of this sample software. To run open62541 in a FreeRTOS + LwIP environment, the following link recommends an approach to generate open62541.c and open62541.h using CMake, which is also used in this sample software.

[Building open62541 — open62541 1.3.0-dirty documentation](#)

This chapter describes the procedure for generating open62541 and Renesas sample information models as files for e² studio or EWARM execution in a Windows environment. Here Windows10 version 1903(OS Build 18362.1049) or later, or Windows11 is used, in which WSL2 is executable.

9.1.1 Linux environment Setup

Set up a Linux environment to run CMake. In this document, we will run CMake on a Linux (Ubuntu 18.04) environment installed using WSL2 with reference to the following linked pages.

(Reference) [Manual installation steps for older versions of WSL | Microsoft Learn](#)

- 1) Launch PowerShell as Administrator. Search PowerShell > right-click > Run as Administrator
- 2) Enter the following command to enable the Windows Subsystem for Linux.
dism.exe /online /enable-feature /featurename:Microsoft-Windows-Subsystem-Linux /all /norestart

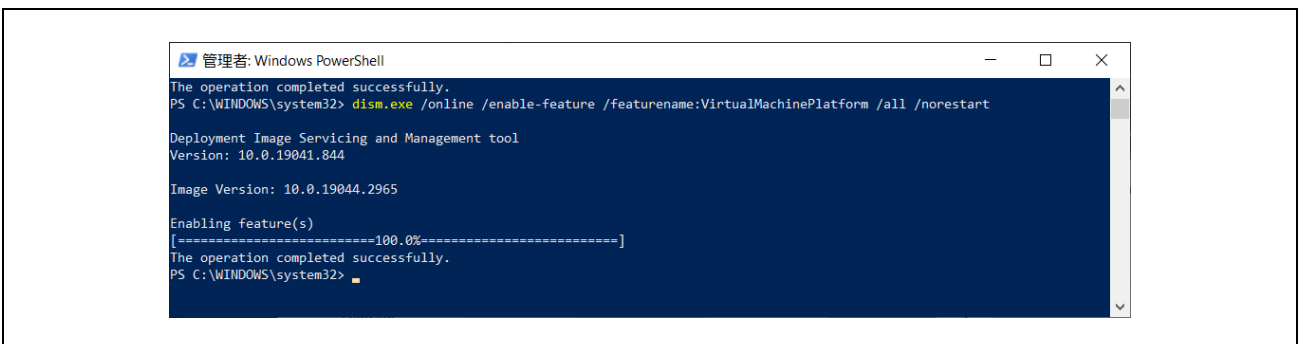


Figure 9.1. Microsoft-Windows-Subsystem-Linux

- 3) Enter the following command to enable the virtual machine platform feature:
dism.exe /online /enable-feature /featurename:VirtualMachinePlatform /all /norestart

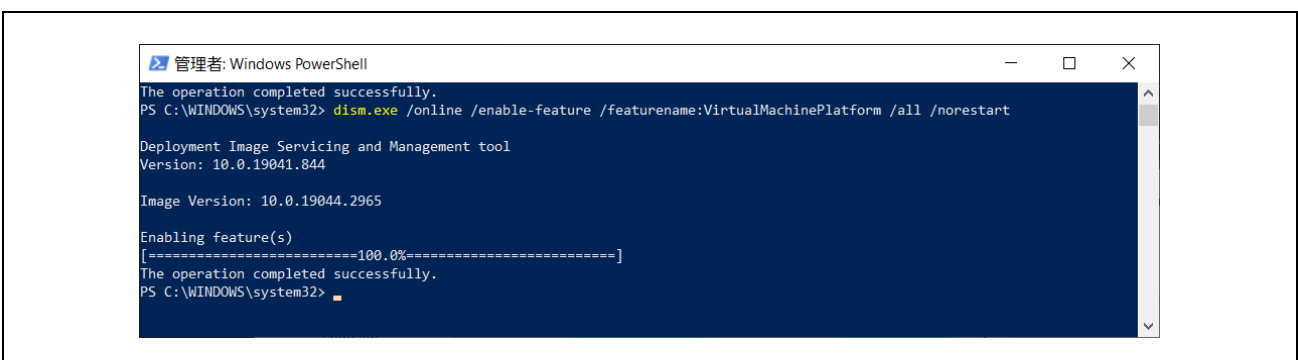


Figure 9.2. VirtualMachinePlatform

- 4) Restart your PC and complete the WSL installation.
- 5) Download and run the WSL2 Linux kernel update package for x64 machines below.

[WSL2 Linux kernel update package for x64 machines](#)

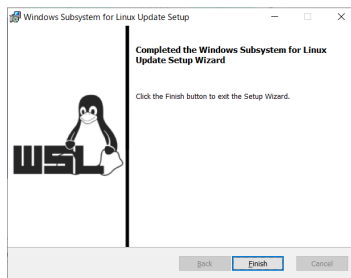


Figure 9.3. wsl_update_x64.msi

- 6) Run the following command to set WSL 2 as the default version.

```
wsl --set-default-version 2
```

- 7) Download Linux distribution. Here download Ubuntu 18.04 below.

[Ubuntu 18.04](#)

- 8) Go to the folder containing the downloaded file and execute the following command.

```
Add-AppxPackage .\Ubuntu_1804.2019.522.0_x64.appx
```

- 9) Double-click Ubuntu_1804.2019.522.0_x64.appx to install.



Figure 9.4. Ubuntu Install

- 10) Set the Linux username and password.

(Reference) [Set up a WSL development environment | Microsoft Learn](#)

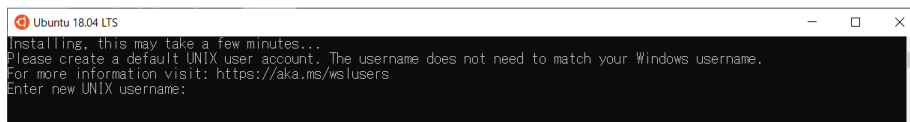


Figure 9.5. UNIX username

9.1.2 Install CMake

11) Execute the following Linux command to update apt-get

```
sudo apt-get update
```

```
lv@IPN-PC63013V10:~$ sudo apt-get update
Hit:1 http://archive.ubuntu.com/ubuntu bionic InRelease
Get:2 http://archive.ubuntu.com/ubuntu bionic-updates InRelease [88.7 kB]
Get:3 http://security.ubuntu.com/ubuntu bionic-security InRelease [88.7 kB]
Get:4 http://archive.ubuntu.com/ubuntu bionic-backports InRelease [83.3 kB]
Get:5 http://archive.ubuntu.com/ubuntu bionic/universe amd64 Packages [8570 kB]
Get:6 http://security.ubuntu.com/ubuntu bionic-security/main amd64 Packages [2717 kB]
Get:7 http://archive.ubuntu.com/ubuntu bionic/universe Translation-en [4941 kB]
Get:8 http://security.ubuntu.com/ubuntu bionic-security/main Translation-en [467 kB]
Get:9 http://security.ubuntu.com/ubuntu bionic-security/restricted amd64 Packages [1317 kB]
Get:10 http://security.ubuntu.com/ubuntu bionic-security/restricted Translation-en [182 kB]
Get:11 http://archive.ubuntu.com/ubuntu bionic/multiverse amd64 Packages [151 kB]
Get:12 http://security.ubuntu.com/ubuntu bionic-security/universe amd64 Packages [1303 kB]
Get:13 http://archive.ubuntu.com/ubuntu bionic/multiverse Translation-en [108 kB]
Get:14 http://archive.ubuntu.com/ubuntu bionic-updates/main amd64 Packages [3045 kB]
Get:15 http://security.ubuntu.com/ubuntu bionic-security/universe Translation-en [308 kB]
Get:16 http://security.ubuntu.com/ubuntu bionic-security/multiverse amd64 Packages [19.8 kB]
Get:17 http://archive.ubuntu.com/ubuntu bionic-updates/main Translation-en [553 kB]
Get:18 http://security.ubuntu.com/ubuntu bionic-security/multiverse Translation-en [3928 B]
Get:19 http://archive.ubuntu.com/ubuntu bionic-updates/restricted amd64 Packages [1347 kB]
Get:20 http://archive.ubuntu.com/ubuntu bionic-updates/restricted Translation-en [187 kB]
Get:21 http://archive.ubuntu.com/ubuntu bionic-updates/universe amd64 Packages [1914 kB]
Get:22 http://archive.ubuntu.com/ubuntu bionic-updates/universe Translation-en [420 kB]
Get:23 http://archive.ubuntu.com/ubuntu bionic-updates/multiverse amd64 Packages [25.6 kB]
Get:24 http://archive.ubuntu.com/ubuntu bionic-updates/multiverse Translation-en [6088 B]
Get:25 http://archive.ubuntu.com/ubuntu bionic-backports/main amd64 Packages [53.3 kB]
Get:26 http://archive.ubuntu.com/ubuntu bionic-backports/main Translation-en [14.6 kB]
Get:27 http://archive.ubuntu.com/ubuntu bionic-backports/universe amd64 Packages [18.2 kB]
Get:28 http://archive.ubuntu.com/ubuntu bionic-backports/universe Translation-en [8668 B]
Fetched 27.9 MB in 21s (1338 kB/s)
Reading package lists... Done
```

Figure 9.6. apt-get update

12) Execute the following Linux command

```
sudo apt-get install git build-essential gcc pkg-config cmake python
```

```
lv@IPN-PC63013V10:~$ sudo apt-get install git build-essential gcc pkg-config cmake python
Reading package lists... Done
Building dependency tree
Reading state information... Done
The following package was automatically installed and is no longer required:
  libfreetype6
Use 'sudo apt autoremove' to remove it.
The following additional packages will be installed:
  binutils binutils-common binutils-x86-64-linux-gnu cmake-data cpp cpp-7 dpkg-dev fakeroot g++ g++-7 gcc-7 gcc-7-base
  gcc-8-base libalgorithm-diff-perl libalgorithm-diff-xs-perl libalgorithm-merge-perl libarchive3 libasan4 libatomic1
  libbinutils libc-dev-bin libc6-dev libcct0 libcilkrts5 libdpkg-perl libfakeroot libfile-fcntllock-perl
  libgcc-7-dev libgcc libgomp1 libisl19 libitm1 libjsoncpp1 liblsan0 libmpx3 libmpx2 libpython-stlib
  libpython2.7-minimal libpython2.7-stdlib libquadmath0 librhsh0 libssl1.1 libstdc++-7-dev libstdc++6 libstdc++11
  libubsan0 linux-libc-dev make manpages-dev python-minimal python2.7 python2.7-minimal
Suggested packages:
  binutils-doc cmake-doc ninja-build cpp-doc gcc-7-locales debian-keyring g++-multilib g++-7-multilib gcc-7-doc
  libstdc++6-7-dbg gcc-multilib autoconf automake libtool flex bison gdb gcc-doc gcc-7-multilib libgcc1-dbg
  libgomp1-dbg libltdl-dbg libatomic1-dbg libasan4-dbg liblsan0-dbg libubsan0-dbg libcilkrts5-dbg
  libmpx2-dbg libquadmath0-dbg git-daemon-run | git-daemon-sysvinit git-doc git-el git-email git-gui gitk gitweb
  git-cvs git-mediawiki git-svn lrzip glibc-doc bzr libstdc++-7-doc make-doc python-doc python-tk python2.7-doc
  binfmt-support
The following NEW packages will be installed:
  binutils binutils-common binutils-x86-64-linux-gnu build-essential cmake cmake-data cpp cpp-7 dpkg-dev fakeroot g++
```

Figure 9.7. install

When the following screen appears during the process, select OK.

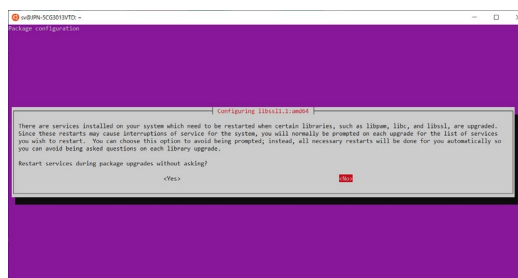


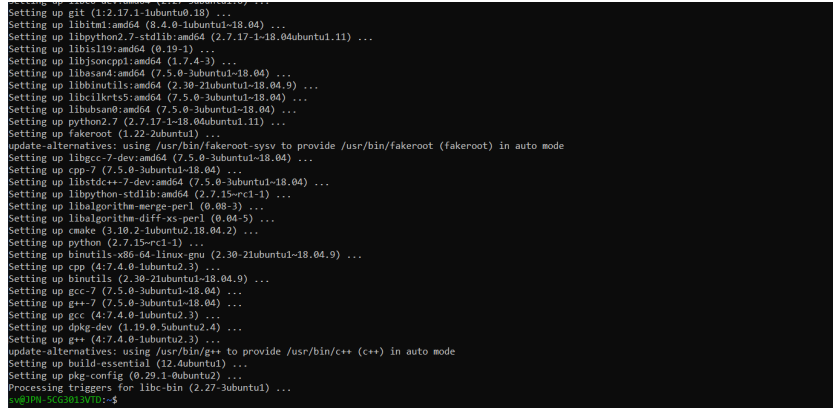
Figure 9.8. restart

13) Execute each of the following commands.

```

sudo apt-get install cmake-curses-gui           # Needed for CMAKE GUI
sudo apt-get install libmbedtls-dev            # For encryption
sudo apt-get install liburcu-dev              # For multithreading
sudo apt-get install check                    # For unit tests
sudo apt-get install python-sphinx graphviz   # For doc generation
sudo apt-get install python-sphinx-rtd-theme  # For doc's style

```



```

Setting up git (1:2.17.1-1ubuntu0.18) ...
Setting up libitm1:amd64 (8.4.0-1ubuntu1-18.04) ...
Setting up libpython2.7-stdlib:amd64 (2.7.17-1-18.04ubuntu1.11) ...
Setting up libisl19:amd64 (0.19-1) ...
Setting up libiconvpp1:amd64 (1.7.4-3) ...
Setting up libassan1:amd64 (7.5.0-3ubuntu1-18.04) ...
Setting up libbinutils:amd64 (2.30-21ubuntu1-18.04.9) ...
Setting up libcilkrts5:amd64 (7.5.0-3ubuntu1-18.04) ...
Setting up libubsan0:amd64 (7.5.0-3ubuntu1-18.04) ...
Setting up python2.7 (2.7.17-1-18.04ubuntu1.11) ...
Setting up fakeroot (1.22-2ubuntu1) ...
update-alternatives: using /usr/bin/fakeroot-sysv to provide /usr/bin/fakeroot (fakeroot) in auto mode
Setting up libgcc-7-dev:amd64 (7.5.0-3ubuntu1-18.04) ...
Setting up cpp-7 (7.5.0-3ubuntu1-18.04) ...
Setting up libstdc++-7-dev:amd64 (7.5.0-3ubuntu1-18.04) ...
Setting up libpython-stdlib:amd64 (2.7.15-rcl-1) ...
Setting up libalgorithm-merge-perl (0.08-3) ...
Setting up libalgorithm-diff-xs-perl (0.04-5) ...
Setting up cmake (3.10.2-1ubuntu2.18.04.2) ...
Setting up python (2.7.15-rcl-1) ...
Setting up binutils-x86_64-linux-gnu (2.30-21ubuntu1-18.04.9) ...
Setting up cpp (4:7.4.0-1ubuntu2.3) ...
Setting up binutils (2.30-21ubuntu1-18.04.9) ...
Setting up gcc-7 (7.5.0-3ubuntu1-18.04) ...
Setting up g++-7 (7.5.0-3ubuntu1-18.04) ...
Setting up gcc (4:7.4.0-1ubuntu2.3) ...
Setting up dpkg-dev (1.19.0.5ubuntu2.4) ...
Setting up g++ (4:7.4.0-1ubuntu2.3) ...
update-alternatives: using /usr/bin/g++ to provide /usr/bin/c++ (c++) in auto mode
Setting up build-essential (12.6ubuntu1) ...
Setting up pkg-config (0.29.1-0ubuntu2) ...
Processing triggers for libc-bin (2.27-3ubuntu1) ...
root@IPM-S0C6M13VTD:~#

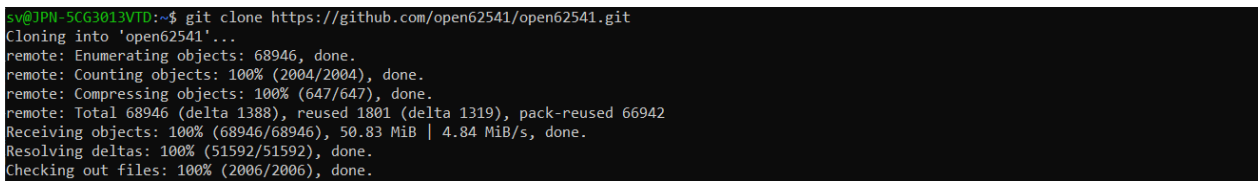
```

Figure 9.9. install

9.1.3 open62541 File Generation

14) Clone open62541 to any folder

```
git clone https://github.com/open62541/open62541.git
```



```

sv@IPM-5CG3013VTD:~$ git clone https://github.com/open62541/open62541.git
Cloning into 'open62541' ...
remote: Enumerating objects: 68946, done.
remote: Counting objects: 100% (2004/2004), done.
remote: Compressing objects: 100% (647/647), done.
remote: Total 68946 (delta 1388), reused 1801 (delta 1319), pack-reused 66942
Receiving objects: 100% (68946/68946), 50.83 MiB | 4.84 MiB/s, done.
Resolving deltas: 100% (51592/51592), done.
Checking out files: 100% (2006/2006), done.

```

Figure 9.10. git clone

15) Go to /open62541 directory and check out the specific version (here, version v1.3.15).

```

cd open62541
git log -1
git checkout 3eed1a6d5c5b207c531b2d35ed88aa0a4a4541e5
git submodule init
git submodule update

```

```

sv@JPN-5CG3013VTD:~$ cd open62541
sv@JPN-5CG3013VTD:~/open62541$ git log -1
commit 6287f33545e3971a73d906e59f3b504b6dc25 (HEAD -> master, origin/master, origin/HEAD)
Merge: 258d6ad84 aa8d96ea5
Author: Julius Pfrommer <jpfr@users.noreply.github.com>
Date: Fri Jul 14 12:13:36 2023 +0200

    Merge pull request #5877 from open62541/1.4

    Merge 1.4 to master
sv@JPN-5CG3013VTD:~/open62541$ git checkout b7e5e49f32d00490be74c2eacef892c7fbd0be60
Checking out files: 100% (3350/3350), done.
Note: checking out 'b7e5e49f32d00490be74c2eacef892c7fbd0be60'.

You are in 'detached HEAD' state. You can look around, make experimental
changes and commit them, and you can discard any commits you make in this
state without impacting any branches by performing another checkout.

If you want to create a new branch to retain commits you create, you may
do so (now or later) by using -b with the checkout command again. Example:

    git checkout -b <new-branch-name>

HEAD is now at b7e5e49f3 [ci skip] Pack with inline submodules
sv@JPN-5CG3013VTD:~/open62541$ git submodule init
Submodule 'deps/mqtt-c' (https://github.com/linnindie/MQTT-C.git) registered for path 'deps/mqtt-c'
sv@JPN-5CG3013VTD:~/open62541$ git submodule update
Cloning into '/home/sv/open62541/deps/mqtt-c'...
Submodule path 'deps/mqtt-c': checked out 'f69ce1e7fd54f3b1834c9c9137ce0ec5d703cb4d'
sv@JPN-5CG3013VTD:~/open62541$ git log -1
commit b7e5e49f32d00490be74c2eacef892c7fbd0be60 (HEAD, origin/pack/v1.3.4)
Author: github-actions[bot] <41898282+github-actions[bot]@users.noreply.github.com>
Date: Mon Nov 14 12:28:23 2022 +0000

    [ci skip] Pack with inline submodules

```

Figure 9.11. git submodule

- 16) Open the Linux folder from File Explorer. Confirm that CMakeLists.txt is present in `/home/(username)/open62541` directory. Copy the following three patch files obtained by unzipping `patch_open62541.zip` attached to the sample software to this directory.

```

diff.patch
Opc.Ua.Renesas.NodeSet2.xml
patch.sh

```

- 17) Execute following command in `/open62541` directory

```
bash patch.sh
```

```

xxxxx @JPN-5CG3013VMD:~/open62541$ bash patch.sh
patching file CMakeLists.txt
patching file tools/schema/Opc.Ua.NodeSet2.Reduced.xml

```

Figure 9.12. command result

- 18) Compile the library according to the standard procedures of the cmake project. Create `/open62541/build` directory and run cmake. (Some items will be Failed, but that is not a problem.)

```

mkdir build && cd build
cmake ..

```

```

xxxxx @JPN-5CG3013VMD:~/open62541/build$ cmake ..
-- The C compiler identification is GNU 9.4.0
-- Check for working C compiler: /usr/bin/cc
-- Check for working C compiler: /usr/bin/cc -- works
-- Detecting C compiler ABI info
-- Detecting C compiler ABI info - done
-- Detecting C compile features
-- Detecting C compile features - done
-- Found Python3: /usr/bin/python3.8 (found version "3.8.10") found components: Interpreter
-- Found Git: /usr/bin/git (found version "2.25.1")
-- open62541: Version: v1.3.4-1-gab7e9a8f8-dirty
-- CMAKE_BUILD_TYPE not given: setting to 'Debug'
-- The selected architecture is: posix
-- Test CC flag -std=c99
-- Performing Test flag_supported
-- Performing Test flag_supported - Success
-- Test CC flag -pipe
-- Performing Test flag_supported
-- Performing Test flag_supported - Success
-- Test CC flag -Wall
-- Performing Test flag_supported
-- Performing Test flag_supported - Success

```

Figure 9.13. cmake

19) Execute the following command to start the cmake setting window.

```
ccmake ..
```

20) After changing the settings as Figure 9.14, press [t] toggle advanced mode and change “UA_ENABLE_NODEMANAGEMENT” to “OFF” and “UA_ENABLE_PUBSUB_ENCRYPTION” to “ON”. After executing [c] to configure, close it by [q] to quit without generating.

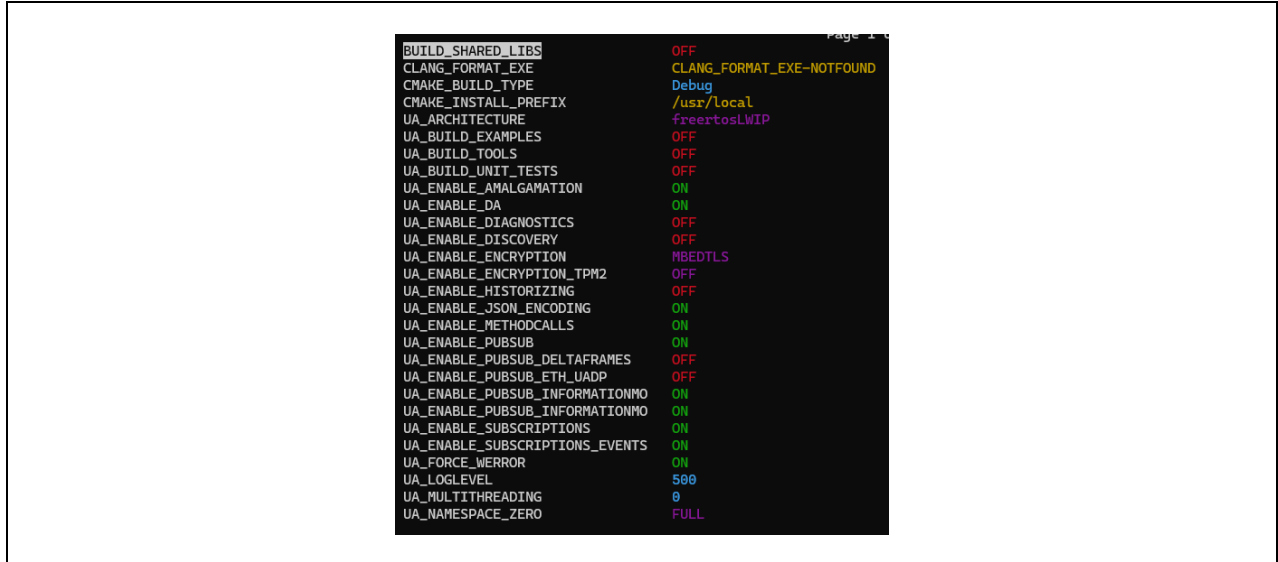


Figure 9.14. cmake configuration

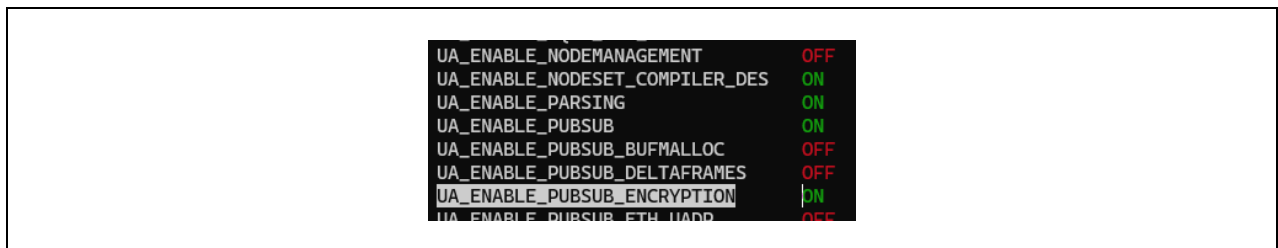


Figure 9.15. cmake advanced configuration

21) Execute the following command to make in the /open62541/build directory. The make process will finish with an error, but it does not matter.

```
make -j
```

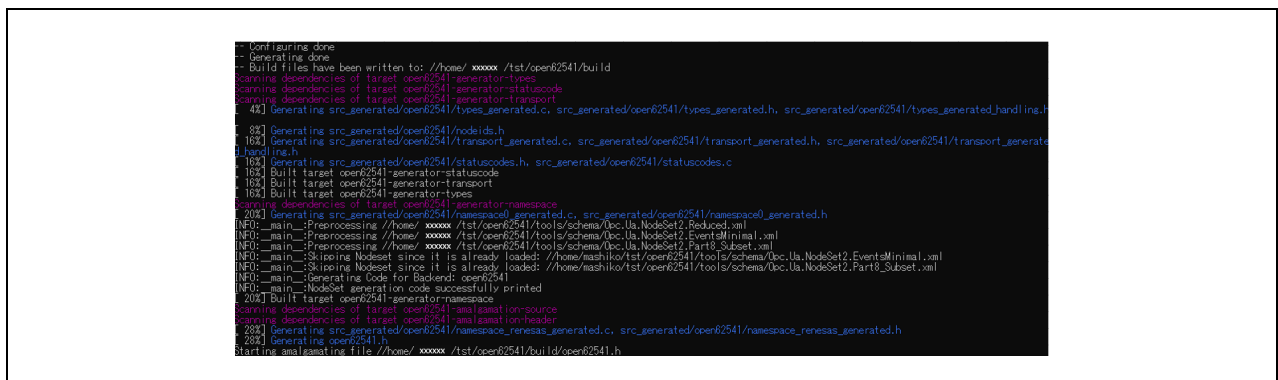


Figure 9.16. make

22) Confirm that the following files are generated in /opn62541/build and ./src_generated/open62541 directories.

- *open62541.c*
- *open62541.h*
- *namespace_renesas_generated.c*
- *namespace_renesas_generated.h*

```

xxxxxx @IPN-50G3013WMM: /opc/open62541/build$ ls -l
total 6048
-rw-r--r-- 1 33687 Sep  4 16:21 OMakeCache.txt
drwxr-xr-x 1 4096 Sep  4 16:47 OMakeFiles
-rw-r--r-- 1 3948 Sep  4 16:19 CPackConfig.cmake
-rw-r--r-- 1 4412 Sep  4 16:19 CPackSourceConfig.cmake
-rw-r--r-- 1 15516 Sep  4 16:47 Makefile
drwxr-xr-x 1 4096 Sep  4 16:47 arch
drwxr-xr-x 1 4096 Sep  4 16:22 bin
-rw-r--r-- 1 5381 Sep  4 16:22 cmake_install.cmake
-rw-r--r-- 1 1008 Sep  4 16:47 compile_commands.json
drwxr-xr-x 1 4096 Sep  4 16:47 doc
drwxr-xr-x 1 4096 Sep  4 16:47 doc-src
-rw-r--r-- 1 4379734 Sep  4 16:22 open62541.c
-rw-r--r-- 1 1687445 Sep  4 16:17 open62541.h
-rw-r--r-- 1 2133 Sep  4 16:21 open62541Config.cmake
-rw-r--r-- 1 1382 Sep  4 16:02 open62541ConfigVersion.cmake
-rw-r--r-- 1 28893 Sep  4 16:02 open62541Macros.cmake
-rw-r--r-- 1 2303 Sep  4 16:22 open62541Targets.cmake
drwxr-xr-x 1 4096 Sep  4 16:47 src_generated
drwxr-xr-x 1 4096 Sep  4 16:02 tools
xxxxxx @IPN-50G3013WMM: ~/opc/open62541/build$ ls -l src_generated/open62541
total 3036
-rw-r--r-- 1 4470 Sep  4 16:21 config.h
-rw-r--r-- 1 1531307 Sep  4 16:22 namespace0_generated.c
-rw-r--r-- 1 1423 Sep  4 16:22 namespace0_generated.h
-rw-r--r-- 1 15600 Sep  4 16:22 namespace_renesas_generated.c
-rw-r--r-- 1 412 Sep  4 16:22 namespace_renesas_generated.h
-rw-r--r-- 1 975379 Sep  4 16:22 nodes.h
-rw-r--r-- 1 18357 Sep  4 16:22 statuscodes.c
-rw-r--r-- 1 32740 Sep  4 16:22 statuscodes.h
-rw-r--r-- 1 9621 Sep  4 16:22 transport_generated.c
-rw-r--r-- 1 3204 Sep  4 16:22 transport_generated.h
-rw-r--r-- 1 8308 Sep  4 16:22 transport_generated_handling.h
-rw-r--r-- 1 245684 Sep  4 16:22 types_generated.c
-rw-r--r-- 1 53239 Sep  4 16:22 types_generated.h
-rw-r--r-- 1 177739 Sep  4 16:22 types_generated_handling.h
xxxxxx @IPN-50G3013WMM: ~/opc/open62541/build$

```

Figure 9.17. Generated Files

23) Store the generated files in package's /common/oss/OPC_UA_SERVER/ folder.

9.1.4 Changes in Generated Files

Several changes have been made to the open62541.c, h file generated by this procedure. The files before the changes are stored in "open62541_before.zip", so if you wish to check the changes, please compare these files with the files in the project.

9.2 TFTP

This sample software has TFTP Server functionality. In the operation check, a Windows PC connected to the evaluation board is used as the TFTP Client. Note that the Windows TFTP Client operation is disabled by default.

TFTP does not allow password setting, so the folder name that files are stored in is used as a simple password. The initial password is "passw0rd", which is defined as "TFTP_PASSWORD" in "tftp_client.h" and can be changed.

9.2.1 File Writing

Launch Command Prompt and change directory to the folder where the files you wish to write reside. As an example, to write "cert_server.der", enter the following command. "Transfer successful" is displayed, then the "cert_server.der" is successfully written to the "<USB_ROOT>/passw0rd" folder of the USB flash drive connected to the evaluation board.

```
tftp -i 192.168.10.100 put cert_server.der passw0rd/cert_server.der
```

9.2.2 File Reading

Launch Command Prompt. As an example, to read "<USB_ROOT>/passw0rd/cert_server.der" from the USB flash drive, enter the following command. If the read is successful, the message "Transfer successful" will be displayed and "cert_server.der" will be stored in the current directory.

```
tftp -i 192.168.10.100 get passw0rd/cert_server.der
```

9.3 LLDP, SNMP MIB

Table 9.1 shows the LLDP functionality and the corresponding MIB of this sample software.

Table 9.1. Supported LLDP and MIB

TLV Type	TLV name	TLV Variable	Transmit Contents	LLDP Local System MIB object	LLDP Remote System MIB object
0	End of LLDPDU	-	-	-	-
1	Chassis ID	chassis ID subtype	MAC address	lldpLocChassisIdSubtype	lldpRemChassisSubtype
		chassis ID	"00:11:22:33:44:55"	lldpLocChassisId	lldpRemChassisId
2	Port ID	port ID subtype	Interface name	lldpLocPortIdSubtype	lldpRemPortIdSubtype
		port ID	"PORT 1" or "PORT 2"	lldpLocPortId	lldpRemPortId
3	Time To Live	Seconds	120	-	-
4	Port description	Port description	"PORT 1" or "PORT 2"	lldpLocPortDesc	lldpRemPortDesc
5	System name	System name	"OPC UA Server/PubSub"	lldpLocSysName	lldpRemSysName
6	System description	System description	"Renesas Electronics Corporation OPC UA Sample"	lldpLocSysDesc	lldpRemSysDesc
7	System capabilities	system capabilities	Station only (bit7=1)	lldpLocSysCapSupported	lldpRemSysCapSupported
		enabled capabilities	Station only (bit7=1)	lldpLocSysCapEnabled	lldpRemSysCapEnabled
8	Management address	management address length	5	lldpLocManAddrLen	-
		management address subtype	IPv4	lldpLocManAddrSubtype	lldpRemManAddrSubtype
		management address	192.168.10.100	lldpLocManAddr	lldpRemManAddr
		interface numbering subtype	systemPortNumber	lldpLocManAddrIfSubtype	lldpRemManAddrIfSubtype
		interface number	1 or 2	lldpLocManAddrIfId	lldpRemManAddrIfId
		OID	1.3.6.1.4.1.26381	lldpLocManAddrOID	lldpRemManAddrOID

9.4 When configuring OPC UA PubSub settings using the Method

This chapter explains how to configure OPC UA PubSub settings using Method. When configuring PubSub settings using Method, note that this software is limited in that the layout for Pub or Sub cannot be freely configured; it uses a specific custom layout. Therefore, when communicating with other devices, the communication counterpart must match this layout. Additionally, PubSub communication using this feature only supports security None.

9.4.1 Publisher

The role of each device when checking OPC UA Publisher operation is shown in Figure 9.18.

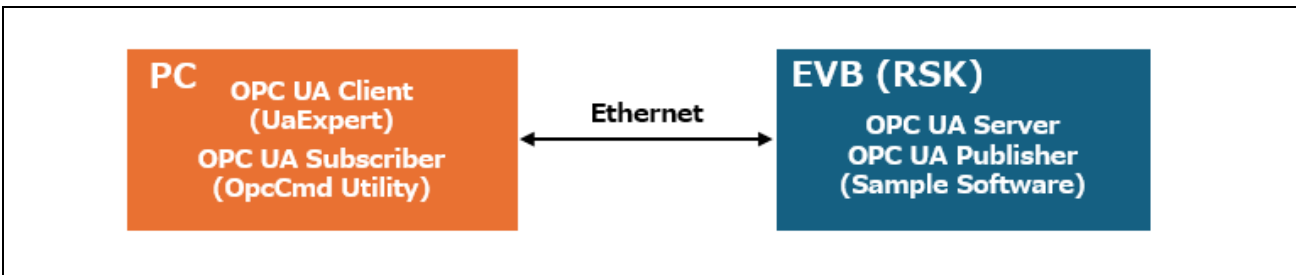


Figure 9.18. Connection Block Diagram for OPC UA Publisher

After connecting as shown in chapter 4, perform the operation check using the following procedure.

- Launch and connect to UaExpert

Connect UaExpert to the OPC UA Server using the same procedure as in chapter 7.2.1.

Right-click on the "Root>Objects>Server>PublishSubscribe>PublishedDataSets>AddPublishedDataItems" Node in the Object tree of the Address Space window and click on the "Call..." that appears.

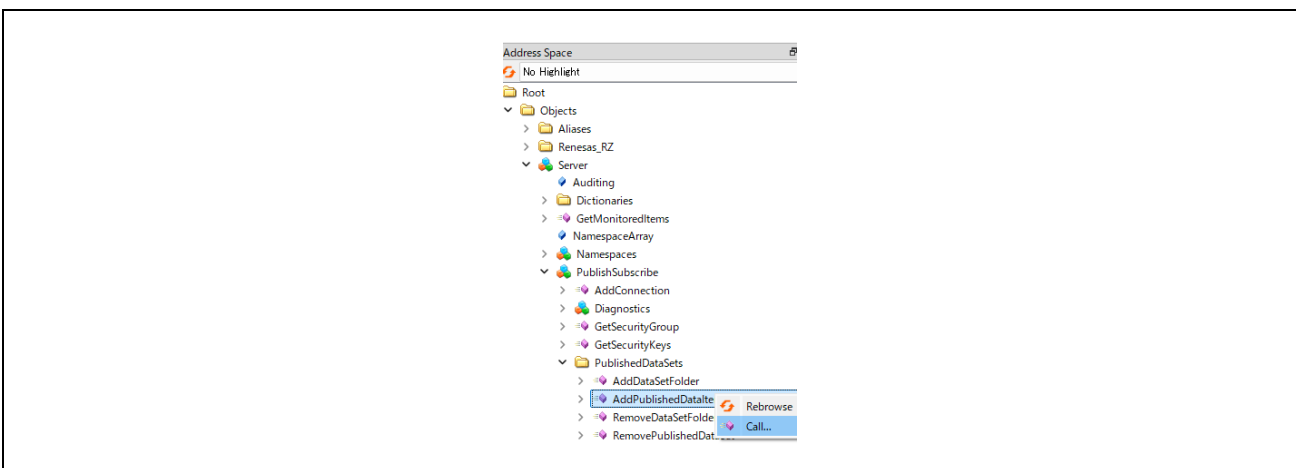


Figure 9.19. Address Space Window

In the window that appears, enter the information for the Node you wish to Publish and click Call. Figure 9.20 shows an example of two settings, Boolean(NS=2, ID=6049) and DateTime(NS=2, ID=6052).

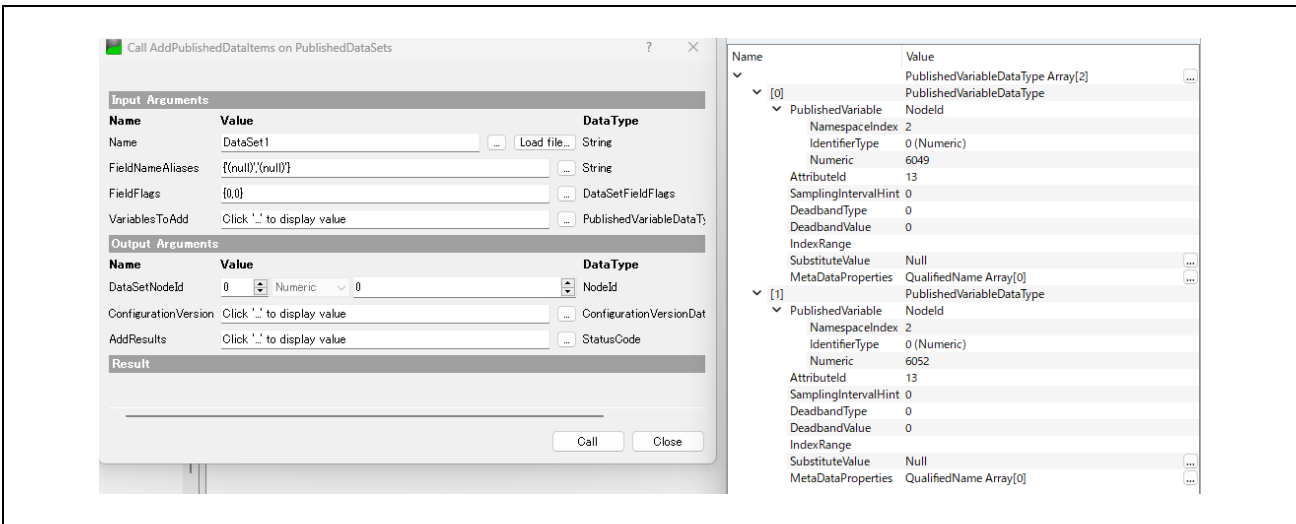


Figure 9.20. Call AddPublishedDataItems

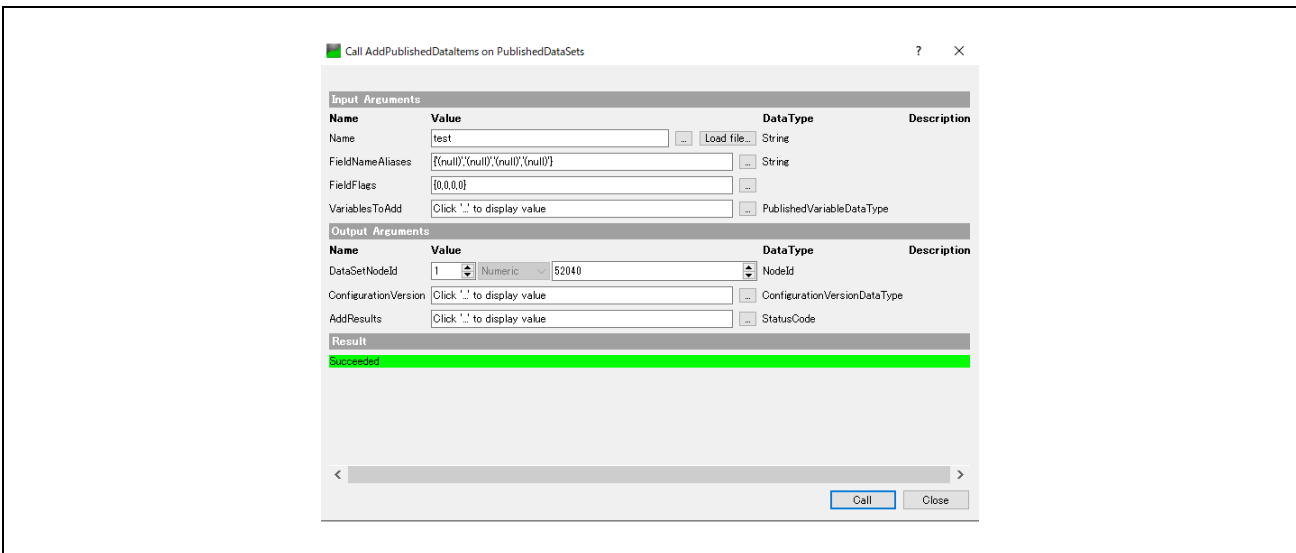


Figure 9.21. Call Result

Right-click on the "Root>Objects>Server>PublishSubscribe> AddConnection" Node and click on the "Call..." that appears.

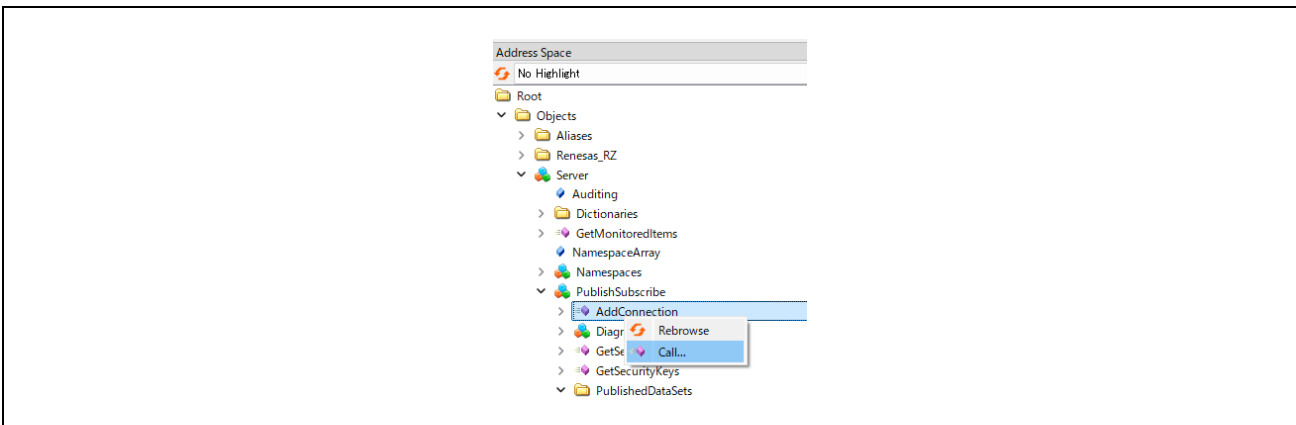


Figure 9.22 Address Space Window

In the window that appears, enter the information for each field as shown in the image below, then click “Call.”

TransportProfileUri: <http://opcfoundation.org/UA-Profile/Transport/pubsub-udp-uadp>

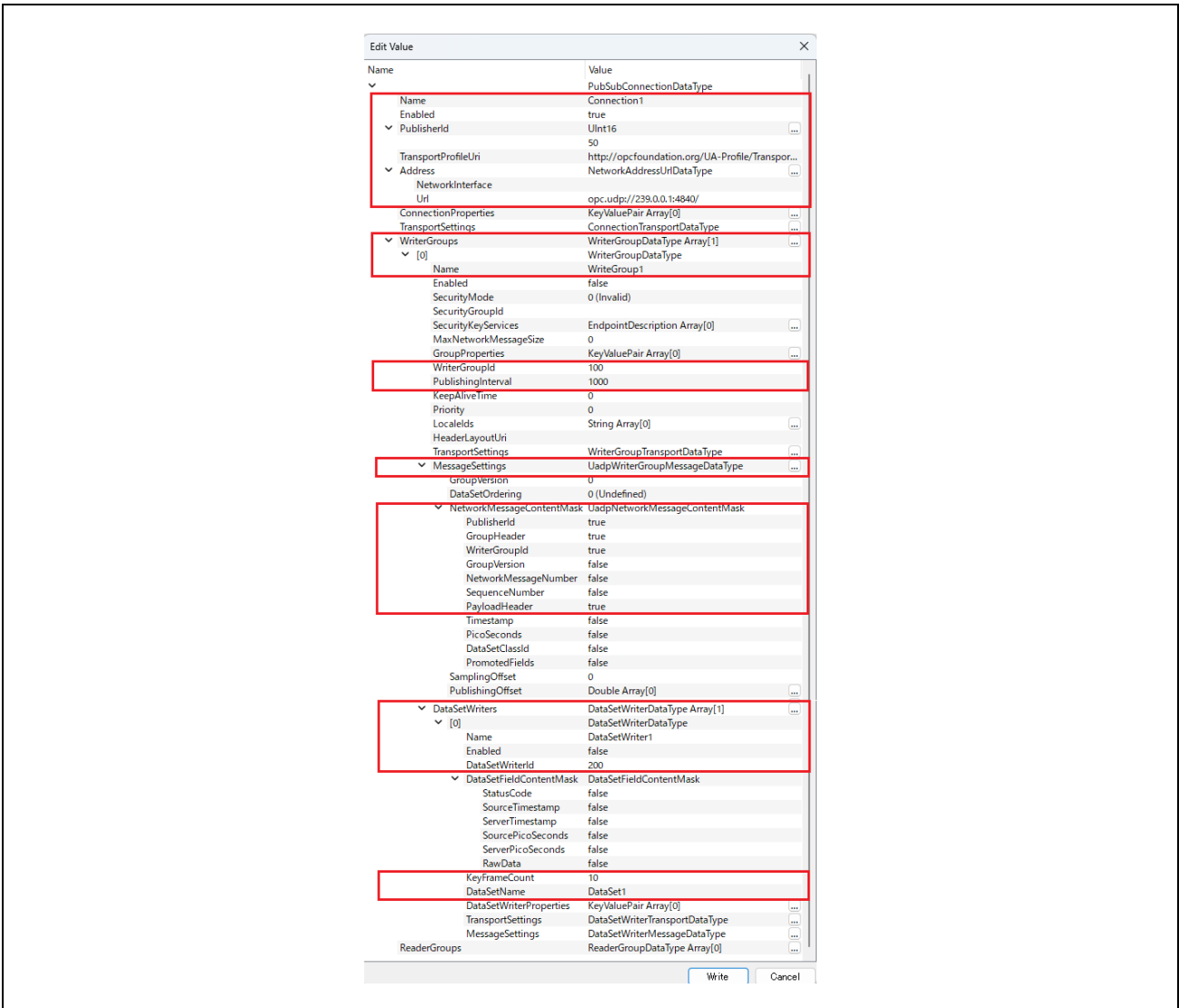


Figure 9.23. Call AddConnection

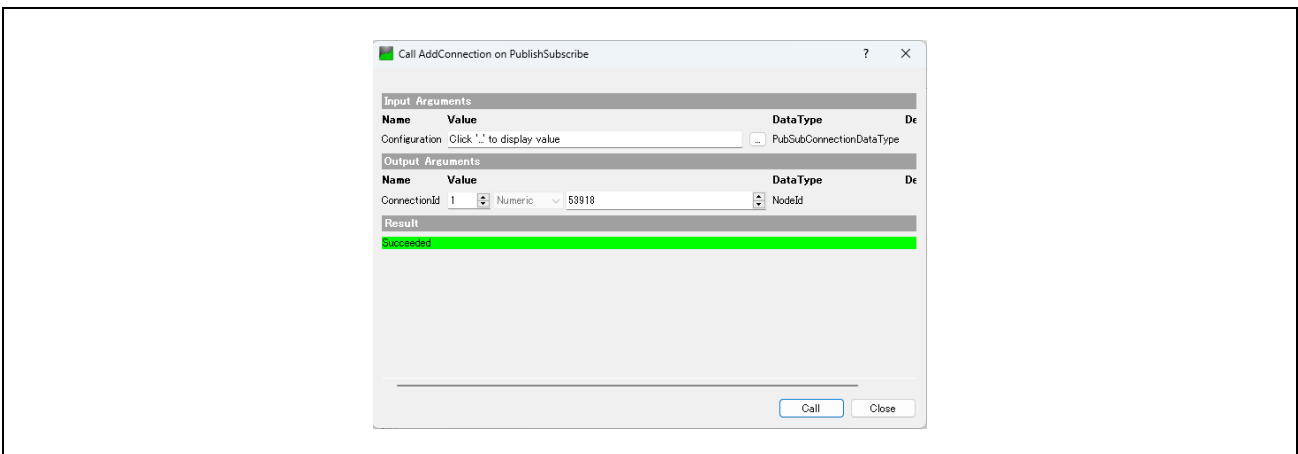


Figure 9.24. Call Result

If the method call is successful, publishing will begin.

- Launch OpcCmd Utility

Launch Command prompt and change directory to the OpcCmd Utility folder. Enter the following command. This command is to subscribe to all published messages. Subscribing will continue for one minute.

```
OpcCmd uaSubscriber subscribeDataSet -cru opc.tcp://192.168.1.100:4840
```

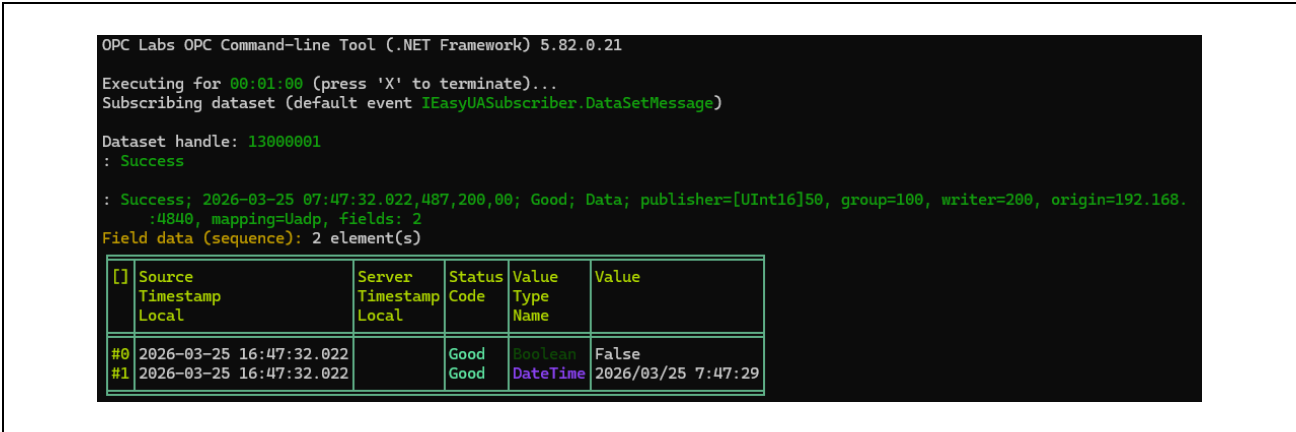


Figure 9.25. Command Execution Result

9.4.2 Subscriber

The role of each device when checking OPC UA Publisher operation is shown in Figure 9.26. In this test, a single evaluation board serves as both the Publisher and the Subscriber.

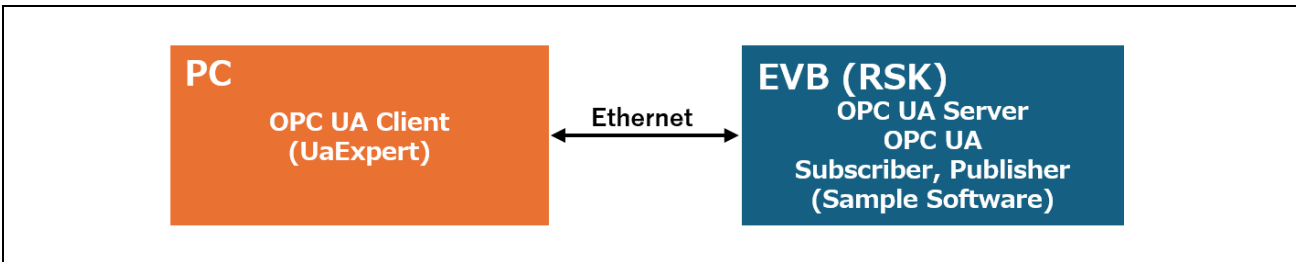


Figure 9.26. Connection Block Diagram for OPC UA Subscriber

- Operation check

Start the Publish process following the same procedure as in chapter 9.4.1.

Right-click on the "Root>Objects>Server>PublishSubscribe>AddConnection" Node in the Object tree of the Address Space window and click on the "Call..." that appears.

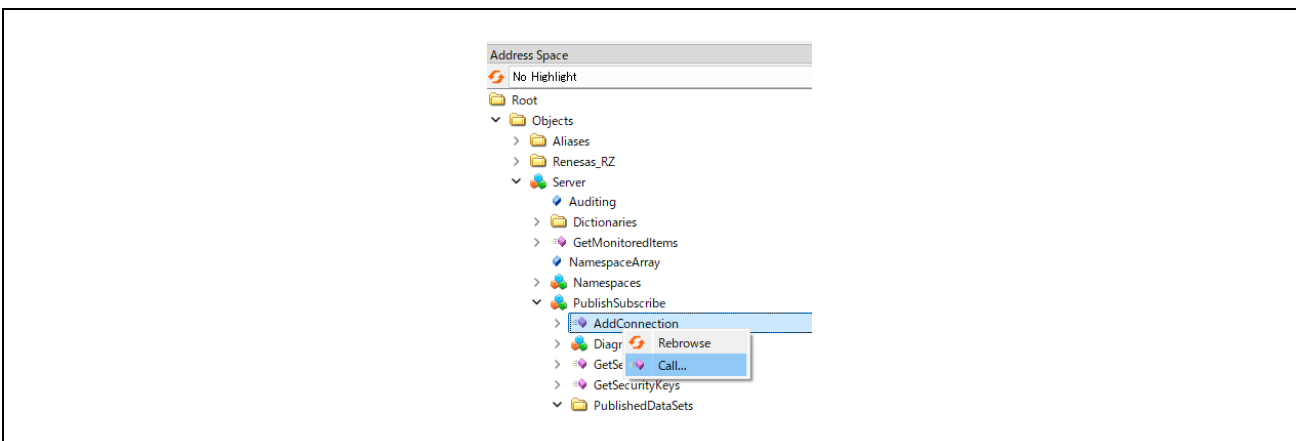


Figure 9.27. Address Space Window

In the window that appears, enter the information for each field as shown in the images below, then click “Call.”

TransportProfileUri: <http://opcfoundation.org/UA-Profile/Transport/pubsub-udp-uadp>

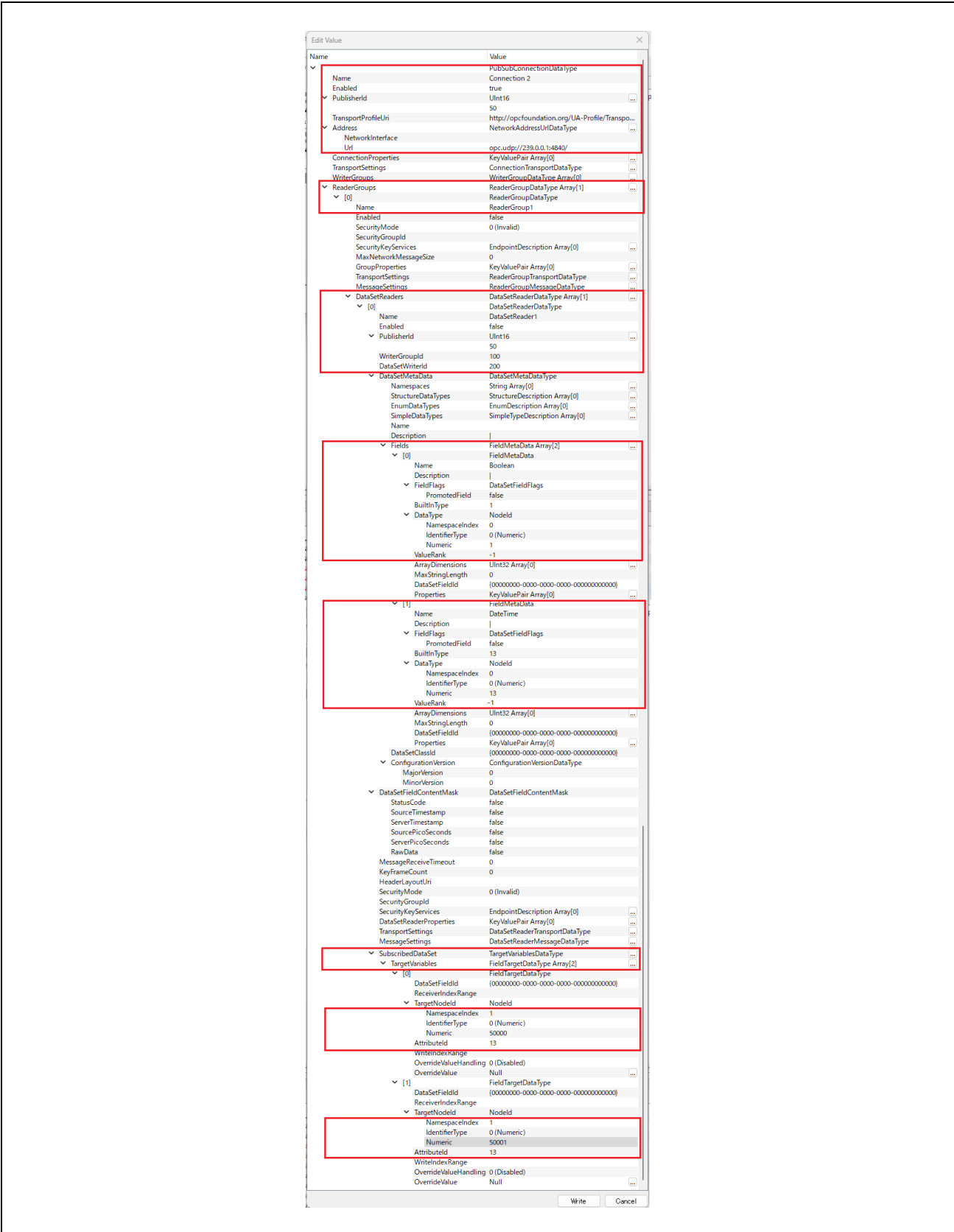


Figure 9.28. Call AddConnection

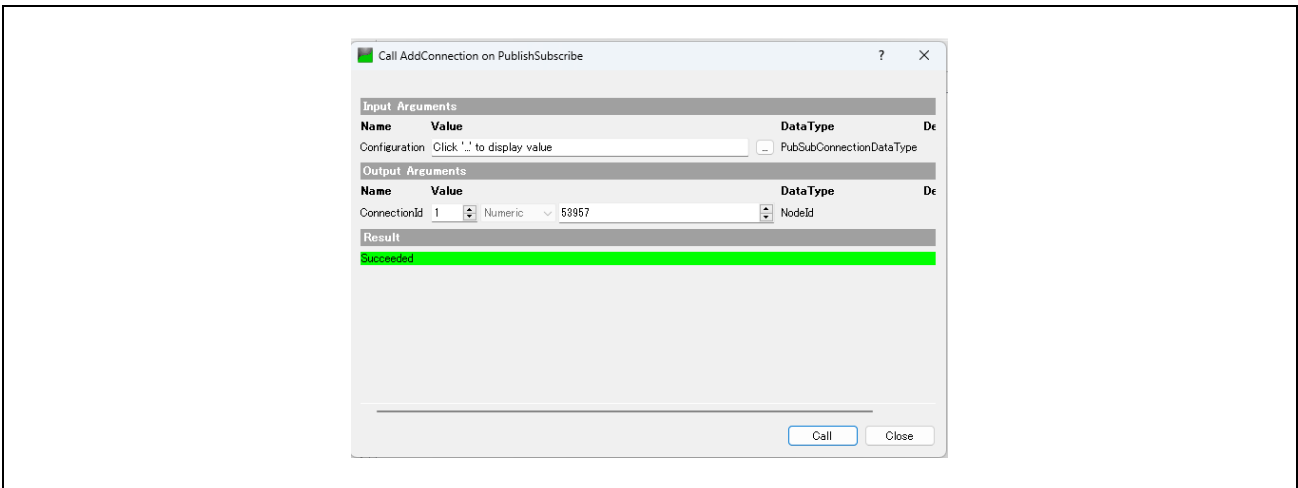


Figure 9.29. Call Result

After successful call method, right-click on "Root" in the Address Space Window of UaExpert and click "Rebrowse". You will see that new Nodes have been added, as shown in Figure 9.31. These are the Nodes for storing the subscribed information.

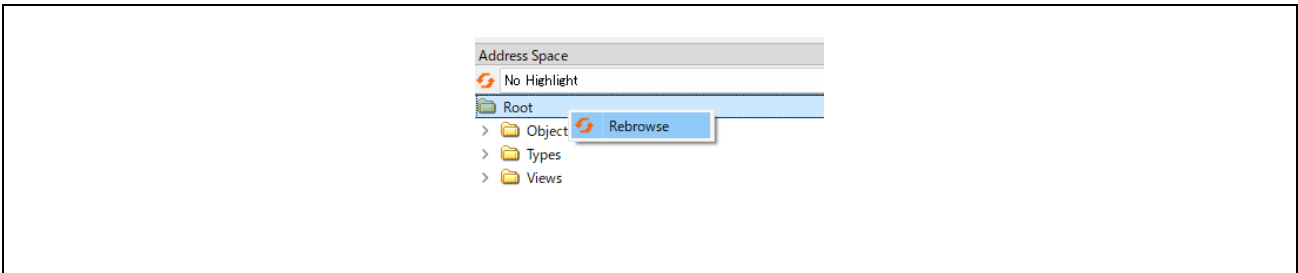


Figure 9.30. Rebrowse on UaExpert

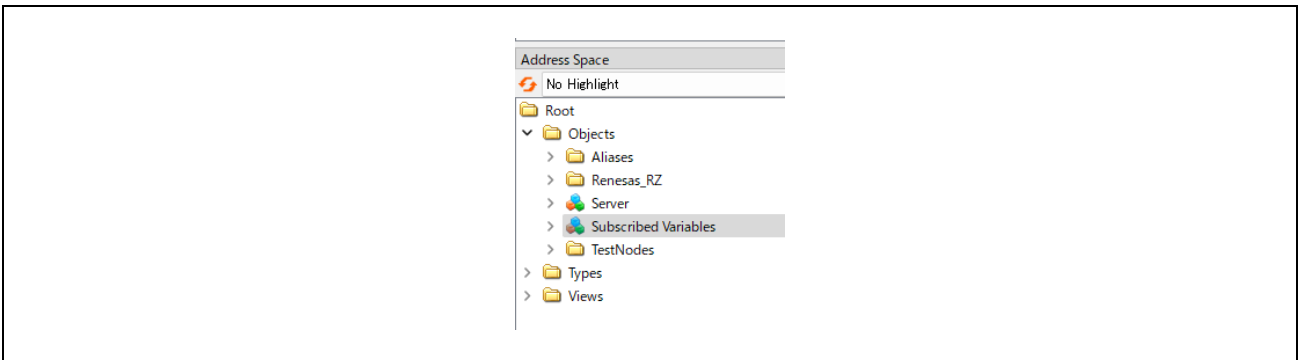


Figure 9.31. "Subscribed_Variables" Node

Checking this Node in the Data Access View, we can confirm that the values are updated periodically and that it is successfully subscribed.

#	Server	Node Id	Display Name	Value	Datatype
1	Test_N2L...	NS1 Numeric 50000	Boolean	true	Boolean 1;
2	Test_N2L...	NS1 Numeric 50001	DateTime	2026-03-25T08:16:59.547Z	DateTime 1;

Figure 9.32. Check the added Node Values

9.5 Configuration for launching FSP Smart Configurator from EWARM

Please follow the steps below to configure the settings.

1. Click “Tools -> Configure Tools...” in EWARM.
2. Select “New” and enter the following information for each field.
 - Menu Text: FSP Smart Configurator
 - Command: \$RASC_EXE_PATH\$
 - Argument: --compiler IAR configuration.xml
 - Initial Directory: \$PROJ_DIR\$

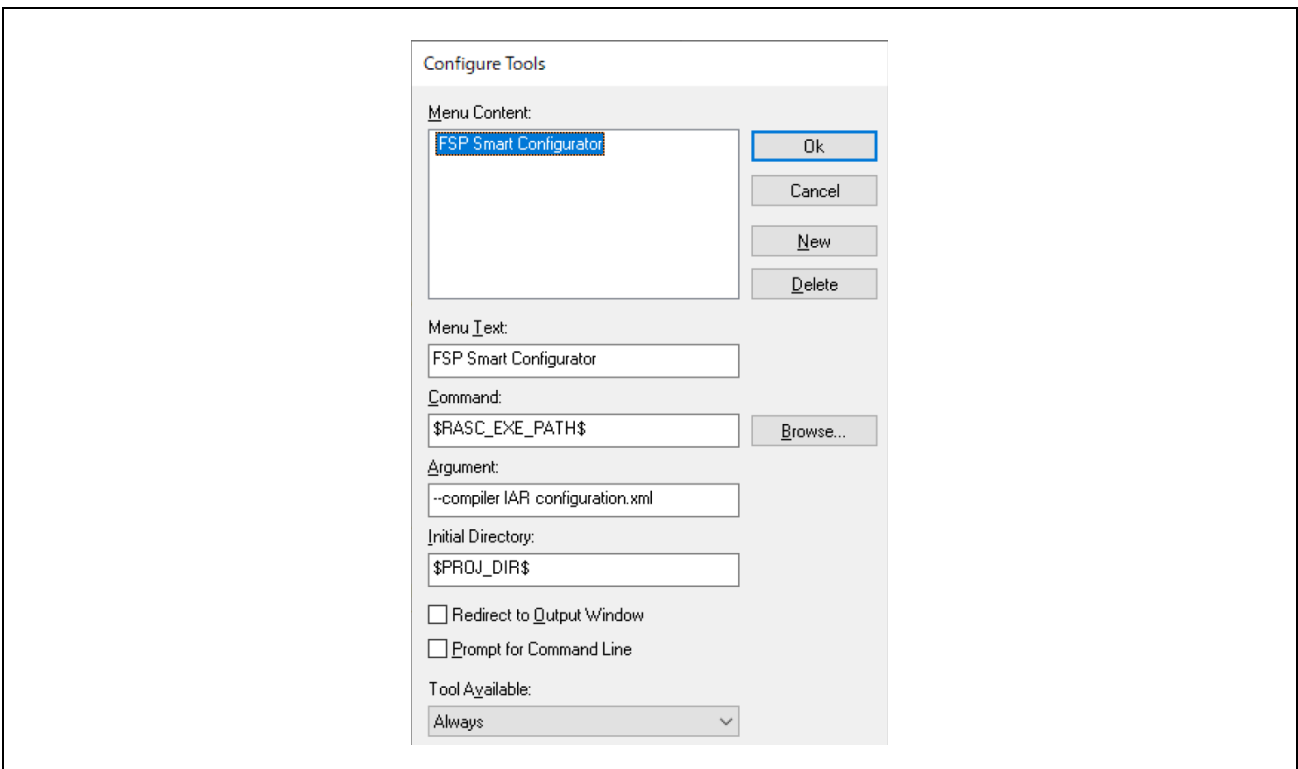


Figure 9.33. Settings “Configure Tools”

3. Open the buildinfo.ipcf file and enter the “FSP Smart Configurator” path in the “RASC_EXE_PATH” field.

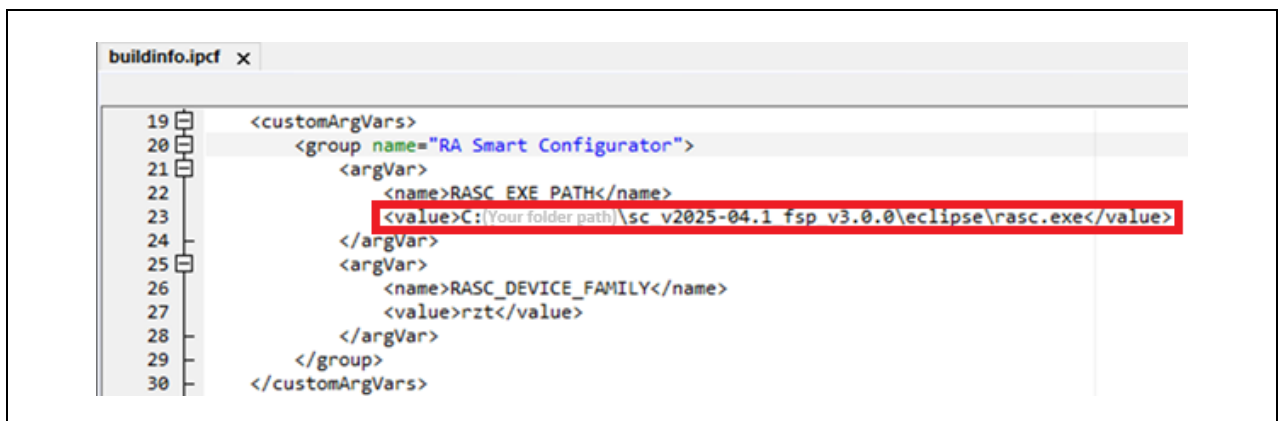


Figure 9.34. buildinfo.ipcf

9.6 How to Change Various Settings in the Sample Software

The following outlines the procedure for changing various settings in the sample software from their default values.

9.6.1 When using e² studio

For dual-core project, select the secondary project and configure its settings.

Select the project name in the Project Explorer window, then open Properties in the Project menu.

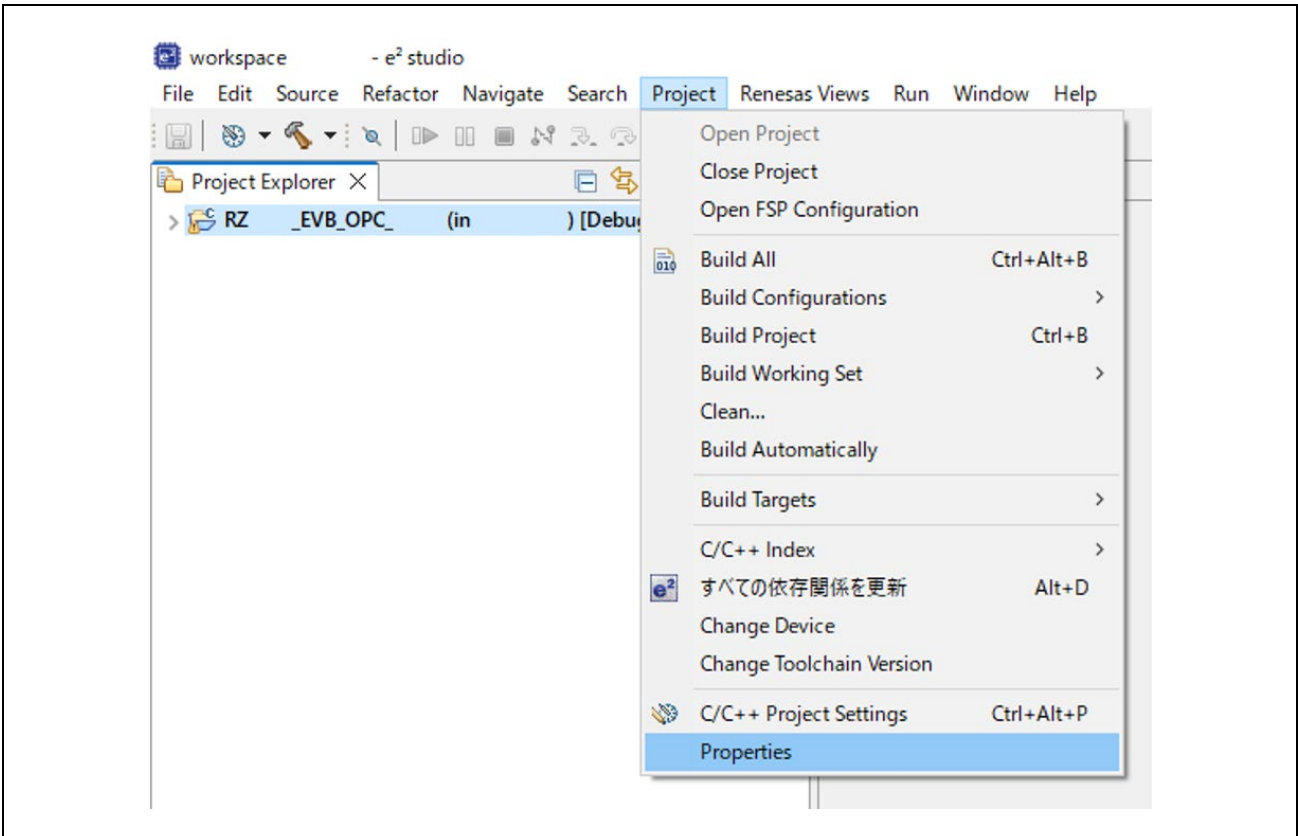


Figure 9.35. Open project properties

Select "GNU C" from the "#Symbols" tag in "C/C++General" > "Paths and Symbols".

Here you can enable/disable various functions and configure settings. Details are shown in Table 9.2.

Table 9.2. Symbol Settings

Symbol Name	Description	Parameter	Initial Value
IPADR1, 2, 3, 4	IP Address Definition	Any IP address	192, 168, 10, 100
IPADR4_NTPServer	The lower 8 bits of the IP address of the NTP server to connect to. * The upper 24 bits are IPADR1, 2, and 3.	IP address of NTP server	20
ENABLE_PUBSUB_OVER_MQTT	Enable PubSub over MQTT functionality * Currently, only 0: Disabled is supported.	0: Disable 1: Enable	0
ENABLE_PUBSUB_OVER_UADP	Enable PubSub over UADP functionality	0: Disable 1: Enable	1
TRUSTLIST_SIZE_MAX	Maximum number of TrustList *Change according to the number of OPC UA Client to be connected.	Any number	32
REVOCACTIONLIST_SIZE_MAX	Maximum number of RevocationList *Change according to the number of CRL files stored.	Any number	8
ISSUERLIST_SIZE_MAX	Maximum number of IssuerList *Change according to the number of Issuer files stored.	Any number	8
ENABLE_FREERTOS_PLUS_FAT	Enable FreeRTOS+FAT, TFTP functionality * If disabled, key files embedded in the source code (keyfiles.h) will be used for security functions.	0: Disable 1: Enable	1

To change the IP address, change the values of #IPADR1, 2, 3, and 4 here.

After changing the various settings, click “Apply and Close” to apply the settings. Click "Rebuild Index" in the pop-up dialog.

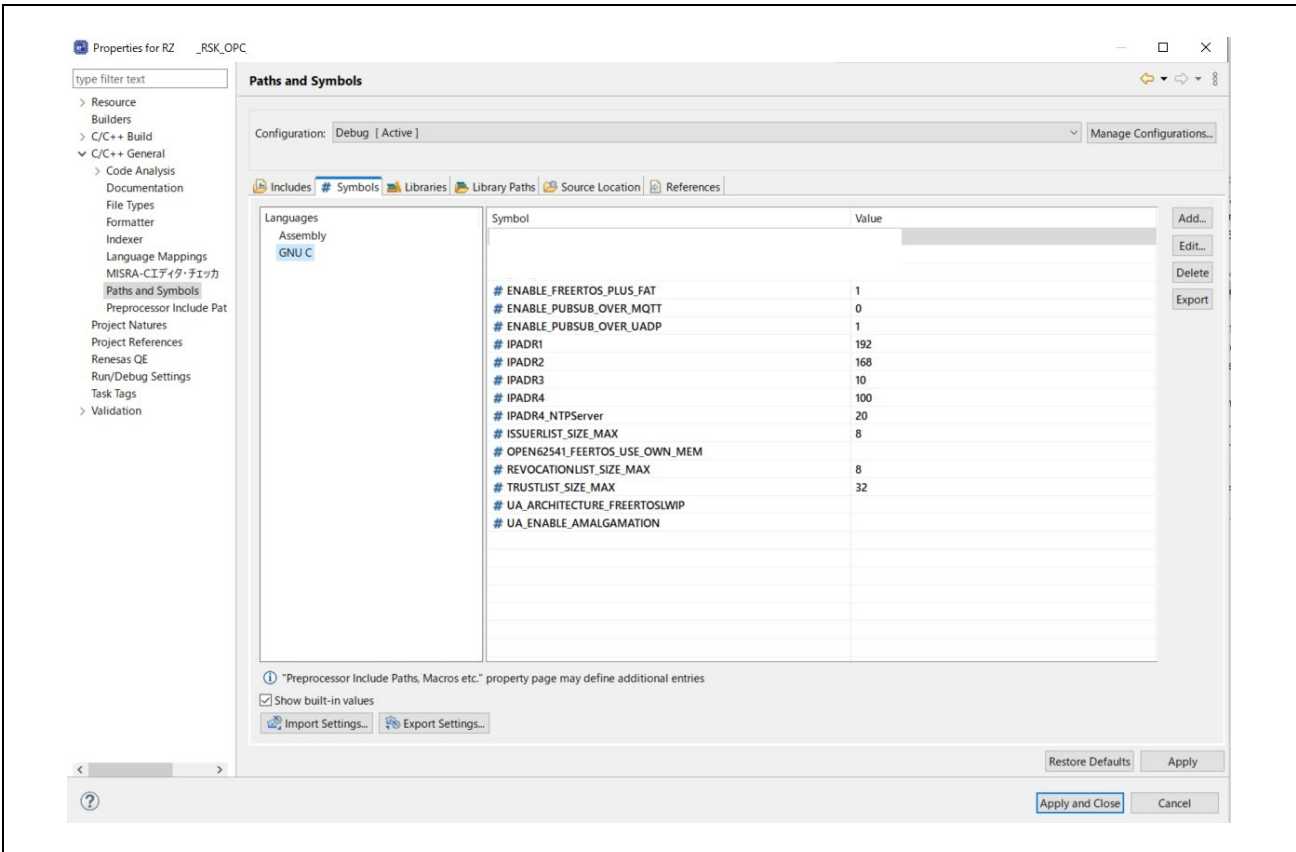


Figure 9.36. Change Build Options

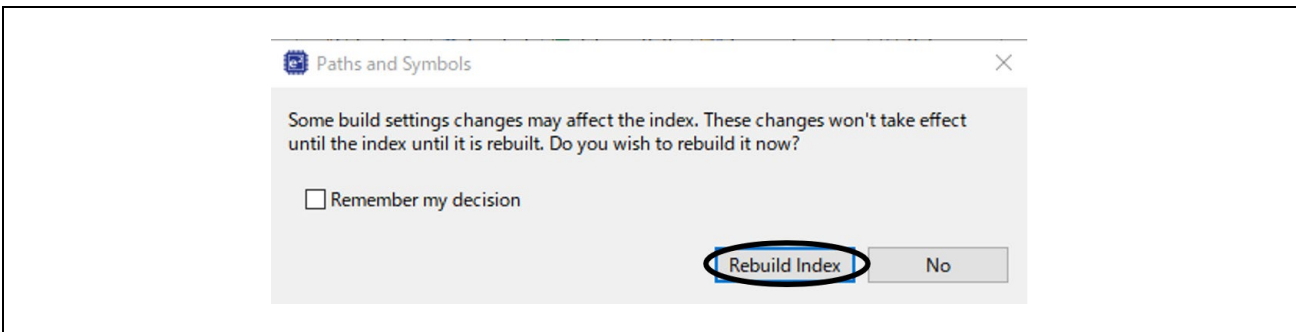


Figure 9.37. Click “Rebuild index”

To change the MAC address, follow the steps below.

Open the Smart Configurator by double-clicking configuration.xml from the tree shown in Figure 9.38. For dual-core project, select the configuration.xml for the secondary project.

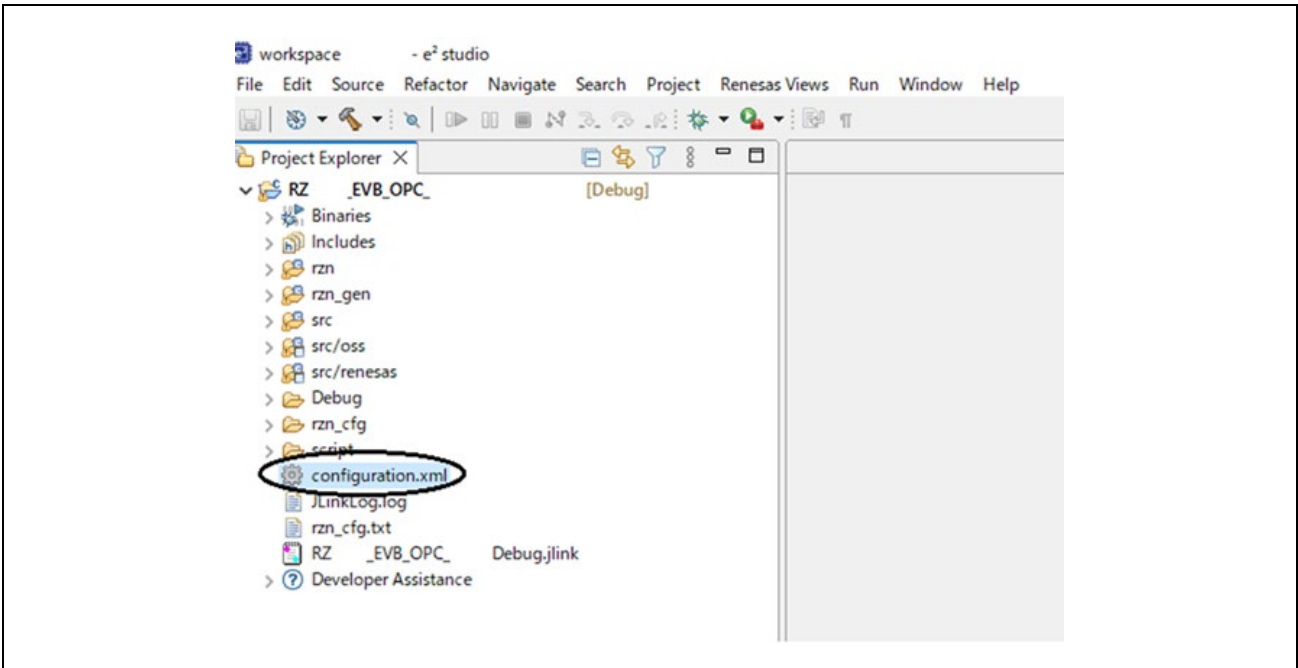


Figure 9.38. Double click configuration.xml

Open the “Stacks” tag and click on “g_ether0 Ethernet”.

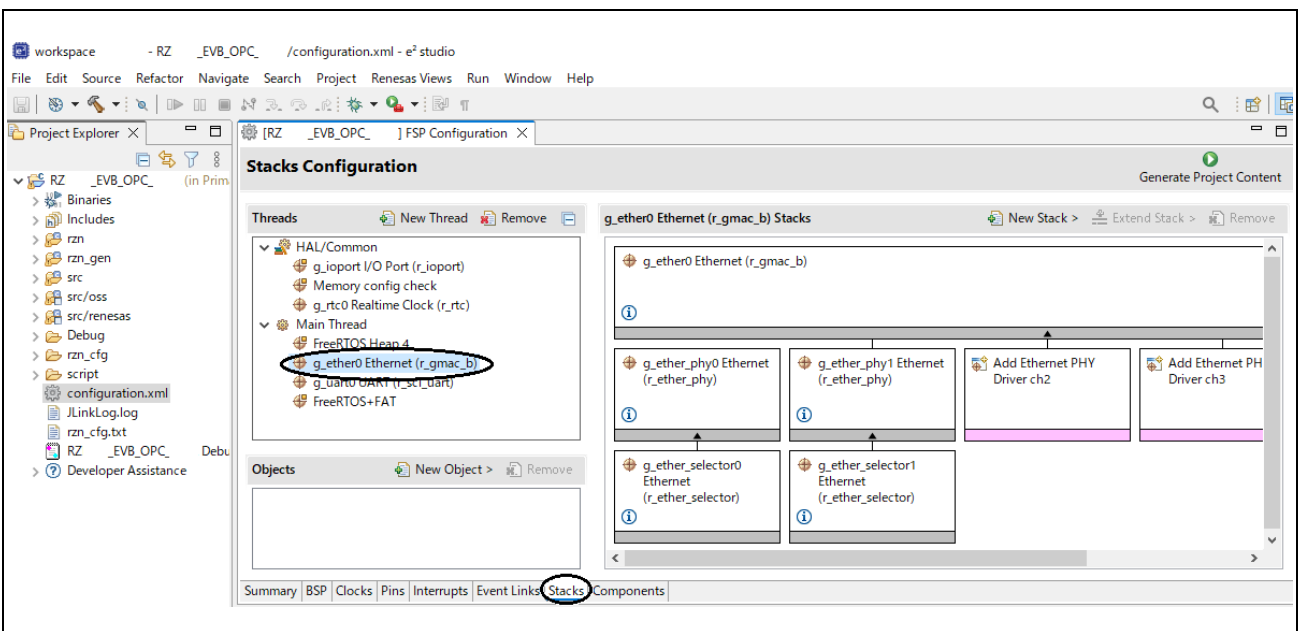


Figure 9.39. Click g_ether0

Then open the Navigate menu and click “Show In”>“Properties”.

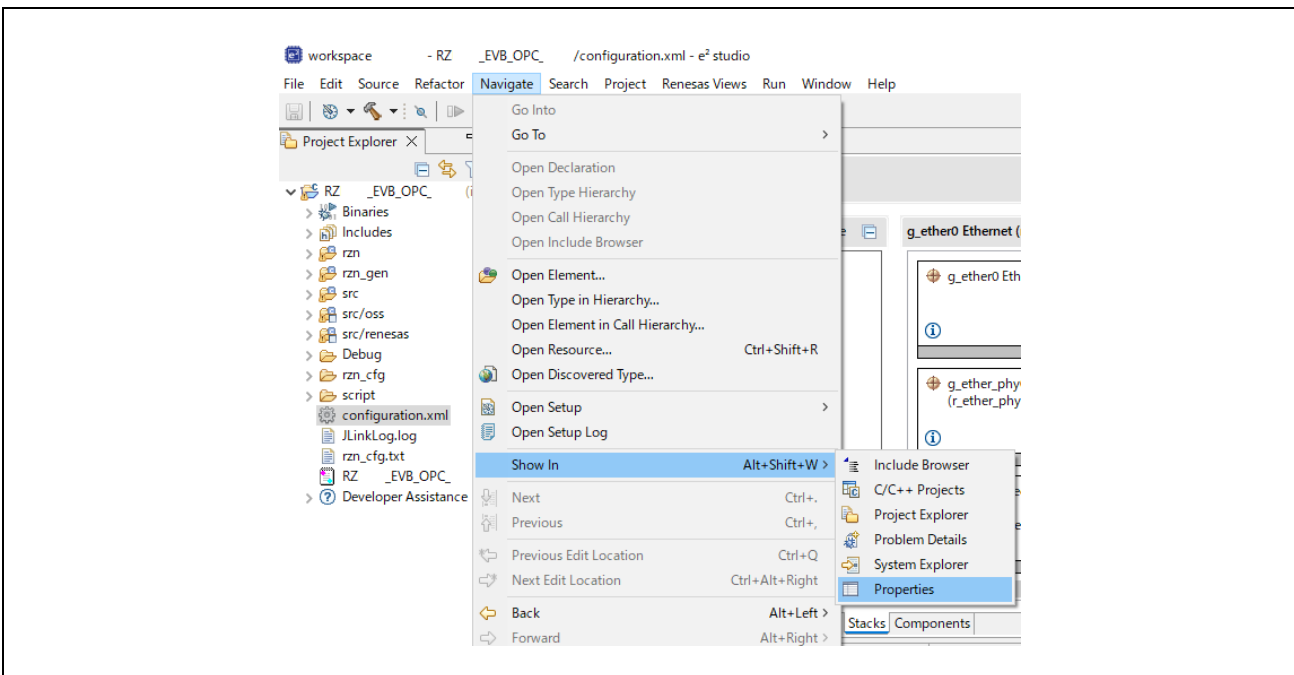


Figure 9.40. Click Properties

Open the Properties and enter General>MAC address0 (e.g. 74:90:50:10:F9:ED).
Click “Generate Project Content” after entering the address.

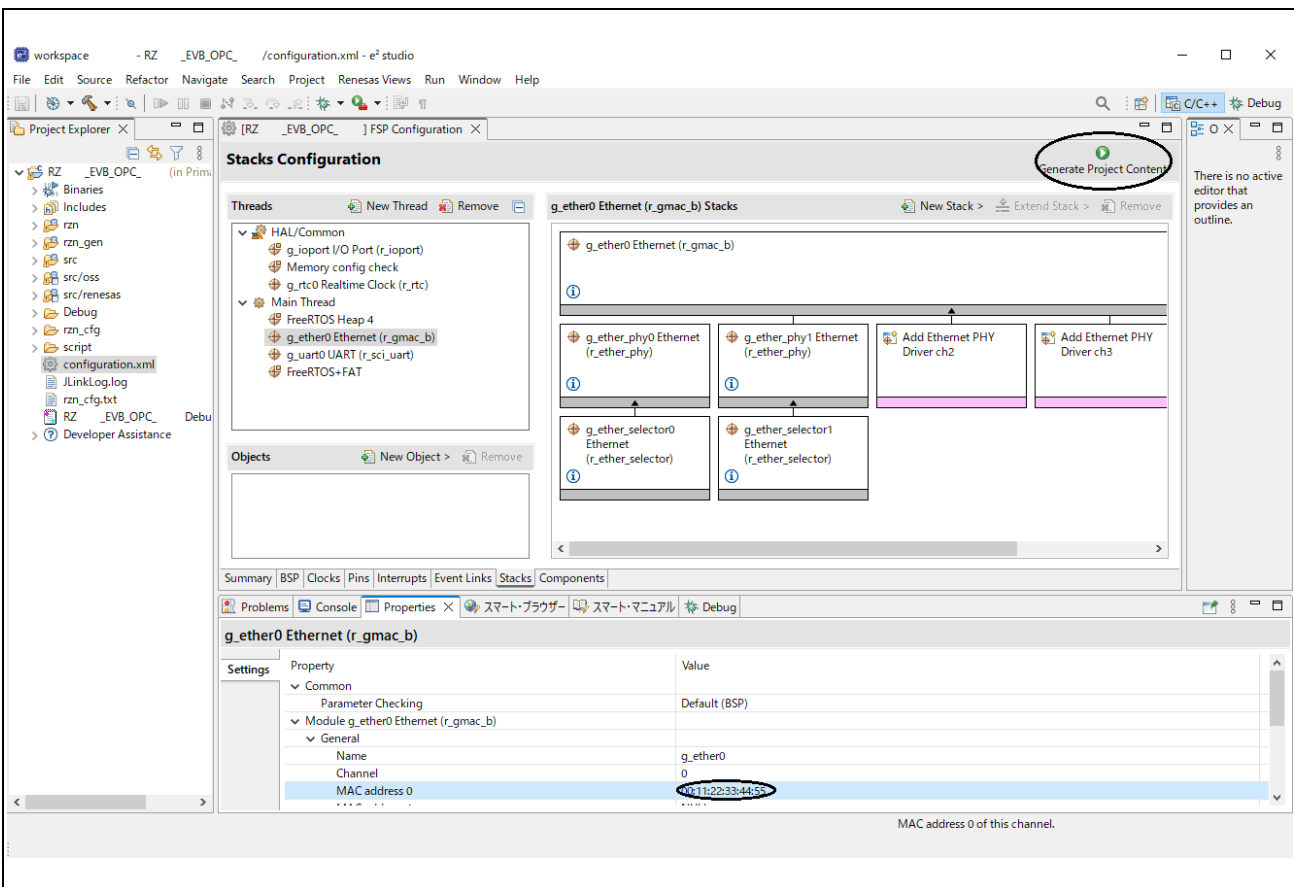


Figure 9.41. Enter MAC address

Additionally, when using the PubSub feature, please modify the definitions in `opc_pubsub_uadp.h`.

Table 9.3. `opc_pubsub_uadp.h` defines

Defines	Description	Parameter	Initial Value
UADP_LAYOUT	Selecting the Layout for the PubSub Example Configuration	UADP_FIXED_LAYOUT: Periodic Fixed Layout UADP_DYNAMIC_LAYOUT: Dynamic Layout	UADP_FIXED_LAYOUT
ENABLE_PUBSUB_EXAMPLE_SETTING	Enabling the PubSub Example Configuration	PUBSUB_EXAMPLE_DISABLE: Disable PUBSUB_EXAMPLE_ENABLE: Enable, No encryption PUBSUB_EXAMPLE_ENABLE_AES128: Enable, Encrypted (AES128-CTR) PUBSUB_EXAMPLE_ENABLE_AES256: Enable, Encrypted (AES256-CTR)	PUBSUB_EXAMPLE_DISABLE

```

1  #define UADP_FIXED_LAYOUT 1
2  #define UADP_DYNAMIC_LAYOUT 2
3  #define UADP_LAYOUT UADP_FIXED_LAYOUT /* Select Fixed or Dynamic */
4
5  #define PUBSUB_EXAMPLE_DISABLE 0 /* Diable pubsub example config */
6  #define PUBSUB_EXAMPLE_ENABLE 1 /* Enable pubusub example config without security */
7  #define PUBSUB_EXAMPLE_ENABLE_AES128 2 /* Enable pubusub example config with security (PubSub-Aes128-CTR) */
8  #define PUBSUB_EXAMPLE_ENABLE_AES256 3 /* Enable pubusub example config with security (PubSub-Aes256-CTR) */
9
10 #define ENABLE_PUBSUB_EXAMPLE_SETTING PUBSUB_EXAMPLE_DISABLE /* Select 0-3 */

```

Figure 9.42. `opc_pubsub_uadp.h`

9.6.2 When using EWARM

*For dual-core project, select the secondary project and configure its settings.

Select the project name in the Workspace window, then open “Options...” in the Project menu.

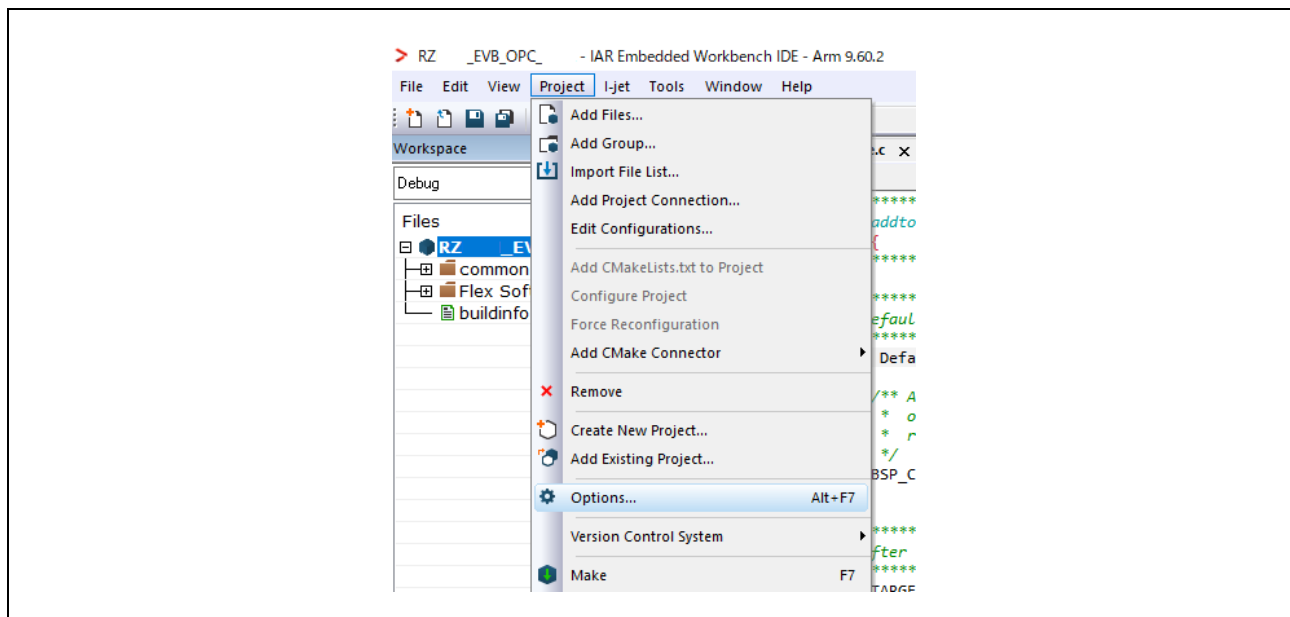


Figure 9.43. Open Options

Various functions can be enabled/disabled and configured in “Defined symbols” in “C/C++ Compiler” > “Preprocessor”. Details are shown in Table 9.4.

Table 9.4. Symbol Settings

Symbol Name	Description	Parameter	Initial Value
IPADR1, 2, 3, 4	IP Address Definition	Any IP address	192, 168, 10, 100
IPADR4_NTPServer	The lower 8 bits of the IP address of the NTP server to connect to. * The upper 24 bits are IPADR1, 2, and 3.	IP address of NTP server	20
ENABLE_PUBSUB_OVER_MQTT	Enable PubSub over MQTT functionality * Currently, only 0: Disabled is supported.	0: Disable 1: Enable	0
ENABLE_PUBSUB_OVER_UADP	Enable PubSub over UADP functionality	0: Disable 1: Enable	1
TRUSTLIST_SIZE_MAX	Maximum number of TrustList *Change according to the number of OPC UA Client to be connected.	Any number	32
REVOCACTIONLIST_SIZE_MAX	Maximum number of RevocationList *Change according to the number of CRL files stored.	Any number	8
ISSUERLIST_SIZE_MAX	Maximum number of IssuerList *Change according to the number of Issuer files stored.	Any number	8
ENABLE_FREERTOS_PLUS_FAT	Enable FreeRTOS+FAT, TFTP functionality * If disabled, key files embedded in the source code (keyfiles.h) will be used for security functions.	0: Disable 1: Enable	1

To change the IP address, change the values of #IPADR1, 2, 3, and 4 here.

After changing various settings, click OK.

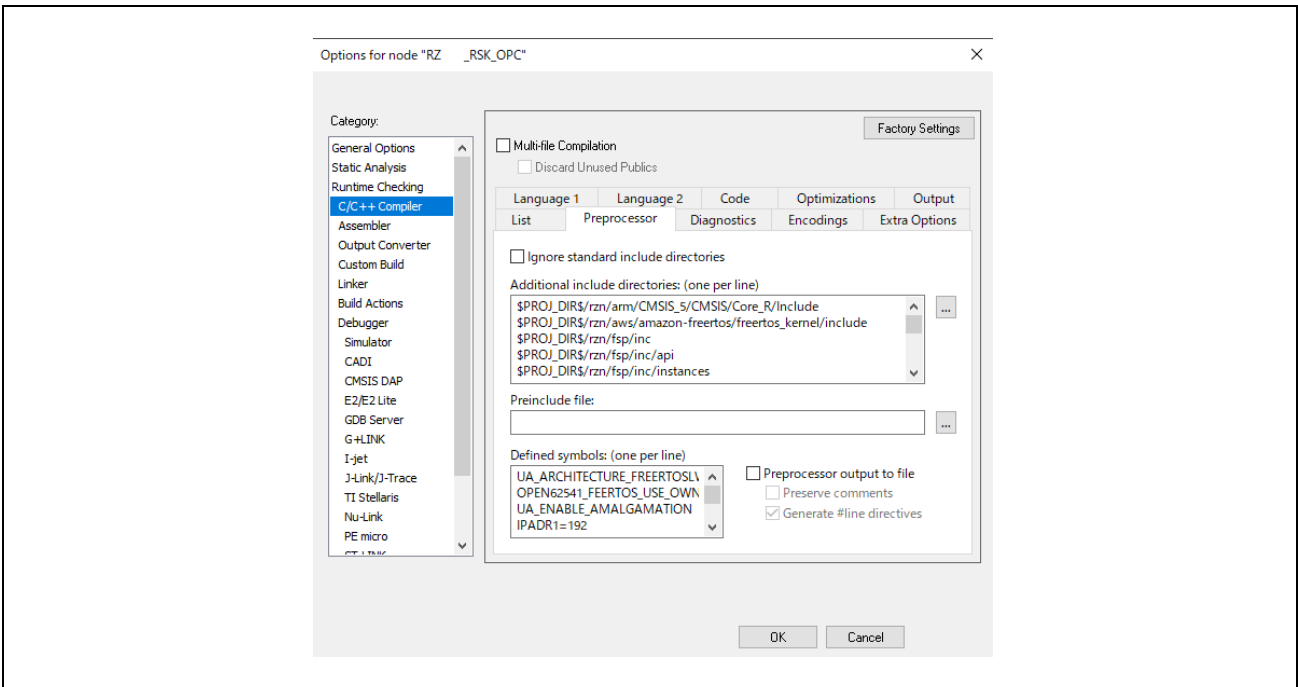


Figure 9.44. Change Build Options

If you change the MAC address, follow the steps below.

In the FSP Smart Configurator, open the Stacks tag and click on “g_ether0 Ethernet” to select it.

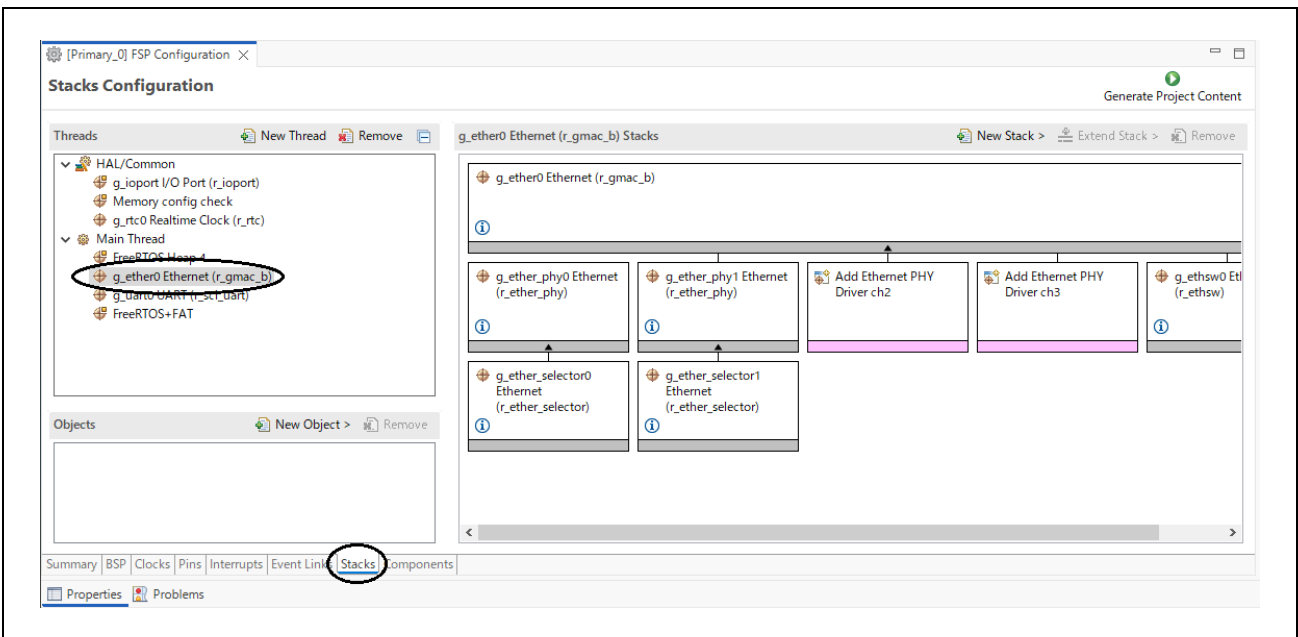


Figure 9.45. Click g_ether0

Open the Properties tag and enter "General">"MAC address0".

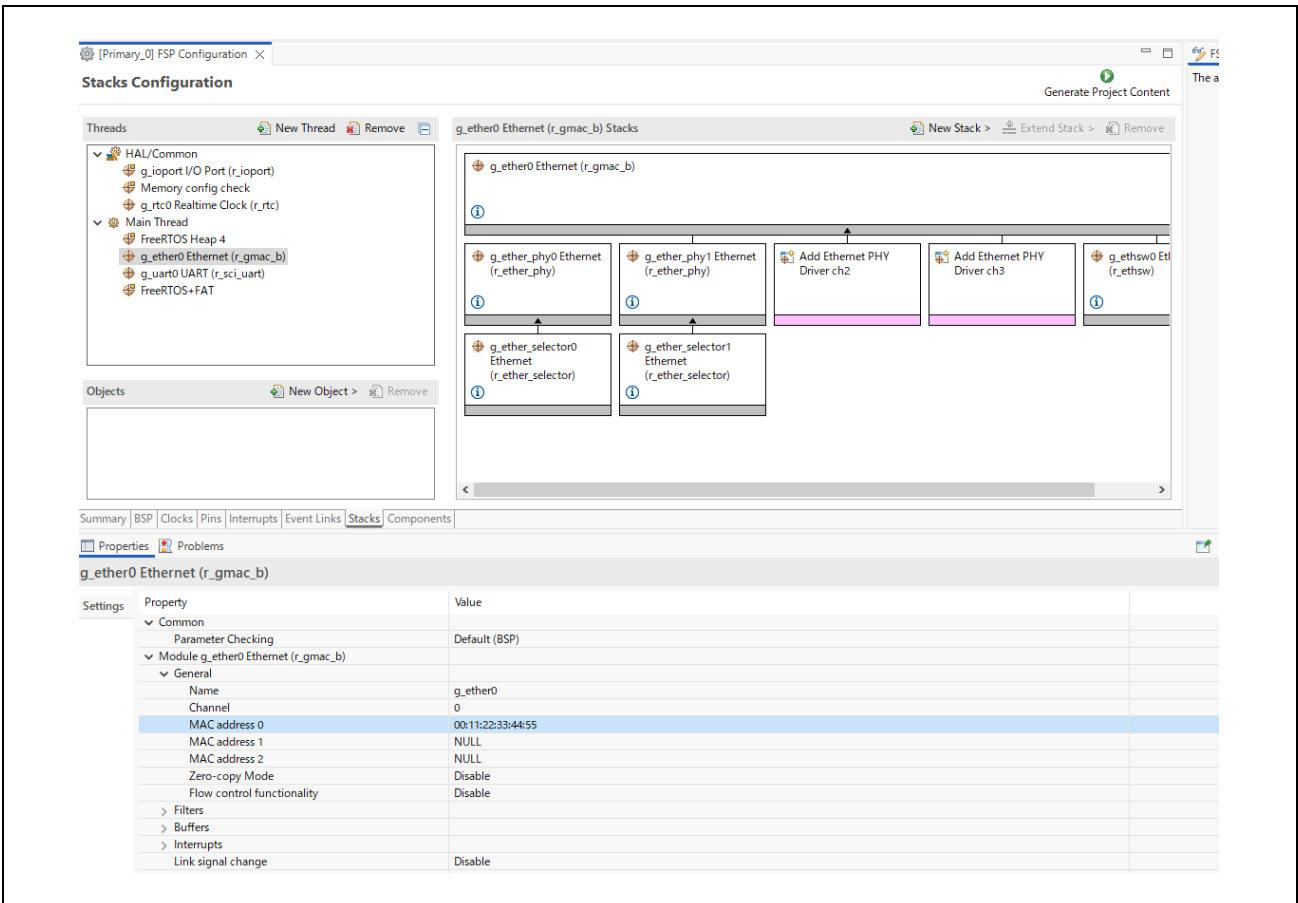


Figure 9.46. Enter MAC address

After the MAC address has been set, click the "Generate Project Content" button to generate the code.

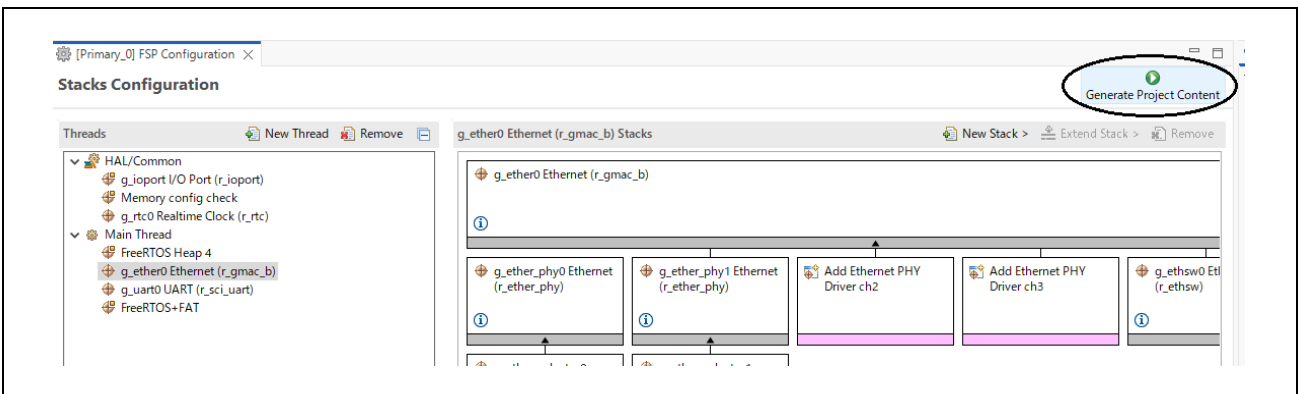


Figure 9.47. Generate Project Content

Additionally, when using the PubSub feature, please modify the definitions in `opc_pubsub_uadp.h`.

Table 9.5. `opc_pubsub_uadp.h` defines

Defines	Description	Parameter	Initial Value
UADP_LAYOUT	Selecting the Layout for the PubSub Example Configuration	UADP_FIXED_LAYOUT: Periodic Fixed Layout UADP_DYNAMIC_LAYOUT: Dynamic Layout	UADP_FIXED_LAYOUT
ENABLE_PUBSUB_EXAMPLE_SETTING	Enabling the PubSub Example Configuration	PUBSUB_EXAMPLE_DISABLE: Disable PUBSUB_EXAMPLE_ENABLE: Enable, No encryption PUBSUB_EXAMPLE_ENABLE_AES128: Enable, Encrypted (AES128-CTR) PUBSUB_EXAMPLE_ENABLE_AES256: Enable, Encrypted (AES256-CTR)	PUBSUB_EXAMPLE_DISABLE

```

5
6
7 #define UADP_FIXED_LAYOUT 1
8 #define UADP_DYNAMIC_LAYOUT 2
9 #define UADP_LAYOUT UADP_FIXED_LAYOUT /* Select Fixed or Dynamic */
10
11 #define PUBSUB_EXAMPLE_DISABLE 0 /* Diable pubsub example config */
12 #define PUBSUB_EXAMPLE_ENABLE 1 /* Enable pubusub example config without security */
13 #define PUBSUB_EXAMPLE_ENABLE_AES128 2 /* Enable pubusub example config with security (PubSub-Aes128-CTR) */
14 #define PUBSUB_EXAMPLE_ENABLE_AES256 3 /* Enable pubusub example config with security (PubSub-Aes256-CTR) */
15
16 #define ENABLE_PUBSUB_EXAMPLE_SETTING PUBSUB_EXAMPLE_DISABLE /* Select 0-3 */

```

Figure 9.48. `opc_pubsub_uadp.h`

9.7 Notes when using newer FSP version

Please refer to the guide in this chapter when using FSP v4.1.0 or later for RZ/T2M or RZ/N2L, or when using FSP v4.2.0 or later for RZ/T2H or RZ/N2H.

- When generating FSP source code, the following linker script files and the shell script files located in (Project Location)/script/ will be overwritten. Please use the original files prior to overwriting for the build. These original files are also provided in “AttachedFiles/original_scripts.zip” in the package.
 - For e² studio projects:
 - fsp_nor_flash_boot.ld (RZ/T2M, RZ/N2L only)
 - fsp_xspi1_boot.ld (RZ/T2H, RZ/N2H only)
 - postbuild.sh (RZ/T2M, RZ/T2H, RZ/N2H only)
 - For EWARM projects:
 - fsp_nor_flash_boot.icf (RZ/T2M, RZ/N2L only)
 - fsp_xspi1_boot.icf (RZ/T2H, RZ/N2H only)
- For e² studio projects, please change the following settings in Properties before building after FSP code generation. However, for dual-core projects, please change these settings only for the secondary project.

Use newlib-nano: Unchecked

Do not use syscalls: Checked

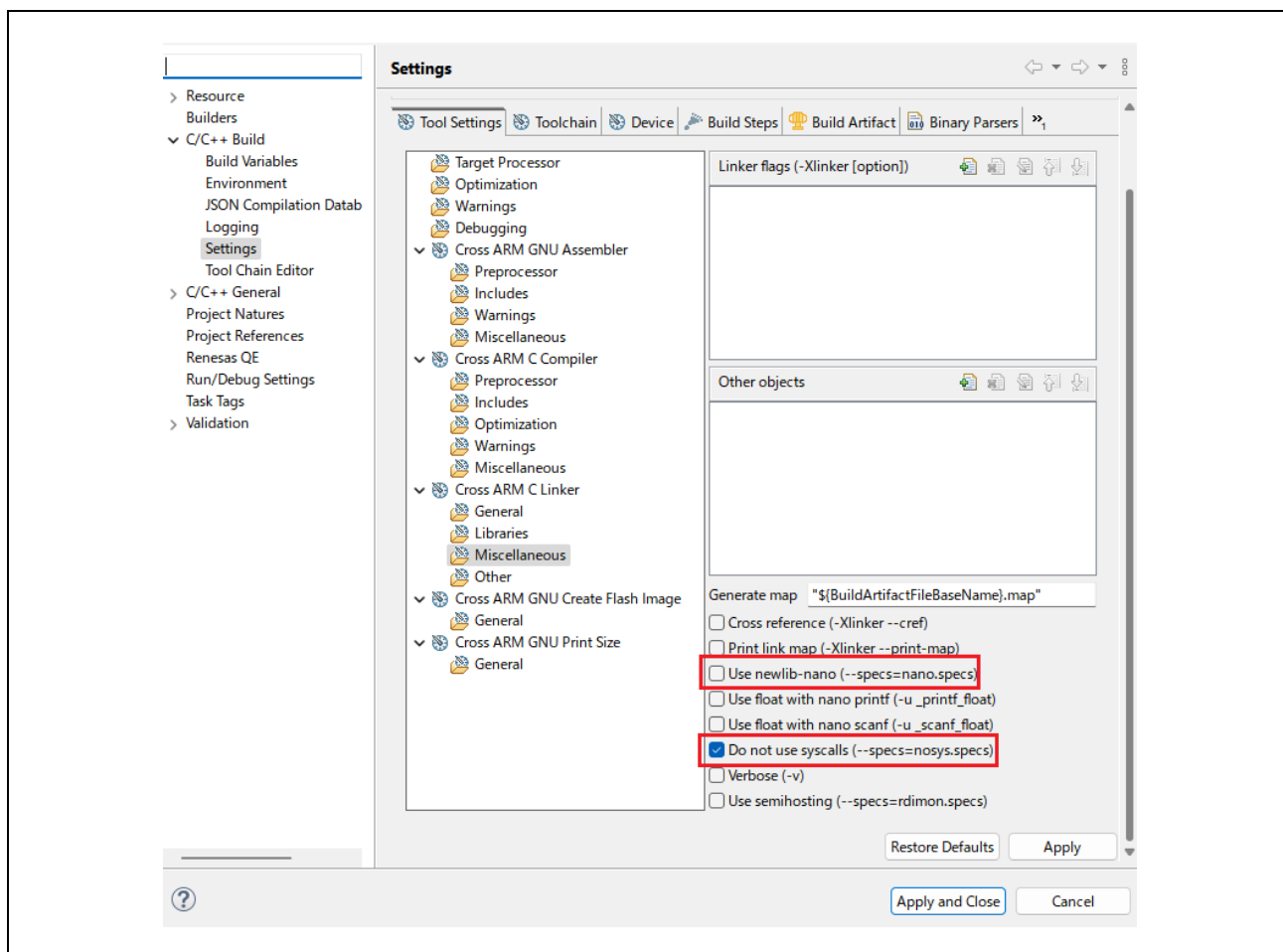


Figure 9.49 Properties

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Apr.15, 2026	-	Integrate the Application Note for RZ/T2M, N2L (R01AN7048xxxxxx) and the Application Note for RZ/T2H, N2H (R01AN7755xxxxxx).
		-	Supported RZ FSP v4.0.0
		p.80	Create a new chapter 8 Software Specifications
1.10	May.29, 2026	p.6	Added notes regarding OPC UA certification. Changed X.509 user authentication to unsupported.
		p.8	Removed descriptions related to files for X.509 user authentication.
		p.12	Updated FSP version for RZ/T2H and N2H. To reflect the the following fix in r_gmac_b: <ul style="list-style-type: none"> Fixed an issue where operation would stop after receiving or transmitting 2^{31} bytes of data via Ethernet.
		p.74	Removed descriptions related to X.509 user authentication.
		p.84	Updated specifications related to SystemReset.
		p.122	Updated configuration values for the ccmake command.
		p.126	Improved the operation verification procedure for PubSub configuration using the Method in section 9.4.
		p.145	Chapter 9.7 Added notes on using newer FSP version

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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(Rev.5.0-1 October 2020)

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